

(Approved by AICTE | NAAC Accreditation with 'A' Grade | Accredited by NBA | Affiliated to JNTUH) Dundigal, Hyderabad - 500 043, Telangana

OUTCOME BASED EDUCATION WITH CHOICE BASED CREDIT SYSTEM

BACHELOR OF TECHNOLOGY ELECTRONICS AND COMMUNICATION ENGINEERING

ACADEMIC REGULATIONS, COURSE STRUCTURE AND SYLLABI (Based on AICTE Model Curriculum)

IARE - R18

B.Tech Regular Four Year Degree Program (for the batches admitted from the academic year 2018- 2019)

&

B.Tech (Lateral Entry Scheme)

(for the batches admitted from the academic year 2019 - 2020)

FAILURE TO READ AND UNDERSTAND THE REGULATIONS IS NOT AN EXCUSE

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"Take up one idea. Make that one idea your life-think of it, dream of it, live on that idea. Let the brain muscles, nerves, every part of your body be full of that idea and just leave every other idea alone. **This is the way to success**"

Swami Vivekananda

PRELIMINARY DEFINITIONS AND NOMENCLATURES

AICTE: Means All India Council for Technical Education, New Delhi.

Autonomous Institute: Means an institute designated as Autonomous by University Grants Commission (UGC), New Delhi in concurrence with affiliating University (Jawaharlal Nehru Technological University, Hyderabad) and State Government.

Academic Autonomy: Means freedom to an institute in all aspects of conducting its academic programs, granted by UGC for Promoting Excellence.

Academic Council: The Academic Council is the highest academic body of the institute and is responsible for the maintenance of standards of instruction, education and examination within the institute. Academic Council is an authority as per UGC regulations and it has the right to take decisions on all academic matters including academic research.

Academic Year: It is the period necessary to complete an actual course of study within a year. It comprises two main semesters i.e., (one odd + one even) and one supplementary semester.

Branch: Means specialization in a program like B.Tech degree program in Aeronautical Engineering, B.Tech degree program in Computer Science and Engineering etc.

Board of Studies (BOS): BOS is an authority as defined in UGC regulations, constituted by Head of the Organization for each of the departments separately. They are responsible for curriculum design and updation in respect of all the programs offered by a department.

Backlog Course: A course is considered to be a backlog course, if the student has obtained a failure grade (F) in that course.

Basic Sciences: The courses offered in the areas of Mathematics, Physics, Chemistry etc., are considered to be foundational in nature.

Betterment: Betterment is a way that contributes towards improvement of the students' grade in any course(s). It can be done by either (a) re-appearing or (b) re-registering for the course.

Commission: Means University Grants Commission (UGC), New Delhi.

Choice Based Credit System: The credit based semester system is one which provides flexibility in designing curriculum and assigning credits based on the course content and hours of teaching along with provision of choice for the student in the course selection.

Certificate Course: It is a course that makes a student to have hands-on expertise and skills required for holistic development in a specific area/field.

Compulsory course: Course required to be undertaken for the award of the degree as per the program.

Continuous Internal Examination: It is an examination conducted towards sessional assessment.

Core: The courses that are essential constituents of each engineering discipline are categorized as professional core courses for that discipline.

Course: A course is a subject offered by a department for learning in a particular semester.

Course Outcomes: The essential skills that need to be acquired by every student through a course.

Credit: A credit is a unit that gives weight to the value, level or time requirements of an academic course. The number of 'Contact Hours' in a week of a particular course determines its credit value. One credit is equivalent to one lecture/tutorial hour per week.

Credit point: It is the product of grade point and number of credits for a course.

Cumulative Grade Point Average (CGPA): It is a measure of cumulative performance of a student over all the completed semesters. The CGPA is the ratio of total credit points secured by a student in various courses in all semesters and the sum of the total credits of all courses in all the semesters. It is expressed up to two decimal places.

Curriculum: Curriculum incorporates the planned interaction of students with instructional content, materials, resources, and processes for evaluating the attainment of Program Educational Objectives.

Department: An academic entity that conducts relevant curricular and co-curricular activities, involving both teaching and non-teaching staff, and other resources in the process of study for a degree.

Detention in a Course: Student who does not obtain minimum prescribed attendance in a course shall be detained in that particular course.

Dropping from Semester: Student who doesn't want to register for any semester can apply in writing in prescribed format before the commencement of that semester.

Elective Course: A course that can be chosen from a set of courses. An elective can be Professional Elective and / or Open Elective.

Evaluation: Evaluation is the process of judging the academic performance of the student in her/his courses. It is done through a combination of continuous internal assessment and semester end examinations.

Grade: It is an index of the performance of the students in a said course. Grades are indicated by alphabets.

Grade Point: It is a numerical weight allotted to each letter grade on a 10 - point scale.

Honours: An Honours degree typically refers to a higher level of academic achievement at an undergraduate level.

Institute: Means Institute of Aeronautical Engineering, Hyderabad unless indicated otherwise by the context.

Massive Open Online Courses (MOOC): MOOC courses inculcate the habit of self learning. MOOC courses would be additional choices in all the elective group courses.

Minor: Minor are coherent sequences of courses which may be taken in addition to the courses required for the B.Tech degree.

Pre-requisite: A specific course or subject, the knowledge of which is required to complete before student register another course at the next grade level.

Professional Elective: It indicates a course that is discipline centric. An appropriate choice of minimum number of such electives as specified in the program will lead to a degree with specialization.

Program: Means, UG degree program: Bachelor of Technology (B.Tech); PG degree program: Master of Technology (M.Tech) / Master of Business Administration (MBA).

Program Educational Objectives: The broad career, professional and personal goals that every student will achieve through a strategic and sequential action plan.

Project work: It is a design or research based work to be taken up by a student during his/her final year to achieve a particular aim. It is a credit based course and is to be planned carefully by the student.

Re-Appearing: A student can reappear only in the semester end examination for theory component of a course, subject to the regulations contained herein.

Registration: Process of enrolling into a set of courses in a semester of a program.

Regulations: The regulations, common to all B.Tech programs offered by Institute, are designated as "IARE Regulations - R18" and are binding on all the stakeholders.

Semester: It is a period of study consisting of 15 to 18 weeks of academic work equivalent to normally 90 working days. Odd semester commences usually in July and even semester in December of every year.

Semester End Examinations: It is an examination conducted for all courses offered in a semester at the end of the semester.

S/he: Means "she" and "he" both.

Student Outcomes: The essential skill sets that need to be acquired by every student during her/his program of study. These skill sets are in the areas of employability, entrepreneurial, social and behavioral.

University: Means Jawaharlal Nehru Technological University Hyderabad (JNTUH), Hyderabad, is an affiliating University.

Withdraw from a Course: Withdrawing from a course means that a student can drop from a course within the first two weeks of odd or even semester (deadlines are different for summer sessions). However, s/he can choose a substitute course in place of it, by exercising the option within 5 working days from the date of withdrawal.

FOREWORD

The autonomy is conferred to Institute of Aeronautical Engineering (IARE), Hyderabad by University Grants Commission (UGC), New Delhi based on its performance as well as future commitment and competency to impart quality education. It is a mark of its ability to function independently in accordance with the set norms of the monitoring bodies including J N T University Hyderabad (JNTUH), Hyderabad and AICTE, New Delhi. It reflects the confidence of the affiliating University in the autonomous institution to uphold and maintain standards it expects to deliver on its own behalf. Thus, an autonomous institution is given the freedom to have its own **curriculum, examination system** and **monitoring mechanism**, independent of the affiliating University but under its observance.

IARE is proud to win the credence of all the above bodies monitoring the quality in education and has gladly accepted the responsibility of sustaining, if not improving upon the standards and ethics for which it has been striving for more than a decade in reaching its present standing in the arena of contemporary technical education. As a follow up, statutory bodies such as Academic Council and Board of Studies (BOS) are constituted with the guidance of the Governing Body of the institute and recommendations of the JNTUH to frame the regulations, course structure, and syllabi under autonomous status.

The autonomous regulations, course structure, and syllabi have been prepared after prolonged and detailed interaction with several expertise solicited from academics, industry and research, in accordance with the vision and mission of the institute in order to produce a quality engineering graduate to the society.

All the faculty, parents, and students are requested to go through all the rules and regulations carefully. Any clarifications needed are to be sought at appropriate time and from the principal of the institute, without presumptions, to avoid unwanted subsequent inconveniences and embarrassments. The cooperation of all the stake holders is requested for the successful implementation of the autonomous system in the larger interests of the institute and brighter prospects of engineering graduates.

PRINCIPAL



INSTITUTE OF AERONAUTICAL ENGINEERING

(Autonomous)

ACADEMIC REGULATIONS

B.Tech. Regular Four Year Degree Program (for the batches admitted from the academic year 2018 - 19) & B.Tech. (Lateral Entry Scheme) (for the batches admitted from the academic year 2019 - 20)

For pursuing four year undergraduate Bachelor of Technology degree program of study in Engineering (B.Tech) offered by Institute of Aeronautical Engineering under Autonomous status and herein after referred to as IARE.

Preamble:

All India Council for Technical Education (AICTE) has introduced Model Curriculum for Bachelor of Technology program with 160 credits in the entire program of 4 years, and additional 20 credits can be acquired for the degree of B.Tech with **Honours or additional Minor in Engineering**. These additional 20 credits will have to be acquired with online courses (MOOCs), perhaps for the first time in the country, to tap the zeal and excitement of learning beyond the classrooms. So, the students will have to complete additional 20 credits through MOOCs within 4 years of time. This creates an excellent opportunity for students to acquire the necessary skill set for employability through massive open online courses where the rare expertise of world famous experts from academics and industry are available.

Separate certificate will be issued in addition to regular degree program mentioning that the student has cleared Honours / Minor specialization in respective courses in addition to scheduled courses for B.Tech programs.

1. CHOICE BASED CREDIT SYSTEM

The Indian Higher Education Institutions (HEIs) are changing from the conventional course structure to Choice Based Credit System (CBCS) along with introduction to semester system in the first year itself. The semester system helps in accelerating the teaching-learning process and enables vertical and horizontal mobility in learning.

The credit based semester system provides flexibility in designing curriculum and assigning credits based on the course content and hours of teaching. The choice based credit system provides a 'cafeteria' type approach in which the students can take courses of their choice, learn at their own pace, undergo additional courses and acquire more than the required credits, and adopt an interdisciplinary approach to learning.

Choice Based Credit System (CBCS) is a flexible system of learning and provides choice for students to select from the prescribed elective courses. A course defines learning objectives and learning outcomes and comprises lectures / tutorials / laboratory work / field work / project work / comprehensive Examination / seminars / assignments / MOOCs / alternative assessment tools / presentations / self-study etc., or a combination of some of these.

Under the CBCS, the requirement for awarding a degree is prescribed in terms of number of credits to be completed by the students.

The CBCS permits students to:

- 1. Choose electives from a wide range of elective courses offered by the departments.
- 2. Undergo additional courses of interest.
- 3. Adopt an interdisciplinary approach in learning.
- 4. Make the best use of expertise of the available faculty.

2. MEDIUM OF INSTRUCTION

The medium of instruction shall be English for all courses, examinations, seminar presentations and project work. The curriculum will comprise courses of study as given in course structure, in accordance with the prescribed syllabi.

3. PROGRAMS OFFERED

Presently, the institute is offering Bachelor of Technology (B.Tech) degree programs in the following disciplines:

- 1. Aeronautical Engineering
- 2. Computer Science and Engineering
- 3. Information Technology
- 4. Electronics and Communication Engineering
- 5. Electrical and Electronics Engineering
- 6. Mechanical Engineering
- 7. Civil Engineering

4. SEMESTER STRUCTURE

Each academic year is divided into three semesters, TWO being **MAIN SEMESTERS** (one odd + one even) and ONE being a **SUPPLEMENTARY SEMESTER**. Main semesters are for regular class work. Supplementary Semester is primarily for failed students i.e. registration for a course for the first time is generally not permitted in the supplementary semester.

- 4.1 Each main semester shall be of 21 weeks (Table 1) duration and this period includes time for registration of courses, course work, examination preparation, and conduct of examinations.
- 4.2 Each main semester shall have a minimum of 90 working days; out of which 75 days are for teaching / practical and 15 days for conduct of exams and preparation.
- 4.3 The supplementary semester shall be a fast track semester consisting of eight weeks and this period includes time for registration of courses, course work, and examination preparation, conduct of examinations, assessment, and declaration of final results.
- 4.4 All subjects may not be offered in the supplementary semester. The student has to pay a stipulated fee prescribed by the institute to register for a course in the supplementary semester. The supplementary semester is provided to help the student in not losing an academic year. It is optional for a student to make use of supplementary semester. Supplementary semester is a special semester and the student cannot demand it as a matter of right and will be offered based on availability of faculty and other institute resources.
- 4.5 The institute may use **supplementary semester** to arrange add-on courses for regular students and / or for deputing them for practical training / FSI model. A student can register for a maximum number of 15 credits during a supplementary semester.
 - 4.5.1 The registration for the supplementary semester (during May July, every year) provides an opportunity to students to clear their backlogs ('F' grade) or who are prevented from appearing for SEE examinations due to shortage of attendance less than 65% in each course ('SA' Grade) in the earlier semesters or the courses which he / she could not register (Drop / Withdraw) due to any reason.

Students will not be permitted to register for more than 15 credits (both I and II semester) in the supplementary semester. Students required to register for supplementary semester courses are to pay a nominal fee within the stipulated time. A separate circular shall be issued at the time of supplementary semester.

It will be optional for a student to get registered in the course(s) of supplementary semester; otherwise, he / she can opt to appear directly in supplementary examination. However, if a student gets registered in a course of supplementary semester, then it will be compulsory for a student to fulfill attendance criterion (\geq 90%) of supplementary semester and he / she will lose option to appear in immediate supplementary examination.

The students who have earlier taken SEE examination and register afresh for the supplementary semester may revoke the CIA marks secured by them in their regular/earlier attempts in the same course. Once revoked, the students shall not seek restoration of the CIA marks.

Supplementary semester will be at an accelerated pace e.g. one credit of a course shall require two hours/week so that the total number of contact hours can be maintained same as in normal semester.

Instructions and guidelines for the supplementary semester course:

- A minimum of 36 to 40 hours will be taught by the faculty for every course.
- Only the students registered and having sufficient percentage of attendance for the course will be permitted to write the examination.
- The assessment procedure in a supplementary semester course will be similar to the procedure for a regular semester course.
- Student shall register for the supplementary semester as per the schedule given in academic calendar.
- Once registered, students will not be allowed to withdraw from supplementary semester.
- 4.5.2 The academic calendar shown in Table 1 is declared at the beginning of the academic year.

	I Spell Instruction Period	8 weeks	
TIDOT	I Mid Examinations	1 week	
FIRST SEMESTER	II Spell Instruction Period	8 weeks	19 weeks
(21 weeks)	II Mid Examinations	1 week	
(21 WEEKS)	Preparation and Practical Examinations	1 week	
	Semester End Examinations		2 weeks
Sem	2 weeks		
	I Spell Instruction Period	8 weeks	
SECOND	I Mid Examinations	1 week	
SEMESTER	II Spell Instruction Period	8 weeks	19 weeks
(21 weeks)	II Mid Examinations	1 week	
(21 WEEKS)	Preparation & Practical Examinations 1 week		
	Semester End Examinations		2 weeks
Summer Vacation, Supplementary Semester and Remedial Exams			8 weeks

Table 1: Academic Calendar

4.6 Students admitted on transfer from JNTUH affiliated institutes, Universities and other institutes in the subjects in which they are required to earn credits so as to be on par with regular students as prescribed by concerned 'Board of Studies'.

5.0 REGISTRATION / DROPPING / WITHDRAWAL

- 5.1. Each student has to compulsorily register for course work at the beginning of each semester as per the schedule mentioned in the Academic Calendar. It is compulsory for the student to register for courses in time. The registration will be organized departmentally under the supervision of the Head of the Department.
- 5.2. In ABSENTIA, registration will not be permitted under any circumstances.
- 5.3. At the time of registration, students should have cleared all the dues of Institute and Hostel for the previous semesters, paid the prescribed fees for the current semester and not been debarred from the institute for a specified period on disciplinary or any other ground.
- 5.4. The student has to normally register for a minimum of 17 credits and may register up to a maximum of 27 credits, in consultation with HOD/faculty mentor. On an average, a student is expected to register for 22 credits.
- 5.5. **Dropping of Courses:** Within one week after the last date of first internal assessment test or by the date notified in the academic calendar, the student may in consultation with his / her faculty mentor/adviser, drop one or more courses without prejudice to the minimum number of credits as specified in clause 5.4. The dropped courses are not recorded in the Grade Card. Student must complete the dropped subject by registering in the supplementary semester / forthcoming semester in order to earn the required credits. Student must complete the dropped subject by registering semester in order to earn the required credits.
- 5.6. **Withdrawal from Courses:** A student is permitted to withdraw from a course by the date notified in the academic calendar. Such withdrawals will be permitted without prejudice to the minimum number of credits as specified in clause 5.4. A student cannot withdraw a course more than once and withdrawal of reregistered subjects is not permitted.
- 5.7 After **Dropping and / or Withdrawal** of courses, minimum credits registered shall be 20.

6.0 UNIQUE COURSE IDENTIFICATION CODE

Every course of the B.Tech program will be placed in one of the seven groups of courses as listed in the Table 2. The various courses and their two-letter codes are given below;

S. No	Branch	Code
1	Aeronautical Engineering	AE
2	Computer Science and Engineering	CS
3	Information Technology	IT
4	Electronics and Communication Engineering	EC
5	Electrical and Electronics Engineering	EE
6	Mechanical Engineering	ME
7	Civil Engineering	CE

Table 2: Group of Courses

7.0 CURRICULUM AND COURSE STRUCTURE

The curriculum shall comprise Theory Courses, Elective Courses, Laboratory Courses, Audit Courses, Mandatory Courses, Mini Project, Internship and Project work. The list of elective courses may also include subjects from allied discipline.

Contact Periods: Depending on the complexity and volume of the course, the number of contact periods per week will be assigned. Each Theory and Laboratory course carries credits based on the number of hours/week as follows:

- Contact classes (Theory): 1 credit per lecture hour per week, 1 credit per tutorial hour per week.
- Laboratory Hours (Practical): 1 credit for 2 practical hours per week.
- **Project Work:** 1 credit for 2 hours of project work per week.
- **Mini Project:** 1 credit for 2 hours per week

7.1 **TYPES OF COURSES**

Courses in a program may be of three kinds: Foundation / Skill, Core and Elective Courses.

7.1.0 Foundation / Skill Course:

Foundation courses are the courses based upon the content leads to enhancement of skill and knowledge as well as value based and are aimed at man making education. Skill subjects are those areas in which one needs to develop a set of skills to learn anything at all. They are fundamental to learning any subject.

7.1.1 Professional Core Courses:

There may be a core course in every semester. This is the course which is to be compulsorily studied by a student as a core requirement to complete the requirement of a program in the said discipline of study.

7.1.2 Elective Course:

Electives provide breadth of experience in respective branch and application areas. Elective course is a course which can be chosen from a pool of courses. It may be:

- Supportive to the discipline of study
- Providing an expanded scope
- Enabling an exposure to some other discipline / domain
- Nurturing student's proficiency / skill.

An elective may be Professional Elective, is a discipline centric focusing on those courses which add generic proficiency to the students or may be Open Elective, chosen from unrelated disciplines.

There are six professional elective tracks; students can choose not more than two courses from each track. Overall, students can opt for six professional elective courses which suit their project work in consultation with the faculty advisor/mentor. Nevertheless, one course from each of the four open electives has to be selected. A student may also opt for more elective courses in his/her area of interest.

7.1.3 Credit distribution for courses offered is given in Table 3.

S. No	Course	Hours	Credits
1	Theory Course	1 / 2 / 3 / 4	1 / 2 / 3 / 4
2	Elective Courses	3	3
3	MOOC Courses	-	2
4	Laboratory Courses	2/3/4	1 / 1.5 / 2
5	Audit Course / Mandatory Course	-	0
6	Project / Research based learning	-	4
7	Full Semester Internship (FSI) / Project Work	-	11

Table 3: Credit distribution

7.2 Course Structure

Every course of the B.Tech program will be placed in one of the eight categories with minimum credits as listed in the Table 4.

S. No	Category	Breakup of Credits
1	Humanities and Social Sciences (HSMC), including Management.	12
2	Basic Science Courses (BSC) including Mathematics, Physics and Chemistry.	25
3	Engineering Science Courses (ESC), including Workshop, Drawing, Basics of Electrical / Electronics / Mechanical / Computer Engineering.	24
4	Professional Core Courses (PCC), relevant to the chosen specialization / branch.	48
5	Professional Electives Courses (PEC), relevant to the chosen specialization / branch.	18
6	Open Elective Courses (OEC), from other technical and/or emerging subject areas.	18
7	Project Based Learning, Research Based Learning and Project Work (PROJ) / Full Semester Internship (FSI)	15
8	Mandatory Courses / Audit Courses.	Non-Credit
	TOTAL	160

Table 4: Category Wise Distribution of Credits

7.3 Semester wise course break-up

Following are the **TWO** models of course structure out of which any student shall choose or will be allotted with one model based on their academic performance.

- i. Full Semester Internship (FSI) Model and
- ii. Non Full Semester Internship (NFSI) Model Project work.

7.4 For Four year regular program (FSI Model):

In the FSI Model, out of the selected students - half of students shall undergo Full Semester Internship in VII semester and the remaining students in VIII semester. In the Non FSI Model,

all the selected students shall carry out the course work and Project work as specified in the course structure. A student who secures a minimum CGPA of 7.5 up to IV semester with no current arrears and maintains the CGPA of 7.5 till VI Semester shall be eligible to opt for FSI.

8.0 EVALUATION METHODOLOGY

8.1 Theory Course:

Each theory course will be evaluated for a total of 100 marks, with 30 marks for Continuous Internal Assessment (CIA) and 70 marks for Semester End Examination (SEE). Out of 30 marks allotted for CIA during the semester, marks are awarded by taking average of two CIA examinations or the marks scored in the make-up examination.

8.1.1 Semester End Examination (SEE):

The SEE is conducted for 70 marks of 3 hours duration. The syllabus for the theory courses is divided into FIVE modules and each modules carries equal weightage in terms of marks distribution. The question paper pattern is as follows.

Two full questions with 'either' 'or' choice will be drawn from each module. Each question carries 14 marks. There could be a maximum of two sub divisions in a question.

The emphasis on the questions is broadly based on the following criteria:

50 %	To test the objectiveness of the concept
50 %	To test the analytical skill of the concept OR to test the application skill of the concept

8.1.2 Continuous Internal Assessment (CIA):

For each theory course the CIA shall be conducted by the faculty / teacher handling the course as given in Table 5. CIA is conducted for a total of 30 marks, with 20 marks for Continuous Internal Examination (CIE), 05 marks for Quiz and 05 marks for Alternative Assessment Tool (AAT).

COMPONENT	THEORY			TOTAL
Type of Assessment	CIE Exam	Quiz	AAT	MARKS
Max. CIA Marks	20	05	05	30

Table 5: Assessment pattern for Theory Courses

8.1.2.1 Continuous Internal Examination (CIE):

Two CIE exams shall be conducted at the end of the 8th and 16th week of the semester respectively. The CIE exam is conducted for 20 marks of 2 hours duration consisting of five descriptive type questions out of which four questions have to be answered where, each question carries 5 marks. Marks are awarded by taking average of marks scored in two CIE exams. The valuation and verification of answer scripts of CIE exams shall be completed within a week after the conduct of the Examination.

8.1.2.2 Quiz – Online Examination

Two Quiz exams shall be online examination consisting of 50 multiple choice questions and are to be answered by choosing the correct answer from a given set

of choices (commonly four). Such a question paper shall be useful in testing of knowledge, skills, application, analysis, evaluation and understanding of the students. Marks shall be awarded considering the average of two quiz examinations for every course.

8.1.2.3 Alternative Assessment Tool (AAT)

In order to encourage innovative methods while delivering a course, the faculty members are encouraged to use the Alternative Assessment Tool (AAT). This AAT enables faculty to design own assessment patterns during the CIA. The AAT enhances the autonomy (freedom and flexibility) of individual faculty and enables them to create innovative pedagogical practices. If properly applied, the AAT converts the classroom into an effective learning centre. The AAT may include tutorial hours/classes, seminars, assignments, term paper, open ended experiments, **METE** (Modeling and Experimental Tools in Engineering), five minutes video, MOOCs etc.

However, it is mandatory for a faculty to obtain prior permission from the concerned HOD and spell out the teaching/assessment pattern of the AAT prior to commencement of the classes.

8.2 Laboratory Course:

- 8.2.1 Each laboratory will be evaluated for a total of 100 marks consisting of 30 marks for internal assessment and 70 marks for semester end lab examination. Out of 30 marks of internal assessment, continuous lab assessment will be done for 20 marks for the day to day performance and 10 marks for the final internal lab assessment. The semester end lab examination for 70 marks shall be conducted by two examiners, one of them being Internal Examiner and the other being External Examiner, both nominated by the Principal from the panel of experts recommended by the Chairman, BOS.
- 8.2.2 All the drawing related courses are evaluated in line with laboratory courses. The distribution shall be 30 marks for internal evaluation (20 marks for day–to–day work, and 10 marks for internal tests) and 70 marks for semester end lab examination. There shall be ONE internal test of 10 marks in each semester.

8.3 Mandatory Courses (MC):

These courses are among the compulsory courses but will not carry any credits. However, a pass in each such course during the program shall be necessary requirement for the student to qualify for the award of Degree. Its result shall be declared as "Satisfactory" or "Not Satisfactory" performance.

8.4 Value Added Courses:

The value added courses are audit courses offered through joint ventures with various organizations providing ample scope for the students as well as faculty to keep pace with the latest technologies pertaining to their chosen fields of study. A plenty of value added programs will be proposed by the departments one week before the commencement of class work. The students are given the option to choose the courses according to their desires and inclinations as they choose the desired items in a cafeteria. The expertise gained through the value added programs should enable them to face the formidable challenges of the future and also assist them in exploring new opportunities. Its result shall be declared with "Satisfactory" or "Not Satisfactory" performance.

8.5 Project / Research Based Learning

This gives students a platform to experience a research driven career in engineering, while developing a device / systems and publishing in reputed SCI / SCOPUS indexed journals and/or filing an **Intellectual Property** (IPR-Patent/Copyright) to aid communities around the world. Students should work individually as per the guidelines issued by head of the department concerned. The benefits to students of this mode of learning include increased engagement, fostering of critical thinking and greater independence.

The topic should be so selected that the students are enabled to complete the work in the stipulated time with the available resources in the respective laboratories. The scope of the work be handling part of the consultancy work, maintenance of the existing equipment, development of new experiment setup or can be a prelude to the main project with a specific outcome.

Project report will be evaluated for 100 marks in total. Assessment will be done for 100 marks out of which, the supervisor / guide will evaluate for 30 marks based on the work and presentation / execution of the work. Subdivision for the remaining 70 marks is based on publication, report, presentation, execution and viva-voce. Evaluation shall be done by a committee comprising the supervisor, Head of the department and an examiner nominated by the Principal from the panel of experts recommended by Chairman, BOS in consultation with Head of the department.

8.6 Project work

The project work shall be evaluated for 100 marks out of which 30 marks for internal evaluation and 70 marks for semester end evaluation. The project work shall be spread over in VII semester and in VIII semester. The project work shall be somewhat innovative in nature and explore the research bent of the mind of the student. A student shall carry out the project work under the supervision of a member of the faculty or may undertake to execute the project in collaboration with an Industry, R&D organization or another academic institution/University where sufficient facilities exist to carry out the project work.

At the end of VII semester, students should submit synopsis summarizing the work done in VII semester. The project is expected to be completed by the end of VIII semester. In VII semester, a first mid review is conducted by Project Review Committee (PRC) (on the progress) for 10 marks.

In VIII semester, a second mid review is conducted by PRC (on the progress) for 10 marks. On completion of the project, a third evaluation is conducted for award of internal marks of another 10 marks before the report is submitted, making the total internal marks 30.

The end semester examination shall be based on the report submitted and a viva-voce exam for 70 marks by a committee comprising the Head of the Department, the project supervisor and an external examiner nominated by the Principal. A minimum of 40% of maximum marks shall be obtained to earn the corresponding credits.

8.7 Full Semester Internship (FSI)

FSI is a full semester internship program carrying 11 credits. The FSI shall be opted in VII semester or in VIII semester. During the FSI, student has to spend one full semester in an identified industry / firm / R & D organization or another academic institution/University where sufficient facilities exist to carry out the project work.

Following are the evaluation guidelines:

- Quizzes: 2 times
- Quiz #1 About the industry profile, weightage: 5%
- Quiz #2 Technical-project related, weightage: 5%
- Seminars 2 times (once in six weeks), weightage: 7.5% + 7.5%
- Viva-voce: 2 times (once in six weeks), weightage: 7.5% + 7.5%
- Project Report, weightage: 15%
- Internship Diary, weightage: 5 %
- Final Presentation, weightage: 40%

FSI shall be open to all the branches with a ceiling of maximum 10% distributed in both semesters. The selection procedure is:

- Choice of the students
- CGPA (> 7.5) up to IV semester
- Competency Mapping / Allotment

9.0 MAKEUP EXAMINATION

The make-up examination facility shall be available to students who may have missed to attend CIE exams in one or more courses in a semester for valid genuine reasons. The make-up examination shall have comprehensive online objective type questions. The syllabus for the make-up examination shall be the whole syllabus covered till the end of the semester under consideration and will be conducted at the end of the semester.

10.0 SUPPLEMENTARY EXAMINATIONS:

In addition to the Regular Semester End Examinations held at the end of each semester, Supplementary Semester End Examinations will be conducted within three weeks of the commencement of the teaching of the next semester. Candidates taking the Regular / Supplementary examinations as Supplementary candidates may have to take more than one Semester End Examination per day. A student can appear for any number of supplementary examinations till he/she clears all courses which he/she could not clear in the first attempt. However the maximum stipulated period for the course shall not be relaxed under any circumstances.

11.0 ATTENDANCE REQUIREMENTS AND DETENTION POLICY

- 11.1 It is desirable for a candidate to have 100% attendance in each course. In every course (theory/laboratory), student has to maintain a minimum of 75% attendance including the days of attendance in sports, games, NCC and NSS activities to be eligible for appearing in Semester End Examination of the course.
- 11.2 In case of medical issues, deficiency of attendance in each course to the extent of 10% may be condoned by the College Academic Committee (CAC) on the recommendation of the Head of the Department if the attendance is between 75% and 65% in every course, subjected to the submission of medical certificates, medical case file, and other needful documents to the concerned departments.
- 11.3 The basis for the calculation of the attendance shall be the period prescribed by the institute by its calendar of events. For late admission, attendance is reckoned from the date of admission to the program. However, in case of a student having less than 65% attendance in any course, s/he shall be detained in the course and in no case such process will be relaxed.

- 11.4 A candidate shall put in a minimum required attendance in atleast 60% of (rounded to the next highest integer) theory courses for getting promoted to next higher class / semester. Otherwise, s/he shall be declared detained and has to repeat semester.
- 11.5 Students whose shortage of attendance is not condoned in any subject are not eligible to write their semester end examination of that courses and their registration shall stand cancelled.
- 11.6 A prescribed fee shall be payable towards condonation of shortage of attendance.
- 11.7 A student shall not be promoted to the next semester unless he satisfies the attendance requirement of the present semester, as applicable. They may seek readmission into that semester when offered next. If any candidate fails to fulfill the attendance requirement in the present semester, he shall not be eligible for readmission into the same class.
- 11.8 Any student against whom any disciplinary action by the institute is pending shall not be permitted to attend any SEE in that semester.

12.0 CONDUCT OF SEMESTER END EXAMINATIONS AND EVALUATION

- 12.1 Semester end examination shall be conducted by the Controller of Examinations (COE) by inviting Question Papers from the External Examiners.
- 12.2 Question papers may be moderated for the coverage of syllabus, pattern of questions by a Semester End Examination Committee chaired by Head of the Department one day before the commencement of semester end examinations. Internal Examiner shall prepare a detailed scheme of valuation.
- 12.3 The answer papers of semester end examination should be evaluated by the internal examiner immediately after the completion of exam and the award sheet should be submitted to COE in a sealed cover before the same papers are kept for second evaluation by external examiner.
- 12.4 In case of difference of more than 15% of marks, the answer paper shall be re-evaluated by a third examiner appointed by the Examination Committee and marks awarded by this examiner shall be taken as final.
- 12.5 COE shall invite 3 9 external examiners to evaluate all the end-semester answer scripts on a prescribed date(s). Practical laboratory exams are conducted involving external examiners.
- 12.6 Examinations Control Committee shall consolidate the marks awarded by internal and external examiners and award grades.

13.0 SCHEME FOR THE AWARD OF GRADE

- 13.1 A student shall be deemed to have satisfied the minimum academic requirements and earn the credits for each theory course, if s/he secures
 - i. Not less than 35% marks for each theory course in the semester end examination, and
 - ii. A minimum of 40% marks for each theory course considering both internal and semester end examination.
- 13.2 A student shall be deemed to have satisfied the minimum academic requirements and earn the credits for each Lab / Project based learning / Research based learning / Project work / FSI, if s/he secures
 - i. Not less than 40% marks for each Lab / Project based learning / Research based learning / Project work / FSI course in the semester end examination,
 - ii. A minimum of 40% marks for each Lab / Project based learning / Research based learning / Project work / FSI course considering both internal and semester end examination.

13.3 If a candidate fails to secure a pass in a particular course, it is mandatory that s/he shall register and reappear for the examination in that course during the next semester when examination is conducted in that course. It is mandatory that s/he should continue to register and reappear for the examination till s/he secures a pass.

14.0 LETTER GRADES AND GRADE POINTS

14.1 Performances of students in each course are expressed in terms of marks as well as in Letter Grades based on absolute grading system. The UGC recommends a 10-point grading system with the following letter grades as given in the Table-6.

Range of Marks	Grade Point	Letter Grade
100 - 90	10	S (Superior)
89 - 80	9	A+ (Excellent)
79 – 70	8	A (Very Good)
69 - 60	7	B+ (Good)
59 - 50	6	B (Average)
49 - 40	5	C (Pass)
Below 40	0	F (Fail)
Absent	0	AB (Absent)
Authorized Break of Study	0	ABS

Table-6: Grade Points Scale (Absolute Grading)

- 14.2 A student is deemed to have passed and acquired to correspondent credits in particular course if s/he obtains any one of the following grades: "S", "A+", "A", "B+", "B", "C".
- 14.3 A student obtaining Grade F shall be considered Failed and will be required to reappear in the examination.
- 14.4 For non credit courses, 'Satisfactory' or "Not Satisfactory" is indicated instead of the letter grade and this will not be counted for the computation of SGPA/CGPA.
- 14.5 "SA" denotes shortage of attendance (as per item 11) and hence prevention from writing Semester End Examination.
- 14.6 "W" denotes **withdrawal** from the exam for the particular course.
- 14.7 At the end of each semester, the institute issues grade sheet indicating the SGPA and CGPA of the student. However, grade sheet will not be issued to the student if s/he has any outstanding dues.

15.0 COMPUTATION OF SGPA AND CGPA

The UGC recommends to compute the Semester Grade Point Average (SGPA) and Cumulative Grade Point Average (CGPA). The credit points earned by a student are used for calculating the Semester Grade Point Average (SGPA) and the Cumulative Grade Point Average (CGPA), both of which are important performance indices of the student. SGPA is equal to the sum of all the total points earned by the student in a given semester divided by the number of credits registered by the student in that semester. CGPA gives the sum of all the total points earned in all the previous semesters and the current semester divided by the number of credits registered in all these semesters. Thus,

$$SGPA = \sum_{i=1}^{n} (C_i G_i) / \sum_{i=1}^{n} C_i$$

Where, C_i is the number of credits of the i^{th} course and G_i is the grade point scored by the student in the i^{th} course and *n* represent the number of courses in which a student is registered in the concerned semester.

$$CGPA = \sum_{j=1}^{m} \left(C_j S_j \right) / \sum_{j=1}^{m} C_j$$

Where, S_j is the SGPA of the j^{th} semester and C_j is the total number of credits upto the semester and *m* represent the number of semesters completed in which a student registered upto the semester.

The SGPA and CGPA shall be rounded off to 2 decimal points and reported in the transcripts.

16.0 ILLUSTRATION OF COMPUTATION OF SGPA AND CGPA

Course Name	Course Credits	Grade letter	Grade point	Credit Point (Credit x Grade)
Course 1	3	А	8	3 x 8 = 24
Course 2	4	B+	7	4 x 7 = 28
Course 3	3	В	6	3 x 6 = 18
Course 4	3	S	10	3 x 10 = 30
Course 5	3	С	5	3 x 5 = 15
Course 6	4	В	6	4 x 6 = 24
	20			139

16.1 Illustration for SGPA

Thus, SGPA = 139 / 20 = 6.95

16.2 Illustration for CGPA

Semester 1	Semester 2	Semester 3	Semester 4
Credit: 20 SGPA: 6.9	Credit: 22 SGPA: 7.8	Credit: 25 SGPA: 5.6	Credit: 26 SGPA: 6.0
Semester 5	Semester 6		
Credit: 26 SGPA: 6.3	Credit: 25 SGPA: 8.0		

Thus,
$$CGPA = \frac{20x6.9 + 22x7.8 + 25x5.6 + 26x6.0 + 26x6.3 + 25x8.0}{144} = 6.73$$

17.0 PHOTOCOPY / REVALUATION

A student, who seeks the re-valuation of the answer script, is directed to apply for the photocopy of his/her semester examination answer paper(s) in the theory course(s), within 2 working days from the declaration of results in the prescribed format to the Controller of Examinations through the Head of the department. On receiving the photocopy, the student can consult with a

competent member of faculty and seek the opinion for revaluation. Based on the recommendations, the student can register for the revaluation with prescribed fee. The Controller of Examinations shall arrange for the revaluation and declare the results. Revaluation is not permitted to the courses other than theory courses.

18.0 PROMOTION POLICIES

The following academic requirements have to be satisfied in addition to the attendance requirements mentioned in item no. 11.

18.1 For students admitted into B.Tech (Regular) program

- 18.1.1 A student will not be promoted from II semester to III semester unless s/he fulfills the academic requirement of securing 50% of the total credits (rounded to the next lowest integer) from I and II semester examinations, whether the candidate takes the examination(s) or not.
- 18.1.2 A student will not be promoted from IV semester to V semester unless s/he fulfills the academic requirement of securing 50% of the total credits (rounded to the next lowest integer) up to III semester or 50% of the total credits (rounded to the next lowest integer) up to IV semester, from all the examinations, whether the candidate takes the examination(s) or not.
- 18.1.3 A student shall be promoted from VI semester to VII semester only if s/he fulfills the academic requirements of securing 50% of the total credits (rounded to the next lowest integer) up to V semester **or** 50% of the total credits (rounded to the next lowest integer) up to VI semester from all the examinations, whether the candidate takes the examination(s) or not.
- 18.1.4 A student shall register for all the 160 credits and earn all the 160 credits. Marks obtained in all the 160 credits shall be considered for the award of the Grade.

18.2 For students admitted into B.Tech (lateral entry students)

- 18.2.1 A student will not be promoted from IV semester to V semester unless s/he fulfills the academic requirement of securing 50% of the total credits (rounded to the next lowest integer) up to IV semester, from all the examinations, whether the candidate takes the examination(s) or not.
- 18.2.2 A student shall be promoted from VI semester to VII semester only if s/he fulfills the academic requirements of securing 50% of the total credits (rounded to the next lowest integer) up to V semester or 50% of the total credits (rounded to the next lowest integer) up to VI semester from all the examinations, whether the candidate takes the examination(s) or not.
- 18.2.3 A student shall register for all the 123 credits and earn all the 123 credits. Marks obtained in all the 123 credits shall be considered for the award of the Grade.

19.0 GRADUATION REQUIREMENTS

The following academic requirements shall be met for the award of the B.Tech degree.

- 19.1 Student shall register and acquire minimum attendance in all courses and secure 160 credits for regular program and 123 credits for lateral entry program.
- 19.2 A student of a regular program, who fails to earn 160 credits within eight consecutive academic years from the year of his/her admission with a minimum CGPA of 4.0, shall forfeit his/her degree and his/her admission stands cancelled.
- 19.3 A student of a lateral entry program who fails to earn 123 credits within six consecutive academic years from the year of his/her admission with a minimum CGPA of 4.0, shall forfeit his/her degree and his/her admission stands cancelled.

20.0 BETTERMENT OF MARKS IN THE COURSES ALREADY PASSED

Students who clear all the courses in their first attempt and wish to improve their CGPA shall register and appear for betterment of marks for one course of any theory courses within a period of subsequent two semesters. The improved marks shall be considered for classification / distinction but not for ranking. If there is no improvement, there shall not be any change in the original marks already awarded.

21.0 AWARD OF DEGREE

21.1 Classification of degree will be as follows:

CGPA ≥ 7.5	$CGPA \ge 6.5 \text{ and} \\ < 7.5$	CGPA ≥ 5.0 and < 6.5	$CGPA \ge 4.0 \text{ and} \\ < 5.0$	CGPA < 4.0
First Class with Distinction	First Class	Second Class	Pass Class	Fail

- 21.2 In order to extend the benefit to the students with one/two backlogs after either VI semester or VIII semester, GRAFTING option is provided to the students enabling their placements and fulfilling graduation requirements. Following are the guidelines for the Grafting:
 - a. Grafting will be done among the courses within the semester shall draw a maximum of 7 marks from the any one of the cleared courses in the semester and will be grafted to the failed course in the same semester.
 - b. Students shall be given a choice of grafting only once in the 4 years program, either after VI semester (Option #1) or after VIII semester (Option #2).
 - c. Option#1: Applicable to students who have maximum of TWO theory courses in V and / or VI semesters.

Option#2: Applicable to students who have maximum of TWO theory courses in VII and / or VIII semesters.

- d. Eligibility for grafting:
 - i. Prior to the conduct of the supplementary examination after the declaration of VI or VIII semester results.
 - ii. S/he must appear in all regular or supplementary examinations as per the provisions laid down in regulations for the courses s/he appeals for grafting.
 - iii. The marks obtained by her/him in latest attempt shall be taken into account for grafting of marks in the failed course(s).
- 21.3 Student, who clears all the courses upto VII semester, shall have a chance to appear for Quick Supplementary Examination to clear the failed courses of VIII semester.
- 21.4 By the end of VI semester, all the students (regular and lateral entry students) shall complete one of the audit course and mandatory course with acceptable performance.
- 21.5 In case, a student takes more than one attempt in clearing a course, the final marks secured shall be indicated by * mark in the grade sheet.

All the candidates who register for the semester end examination will be issued grade sheet by the institute. Apart from the semester wise grade sheet, the institute will issue the provisional certificate and consolidated grade sheet subject to the fulfillment of all the academic requirements.

22 B.TECH WITH HONOURS OR ADDITIONAL MINORS IN ENGINEERING

Students acquiring 160 credits are eligible to get B.Tech degree in Engineering. A student will be eligible to get B.Tech degree with Honours or additional Minors in Engineering, if s/he completes an additional 20 credits (3/4 credits per course). These could be acquired through MOOCs from SWAYAM / NPTEL / edX / Coursera / Udacity /PurdueNext / Khan Academy / QEEE etc. The list for MOOCs will be a dynamic one, as new courses are added from time to time. Few essential skill sets required for employability are also identified year wise. Students interested in doing MOOC courses shall register the course title at their department office at the start of the semester against the courses that are announced by the department. Any expense incurred for the MOOC course / summer program should be met by the students.

Only students having no credit arrears and a CGPA of 7.5 or above at the end of the fourth semester are eligible to register for B.Tech (Honours / Minor). After registering for the B.Tech (Honours / Minor) program, if a student fails in any course, s/he will not be eligible for B.Tech (Honours / Minor).

Every Department to develop and submit a Honours / Minors – courses list of 5 - 6 theory courses.

Honours Certificate for Vertical in his/her OWN Branch for Research orientation; Minor in any OTHER branch for Improving Employability.

For the MOOCs platforms, where examination or assessment is absent (like SWAYAM) or where certification is costly (like Coursera or edX), faculty members of the institute prepare the examination question papers, for the courses undertaken by the students of respective Institutes, so that examinations Control Office (ECO) can conduct examination for the course. There shall be one Continuous Internal Examination (Quiz exam for 30 marks) after 8 weeks of the commencement of the course and semester end examination (Descriptive exam for 70 marks) shall be done along with the other regular courses.

A student can enroll for both Minor & Honours or for two Minors. The final grade sheet will only show the basic CGPA corresponding to the minimum requirement for the degree. The Minors/Honours will be indicated by a separate CGPA. The additional courses taken will also find separate mention in the grade sheet.

If a student drops (or terminated) from the Minor/Honours program, they cannot convert the earned credits into free or core electives; they will remain extra. These additional courses will find mention in the grade sheet (but not in the degree certificate). In such cases, the student may choose between the actual grade or a "Pass (P)" grade and also choose to omit the mention of the course as for the following:

- > All the courses done under the dropped Minor/Honours will be shown in the grade sheet
- None of the courses done under the dropped Minor/Honours will be shown in the grade sheet.

Honours will be reflected in the degree certificate as "B.Tech (honours) in XYZ Engineering". Similarly, Minor as "B.Tech in XYZ Engineering with Minor in ABC". If a student has done both honours & minor, it will be acknowledged as "B.Tech (honours) in XYZ Engineering with Minor in ABC". And two minors will be reflected as "B.Tech in XYZ Engineering with Minor in ABC". Minor in DEF".

22.1. B.Tech with Honours

The total of 20 credits required to be attained for B.Tech Honours degree are distributed from V semester to VII semester in the following way:

For V semester	:	4-8 credits
For VI semester	:	4-8 credits
For VII semester	:	4-8 credits

Following are the details of such Honours which include some of the most interesting areas in the profession today:

S. No	Department	Honours scheme
1	Aeronautical Engineering	Aerospace Engineering / Space Science etc.
2	Computer Science and	Big data and Analytics / Cyber Physical Systems,
	Engineering / Information	Information Security / Cognitive Science / Internet of
	Technology	Things (IoT) etc.
3	Electronics and	Digital Communication / Signal Processing /
	Communication	Communication Networks / VLSI Design /
	Engineering	Embedded Systems etc.
4	Electrical and Electronics	Renewable Energy systems / Energy and
	Engineering	Sustainability / IoT Applications in Green Energy
		Systems etc.
5	Mechanical Engineering	Industrial Automation and Robotics / Manufacturing
		Sciences and Computation Techniques etc.
6	Civil Engineering	Structural Engineering / Environmental Engineering
		etc.

22.2 B.Tech with additional Minor in Engineering

Every Department to develop and submit Minor Courses List of 5 - 6 Theory courses. Student from any department is eligible to apply for Minor from any other department. The total of 20 credits to complete the B.Tech (Minor) program by registering for MOOC courses each having a minimum of 3/4 credits offered by reputed institutions / organization with the approval of the department. Registration of the student for B.Tech (Minor), is from V Semester to VII Semester of the program in the following way:

For V semester	:	4-8 credits
For VI semester	:	4-8 credits
For VII semester	:	4-8 credits

Only students having no credit arrears and a CGPA of 7.5 or above at the end of the fourth semester are eligible to register for B.Tech (Minor). After registering for the B.Tech (Minor) program, if a student fails in any course, s/he will not be eligible for B.Tech (Minor).

Every student shall also have the option to do a minor in engineering. A major is a primary focus of study and a minor is a secondary focus of study. The minor has to be a subject offered by a department other than the department that offers the major of the student or it can be a different major offered by the same department. For example, a student with the declared major in Computer Science and Engineering (CSE) may opt to do a minor in Physics; in which case, the student shall receive the degree B.Tech, Computer Science and Engineering with a minor in Physics. A student can do Majors in chosen filed as per the career goal, and a minor may be chosen to enhance the major thus adding the diversity, breadth and enhanced skills in the field.

Advantages of Minor in Engineering:

The minors mentioned above are having lots of advantages and a few are listed below:

- 1. To apply the inter-disciplinary knowledge gained through a Major (Stream) + Minor.
- 2. To enable students to pursue allied academic interest in contemporary areas.

- 3. To provide an academic mechanism for fulfilling multidisciplinary demands of industries.
- 4. To provide effective yet flexible options for students to achieve basic to intermediate level competence in the Minor area.
- 5. Provides an opportunity to students to become entrepreneurs and leaders by taking business/ management minor.
- 6. Combination in the diverse fields of engineering e.g., CSE (Major) + Electronics (Minor) combination increases placement prospects in chip designing companies.
- 7. Provides an opportunity to Applicants to pursue higher studies in an inter-disciplinary field of study.
- 8. Provides opportunity to the Applicants to pursue interdisciplinary research.
- 9. To increase the overall scope of the undergraduate degrees.

Following are the details of such Minor / Honours which include some of the most interesting areas in the profession today:

- 1. Space Science
- 2. Information Security
- 3. Data Analytics
- 4. Cyber Physical Systems
- 5. Electronic System Design
- 6. Renewable Energy Sources
- 7. Energy and Sustainability
- 8. Industrial Automation and Robotics
- 9. Aerospace Engineering
- 10. Manufacturing Sciences and Computation Techniques
- 11. Structural Engineering
- 12. Environmental Engineering
- 13. Internet of Things
- 14. Computer Science and Engineering
- 15. Technological Entrepreneurship
- 16. Materials Engineering
- 17. Physics (Materials / Nuclear / Optical / Medical)
- 18. Mathematics (Combinatorics / Logic / Number theory / Dynamical systems and differential equations./ Mathematical **physics** / Statistics and Probability).

23.0 TEMPORARY BREAK OF STUDY FROM THE PROGRAM

23.1 A candidate is normally not permitted to take a break from the study. However, if a candidate intends to temporarily discontinue the program in the middle for valid reasons (such as accident or hospitalization due to prolonged ill health) and to rejoin the program in a later respective semester, s/he shall seek the approval from the Principal in advance. Such application shall be submitted before the last date for payment of examination fee of the semester in question and forwarded through the Head of the Department stating the reasons for such withdrawal together with supporting documents and endorsement of his / her parent / guardian.

- 23.2 The institute shall examine such an application and if it finds the case to be genuine, it may permit the student to temporarily withdraw from the program. Such permission is accorded only to those who do not have any outstanding dues / demand at the College / University level including tuition fees, any other fees, library materials etc.
- 23.3 The candidate has to rejoin the program after the break from the commencement of the respective semester as and when it is offered.
- 23.4 The total period for completion of the program reckoned from the commencement of the semester to which the candidate was first admitted shall not exceed the maximum period specified in clause 19. The maximum period includes the break period.
- 23.5 If any candidate is detained for any reason, the period of detention shall not be considered as 'Break of Study'.

24.0 TERMINATION FROM THE PROGRAM

The admission of a student to the program may be terminated and the student is asked to leave the institute in the following circumstances:

- a. The student fails to satisfy the requirements of the program within the maximum period stipulated for that program.
- b. A student shall not be permitted to study any semester more than three times during the entire program of study.
- c. The student fails to satisfy the norms of discipline specified by the institute from time to time.

25.0 WITH-HOLDING OF RESULTS

If the candidate has not paid any dues to the institute / if any case of indiscipline / malpractice is pending against him, the results and the degree of the candidate will be withheld.

26.0 GRADUATION DAY

The institute shall have its own annual Graduation Day for the award of degrees to the students completing the prescribed academic requirements in each case, in consultation with the University and by following the provisions in the Statute. The college shall institute prizes and medals to meritorious students and award them annually at the Graduation Day. This will greatly encourage the students to strive for excellence in their academic work.

27.0 DISCIPLINE

Every student is required to observe discipline and decorum both inside and outside the institute and are expected not to indulge in any activity which will tend to bring down the honour of the institute. If a student indulges in malpractice in any of the theory / practical examination, continuous assessment examinations, he/she shall be liable for punitive action as prescribed by the institute from time to time.

28.0 GRIEVANCE REDRESSAL COMMITTEE

The institute shall form a Grievance Redressal Committee for each course in each department with the Course Teacher and the HOD as the members. This Committee shall solve all grievances related to the course under consideration.

29.0 TRANSITORY REGULATIONS

A candidate, who is detained or has discontinued a semester, on readmission shall be required to do all the courses in the curriculum prescribed for the batch of students in which the student joins

subsequently. However, exemption will be given to those candidates who have already passed such courses in the earlier semester(s) he was originally admitted into and substitute subjects are offered in place of them as decided by the Board of Studies. However, the decision of the Board of Studies will be final.

a) Four Year B.Tech Regular course:

A student who is following Jawaharlal Nehru Technological University (JNTUH) curriculum and detained due to the shortage of attendance at the end of the first semester shall join the autonomous batch of first semester. Such students shall study all the courses prescribed for the batch in which the student joins and considered on par with regular candidates of Autonomous stream and will be governed by the autonomous regulations.

A student who is following JNTUH curriculum, detained due to lack of credits or shortage of attendance at the end of the second semester or at the subsequent semesters shall join with the autonomous batch in the appropriate semester. Such candidates shall be required to pass in all the courses in the program prescribed by the Board of Studies concerned for that batch of students from that semester onwards to be eligible for the award of degree. However, exemption will be given in the courses of the semester(s) of the batch which he had passed earlier and substitute courses will be offered in place of them as decided by the Board of Studies. The student has to clear all his backlog courses up to previous semester by appearing for the supplementary examinations conducted by JNTUH for the award of degree. The total number of credits to be secured for the award of the degree will be sum of the credits up to previous semester under JNTUH regulations and the credits prescribed for the semester in which a candidate seeks readmission and subsequent semesters under the autonomous stream. The class will be awarded based on the academic performance of a student in the autonomous pattern.

b) Three Year B.Tech program under Lateral Entry Scheme:

A student who is following JNTUH curriculum and detained due to the shortage of attendance at the end of the first semester of second year shall join the autonomous batch of third semester. Such students shall study all the courses prescribed for the batch in which the student joins and considered on par with Lateral Entry regular candidates of Autonomous stream and will be governed by the autonomous regulations.

A student who is following JNTUH curriculum, if detained due to lack of credits or shortage of attendance at the end of the second semester of second year or at the subsequent semesters shall join with the autonomous batch in the appropriate semester. Such candidates shall be required to pass in all the courses in the program prescribed by the Board of Studies concerned for that batch of students from that semester onwards to be eligible for the award of degree. However, exemption will be given in the courses of the semester(s) of the batch which he had passed earlier and substitute courses are offered in place of them as decided by the Board of Studies. The student has to clear all his backlog courses up to previous semester by appearing for the supplementary examinations conducted by JNTUH for the award of degree. The total number of credits to be secured for the award of the degree will be sum of the credits up to previous semester under JNTUH regulations and the credits prescribed for the supplementary. The class will be awarded based on the academic performance of a student in the autonomous pattern.

c) Transfer candidates (from non-autonomous college affiliated to JNTUH):

A student who is following JNTUH curriculum, transferred from other college to this institute in third semester or subsequent semesters shall join with the autonomous batch in the appropriate semester. Such candidates shall be required to pass in all the courses in the program prescribed by the Board of Studies concerned for that batch of students from that semester onwards to be eligible for the award of degree. However, exemption will be given in the courses of the semester(s) of the batch which he had passed earlier and substitute courses are offered in their place as decided by the Board of Studies. The student has to clear all his backlog courses up to previous semester by appearing for the supplementary examinations conducted by JNTUH for the award of degree. The total number of credits to be secured for the award of the degree will be the sum of the credits up to the previous semester under JNTUH regulations and the credits prescribed for the semester in which a candidate joined after transfer and subsequent semesters under the autonomous status. The class will be awarded based on the academic performance of a student in the autonomous pattern.

d) Transfer candidates (from an autonomous college affiliated to JNTUH):

A student who has secured the required credits up to previous semesters as per the regulations of other autonomous institutions shall also be permitted to be transferred to this institute. A student who is transferred from the other autonomous colleges to this institute in third semester or subsequent semesters shall join with the autonomous batch in the appropriate semester. Such candidates shall be required to pass in all the courses in the program prescribed by the Board of Studies concerned for that batch of students from that semester onwards to be eligible for the award of degree. However, exemption will be given in the courses of the semester(s) of the batch which he had passed earlier and substitute subjects are offered in their place as decided by the Board of Studies. The total number of credits to be secured for the award of the degree will be the sum of the credits up to previous semester as per the regulations of the college from which he is transferred and the credits prescribed for the autonomous status. The class will be awarded based on the academic performance of a student in the autonomous pattern.

e) Readmission from IARE-R16 to IARE-R18 regulations

A student took admission in IARE-R16 Regulations, detained due to lack of required number of credits or percentage of attendance at the end of any semester is permitted to take readmission at appropriate level under any regulations prevailing in the institute subject to the following rules and regulations.

- 1. Student shall pass all the courses in the earlier scheme of regulations (IARE R16). However, in case of having backlog courses, they shall be cleared by appearing for supplementary examinations conducted under IARE - R16 regulations from time to time.
- 2. After rejoining, the student is required to study the courses as prescribed in the new regulations for the re-admitted program at that level and thereafter.
- 3. If the student has already passed any course(s) of readmitted program in the earlier regulation / semester of study, such courses are exempted in the new scheme to appear for the course(s).
- 4. The courses that are not done in the earlier regulations / semester as compared with readmitted program need to be cleared after readmission by appearing for the examinations conducted time to time under the new regulations.
- 5. In general, after transition, course composition and number of credits / semester shall be balanced between earlier and new regulations on case to case basis.

- 6. In case, the students who do not have option of acquiring required credits with the existing courses offered as per the new curriculum, credit balance can be achieved by clearing the additional courses offered by the respective departments (approved in Academic Council meeting). The additional courses that are offered can be of theory or laboratory courses and shall be offered during semester.
- Students re-joined in III semester shall be treated on par with "Lateral Entry" students for credits and graduation requirements. However, the student shall clear all the courses in B.Tech I Semester and B.Tech II Semester as per IARE-R16 regulations.

30.0 REVISION OF REGULATIONS AND CURRICULUM

The Institute from time to time may revise, amend or change the regulations, scheme of examinations and syllabi if found necessary and on approval by the Academic Council and the Governing Body and shall be binding on the students, faculty, staff, all authorities of the Institute and others concerned.

FAILURE TO READ AND UNDERSTAND THE REGULATIONS IS NOT AN EXCUSE



INSTITUTE OF AERONAUTICAL ENGINEERING

(Autonomous)

ELECTRONICS AND COMMUNICATION ENGINEERING

COURSE STRUCTURE

I SEMESTER

Course Code	Course Name	Subject Area	Category	Pe	Periods per week			Scheme of Examination Max. Marks		
		Š		L	Т	Р	Credits	CIA	SEE	Total
THEORY										
AHSB01	English	HSMC	Foundation	2	0	0	2	30	70	100
AHSB02	Linear Algebra and Calculus	BSC	Foundation	3	1	0	4	30	70	100
AHSB04	Waves and Optics	BSC	Foundation	3	1	0	4	30	70	100
PRACTICA	AL									
AHSB08	English Language and Communication Skills Laboratory	HSMC	Foundation	0	0	2	1	30	70	100
AHSB10	Engineering Physics Laboratory	BSC	Foundation	0	0	3	1.5	30	70	100
AMEB02	Engineering Graphics and Design Laboratory	ESC	Foundation	1	0	4	3	30	70	100
	TOTAL			09	02	09	15.5	180	420	600

II SEMESTER

Course Code	Course Name	Subject Area Category		Periods per week			Credits	Scheme of Examination Max. Marks		
				L	Т	Р		CIA	SEE	Total
THEORY										
AHSB11	Mathematical Transform Techniques	BSC	Foundation	3	1	0	4	30	70	100
AHSB03	Engineering Chemistry	BSC	Foundation	3	1	0	4	30	70	100
ACSB01	Programming for Problem Solving	ESC	Foundation	3	0	0	3	30	70	100
AEEB03	Electrical Circuits	ESC	Foundation	3	1	0	4	30	70	100
PRACTICA	AL									
AHSB09	Engineering Chemistry Laboratory	BSC	Foundation	0	0	3	1.5	30	70	100
ACSB02	Programming for Problem Solving Laboratory	ESC	Foundation	0	0	4	2	30	70	100
AMEB01	Workshop / Manufacturing Practices Laboratory	ESC	Foundation	0	0	3	1.5	30	70	100
AEEB06	Electrical Circuits Analysis Laboratory	ESC	Foundation	0	0	3	1.5	30	70	100
	TOTAL			12	03	13	21.5	240	560	800

III SEMESTER

Course Code	Course Name	Subject Area	Category		Periods per week		week		Credits	Ex M	cheme amina ax. Ma	arks
THEODY		•1		L	Τ	Р		CIA	SEE	Total		
THEORY												
AHSB05	Complex Analysis and Special Functions	BSC	Foundation	3	0	0	3	30	70	100		
AECB06	Electronic Devices and Circuits	PCC	Core	3	1	0	4	30	70	100		
AECB07	Digital System Design	PCC	Core	3	1	0	4	30	70	100		
AECB08	Probability Theory and Stochastic Process	PCC	Core	3	1	0	4	30	70	100		
ACSB03	Data Structures	PCC	Core	3	0	0	3	30	70	100		
PRACTICA	AL											
AECB09	Electronic Devices and Circuits Laboratory	PCC	Core	0	0	3	1.5	30	70	100		
AECB10	Digital System Design Laboratory	PCC	Core	0	0	2	1	30	70	100		
ACSB05	Data Structures Laboratory	PCC	Core	0	0	3	1.5	30	70	100		
	TOTAL					08	22	240	560	800		

IV SEMESTER

Course Code	Course Name	Subject Area	Category	Per	eriods per week		Credits	Ex	Scheme xamina ax. Ma	tion
		S		L	LT		0	CIA	SEE	Total
THEORY										
AECB11	Analog and Pulse Circuits	PCC	Core	3	1	0	4	30	70	100
AECB12	Analog Communications	PCC	Core	3	1	0	4	30	70	100
AECB13	Electromagnetic Waves and Transmission Lines	PCC	Core	3	0	0	3	30	70	100
AECB14	Signals and Systems	PCC	Core	3	0	0	3	30	70	100
AEEB16	Control Systems	PCC	Core	3	1	0	4	30	70	100
AHSB07	Environmental Science	MC-II		0	0	0	0	30	70	100
PRACTICA	AL									
AECB15	Analog and Pulse Circuits Laboratory	PCC	Core	0	0	3	1.5	30	70	100
AECB16	Analog Communications Laboratory	PCC	Core	0	0	3	1.5	30	70	100
AECB17	Signals and Systems Laboratory	PCC	Core	0	0	2	1	30	70	100
TOTAL 15 03							22	270	630	900

V SEMESTER

Course Code	Course Name	Subject Area	Category		Periods pe week		week		week		week				Credits	Ex	cheme aminat ax. Ma	tion
		S		L	Τ	Р	\cup	CIA	SEE	Total								
THEORY																		
AECB18	Antennas and Wave Propagation	PCC	Core	2	1	0	3	30	70	100								
AECB19	Linear and Digital IC Applications	PCC	Core	2	1	0	3	30	70	100								
AECB20	Digital Communications	PCC	Core	3	0	0	3	30	70	100								
ACSB41	JAVA Programming	PCC	Core	3	0	0	3	30	70	100								
	Professional Elective - I	PEC	Elective	3	0	0	3	30	70	100								
	Open Elective – I	OEC	Elective	3	0	0	3	30	70	100								
AHSB15	Project Based Learning (Prototype / Design Building)	PCC	Core	2	0	0	2	30	70	100								
PRACTICA	AL																	
AECB21	Linear and Digital IC Applications Laboratory	PCC	Core	0	0	2	1	30	70	100								
AECB22	Digital Communications Laboratory	PCC	Core	0	0	2	1	30	70	100								
	TOTAL					04	22	270	630	900								

VI SEMESTER

Course Code	Course Name Z Z Category Week		-	Credits	Scheme of Examination Max. Marks					
		S		L	Т	Р	0	CIA	SEE	Total
THEORY										
AECB23	Digital Signal Processing	PCC	Core	2	1	0	3	30	70	100
AECB24	Microprocessors and Microcontrollers	PCC	Core	2	1	0	3	30	70	100
AHSB14	Business Economics and Financial Analysis	PCC	Core	3	0	0	3	30	70	100
	Professional Elective - II	PEC	Elective	3	0	0	3	30	70	100
	Professional Elective - III	PEC	Elective	3	0	0	3	30	70	100
	Open Elective – II	OEC	Elective	3	0	0	3	30	70	100
AHSB16	Research Based Learning (Fabrication / Model Development)	PCC	Core	2	0	0	2	30	70	100
PRACTICA	AL									
AECB25	Digital Signal Processing Laboratory	PCC	Core	0	0	2	1	30	70	100
AECB26	Microprocessors and Microcontrollers Laboratory	PCC Core		0	0	2	1	30	70	100
	TOTAL						22	270	630	900

VII SEMESTER

Course Code	Course Name	Area Category		Course Name 25 25 Category week		Credits	Scheme of Examination Max. Marks			
				L	Т	P		CIA	SEE	Total
THEORY										
AECB27	VLSI Design	PCC	Core	3	0	0	3	30	70	100
AECB28	Satellite and Microwave Engineering	PCC	Core	3	0	0	3	30	70	100
	Professional Elective – IV	PEC	Elective	3	0	0	3	30	70	100
	Professional Elective - V	PEC	Elective	3	0	0	3	30	70	100
	Open Elective - III	OEC	Elective	3	0	0	3	30	70	100
AHSB17	Essence of Indian Traditional Knowledge	MCC		0	0	0	0	30	70	100
PRACTICA	AL									
AECB29	VLSI Design Laboratory	PCC	Core	0	0	3	1.5	30	70	100
AECB30	Antennas and Microwave Engineering Laboratory	PCC	Core	0	0	3	1.5	30	70	100
AECB61	Project work – I	SEC	Core	0	0	10	5	30	70	100
	TOTAL						23	270	630	900

VIII SEMESTER

Course Code	Course Name	Subject Area Category		Periods per week			Credits	Scheme of Examination Max. Marks		
		\mathbf{N}		L	Т	Р	0	CIA	SEE	Total
THEORY										
	Professional Elective - VI	PEC	Elective	3	0	0	3	30	70	100
	Open Elective - IV	OEC	Elective	3	0	0	3	30	70	100
PRACTICA	AL									
AECB62	Project Work – II / Full Semester Internship	SEC	Core	0 0 12		6	30	70	100	
	TOTAL						12	90	210	300

PROFESSIONAL ELECTIVES

PROFESSIONAL ELECTIVE - I: SEMICONDUCTOR TECHNOLOGY

Course Code	Course Title
AECB31	Introduction to MEMS
AECB32	Electronic Measurements and Instrumentation
AECB33	Nano Electronics: Devices and Materials
AECB34	RF Circuit Design

PROFESSIONAL ELECTIVE - II: IMAGE PROCESSING

Course Code	rse Code Course Title				
AECB35	Digital Image Processing				
AECB36	6 Speech and Audio Processing				
AECB37	Video Processing				
AECB38	Wavelets				

PROFESSIONAL ELECTIVE - III: ADVANCED COMMUNICATIONS

Course Code	Course Title			
AECB39	Cellular and Mobile Communications			
AECB40	Mobile Adhoc Networks			
AECB41	Optical Communications			
AECB42	Wireless Communications and Networks			

PROFESSIONAL ELECTIVE - IV: MICRO ELECTRONICS

Course Code	Course Title					
AECB43	Advanced Programmable Logic Device Architectures					
AECB44	Digital design through Verilog					
AECB45	Scripting Languages for VLSI Design					
AECB46	Design for Testability					

PROFESSIONAL ELECTIVE - V: SIGNAL AND DATA PROCESSING

Course Code	Course Title				
AECB47	Advanced Digital Signal Processing				
AECB48	Information Theory and Coding				
AECB49	Error Correction Codes				
AECB50	Radar Systems and Processing				

PROFESSIONAL ELECTIVE - VI: EMBEDDED SYSTEMS

Course Code	Course Title
AECB51	Embedded C
AECB52	Real Time Systems
AECB53	Embedded Networking
AECB54	Advanced RISC Machine Architectures

OPEN ELECTIVE - I

Course Code	Course Title
ACSB32	Computer Architecture
ACSB33	Analysis of Algorithms and Design
ACSB34	Relational Database Management Systems
AITB30	Advanced Data Structures
AITB31	Data Communications and Networks
AITB32	Network Security

OPEN ELECTIVES – II

Course Code	Course Title
ACEB52	Energy from Waste
ACEB53	Disaster Management
AAEB55	Elements of Aeronautics
AAEB28	Aviation Management
AMEB56	Introduction to Robotics
AMEB57	Rapid Prototyping

OPEN ELECTIVE - III

Course Code	Course Title
AECB58	Embedded Systems
AECB59	Cognitive Radio
AECB60	IoT and Applications
AEEB58	Industrial Automation and Control
AEEB59	Artificial Neural Networks
AEEB60	Renewable Energy Sources

OPEN ELECTIVE - IV

Course Code	Course Title
AHSB18	Soft Skills and Interpersonal Communication
AHSB19	Cyber Law and Ethics
AHSB20	Economic Policies in India
AHSB21	Global Warming and Climate Change
AHSB22	Intellectual Property Rights
AHSB23	Entrepreneurship

MANDATORY COURSES

Course Code	Course Title
AHSB07	Environmental Sciences
AHSB17	Essence of Indian Traditional Knowledge

SYLLABUS

ENGLISH

Course Code		Category	Ho	ours / V	Week	Credits	Ν	laximum	n Marks
			L	Т	Р	С	CIA	SEE	Total
AHSB01		Foundation	2	0	0	2	30	70	100
Contact Classes: 30		Tutorial Classes: Nil	utorial Classes: Nil Practical Classes: Nil To		To	tal Classes: 30			
I. Communicate II. Use the four la	in an ngua	ble the students to: intelligible English acce ge skills i.e., Listening, S writing accurate English	Speaki	ng, Rea	ading a	nd Writing			
MODULE - I	GEN	ERAL INTRODUCTIO	ON A	ND LI	STEN	IG SKILLS	5	Cla	sses: 06
hard skills; Impo	rtance	nication skills; Commun e of soft skills for engir stening and effectiveness	neering	g stude	ents; Li	stening ski	lls; Sign		
MODULE - II SPEAKING SKILLS Classes:					sses: 06				
Generating talks	based	s; Barriers and effective on visual prompts; Pub ation; Power point prese	olic sp	eaking					
MODULE - III	voc	CABULARY & GRAMMAR					Cla	Classes: 06	
Acquaintance wi Synonyms; Antor Grammar:	th pr tyms; re; U	d Formation; Root wo refixes and suffixes fro Standard abbreviations; ses of phrases and cla	om fo Idiom	oreign is and j	langua ohrases	ges in Eng ; Oneword s	glish to substitute	form de es.	erivatives
· · · · · · · · · · · · · · · · · · ·									
MODULE - IV	REA	DING SKILLS						Cla	sses: 06
MODULE - IV Significance; Tec specific informat	hniqu ion;	DING SKILLS tes of reading; Skimmin Intensive; Extensive rea m; Diagram to text.						ning - Re	eading fo

Significance; Effectiveness of writing; Organizing principles of Paragraphs in documents; Writing introduction and conclusion; Techniques for writing precisely; Letter writing; Formal and Informal letter writing; E-mail writing, Report Writing.

Text Books:

Handbook of English for Communication (Prepared by Faculty of English, IARE)

Reference Books:

- 1. Sanjay Kumar and Pushp Lata. "Communications Skills". Oxford University Press. 2011.
- 2. Michael Swan. "Practical English Usage", Oxford University Press, 1995.
- 3. F.T. Wood. "Remedial English Grammar", Macmillan. 2007.
- 4. William Zinsser. "On Writing Well". Harper Resource Book, 2001.
- 5. Raymond Murphy, "Essential English Grammar with Answers", Cambridge University Press, 2nd Edition.

Web References:

- 1. www.edufind.com
- 2. www.myenglishpages.com
- 3. http://grammar.ccc.comment.edu
- 4. http://owl.english.prudue.edu

- 1. http://bookboon.com/en/communication-ebooks-zip
- 2. http://www.bloomsbury-international.com/images/ezone/ebook/writing-skills-pdf.pdf
- 3. https://americanenglish.state.gov/files/ae/resource_files/developing_writing.pdf
- 4. http://learningenglishvocabularygrammar.com/files/idiomsandphraseswithmeaningsandexamplespdf. pdf
- 5. http://www.robinwood.com/Democracy/General Essays/CriticalThinking.pdf

LINEAR ALGEBRA AND CALCULUS

	Code	Category	Ho	urs / W	eek	Credits	Max	imum N	Iarks
	DUJ	Foundation	L	Т	Р	С	CIA	SEE	Total
AHS	BU2	Foundation	3	1	-	4	30	70	100
Contact Cl	lasses: 45	Tutorial Classes: 15	P	ractica	l Class	es: Nil	Tot	al Classe	es: 60
I. Determin II. Determin III. Apply m IV. Determin V. Analyze Module-I THEORY (matrices: He of a matrix: HIGHER ()	should enal ne rank of a ne the chara ne the chara ne the function gradient, di THEORY DIFFERE OF MATRI remitian, Ske Echelon for	De the students to: matrix and solve linear directeristic roots and apply de neorems and apply triple in ional dependence and extra- vergence, curl and evaluat COF MATRICES AND I ENTIAL EQUATIONS CES: Real matrices: Symew-Hermitian and unitary ison and normal form; Inver NEAR DIFFERENTIAL estant coefficients, non-F	ouble int ntegrals i emum va te line, si HIGHE metric, matrices rse by Ga	tegrals t to evalu alue of a urface, v R ORD skew-sy ; Eleme auss-Jor	o evalu ate volu a functi volume ER LI ymmetr entary ro rdan me : Linea	ate area. ume. on. integrals ov NEAR ic and ortho ow and colum- thod. r differentia	er a vect ogonal m mn transf	Class atrices; C formation ns of sec	ns; Ranl
and $f(v) = v$	n ar c		-		erm of	the type	f(x) = c	e^{ax} , sin at	x,cos <i>ax</i>
Module-II LINEAR T	LINEAR RANSFOR	p(x); Method of variation TRANSFORMATIONS MATIONS: Cayley-Han hear dependence and independence	of paran AND D nilton th	neters. OUBLI eorem:	E INTH Statem	EGRALS ent, verifica	tion, fin	Class ding invo	sses: 09 erse and
Module-II LINEAR T powers of a matrix and P DOUBLE I Change of or	LINEAR RANSFOR matrix; Lin Properties (w NTEGRAI rder of integ	TRANSFORMATIONS	of param AND D hilton the pendence ation of the integral; 7	eorem: ce of ve matrix b ls in C Fransfor	E INTE Statem ectors; oy linear artesiar rmation	EGRALS ent, verifica Eigen value r transforma n coordinate of coordina	tion, fin s and Ei tion. s and Po te systen	Class ding invo gen vect olar coor n.	erse and cors of rdinates
Module-II LINEAR T powers of a matrix and P DOUBLE I Change of or Module-III FUNCTION Cauchy's the	LINEAR RANSFOR matrix; Lin roperties (w NTEGRAL FUNCTIONS OF SIN corem-withon	TRANSFORMATIONS MATIONS: Cayley-Han hear dependence and inde- rithout proof); Diagonaliza LS: Evaluation of double ration; Area as a double in	of paran AND D hilton the pendence ation of the integral; 7 ABLES ean value	eorem: ce of ve matrix b ls in C Fransfor AND T e theore ation.	E INTE Statem ectors; oy linear artesiar rmation RIPLE ems: R	EGRALS ent, verifica Eigen value r transforma n coordinate of coordina EINTEGRA olle's theor	tion, finds s and Ei tion. s and Po te system LS em, Lag	Class ding invo gen vect olar coor n. Class range's t	sses: 09 erse and cors of a rdinates sses: 09 theorem
Module-II LINEAR T powers of a matrix and P DOUBLE I Change of or Module-III FUNCTION Cauchy's the TRIPLE IN	LINEAR RANSFOR matrix; Lin roperties (w NTEGRAL rder of integ FUNCTIONS OF SIN corem-without NTEGRALS ttion.	TRANSFORMATIONS MATIONS: Cayley-Ham near dependence and inde- vithout proof); Diagonaliza S: Evaluation of double ration; Area as a double in ONS OF SINGLE VARIA GLE VARIABLES: Me out proof and geometrical in S: Evaluation of triple into ONS OF SEVERAL VAL	of paran AND D hilton the pendence attion of the integral; T ABLES ean value interpret tegrals i	eorem: ce of ve matrix b ls in C Transfor AND T e theore ation. n Carte	E INTE Statem ectors; Dy linear artesiar rmation RIPLE ems: R	EGRALS ent, verifica Eigen value r transforma n coordinate of coordinate of coordinate of coordinates; w	tion, find s and Ei tion. s and Po te system LS em, Lag	Class ding invegen vect olar coord olar coord n. Class range's t f a region	sses: 09 erse and cors of rdinates sses: 09 theorem

Module-V	VECTOR DIFFERENTIAL AND INTEGRAL CALCULUS	Classes: 09
VECTOR I	DIFFERENTIAL CALCULUS: Scalar and vector point functions; Definitions	s of Gradient,
divergent and	d curl with examples; Solenoidal and irrotational vector point functions; Scalar poter	ntial function.

VECTOR INTEGRAL THEOREMS: Line integral, surface integral and volume integral, Green's theorem in a plane, Stoke's theorem and Gauss divergence theorem without proofs.

Text Books:

- 1. B.S. Grewal, "Higher Engineering Mathematics", Khanna Publishers, 36th Edition, 2010.
- 2. N.P. Bali and Manish Goyal, "A Text Book of Engineering Mathematics", Laxmi Publications, Reprint, 2008.
- 3. Ramana B.V., "Higher Engineering Mathematics", Tata McGraw Hill New Delhi, 11th Reprint, 2010.

Reference Books:

- 1. Erwin Kreyszig, "Advanced Engineering Mathematics", 9th Edition, John Wiley & Sons, 2006.
- 2. Veerarajan T., "Engineering Mathematics" for first year, Tata McGraw-Hill, New Delhi, 2008.
- 3. D. Poole, "Linear Algebra A Modern Introduction", 2nd Edition, Brooks/Cole, 2005.
- 4. Dr. M Anita, "Engineering Mathematics-I", Everest Publishing House, Pune, First Edition, 2016.

Web References:

- 1. http://www.efunda.com/math/math_home/math.cfm
- 2. http://www.ocw.mit.edu/resources/#Mathematics
- 3. http://www.sosmath.com/
- 4. http://www.mathworld.wolfram.com/

- 1. http://www.e-booksdirectory.com/details.php?ebook=10166
- 2. http://www.e-booksdirectory.com/details.php?ebook=7400re

WAVES AND OPTICS

Course Code	Category	Ho	urs / V	Veek	Credits	Ma	ximum I	Marks
		L	Τ	Р	С	CIA	SEE	Total
AHSB04	Foundation	3	1	0	4	30	70	100
Contact Classes:4	5 Tutorial Classes: 15]	Practio	al Cla	sses: Nil	То	tal Class	es: 60
I. Enrich knowledII. Correlate princeIII. Acquire skills course literature	enable the students to: lge in principals of quantum ples and applications of lase allowing the student to ide e. fundamentals of transverse,	rs and ntify a	fiber o ind app	ptics. bly for	mulas of op		wave ph	ysics using
MODULE - I	QUANTUM MECHANICS						Cl	asses: 08
Broglie's hypothesis	tum physics, Black body rad , Wave-particle duality, Day function, Born interpretations-particle in a box.	visson a	and Ge	rmer ex	xperiment, T	ime-indep	pendent S	
MODULE - II	NTRODUCTION TO SOI	LIDS A	ND SI	EMICO	ONDUCTO	RS	Cl	asses: 10
energy bands. Type semiconductors, Car	particles in a periodic poter s of electronic materials: m rier concentration, Dependent rd recombination, Hall effect	etals, ence of	semico	nducto	rs, and insul	lators; In	trinsic ar	nd extrinsic
MODULE - III	LASERS AND FIBER OPT	TICS					Cl	asses: 10
	asers, Spontaneous and stin tion, Ruby laser, He-Ne lase					Metastab	le state,	Population
(Single mode, mu	uction of an optical fiber, A ltimode, step index, grac em with block diagram.							
MODULE - IV	LIGHT AND OPTICS						Cl	asses: 07
splitting; Young's d	Superposition of waves an ouble slit experiment, New cular aperture and diffractio	ton's r	ings, N					
MODULE - V	HARMONIC OSCILLATI	ONS A	ND W	AVES	IN ONE D	IMENSI	ON CI	asses: 10
electrical oscillators on a string, the wa	ctrical simple harmonic osci , Impedance, Steady state m ve equation on a string, H nal waves and the wave equa	otion c armon	of force ic way	ed damj es, Re	ped harmonie flection and	c oscillat	or; Trans	verse wave

Text Books:

- 1. Dr. K Vijay Kumar and Dr. S Chandralingam, "Modern Engineering Physics" Volume-1&2, S Chand.Co, 2018.
- 2. I. G. Main, "Vibrations and Waves in Physics", Cambridge University Press, 1993.
- 3. R. K. Gaur, S. L. Gupta, "Engineering Physics", Dhanpat Rai Publications, 8th Edition, 2001.

Reference Books:

- 1. H.J. Pain, "The Physics of Vibrations and Waves", Wiley, 2006.
- 2. A. Ghatak, "Optics", McGraw Hill Education, 2012.
- 3. O. Svelto, "Principles of Lasers", Springer Science & Business Media, 2010.

Web References:

- 1. http://link.springer.com/book
- 2. http://www.thphys.physics.ox.ac.uk
- 3. http://www.sciencedirect.com/science
- 4. http://www.e-booksdirectory.com

- 1. http://www.peaceone.net/basic/Feynman/
- 2. http://physicsdatabase.com/free-physics-books/
- 3. http://www.damtp.cam.ac.uk/user/tong/statphys/sp.pdf
- 4. http://www.freebookcentre.net/Physics/Solid-State-Physics-Books.html

ENGLISH LANGUAGE AND COMMUNICATION SKILLS LABORATORY

Course	e Code	Category	Ηοι	ırs / V	Veek	Credits	Μ	aximum	Marks
AHS	2008	Foundation	L	Т	Р	С	CIA	SEE	Total
And	5000	Foundation	-	-	2	1	30	70	100
Contact C OBJECTI	lasses: Nil	Tutorial Classes: Nil	P	ractic	al Clas	ses: 24	Tot	al Classe	es: 24
The cours I. Imj II. Up	e enables the prove their a grade the flu	e students to: bility to listen and compre- ency and acquire a function process by viewing a prob LIST O	onal k olem t	nowle hroug	dge of h multij		iguage.		
Week-l	LISTENI	NG SKILL							
practice	e related to the	sations and interviews of he TV talk shows and new fic information; Listening	vs.					-	
Week-2	LISTENI	NG SKILL							
choic b. Lister	e questions. ning to telepl	of short duration and mor honic conversations; Liste can: Barrack Obama speal	ening t	o nati	ve India	an: Abdul K	lalam, Br	itish: He	len
Week-3	SPEAKIN	IG SKILL							
b. Tips o	on how to de	sh Language; Introduction evelop fluency, body lang ers, leave taking.							: Talkin
Week-4	SPEAKIN	IG SKILL							
contex	· · ·	g exercises involving the us s on Homophones and Ho M) session.			ls and (Consonant s	ounds in	different	-
Week-5	SPEAKIN	IG SKILL							
b. Situat		sations: common everyda rent occasions with feedba							er;
Week-6	READING	G SKILL							
a. Intona b. Readi	ation. ng newspape								

Week-7	READING SKILL
b. Readir	ving pronunciation through tongue twisters. ag advertisements, pamphlets; Reading comprehension exercises with critical and analytical ons based on context.
Week-8	WRITING SKILL
	ing to inspirational short stories. g messages, leaflets, Notice; Writing tasks; Flashcards – Exercises.
Week-9	WRITING SKILL
	the review on a video clipping of short duration (5 to 10minutes). a slogan related to the image; Write a short story of 6-10 lines based on the hints given.
Week-10	WRITING SKILL
	izing Mother Tongue Influence to improve fluency through watching educational videos. g practices – précis writing; Essay writing.
Week-11	THINKING SKILL
b. Practice	ing common errors in day to day conversations. e in preparing thinking blocks to decode diagrammatical representations into English words, ions, idioms, proverbs.
Week-12	THINKING SKILL
	ing common errors in day to day conversations. pictures and improvising diagrams to form English words, phrases and proverbs.
Reference	Books:
Univers	tshi Raman, Sangeetha Sharma, "Technical Communication Principles and Practices", Oxford sity Press, New Delhi, 3 rd Edition, 2015. n, Daniel, "Technical Communication", Cengage Learning, New Delhi, 1 st Edition, 2009.
Web Refer	ences:
2. http://ww	rrnenglish.britishcouncil.org ww.esl-lab.com/ ww.elllo.org/

EQUIPMENT REQUIRED FOR A BATCH OF 60 STUDENTS (ORAL AND MULTIMEDIA)

- 1. Career laboratory: 1 Room
- 2. Server computer for the laboratory with high configuration: 1 no
- 3. Computers: 30 nos
- 4. Software: K Van Solution
- 5. LCD Projector: 1 no
- 6. Speakers with amplifiers, one wireless mic and one collar mic
- 7. Podium: 1
- 8. Chairs: 30
- 9. Discussion Tables: 2
- 10. White board: 1

ENGINEERING PHYSICS LABORATORY

Course	Code	Category	E	Iours /	Week	Credits	M	aximum	Marks
A 116	D 10	Foundation	L	Т	Р	С	CIA	SEE	Tota
AHS	Б10		0	0	3	1.5	30	70	100
Contact Cl	lasses: Nil	Tutorial Classes: Nil		Pract	ical Cla	sses: 39	Tot	al Classe	es: 39
I. Upgrade II. Analyze	should enal e practical kr e the behavio	ble the students to: nowledge in optics. or and characteristics of van ge of electric and magnetic			ls for its	optimum util	ization.		
		LIST OF	F EXP	ERIM	ENTS				
Week-l	INTROI	DUCTION TO PHYSICS	LAB	ORAT	TORY				
Do's and Do	on'ts in physi	cs laboratory. Precautions	to be	taken i	n laborat	ory.			
Week-2	HALL E	FFECT (LORENTZ FO	RCE))					
Determinati	on of charge	carrier density.							
Week-3	MELDE	'E EXPERIMENT							
Determinati	on of freque	ncy of a given tuning fork.							
Week-4	STEWA	RT GEE'S APPARATUS	S						
Magnetic fie	eld along the	axis of current carrying co	oil-Ste	ewart a	nd Gee's	method.			
Week-5	B-H CU	RVE WITH CRO							
To determin	e the value of	of retentivity and coercivity	y of a	given 1	nagnetic	material.			
Week-6	ENERG	Y GAP OF A SEMICON	DUC	TOR I	DIODE				
Determinati	on of energy	gap of a semiconductor d	iode.						
Week-7	PIN ANI	D AVALANCHE DIODE	C						
Studying V-	I characteris	tics of PIN and Avalanche	e diode	e .					
Week-8	OPTICA	L FIBER							
Evaluation of	of numerical	aperture of a given optical	l fiber						
Week-9	WAVE I	LENGTH OF LASER LI	GHT						
Defense	on of wowals	ength of a given laser light		1.00					

Week-10	PLANK'S CONSTANT
Determination	n of Plank's constant using LED.
Week-11	LIGHT EMITTING DIODE
Studying V-I	characteristics of LED
Week-12	NEWTONS RINGS
Determination	n of radius of curvature of a given plano-convex lens.
Week-13	SINGLE SLIT DIFFRACTION
Determination	n of width of a given single slit.
Manuals:	
	a, "Practical Physics", S. Chand & Co., New Delhi, 3 rd Edition, 2012. har, Dr. T. Radhakrishna, "Practical Physics for Engineering Students", S M Enterprises, 2 nd 14.
Web Referen	ce:
http://www.ia	re.ac.in

ENGINEERING GRAPHICS AND DESIGN LABORATORY

Course Code		Category	He	ours / W	eek	Credits	Max	imum M	Iarks
A MEDO2		Foundation	L	Т	Р	С	CIA	SEE	Tota
AMEB02		Foundation	1	0	4	3	30	70	100
Contact Classes:	15	Tutorial Classes: Nil	Р	ractical	Classes	:: 60	Tota	d Classe	s: 75
field. II. Apply the kno III. Understand th IV. Convert the pi	e bas wledg e proj ctoria	ic principles of engineer ge of interpretation of pro jections of solids, when it al views into orthographic ails of components throug	jection i is inclin view an h section	n differe and to both and vice vote and and de	nt quadı th plane ersa. evelop it	rants. s simultaneo		d in engi	neering
MODULE - I		LIST OI RODUCTION TO ENG				0			
sections including t Involute; Scales-Pla MODULE - II	he Rea in, Di OVE DRA DEN	Graphics and their signification of the second state of the second	neral me es. ER GR. NS, LAY SIMPLI	thod only APHICS (ERING E TEAM	y); Cycl 5, CUST 6 & OT 1 DESI	oid, Epicycl TOMIZATI HER FUNC GN PROJE	loid, Hyp CON & C CTIONS CT	CAD	l and
heory of CAD softy and Dimension), Dr Shortcut menus (But coom as used in CA Solids]. Consisting of set up frawing limits; ISC constraints, Snap to nput entry methods Applying dimension create drawings, Cre extend/lengthen); P Drawing sectional vi surface; Drawing a Parametric and nor locumentation of m	ware [awing ton B AD, S o of th D and object to dra s to c ate, ec rinting ews o nnotat para odels.	nologies that impact on g [such as: The Menu Syst g Area (Background, Cro bars), The Command Line elect and erase objects.; the drawing page and the d ANSI standards for cts manually and automa w straight lines, Applying objects, applying annotat dit and use customized la g documents to paper us of composite right regular tion, Computer-aided de metric solid, surface, a . Planar projection theory ws. Spatial visualization	em, Tocosshairs, e (where Isometr e printer, coordina atically; g various tions to yers; Ch ing the p c geomet esign (C nd wire y, includ	olbars (St Coordin applicat ic Views ic Views includin the dime Producin s ways of drawings anging li print con ric solids AD) sof frame m ling skete	tandard, ate Syst ole), The s of line ng scale nsionin ng draw drawin s; Settir ne leng mand; s and pr tware r nodels. ching of	Object Pro tem), Dialog e Status Bar es, Planes, S g and tole vings by usi g circles. ng up and u ths through orthographi oject the tru nodeling of Part editin f perspectiv	perties, g boxes c, Differe Simple a etting up rancing; ing vario use of L modifyin c projec le shape f parts a g and t e, isome	Draw, M and win ent metho and comp p of unit Orthog ous coor ayers, la ng existin tion tech of the se and asse wo-dime etric, mu	Iodify dows, ods of pound ts and raphic dinate tyers to ng lines niques ctionec emblies ensiona ltiview.

MODULE - III	ORTHOGRAPHIC PROJECTIONS

Principles of Orthographic Projections-Conventions-Projections of Points and lines inclined to both planes.

Projections of planes inclined Planes-Auxiliary Planes.

MODULE - IV PROJECTIONS OF REGULAR SOLIDS AND SECTIONS AND SECTIONAL VIEWS OF RIGHT ANGULAR SOLIDS

Those inclined to both the Planes- Auxiliary Views; Draw simple annotation, dimensioning and scale.Floor plans that include: windows, doors, and fixtures such as WC, bath, sink, shower, etc.

Draw the sectional orthographic views of geometrical solids of Prism, Pyramid, Cylinder and Cone; Objects from industry and dwellings (foundation to slab only).

MODULE - V DEVELOPMENT OF SURFACES AND ISOMETRIC PROJECTIONS

Development of surfaces of Right Regular Solids - Prism, Pyramid, Cylinder and Cone; Principles of Isometric projection–Isometric Scale, Isometric Views, Conventions; Isometric Views of lines, Planes, Simple and compound Solids; Conversion of Isometric Views to Orthographic Views and Vice-versa, Conventions.

DEMONSTRATION OF A SIMPLE TEAM DESIGN PROJECT:

Geometry and topology of engineered components: creation of engineering models and their presentation in standard 2D blueprint form and as 3D wire-frame and shaded solids; meshed topologies for engineering analysis and tool-path generation for component manufacture; geometric dimensioning and tolerancing; Use of solid-modeling software for creating associative models at the component and assembly levels; floor plans that include: windows, doors, and fixtures such as WC, bath, sink, shower, etc. Applying colour coding according to building drawing practice; Drawing sectional elevation showing foundation to ceiling; Introduction to Building Information Modelling (BIM).

Text Books

N. D. Bhatt (2012), "Engineering Drawing", Charotar Publications, New Delhi, 49th Edition, 2010.
 C.M. Agarwal, Basant Agarwal, "Engineering Drawing", Tata McGrawHill, 2nd Edition, 2013.

Reference Books:

1.K. Venugopal, "Engineering Drawing and Graphics". New Age Publications, 2nd Edition, 2010.

- 2. Dhananjay. A. Johle, "Engineering Drawing", Tata McGraw Hill, 1st Edition, 2008.
- 3.S.Trymbaka Murthy, "Computer Aided Engineering Drawing", I.K. International Publishers, 3rd Edition, 2011.

4.A. K. Sarkar, A.P Rastogi, "Engineering graphics with Auto CAD", PHI Learning, 1st Edition, 2010.

Web References:

1. http://nptel.ac.in/courses/112103019

 $2.\,http://www.autocadtutorials.net/$

3. http://gradcab.com/questions/tutorial-16-for -beginner-engineering-drawing-I

SOFTWARE AND HARDWARE REQUIREMENTS FOR A BATCH OF 30 STUDENTS:

SOFTWARE: AUTOCAD 2016 **HARDWARE:** 30 numbers of Intel Desktop Computers with 2 GB RAM

MATHEMATICAL TRANSFORM TECHNIQUES

Course	Code	Category	Ho	urs / W	eek	Credits	Maxim	um Mai	rks
AHS	P 11	Foundation	L	Т	Р	С	CIA	SEE	Total
And	D11	roundation	3	1	I	4	30	70	100
Contact Cl	lasses: 45	Tutorial Classes: 15	P	ractica	Class	es: Nil	Tot	al Class	es: 60
OBJECTIV The course		ole the students to:							
transfor II. Determ III. Fitting o IV. Solving	ms. ine the unkn of a curve an the ordinar	ge solving algebra and tran own values of a function b nd determining the Fourier y differential equations by partial differential equation	y interp transfo	oolation rm of a :	and ap	plying inver	C	•	orms.
Module-I	ROOT FI	NDING TECHNIQUES	AND L	APLAC	CE TR	ANSFORM	IS	Class	ses: 09
by bisection LAPLACE function, exi	method, me TRANSFO istence of L	CHNIQUES: Root finding thod of false position, Nev PRMS : Definition of Lap aplace transform, function	vton-Ra lace tra on of ex	phson n nsform, ponentia	linea al orde	rity propert r, first and	y, piece second sl	wise co hifting t	ntinuou heorems
by bisection LAPLACE function, exi change of s Laplace tran	method, me TRANSFO istence of L cale propert sform of per	thod of false position, Nev PRMS : Definition of Lap	vton-Ra lace tra on of ex derivat	phson n insform, ponentia tives an	linea al orde d integ	rity propert r, first and rals, multip	y, piece second sl	ewise co hifting tl t, divid	ntinuou
by bisection LAPLACE function, exic change of s Laplace tran Module-II INTERPOI differences; forward cen intervals: La INVERSE I linearity pro	method, me TRANSFO istence of L cale propert sform of per INTERPO ATION: In Symbolic r tral differer grange's int LAPLACE perty, first a	 thod of false position, New PRMS: Definition of Lap aplace transform, function y, Laplace transforms of iodic functions. DLATION AND INVERSE terpolation: Finite different elations; Newton's forwance formula, Gauss backwards 	vton-Ra lace tra on of ex derivat SE LAP nces, fo rd inter ward ce Laplace	phson n insform, ponentia tives an PLACE rward d polation entral di e transfo	nethod. linea al orde d integ TRAN ifference n, New fference	rity propert r, first and rrals, multip SFORMS ces, backwa ton's backwa ton's backwa ton's backwa ton's of I	y, piece second sl blied by rd differe vard inte Interpola	wise co hifting th t, divid Class ences and rpolation ation of	ntinuou heorems led by t ses: 09 d centra n; Gaus unequa
by bisection LAPLACE function, exic change of s Laplace tran Module-II INTERPOI differences; forward cen intervals: La INVERSE I linearity pro	method, me TRANSFO istence of L cale propert sform of per INTERPO ATION: In Symbolic r tral differer grange's int LAPLACE perty, first a theorem and	 thod of false position, New PRMS: Definition of Lap aplace transform, function y, Laplace transforms of iodic functions. DLATION AND INVERSE terpolation: Finite different elations; Newton's forwation formula, Gauss backwerpolation. TRANSFORMS: Inverse and second shifting theorem 	vton-Ra lace tra on of ex derivat SE LAP nces, fo rd inter ward ce Laplace ms, cha	phson n insform, ponentia tives an PLACE rward d polatior entral di e transfo nge of s	nethod. linea al orde d integ TRAN ifference n, New fference orm: Dec cale pr	rity propert r, first and rrals, multip SFORMS ces, backwa ton's backwa ton's backwa ton's backwa ton's of I	y, piece second sl blied by rd differe vard inte Interpola	ewise co hifting th t, divid Class ences and rpolation ation of aplace tr y s, divid	ntinuou heorems led by ses: 09 d centra n; Gaus unequa
by bisection LAPLACE function, exic change of s Laplace tran Module-II INTERPOI differences; forward cen intervals: La INVERSE I linearity pro Convolution Module-III	method, me TRANSFO istence of L cale propert sform of per INTERPO ATION: In Symbolic r tral differer grange's int LAPLACE ' perty, first a theorem and CURVE H TTING: Fit	 thod of false position, New PRMS: Definition of Lap aplace transform, function y, Laplace transforms of iodic functions. DLATION AND INVERSE terpolation: Finite different elations; Newton's forwation formula, Gauss backwerpolation. TRANSFORMS: Inverse and second shifting theorem d applications. 	vton-Ra lace tra on of ex derivat SE LAP nces, fo rd inter ward ce Laplace ms, cha R TRA	phson n insform, ponentia tives an PLACE rward d rpolatior entral di e transfor nge of s NSFOR	nethod. linea al orde d integ TRAN ifference orm: De cale pr	rity propert r, first and grals, multip SFORMS ces, backwa ton's backwa ton's backwa ton's backwa ton's backwa ton's backwa ton's mula;	y, piece second sl plied by rd differe vard inte Interpola	ewise co hifting th t, divid Class ences and rpolation ation of aplace tr y s, divid	ntinuou heorem led by ses: 09 d centra n; Gaus unequa ansform led by s

Module-IV	NUMERICAL SOLUTION OF ORDINARY DIFFERENTIAL EQUATIONS	Classes: 09
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STEP BY STEP METHOD: Taylor's series method; Euler's method, modified Euler's method for first order differential equations.

MULTI STEP METHOD: Runge-Kutta method for first order differential equations.

Module-V PARTIAL DIFFERENTIAL EQUATIONS AND APPLICATIONS

Classes: 09

PARTIAL DIFFERENTIAL EQUATIONS: Formation of partial differential equations by elimination of arbitrary constants and arbitrary functions, solutions of first order linear equation by Lagrange method.

APPLICATIONS: Method of separation of variables; One dimensional heat and wave equations under initial and boundary conditions.

Text Books:

- 1. B.S. Grewal, "Higher Engineering Mathematics", Khanna Publishers, 36th Edition, 2010.
- 2. N.P. Bali and Manish Goyal, "A Text Book of Engineering Mathematics", Laxmi Publications, Reprint, 2008.
- 3. Ramana B.V., "Higher Engineering Mathematics", Tata McGraw Hill New Delhi, 11th Reprint, 2010.

Reference Books:

- 1. Erwin Kreyszig, "Advanced Engineering Mathematics", 9th Edition, John Wiley & Sons, 2006.
- 2. Veerarajan T., "Engineering Mathematics" for first year, Tata McGraw-Hill, New Delhi, 2008.
- 3. D. Poole, "Linear Algebra A Modern Introduction", 2nd Edition, Brooks/Cole, 2005.
- 4. Dr. M Anita, "Engineering Mathematics-I", Everest Publishing House, Pune, First Edition, 2016.

Web References:

- $1. \ http://www.efunda.com/math/math_home/math.cfm$
- 2. http://www.ocw.mit.edu/resources/#Mathematics
- 3. http://www.sosmath.com/
- 4. http://www.mathworld.wolfram.com/

- 1. http://www.e-booksdirectory.com/details.php?ebook=10166
- 2. http://www.e-booksdirectory.com/details.php?ebook=7400re

ENGINEERING CHEMISTRY

	Category	Н	ours /	Week	Credits	Ma	aximum I	Marks
AHSB03 F	oundation	L	T	P	C	CIA	SEE	Total
Contract Classes 45 Trater	ial Classes 15	3	1		4	30	70	100
OBJECTIVES: The course should enable the I. Apply the electrochemica II. Analysis of water for its Applications. III. Analyze microscopic che IV. Analysis of major chemica V. Understand the chemistry	al principles in b various parameter mistry in terms cal reactions that of various fuels OCHEMISTRY trode potential, ode; Nernst equ (Dry cell) and sion: Theories Types of corro	oatteri ers an of ato t are s and ANI stand ation seco of ch sion:	ies, und nd its si omic, n used in their c D COR dard el ; Elect ndary l nemica Galva	ignificant nolecula the synt ombusti ROSIO ectrode rochemic batteries	the fundamente of the fundamente of the sis of mo on. N potential, ty cal series an (Lead-acid ectrochemic tter-line and	entals of co rial and don d Intermole lecules. /pes of ele d its applic storage ba al corrosic l pitting c	Classic cular for Classic ctrodes; 0 ations; N ttery and on, mecha corrosion;	ces sses: 09 Calomel, umerical Lithium unism of Factors
impressed current; Surface c electroplating and Electroless	•		atings-	Method	is of coating	g- not aipp	mg, cem	entation
MODULE -II WATER A	ND ITS TREA	тм	ENT				Clas	ses: 08
MODULE -II WATER A Introduction: Hardness of w expression and units of hardness water and its specifications, s and ozonization; Boiler feed Colloidal conditioning; Exter Reverse osmosis, numerical p	ness; Estimation Steps involved i water and its tr ernal treatment	haro hof h hof h hotre	dness; ardnes atment ent, Ca	s of wat of wate	ter by comp r, Disinfecti nditioning, I	lexometric on of wate Phosphate	and per- method; or by chlo condition	Potable rination ing and
Introduction: Hardness of w expression and units of hard water and its specifications, s and ozonization; Boiler feed Colloidal conditioning; Exte Reverse osmosis, numerical p	rater, Causes of ness; Estimation Steps involved i water and its tr ernal treatment problems.	hard h of h in tre reatm of v	dness; aardnes atment ent, Ca vater;	s of wate of wate algon co Ion-exch	ter by comp r, Disinfecti nditioning, I nange proce	lexometric on of wate Phosphate ess; Desalin	r and perm method; r by chlo condition nation of Class	manent, Potable rination ing and water:

MODULE -IV STEREOCHEMISTRY, REACTION MECHANISM AND SYNTHESIS OF DRUG MOLECULES Classes: 12

Introduction to representation of 3-dimensional structures: Structural and stereoisomers, configurations, symmetry and chirality; Enantiomers, diastereomers, optical activity and Absolute configuration; Confirmation analysis of n- butane. Substitution reactions: Nucleophilic substitution reactions, Mechanism of SN^1 , SN^2 reactions; Electrophilic and nucleophilic addition reactions; Addition of HBr to propene; Markownikoff and anti Markownikoff's additions; Grignard additions on carbonyl compounds; Elimination reactions: Dehydro halogenation of alkylhalides; Saytzeff rule; Oxidation reactions: Oxidation of alcohols using KMnO₄ and chromicacid; Reduction reactions: Reduction of carbonyl compounds using LiAlH₄ & NaBH₄; Hydroboration of olefins; Structure, synthesis and pharmaceutical applications of Paracetamol and Aspirin.

MODULE –V FUELS AND COMBUSTION

Classes: 08

Fuels: Definition, classification of fuels and characteristics of a good fuels; Solid fuels: Coal; Analysis of coal: Proximate and ultimate analysis; Liquid fuels: Petroleum and its refining; Cracking: Fixed bed catalytic cracking; Knocking: Octane and cetane numbers; Gaseous fuels: Composition, characteristics and applications of natural gas, LPG and CNG; Combustion: Calorific value: Gross Calorific Value(GCV) and Net Calorific Value(NCV), calculation of air quantity required for complete combustion of fuel, numerical problems.

Text Books:

- 1. P. C. Jain, Monica Jain, "Engineering Chemistry", Dhanpat Rai Publishing Company, 16th Edition, 2017.
- 2. Shasi Chawla, "Text Book of Engineering Chemistry", Dhantpat Rai Publishing Company, New Delhi, 2017.
- 2. R.T. Morrison, RN Boyd and SK Bhattacharya "Organic Chemistry", Pearson, 7th Edition, 2011.
- 3. K.F. Purcell and J.C. Kotz, "Inorganic Chemistry", Cengage learning, 2017.

Reference Books:

- K.P.C. Volhardt and N. E. Schore, "Organic Chemistry Structure and Functions", Oxford Publications, 7th Edition.
- 2. B. H. Mahan, "University Chemistry", Narosa Publishers, 4th Edition, 2009.

Web References:

1. Engineering Chemistry (NPTEL Web-book), by B.L.Tembe, Kamaluddin and M.S.Krishnan.

PROGRAMMING FOR PROBLEM SOLVING

	è	Category	Ho	ours / V	Week	Credits	Maximum Marks		
ACSB01		Foundation	L	Т	Р	С	CIA	SEE Tot	
ACODOT		Foundation	3	0	0	3	30	70	100
Contact Classes	s: 45	Tutorial Classes: Nil	P	ractica	al Class	es: Nil	Tota	l Classe	s: 45
 I. Learn adequation II. Understand prior III. Improve probins IV. Understand the 	te know ogrami lem sol e dyna:	le the students to: vledge by problem solving ming skills using the fund ving skills using arrays, so mics of memory by pointe process with access permis	amenta trings, ers.	als and			nge.	1	
MODULE - I	INTE	RODUCTION						Class	es: 10
computer languag Computer languag	ges, cre ges, Hi	ning: Computer system, c eating and running progr story of C, basic structu yords, identifiers, constan	ams, a	algorit C prog	hms, flo grams, j	owcharts; In process of a	ntroduction compiling	to C and run	anguage ning a
MODULE - II	CON	TROL STRUCTURES						Class	es: 08
	stateme	ctures: Decision stateme ent; Loop control stateme							
MODULE - III	ARR	AYS AND FUNCTIONS	5					Class	es: 10
dimensional array	ys, init haracte for use	dimensional arrays, decla ialization and accessing, or strings, inputting char r defined functions, functions	multi acter a	-dimen strings eclarat	nsional , chara ion, fun	arrays; Str cter library ction proto chanisms, r	ings: Array functions, type, categ	ys of cl string ory of f	haracter handlin function
Functions: Need		cation, function calls, pa to functions, storage clas		eproce	essor dir	ective		-	allays i
Functions: Need	strings	cation, function calls, pa	ses, pr	-		ective		Class	es: 09

MODULE - V	FILE HANDLING AND BASICALGORITHMS	Classes: 08
special functions f	asic file operations, file types, file opening modes, input and output operations working with files, file positioning functions, command line arguments. (bubble, insertion, selection), algorithm complexity through example proged).	Searching, basic
Text Books:		
2017.	d, "Programming with C", Schaum's Outlines Series, McGraw Hill Education, "Programming in ANSI C", McGraw Hill Education, 6 th Edition, 2012.	n, 3 rd Edition,
Reference Books	:	
 1988. YashavantKar Schildt Herber R. S. Bichkar, Dey Pradeep, Press, 2nd Edit Stephen G. Kor Web References: https://www.bf https://www.kf https://www.edit 	ochan, "Programming in C", Addison-Wesley Professional, 4 th Edition, 2014 foit.org/itp/Programming.html nanacademy.org/computing/computer-programming lx.org/course/programming-basics-iitbombayx-cs101-1x-0	2014. ord University
E-Text Books:	lx.org/course/introduction-computer-science-harvardx-cs50x	
1. http://www.free 2. http://www.ima	ebookcentre.net/Language/Free-C-Programming-Books-Download.htm ada.sdu.dk/~svalle/courses/dm14-2005/mirror/c/ ggnotebook.weebly.com/uploads/2/2/7/1/22718186/ge6151-notes.pdf	
MOOC Course		
2. http://www.ocv	ison.com/courses/Introduction-to-Programming-in-c w.mit.edu/courses/electrical-engineering-and-computer-science/6-s096-effec n-c-and-c-january-iap-2014/index.htm	tive-

ELCTRICAL CIRCUITS

Course Code		Category	Ho	ours / We	ek	Credits	Maximum Marks		
		Foundation	L	Т	Р	С	CIA	SEE	Tota
AEEB03		Foundation	3	1	0	4	30	70	100
Contact Classe	s: 45	Tutorial Classes: 15	Р	ractical	Classes	Nil	Tota	l Classe	s: 60
I. Classify circ II. Apply mesh III. Illustrate sing	uld ena uit para analys gle pha	able the students to: ameters and apply Kirch is and nodal analysis to s use AC circuits and apply l circuits with the help	solve elec y steady s	trical net tate analy	works. ysis to ti		circuits.	I	
MODULE-I	INT	RODUCTION TO ELF	ECTRIC	AL CIRO	CUITS			Class	es:09
parameters, inde different input s	epender signals ance, se	definitions, Ohm's law at and dependent sources like square, ramp, saw ource transformation, K	s, voltage tooth, tri	and curi	rent rela and con	tionships for plex), temp	r passivo erature	e elemen depende	nts (fo ence o
series paramer ne	1								
*		ALYSIS OF ELECTRI	CAL CIF	RCUITS				Class	es:09
MODULE-II Circuit analysis Kirchhoff's law	ANA : Star rs, insp		star trans nesh, suj	sformatio per node	analysi	s; Network	topolog	al analy 39: defin	vsis by
MODULE-II Circuit analysis: Kirchhoff's law incidence matrix	ANA : Star rs, insp c, basic	to delta and delta to pection method, super r	star trans nesh, suj matrices t	sformatio per node for planai	analysi r networ	s; Network ks, duality a	topolog	al analy gy: defin network	ysis by nitions as.
MODULE-II Circuit analysis Kirchhoff's law incidence matrix MODULE-III Single phase AC factor and peak f reactance, imper reactive and com Steady state anal	ANA : Star s, insp a, basic SINO C circui factor f dance, nplex p lysis: S	LYSIS OF ELECTRIC to delta and delta to bection method, super r tie set and basic cut set r GLE PHASE AC CIRC ts: Representation of alt for different periodic was susceptance and admitt ower, power factor.	star trans mesh, sup matrices to CUITS Al ernating of ve forms, tance, reo L, RC an	sformatio per node for planar ND RES quantities phase ar ctangular d RLC ci	analysi r networ ONANC a, instant ad phase and pc ircuits (i	s; Network ks, duality a CE aneous, pea difference, lar form, co n series, par	topolog nd dual k, RMS 'j' notat oncept o allel and	al analy al analy y: defin network Class , averag ion, con of powe	vsis by nitions s. es: 10 e, form cept o r, real paralle
MODULE-II Circuit analysis: Kirchhoff's law incidence matrix MODULE-III Single phase AC factor and peak f reactance, imper reactive and com Steady state anal	ANA : Star rs, insp t, basic SINO C circui factor f dance, nplex p lysis: S with sin	to delta and delta to bection method, super to tie set and basic cut set and GLE PHASE AC CIRC ts: Representation of alt for different periodic war susceptance and admitto ower, power factor.	star trans mesh, sup matrices to CUITS Al ernating of ve forms, tance, reo L, RC an	sformatio per node for planar ND RES quantities phase ar ctangular d RLC ci	analysi r networ ONANC a, instant ad phase and pc ircuits (i	s; Network ks, duality a CE aneous, pea difference, lar form, co n series, par	topolog nd dual k, RMS 'j' notat oncept o allel and	al analy al analy y: defin network Class , averag ion, con of powe	vsis by nitions s. es: 10 e, form cept o r, real paralle
MODULE-II Circuit analysis: Kirchhoff's law incidence matrix MODULE-III Single phase AC factor and peak f reactance, imped reactive and com Steady state anal combinations) w	ANA : Star rs, insp t, basic SINO C circui factor f dance, nplex p lysis: S vith sin ctor.	LYSIS OF ELECTRIC to delta and delta to bection method, super r tie set and basic cut set r GLE PHASE AC CIRC ts: Representation of alt for different periodic was susceptance and admitt ower, power factor.	star trans mesh, sup matrices to CUITS Al ernating of ve forms, tance, reo L, RC an	sformatio per node for planar ND RES quantities phase ar ctangular d RLC ci	analysi r networ ONANC a, instant ad phase and pc ircuits (i	s; Network ks, duality a CE aneous, pea difference, lar form, co n series, par	topolog nd dual k, RMS 'j' notat oncept o allel and	al analy y: defin network Class , averag ion, com of powe l series p ncept o	vsis b nitions ss. es: 10 e, form cept o r, real paralle f band
MODULE-II Circuit analysis: Kirchhoff's law incidence matrix MODULE-III Single phase AC factor and peak f reactance, imped reactive and com Steady state anal combinations) w width and Q fac MODULE-IV Magnetic circuit	ANA : Star rs, insp , basic SINO C circui factor f dance, plex p lysis: S vith sin ctor. MAC	CLYSIS OF ELECTRIC to delta and delta to bection method, super r tie set and basic cut set r GLE PHASE AC CIRC ts: Representation of alt for different periodic wa susceptance and admitt ower, power factor. teady state analysis of R susoidal excitation; Rese	star trans mesh, suj matrices f CUITS Al ernating o ve forms, tance, reo L, RC an onance:	sformation per node for planar ND RES quantities phase ar ctangular d RLC ci Series at duction, o	analysi r networ ONAN(a, instant ad phase and pc ircuits (i nd para	s; Network ks, duality a CE aneous, pea difference, lar form, co n series, par llel resonar	topolog nd dual k, RMS, 'j' notat oncept c allel and nce, con mutual i	al analy y: defin network Class , averag ion, com of powe l series p ncept o Class nductan	vsis b nitions ss. es: 10 e, form cept o r, real paralle f band es: 09 cce, do

Text Books:

- 1. A Sudhakar, Shyammohan S Palli, "Circuits and Networks", Tata McGraw-Hill, 4th Edition, 2010.
- 2. M E Van Valkenberg, "Network Analysis", PHI, 3rd Edition, 2014.

Reference Books:

- 1. John Bird, "Electrical Circuit Theory and Technology", Newnes, 2nd Edition, 2003.
- 2. C L Wadhwa, "Electrical Circuit Analysis including Passive Network Synthesis", New Age International, 2nd Edition, 2009.
- 3. David A Bell, "Electric circuits", Oxford University Press, 7th Edition, 2009.
- 4. E Hughes, "Electrical and Electronics Technology", Pearson Education, 2010.
- 5. A Chakrabarthy, "Electric Circuits", Dhanipat Rai & Sons, 6th Edition, 2010.
- 6. V D Toro, "Electrical Engineering Fundamentals", Prentice Hall India, 1989.

Web References:

- 1. https://www.igniteengineers.com
- 2. https://www.ocw.nthu.edu.tw
- 3. https://www.uotechnology.edu.iq
- 4. https://www.iare.ac.in

- 1. https://www.bookboon.com/en/concepts-in-electric-circuits-ebook
- 2. https://www.www.jntubook.com
- 3. https://www.allaboutcircuits.com
- 4. https://www.archive.org

ENGINEERING CHEMISTRY LABORATORY

Cours	se Code	Category	Ho	urs / V	Veek	Credit	Maximum Mark		
АН	SB09	Foundation	L	Т	Р	С	CIA	SEE	Tota
	500	roundation	-	-	3	1.5	30	70	100
Contact	Classes: Nil	Tutorial Classes: Nil]	Practio	cal Clas	ses: 36	Tot	al Classo	es: 36
I. Analy II. Descri III. Perfor	e should enab ze, interpret, a be the fluid pr m a complexo	ble the students to: nd draw conclusions from roperty of surface tension a metric titration to determin perimental results.	and visc	cosity.		er from vari	ous sourc	ees.	
	1	LIST OF	EXPE	RIME	NTS				
Week-l	INTRODU	CTION TO CHEMISTR	Y LAB	BORA	TORY				
Introductio	on to chemistry	y laboratory. Do's and Don	'ts in ch	nemistr	y labora	atory.			
Week-2	PREPARA	TION OF ORGANIC CO	OMPO	UNDS					
Synthesis	of Aspirin.								
Week-3	VOLUME	TRIC ANALYSIS							
Estimation	of Total hard	ness of water by complexo	metric	method	lusing	EDTA.			
Week-5	INSTRUMENTATION								
Estimation	of an HCl by	conductometric titrations.							
Week-6	INSTRUMENTATION								
Estimation	of HCl by po	tentiometric titrations.							
Week-7	INSTRUM	ENTATION							
Estimation	of Acetic acid	d by Conductometric titrati	ions.						
Week-8	INSTRUM	ENTATION							
	1								

Week-	9 VOLUMETRIC ANALYSIS						
Determi	nation of chloride content of water b	by Argentometry.					
Week-1	0 PHYSICAL PROPERTIES						
Determi	nation of surface tension of a given	liquid using Stalagmometer.					
Week-1	1 PHYSICAL PROPERTIES						
Determi	nation of viscosity of a given liquid	using Ostwald's viscometer.					
Week-1	2 PHYSICAL PROPERTIES						
Verifica	tion of freundlich adsorption isother	m-adsorption of acetic and on ch	arcoal.				
Week-1	3 ANALYSIS OF ORGANIC C	OMPOUNDS					
Thin lay	ver chromatography calculation of R_{f}	values .Eg: ortho and para nitro	phenols.				
Week-1	4 REVISION						
Revision	n.						
Referen	Reference Books:						
1. Vog 2. Gar	el's, "Quantitative Chemical Analys y D. Christian, "Analytical Chemistr	is", Prentice Hall, 6 th Edition, 20 y", Wiley India, 6 th Edition, 2007	00. 7.				
Web Re	eferences:						
http://www.iare.ac.in							
LIST OF EQUIPMENT REQUIRED FOR A BATCH OF 30 STUDENTS:							
S. No	Name of the Apparatus	Apparatus Required	Quantity				
1	Analytical balance	04	100 gm				
2	Beaker	30	100 ml				
3	Burette	30	50 ml				
4	Burette Stand	30	Metal				
5	Clamps with Boss heads	30	Metal				
6	Conical Flask	30	250 ml				
7	Conductivity cell	10	K=1				
8	Calomel electrode	10	Glass				
9	Digital Potentiometer	10	EI				
10	Digital Conductivity meter	10	EI				
11 12	Digital electronic balance Distilled water bottle	01 30	RI 500 ml				
12		30	500 ml				

13	Funnel	30	Small
14	Glass rods	30	20 cm length
15	Measuring Cylinders	10	10 ml
16	Oswald Viscometer	30	Glass
17	Pipette	30	20 ml
18	Platinum Electrode	10	PP
19	Porcelain Tiles	30	White
20	Reagent bottle	30	250 ml
21	Standard Flask	30	100 ml
22	Stalagmo meter	30	Glass
23	TLC Plates	40	
24	UV Chamber	02	

PROGRAMMING FOR PROBLEM SOLVING LABORATORY

	e Code	Category	H	lours / V	Veek	Credits	Maximum Marks		
	5002	Foundation	L	Т	Р	С	CIA	SEE	Tota
ACS	SB02	Foundation	0	0	4	2	30	70	100
Contact C	lasses: Nil	Tutorial Classes: Nil	Pr	actical	Classes:	36	Tot	al Class	es:36
I. Form II. Devel III. Learn	should enab ulate probler lop programs memory all	the students to: ns and implement algorith s using decision structures ocation techniques using ogramming approach for s	s, loop pointe	s and fu rs.	nctions.		-	rld.	
		LIST OF	EXPE	ERIME	NTS				
Week-1	OPERATO	RS AND EVALUATION	NOF	EXPRE	SSIONS	5			
one line: i. (x - ii. (x +	+ y) / (x -y) + y)(x - y)	o read the values of x and	y and						is in
a. Write ab. A Fibon Subsequ	C program to acci sequence ent terms are the first n to C program t	o find the sum of individu ce is defined as follows: e found by adding the pre erms of these sequences.	The fi	rst and g two ter	second to rms in th	erms in the	e. Write	a C prog	gram to
c. Write a the user.d. A chara entered i	cter is enter is a capital l	o generate all the prime n red through keyboard. W etter, a small case letter, a shows the range of ASCII	a digit	or a spe	ecial syn	bol using			

Week-3	CONTROL STRUCTURES
operati b. Write a c. Write a d. Write a	a C program, which takes two integer operands and one operator from the user, performs the on and then prints the result. (Consider the operators +, -, *, /, % and use switch statement). a C program to calculate the following sum: $sum = 1 - x^2/2! + x^4/4! - x^6/6! + x^8/8! - x^{10}/10!$ a C program to find the roots of a quadratic equation. a C program to check whether a given 3 digit number is Armstrong number or not. a C program to print the numbers in triangular form 1 1 2 1 2 3 1 2 3 4
Week-4	ARRAYS
b. Write a i. A ii. M c. Write a d. Write a	 a C program to find the second largest integer in a list of integers. a C program to perform the following: ddition of two matrices lultiplication of two matrices a C program to count and display positive, negative, odd and even numbers in an array. a C program to merge two sorted arrays into another array in a sorted order. a C program to find the frequency of a particular number in a list of integers.
Week-5	STRINGS
i. T ii. T b. Write a c. Write a e. Write a	 a C program that uses functions to perform the following operations: o insert a sub string into a given main string from a given position. o delete n characters from a given position in a given string. a C program to determine if the given string is a palindrome or not. a C program to find a string within a sentence and replace it with another string. a C program that reads a line of text and counts all occurrence of a particular word. a C program that displays the position or index in the string S where the string T begins, or 1 if n't contain T.
Week-6	FUNCTIONS
i. T ii. T b. Write i. T ii. T c. Write	C programs that use both recursive and non-recursive functions o find the factorial of a given integer. o find the greatest common divisor of two given integers. C programs that use both recursive and non-recursive functions o print Fibonacci series. o solve towers of Hanoi problem. a C program to print the transpose of a given matrix using function. a C program that uses a function to reverse a given string.
Week-7	POINTERS
b. Write ac. Write ad. Write a	A C program to concatenate two strings using pointers. a C program to find the length of string using pointers. a C program to compare two strings using pointers. a C program to copy a string from source to destination using pointers. a C program to reverse a string using pointers.

Week-8	STRUCTURES AND UNIONS
 i. Readi ii. Writi iii. Addit iv. Multi b. Write a C pay. The D name and g c. Create a B structure a d. Create a un program to e. Write a C 	program that uses functions to perform the following operations: ing a complex number ng a complex number tion and subtraction of two complex numbers plication of two complex numbers. Note: represent complex number using a structure. program to compute the monthly pay of 100 employees using each employee's name, basic DA is computed as 52% of the basic pay. Gross-salary (basic pay + DA). Print the employees gross salary. Book structure containing book_id, title, author name and price. Write a C program to pass a s a function argument and print the book details. nion containing 6 strings: name, home_address, hostel_address, city, state and zip. Write a C o display your present address. program to define a structure named DOB, which contains name, day, month and year. concept of nested structures display your name and date of birth.
Week-9	ADDITIONAL PROGRAMS
progression 1+5+25+1 sense for r then go ba also illegal b. 2's comple bits after t find the 2's	program to read in two numbers, x and n, and then compute the sum of this geometric n: $1+x+x^2+x^3++x^n$. For example: if n is 3 and x is 5, then the program computes 25. Print x, n, the sum. Perform error checking. For example, the formula does not make negative exponents – if n is less than 0. Have your program print an error message if n<0, ck and read in the next pair of numbers of without computing the sum. Are any values of x l? If so, test for them too. ement of a number is obtained by scanning it from right to left and complementing all the he first appearance of a 1. Thus 2's complement of 11100 is 00100. Write a C program to s complement of a binary number. program to convert a Roman numeral to its decimal equivalent. E.g. Roman number CD is to400.
Week-10	PREPROCESSOR DIRECTIVES
macro to c b. Define a m program fo c. Write sym	hacro with one parameter to compute the volume of a sphere. Write a C program using this ompute the volume for spheres of radius 5, 10 and 15meters. hacro that receives an array and the number of elements in the array as arguments. Write a C or using this macro to print the elements of the array. bolic constants for the binary arithmetic operators +, -, *, and /. Write a C program to he use of these symbolic constants.
Week-11	FILES
 b. Write a C c. Write a C d. Two files contents or second are 	program to display the contents of a file. program to copy the contents of one file to another. program to reverse the first n characters in a file, where n is given by the user. DATA1 and DATA2 contain sorted lists of integers. Write a C program to merge the f two files into a third file DATA i.e., the contents of the first file followed by those of the put in the third file. program to count the no. of characters present in the file.

Week-12	COMMAND LINE ARGUMENTS AND NUMERICAL METHODS
b. Write a C c. Write a C	program to read two numbers at the command line and perform arithmetic operations on it. program to read a file name at the command line and display its contents. program to solve numerical methods problems (root finding, numerical differentiation and integration)
Reference Bo	oks:
 Oualline S King KN, Kochan S Sam's Pub 	Kanetkar, "Let Us C", BPB Publications, New Delhi, 13 th Edition, 2012. Steve, "Practical C Programming", O'Reilly Media, 3 rd Edition, 1997. "C Programming: A Modern Approach", Atlantic Publishers, 2 nd Edition, 2015. Stephen G, "Programming in C: A Complete Introduction to the C Programming Language", olishers, 3 rd Edition, 2004. ter V, "Expert C Programming: Deep C Secrets", Pearson India, 1 st Edition, 1994.
Web Referen	ces:
·	v.sanfoundry.com/c-programming-examples v.geeksforgeeks.org/c

- http://www.cprogramming.com/tutorial/c
 http://www.cs.princeton.edu

WORKSHOP / MANUFACTURING PRACTICES LABORATORY

AMEBO1 Foundation - - 3 1.5 30 70 70 Contact Classes: Nil Tutorial Classes: Nil Practical Classes: 36 Total Classes: 3 OBJECTIVES: The course should enable the students to: I. Identify and use of tools, types of joints in carpentry, fitting, tin smithy and plumbing operations. II. Identify and use of tools, types of joints in carpentry, fitting, tin smithy and plumbing operations. III. Understand of electrical wiring and components. III. Observation of the function of lathe, shaper, drilling, boring, milling, grinding machines. III. Observation of the function of lathe, shaper, drilling, boring, milling, grinding machines. IIIST OF EXPERIMENTS Week-1 MACHINE SHOP-Turning and other machines Batch II: Working on central lathe and shaping machine. Batch II: Working on milling machine. Batch I: Working on milling machine. ADVANCED MACHINE SHOP IIII. ADVANCED MACHINE SHOP Batch I: Working on CNC Turning machines. Batch I: Working on CNC Turning machines. Batch I: Working on CNC Vertical Drill Tap Center. Week-4 FITTING Batch I: Make a straight fit and straight fit for given dimensions. East of the straight fit and straight fit for given dimensions.	Course Code		Category	Ho	urs / W	eek	Credits	Maximum Marks		
Contact Classes: Nil Tutorial Classes: Nil Practical Classes: 36 Total Classes: 3 OBJECTIVES: The course should enable the students to: I. Identify and use of tools, types of joints in carpentry, fitting, tin smithy and plumbing operations. II. Understand of electrical wiring and components. III. Observation of the function of lathe, shaper, drilling, boring, milling, grinding machines. Week-1 MACHINE SHOP-Turning and other machines III. Working on central lathe and shaping machine. Batch I: Working on central lathe and shaping machine. MACHINE SHOP-Milling and other machines Batch I: Working on milling machine. MACHINE SHOP-Milling and other machines Batch I: Working on milling machine. MACHINE SHOP-Milling and other machines Batch I: Working on CNC Turning machine. Machine assessment. Week-3 ADVANCED MACHINE SHOP Batch I: Working on CNC Turning machines. Batch I: Working on CNC Vertical Drill Tap Center. Week-4 FITTING Batch I: Working on CNC Vertical Drill Tap Center. Week-1 Week-5 CARPENTRY-I Batch I: Preparation of dove tail joint as per given dimensions. Batch I: Preparation of dove tail joint as per given taper angle. Week-6 CARPENTRY-II	A MI	7 B 01	Foundation	L	Т	Р	С	CIA	SEE	Tota
OBJECTIVES: The course should enable the students to: I. Identify and use of tools, types of joints in carpentry, fitting, tin smithy and plumbing operations. II. Identify and use of tools, types of joints in carpentry, fitting, tin smithy and plumbing operations. III. Observation of the function of lathe, shaper, drilling, boring, milling, grinding machines. LIST OF EXPERIMENTS Week-1 MACHINE SHOP-Turning and other machines Batch I: Working on central lathe and shaping machine. Batch I: Working on central lathe and shaping machine. Week-2 MACHINE SHOP-Milling and other machines Batch I: Working on milling machine. Batch I: Working on milling machine. Batch I: Working on CNC Turning machines. Batch I: Working on CNC Turning machines. Batch I: Working on CNC Turning machines. Batch I: Working on CNC Vertical Drill Tap Center. Week-4 FTTING Batch I: Make a straight fit and straight fit for given dimensions. Batch I: Make a square fit for straight fit for given sizes. Week-5 CARPENTRY-I Batch I: Preparation of lap joint as per given dimensions. Batch I: Preparation of	Alvii		Foundation	-	-	3	1.5	30	70	100
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Week-1 MACHINE SHOP-Turning and other machines Batch I: Working on central lathe and shaping machine. Batch II: Working on drilling, grinding machines. Week-2 MACHINE SHOP-Milling and other machines Batch I: Working on milling machine. Batch II: Working on milling machine. Batch II: Working on milling and shaping machine. Meek-3 ADVANCED MACHINE SHOP ADVANCED MACHINE SHOP Batch I: Working on CNC Turning machines. Batch II: Working on CNC Turning machines. Batch I: Working on CNC Turning machines. Batch II: Working on CNC Vertical Drill Tap Center. Week-4 FITTING Batch I: Make a straight fit and straight fit for given dimensions. Batch II: Make a square fit for straight fit for given sizes. Week-5 CARPENTRY-I Batch I: Preparation of lap joint as per given dimensions. Batch II: Preparation of dove tail joint as per given taper angle. Week-6 CARPENTRY-II Batch I: Preparation of dove tail joint as per given taper angle. Meek-6	The course s I. Identify II. Underst	hould enable and use of t and of electr	ools, types of joints in ca ical wiring and compone	nts.	-			-	_	IS.
Batch I: Working on central lathe and shaping machine. Batch II: Working on drilling, grinding machines. Week-2 MACHINE SHOP-Milling and other machines Batch I: Working on milling machine. Batch II: Working on milling and shaping machine. Week-3 ADVANCED MACHINE SHOP Batch I: Working on CNC Turning machines. Batch I: Working on CNC Turning machines. Batch II: Working on CNC Vertical Drill Tap Center. Week-4 FITTING Batch I: Make a straight fit and straight fit for given dimensions. Batch II: Make a square fit for straight fit for given sizes. Week-5 CARPENTRY-I Batch I: Preparation of lap joint as per given dimensions. Batch I: Preparation of dove tail joint as per given taper angle. Week-6 CARPENTRY-II		1	LIST OF	EXPE	RIMEN	NTS				
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Batch I: Working on CNC Turning machines. Batch II: Working on CNC Vertical Drill Tap Center.Week-4FITTINGBatch I: Make a straight fit and straight fit for given dimensions. Batch II: Make a square fit for straight fit for given sizes.Week-5CARPENTRY-IBatch I: Preparation of lap joint as per given dimensions. Batch II: Preparation of dove tail joint as per given taper angle.Week-6CARPENTRY-IIBatch I: Preparation of dove tail joint as per given taper angle.				е.						
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Batch II: Preparation of dove tail joint as per given taper angle. Week-6 CARPENTRY-II Batch I: Preparation of dove tail joint as per given taper angle.	Week-5	CARPEN	TRY-I							
Batch I: Preparation of dove tail joint as per given taper angle.										
	Week-6	CARPEN	FRY-II							
Week-7 ELECTRICAL AND ELECTRONICS	Week-7	ELECTR	CAL AND ELECTRO	NICS						

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Week-8	WELDING
	velding & Gas Welding. welding & Arc Welding.
Week-9	MOULD PREPARATION
	are a wheel flange mould using a given wooden pattern. are a bearing housing using an aluminum pattern.
Week-10	MOULD PREPARATION
	are a bearing housing using an aluminum pattern. are a wheel flange mould using a given wooden pattern.
Week-11	BLACKSMITHY- I, TINSMITHY- I,
·	are S-bend & J-bend for given MS rod using open hearth furnace. pare the development of a surface and make a rectangular tray and a round tin.
Week-12	TINSMITHY- I, BLACKSMITHY- I
	are the development of a surface and make a rectangular tray and a round tin. are S-bend & J-bend of given MS rod using open hearth furnace.
Week-13	PLASTIC MOULDING, INJECTION MOULDING, GLASS CUTTING
	ic Moulding and Glass cutting. tic Moulding and Glass cutting.
Week-14	BLOW MOULDING
Batch I& II: F	Blow Moulding.
Reference Bo	ooks:
Technolog 2. Kalpakjia India Edit 3. Gowri P. 4. Roy A. Li	oudhury S.K., Hajra Choudhury A.K. and Nirjhar Roy S.K., "Elements of Workshop gy", Vol. I 2008 and Vol. II 2010, Media promoters and publishers private limited, Mumbai. n S, Steven S. Schmid, "Manufacturing Engineering and Technology", Pearson Education ion, 4 th Edition, 2002. Hariharan, A. Suresh Babu," Manufacturing Technology – I", Pearson Education, 2008. ndberg, "Processes and Materials of Manufacture", Prentice Hall India, 4 th Edition, 1998. "Manufacturing Technology", Vol. I and Vol. II, Tata McGraw-Hill House, 2017.
Web Referen	ices:
http://www.ia	re.ac.in

ELECTRICAL CIRCUITS ANALYSIS LABORATORY

Course Code		Category	Н	ours / W	Veek	Credits	Maximum Marks		
AEEB06		Foundation	L	Т	Р	С	CIA	SEE	Tota
			-	-	3	1.5	30	70	100
Contact Classes: Nil		Tutorial Classes: Nil	Practical Classes: 36				Total Classes: 36		
OBJECT	IVES:								
The course	e should ena	ble the students to:							
II. Predic III. Meas	ct the charact ure impedanc	laws and network reduction teristics of sinusoidal func- teristics of series RL, RC and R theorems used to reduce the	ction. LC cir	cuits.		trical netwo	rk.		
		LIST OF	EXPI	ERIME	NTS				
Expt. 1	OHM'S LAW, KVL AND KCL								
Verificatio	on of Ohm's l	aw, KVL and KCL using	hardw	vare and	digital	simulation.			
Expt. 2	MESH AN	ALYSIS							
Determina	tion of mesh	currents using hardware a	and dig	gital sim	ulation.				
Expt. 3	NODAL A	NALYSIS							
Measurem	ent of nodal	voltages using hardware a	und dig	gital sim	ulation.				
Expt. 4	SINGLE I	PHASE AC CIRCUITS							
Calculation	n of average	value, RMS value, form f	actor,	peak fac	ctor of s	inusoidal w	ave usin	g hardwa	re.
Expt. 5	IMPEDAN	NCE OF SERIES RL,RO	C ,RLC	C CIRC	UIT				
Examine the	he impedance	e of series RL,RC,RLC C	Circuit						
Expt. 6	SERIES R	ESONANCE							
Verificatio	on of series re	sonance using hardware a	and dig	gital sim	ulation.				
Expt. 7	PARALLEL RESONANCE								
Verificatio	n of parallel	resonance using hardware	e and c	ligital si	mulatio	n.			
Expt. 8	SUPERPO	OSITION THEOREM							
Verificatio	on of superpo	sition theorem using hard	ware a	and digit	al simu	lation			

Verification of reciprocity theorem using hardware and digital simulation.

Expt. 10 MAXIMUM POWER TRANSFER THEOREM

Verification of maximum power transfer theorem using hardware and digital simulation .

Expt. 11 THEVENINS THEOREM

Verification of Thevenin's theorem using hardware and digital simulation.

Expt. 12 NORTON'S THEOREM

Verification of Norton's theorem using hardware and digital simulation.

Expt. 13 COMPENSATION THEOREM

Verification of compensation theorem using hardware and digital simulation

Expt. 14 MILLIMAN'S THEOREM

Verification of Milliman's theorem using hardware and digital simulatio

Reference Books:

- 1. A Chakrabarti, "Circuit Theory", Dhanpat Rai Publications, 6th Edition, 2006.
- 2. William Hayt, Jack E Kemmerly S.M. Durbin, "Engineering Circuit Analysis", Tata McGraw Hill, 7th Edition, 2010.
- 3. K S Suresh Kumar, "Electric Circuit Analysis", Pearson Education, 1st Edition, 2013.

Web References:

- 1. https://www.ee.iitkgp.ac.in
- 2. https://www.citchennai.edu.in
- 3. https://www.iare.ac.in

SOFTWARE AND HARDWARE REQUIREMENTS FOR A BATCH OF 24 STUDENTS:

SOFTWARE: Microsoft Windows 7 and MATLAB – V 8.5 **HARDWARE:** 06 numbers of Intel Desktop Computers with 2 GB RAM

COMPLEX ANALYSIS AND SPECIAL FUNCTIONS

III Semester: ECE							[
Course Code		Category	Hours / Week Credits Maxim					timum Ma	mum Marks	
AHSB05		Foundation	L	Т	Р	C	CIA	SEE	Total	
			3	-	-	3	30	70	100	
Contact Classes: 45 Tutorial Classes: Nil				Practica	al Class	es: Nil	r	Fotal Clas	ses: 45	
II. Evaluate the	he bas contou	le the students to: ic theory of complex fur ir integration using Cauc lge of probability on sing	chy res	idue theor	rem.		v distributi	ons.		
MODULE -I	MODULE -I COMPLEX FUNCTIONS AND DIFFERENTIATION Classes: 08									
concepts of limit, Milne-Thomson me	contin ethod,	ferentiation and integra uity, differentiability, a Bilinear Transformatior	analytic 1.							
MODULE –II	MODULE –II COMPLEX INTEGRATION						Cla	Classes: 10		
Radius of converge MODULE –III Expansion in Taylo	nce. POW or's ser singul	egral formula; Power s ER SERIES EXPANS ries, Maclaurin's series a arity; Residue: Cauchy f the type	ION O and Lat	F COMP	LEX F es. Singu	UNCTION	solated sin	Cla gular poin	asses: 10 it; Pole of	
$1.\int_{0}^{2\Pi} f(\cos \theta)$	θ , sin	θ) $d\theta$ 2. $\int_{-\infty}^{\infty} f(x)$)dx							
MODULE –IV	SPEC	TAL FUNCTIONS - I						Cla	asses: 08	
		and Gamma functions: Relationship between Bo			•		d Gamma	function;	Standard	
MODULE -VI SPECIAL FUNCTIONS - II Class						asses: 09				
		ation: Bessel function, ction and Orthogonality								
Text Books:										
2014.		anced Engineering Matl Engineering Mathemat			-			Edition,		

Reference Books:

- 1. Churchill, R.V. and Brown, J.W, "Complex Variables and Applications", Tata Mc Graw-Hill, 8th Edition, 2012.
- A. K. Kapoor, "Complex Variables Principles and Problem Sessions", World Scientific Publishers, 1st Edition, 2011.
- 3. Murray Spiegel, John Schiller, "Probability and Statistics", Schaum's Outline Series, 3rd Edition, 2010.

Web References:

- $1.\ http://www.efunda.com/math/math_home/math.cfm$
- 2. http://ocw.mit.edu/resources/#Mathematics
- 3. http://www.sosmath.com/
- 4. http://mathworld.wolfram.com/

- 1. http://keralatechnologicaluniversity.blogspot.in/2015/06/erwin-kreyszig-advanced-engineering-mathematics-ktuebook-download.html
- 2. http://www.faadooengineers.com/threads/13449-Engineering-Maths-II-eBooks.

ELECTRONIC DEVICES AND CIRCUITS

Semester: ECE									
Course Code	Category	Hours / Week			Credits	Maximum Marks			
A E C DOC	CORE	L	Т	Р	С	CIA	SEE	Total	
AECB06		3	1	-	4	30	70	100	
Contact Classes: 45	Tutorial Classes: 15		Practic	cal Class	es: Nil	То	tal Clas	d Classes: 60	
II. Know the applic III. Know the switch	ble the students to: nents such as diodes, BJT cations of components. hing characteristics of co ding of various types of	ompone	ents.	euits.					
MODULE -I DIOD	E AND APPLICATION	NS					C	Classes: 08	
Capacitances, Diode Ap Rectifier, Bridge Rectifi	amic resistances, Equiva pplications: Switch-Swit ier, Rectifiers With Capa eration, types, Clamping	tching t acitive 1	times. I Filter, C	Rectifier Clippers-(- Half Ward - Half - Half Ward - Half - Half Ward - Half - Ha	ave Re	ctifier, I	Full Wave	
MODULE - II BIPO	LAR JUNCTION TRA	NSIST	'OR (B.	JT)			0	Classes: 10	
Configurations, Operation	and characteristics - ng point, DC & AC load ansistor characteristics, C	l lines,	Transis	tor Hybr	id parame				
MODULE - III TRAN	SISTOR BIASING AN	VD ST A	ABILIZ	ATION			0	Classes: 10	
Transistors. Analysis and Design of Amplifiers and CE Amp	Bias, Collector to Base f Small Signal Low Free plifier with emitter resist pacitors on CE Amplifier	q uency ance, lo	BJT A	mplifier	·s : Analysi	s of CE	E, CC, C	В	
MODULE - IV JUNCTION FIELD EFFECT TRANSISTOR							0	Classes: 08	
and FET, Biasing of	of Operation, Pinch-Off FET, FET as Voltag acement and Depletion m	ge Var		.					
MODULE - V FET A	AMPLIFIERS						0	Classes: 09	
	nalysis of CS, CD, CG JF ces: Zener Diode - Cha Γ, Varactor Diode.								
Text Books:									
	and Circuits - Jacob Mil and Circuits theory– Ro					sky, 11	th Editio	on, Pearson	

Reference Books:

- 1. The Art of Electrionics, Horowitz, 3rdEdition Cambridge University Press, 2018
- 2. Electronic Devices and Circuits, David A. Bell 5th Edition, Oxford.
- 3. Pulse, Digital and Switching Waveforms –J. Millman, H. Taub and Mothiki S. Prakash Rao, 2 Ed., McGraw Hill, 2008.
- 4. Electronic Devices and Circuits, S. Salivahanan, N.Suresh Kumar, A Vallvaraj, 2nd Edition, TMH.

Web References:

- 1. http://www-mdp.eng.cam.ac.uk/web/library/enginfo/electrical/hong1.pdf
- 2. https://archive.org/details/ElectronicDevicesCircuits
- 3. http://nptel.ac.in/courses/Webcourse-contents/IIT-ROORKEE/BASIC ELECTRONICS/home_page.htm
- 4. http://www.vidyarthiplus.in/2011/11/electronic-device-and-circuits-edc.html
- 5. http://www.satishkashyap.com/2013/03/video-lectures-on-electron-devices-by.html

- 1. http://services.eng.uts.edu.au/pmcl/ec/Downloads/LectureNotes.pdf
- 2. http://nptel.ac.in/courses/122106025/
- 3. http://www.freebookcentre.net/electronics-ebooks-download/Electronic-Devices-and-Circuits-(PDF-313p).html
- 4. https://www.jntubook.com/electronic-device-circuits-textbook-free-download/
- 5. http://www.faadooengineers.com/threads/32735-Electronic-Devices-And-Circuits-(EDC)-by-J-B-Gupta-full-book-pdf

	DIGITA		SIENII	JESIGN					
III Semester: ECE									
Course Code	Category	egory Hours / Week Credits M					faximum Marks		
AECB07	Core	L	Т	Р	С	CIA	SEE	Total	
		3	1	0	4	30	70	100	
Contact Classes: 45 Tutorial Classes: 15			Practical	tal Class	Classes: 60				
 II. Learn basic techn of digital systems III. Understand the control of the R IV. Understand the R MODULE - I COG DESS Review of Boolean Alg 	non forms of number re iques for the design of oncepts of combinationa ealization of Logic Gat	digita al logi es Usi N AN	l circuits c circuits ng Diode D COMI orem, SC	and funda and sequ s & Trans BINATI(amental c ential circ sistors. DNAL LO	cuits.	CI	asses: 08	
	DEVICES arators, Multiplexers, E s, Serial and Parallel Ad						oisplay, H	asses: 10	
MODULE - III SEQ				,				asses: 10	
Building blocks like S counters, Shift registers Finite state machines, synchronous circuits l generation	Design of synchrono	ous F	SM, Alg	orithmic	State M	lachines	charts.	Designin	
MODULE - IV LOGIC FAMILIES AND SEMICONDUCTOR MEMORIES								Classes: 08	
FTL NAND gate, Spe CMOS families and th FPGA. Logic implement	neir interfacing, Memo	ory ele	ements, C						
MODULE - V VLS	I DESIGN FLOW						C	lasses: 09	
Design entry: Schemat Dataflow, Behavioral a combinational and sequ	nd Structural Modeling								

DIGITAL SYSTEM DESIGN

Text Books:

- 1. R.P. Jain, "Modern digital Electronics", Tata McGraw Hill, 4th Edition, 2009.
- 2. Douglas Perry, "VHDL", Tata McGraw Hill, 4th Edition, 2002.
- 3. W.H. Gothmann, "Digital Electronics- An introduction to theory and practice", PHI, 2nd Edition ,2006

Reference Books:

- 1. D.V. Hall, "Digital Circuits and Systems", Tata McGraw Hill, 1989
- 2. Charles Roth, "Digital System Design using VHDL", Tata McGraw Hill 2nd Edition 2012.

Web References:

- 1. mcsbzu.blogspot.com
- 2. http://books.askvenkat.com
- 3. http://worldclassprogramme.com
- 4. http://www.daenotes.com
- 5. http://nptel.ac.in/courses/117106086/1

- 1. https://books.google.co.in/books/about/Switching_Theory_and_Logic_Design
- 2. https://www.smartzworld.com/notes/switching-theory-and-logic-design-stld
- 3. https://www.researchgate.net/.../295616521_Switching_Theory_and_Logic_Design
- 4. https://books.askvenkat.com/switching-theory-and-logic-design-textbook-by-anand-kumar/
- 5. http://www.springer.com/in/book/9780387285931

PROBABILITY THEORY AND STOCHASTIC PROCESSES

III Semester: ECE	1				Γ			
Course Code	Category	Ho	ours / W	Veek	Credits	Ma	ximum N	Iarks
AECB08	Core	L	Т	Р	C	CIA	SEE	Total
		3	1	0	4	30	70	100
Contact Classes: 45Tutorial Classes: 15Practical Classes: NilTotal Classes: 60								
 II. Study the random varia variables. III. Understand the concept IV. Explore the temporal ar 	experiments, sample sp bles, density and distrib of random process and ad spectral characteristic LITY, RANDOM VAI VARIABLES ble Spaces, Events, Prol nt Events. Random Va F Random Variable, Dis m, Gaussian, Exponer ional Distribution, Con	ution f sample s of ran RIABI bability riables stributi ntial, I ditiona	unction function ndom p LES AN , Axio , Axio , Axio , Con and Rayleig l Dens:	s, mom ons (sig rocesser D OPF ms, Join nition, (Densit h, rand ity and	ents and tra nals). s. ERATIONS nt, Conditions y functions dom varial their Prop	SON onal and for map : Definit bles, Me erties, E ₂	Classe Total Pro ping func ion and F thods of spected V	s: 09 babilities tion of a Properties defining falue of
	ANDOM VARIABLE E RANDOM VARIAB		NSFOR	RMATI	ONS -		Clas	ses: 09
Characteristic Function, Mor Random Variables (Continu Properties, Marginal Distri Functions, Conditional Dist Interval conditioning, Statist Equal and Unequal Distribut	ous and Discrete), Ve bution Functions, Join ribution and Density – ical Independence, Sum	ctor R t Dens Point	andom sity Fu Condit	Variab nction ioning,	les, Joint l and its Pr Conditiona	Distributi operties, al Distrib	on Funct Margin ution and	ion and al Densi Density
OPERATI	ONS ON MULTIPLE	RANI	DOM V	ARIA	BLES –		Clas	ses: 09
Expected value of a function Joint Moments about the or function	n of multiple random va							
Jointly Gaussian random v Transformations of Multiple Variables								
MODULE - IV RANDOM	PROCESSES – TEM	PORA	L CHA	RACT	ERISTICS	5	Cla	sses: 09
Random Process: Definition Independence., First- Order, Time Averages and Ergodic Its Properties, Cross-Correla Processes. Response of Lin Autocorrelation Function of	Second- Order, Wide ity, Mean-Ergodic and tion Function and Its Pro ear Systems to Randon	-Sense Correl operties n Proc	e Station ation-E s, Cova cess inp	narities rgodic riance H put, Me	(N-Order) Processes, Functions, C an and MS	and Stric Autocorr Gaussian S value c	et-Sense S elation Fu and Poisse	stationari inction a on Rando

MODULE - V RANDOM PROCESSES – SPECTRAL CHARACTERISTICS

Classes: 09

Power Density Spectrum: Definition and Properties, Relationship between Power Density Spectrum and Autocorrelation Function, Cross Power Spectral Density: Definition and Properties, Relationship between Cross-Power Spectrum and Cross-Correlation Function, System Evaluation using Random Noise, Spectral Characteristics of System Response: Power Density Spectrum of Response, Cross-Power Density Spectra of Input and Output, Noise Bandwidth, White and Colored Noises

Text Books:

1. Peyton Z. Peebles, "Probability, Random Variables & Random Signal Principles", TMH, 4th Edition, 2001.

Reference Books:

- 1. Bruce Hajck, "Random Processes for Engineers", Cambridge Unipress, 2015.
- 2. Athanasios Papoulis and S. Unnikrishna Pillai, "Probability, Random Variables and Stochastic Processes", PHI, 4th Edition, 2002.
- 3. K. Murugesan, P. Guruswamy, "Probability, Statistics & Random Processes", Anuradha Agencies, 3rd Edition, 2003.
- 4. B.P. Lathi, "Signals, Systems & Communications" B.S. Publications, 2003.

Web References:

- 1. www.britannica.com/topic/probability-theory
- 2. www.math.uiuc.edu/~r-ash/BPT.html
- 3. https://www.ma.utexas.edu/users/gordanz/.../introduction_to_stochastic_processes.pdf
- 4. nptel.ac.in/courses/111102014/
- 5. http://vceece2k10.blogspot.in/p/semester-2-1.html

- 1. http://freecomputerbooks.com/mathProbabilityBooks.html
- 2. http://www.springer.com/in/book/9780387878584
- 3. http://www.e-booksdirectory.com/listing.php?category=15

DATA STRUCTURES

	Category	Но	ours / W	eek	Credits	Maxi	mum M	arks	
		L	Т	Р	С	CIA	SEE	Tota	
ACSB03	Core	3	-	-	3	30	70	100	
Contact Classes: 45	Tutorial Classes: Nil	l	Practica	l Class	es: Nil	Tota	l Classe	s: 45	
II. Demonstrate seaIII. Implement linearIV. Demonstrate non	le the students to: echniques of algorithm ana arching and sorting algorith data structures viz. stack, a-linear data structures viz. e appropriate data structure	ms and queue a tree and	ind linke d graph t	d list. raversa	l algorithms.				
MODULE - I SORT							Classe		
	iction to data structures, cl Linear search and Binary se sorting algorithms.								
MODULE - II LINH	EAR DATA STRUCTUR	ES					Classes: 09		
	tions, implementation of sta					acks arith	metic		
	ieue, circular queue and do							, Array	
applications of linear qu	eue, circular queue and do								
applications of linear que MODULE - III LINK Linked lists: Introducti linked list; Applications	teue, circular queue and do ED LISTS on, singly linked list, repr s of linked lists: Polynomia	uble en esentati al repres	ded quei	ie (deq linked and sp	list in memo parse matrix	n of queu ory, opera manipulat	classe tions on ion.	es: 09 a sing	
applications of linear que MODULE - III LINK Linked lists: Introducti linked list; Applications	eue, circular queue and do ED LISTS on, singly linked list, repr	uble en esentati al repres	ded quei	ie (deq linked and sp	list in memo parse matrix	n of queu ory, opera manipulat	classe tions on ion.	es: 09 a sing	
Applications of linear que MODULE - III LINK Linked lists: Introducti linked list; Applications Types of linked lists: Stack and Queue.	teue, circular queue and do ED LISTS on, singly linked list, repr s of linked lists: Polynomia	uble en esentati al repres	ded queu ion of a sentation ed lists;	ie (deq linked and sp	list in memo parse matrix	n of queu ory, opera manipulat	classe tions on ion.	a sing	
MODULE - IIILINKLinked lists: Introductilinked list; ApplicationsTypes of linked lists:Stack and Queue.MODULE - IVNONTrees: Basic concept, btraversal, binary tree	eue, circular queue and do ED LISTS on, singly linked list, repr s of linked lists: Polynomia Circular linked lists, doub	uble en resentati al repres oly link CTURE represent trees;	ded queu ion of a sentation ed lists; S ation, a	linked and sp Linked	list in memo parse matrix i d list represe nd linked re	ory, opera manipulat entation a	classe tions on ion. nd opera Classe ons, bir	a sing a tions of es: 09 nary tro	
applications of linear queMODULE - IIILINKLinked lists: Introductilinked list; ApplicationsTypes of linked lists:Stack and Queue.MODULE - IVNONCrees: Basic concept, btraversal, binary treeimplementation, graph tree	teue, circular queue and do KED LISTS on, singly linked list, repr s of linked lists: Polynomia Circular linked lists, doub LINEAR DATA STRUC pinary tree, binary tree re variants, application of	uble en esentati al repres bly link TURE epresent trees; caphs.	ded queu ion of a sentation ed lists; S ation, a	linked and sp Linked	list in memo parse matrix i d list represe nd linked re	ory, opera manipulat entation a	classe tions on ion. nd opera Classe ons, bir	a sing a sing ations o es: 09 hary tro 7, grap	

Text Books:

Rance D. Necaise, "Data Structures and Algorithms using Python", Wiley, John Wiley & Sons, INC., 2011.
 Benjamin Baka, David Julian, "Python Data Structures and Algorithms", Packt Publishing Ltd., 2017.

Reference Books:

- 1. S. Lipschutz, "Data Structures", Tata McGraw Hill Education, 1st Edition, 2008.
- 2. D. Samanta, "Classic Data Structures", PHI Learning, 2nd Edition, 2004.

Web References:

- 1. https://www.tutorialspoint.com/data_structures_algorithms/algorithms_basics.htm
- 2. https://www.codechef.com/certification/data-structures-and-algorithms/prepare
- 3. https://www.cs.auckland.ac.nz/software/AlgAnim/dsToC.html
- 4. https://online-learning.harvard.edu/course/data-structures-and-algorithms

ELECTRONIC DEVICES AND CIRCUITS LABORATORY

AEC			bry Hours / Week				Maximum Mark		
AEC	DAA	C	L	Т	Р	С	CIA	SEE	Tota
ALC BU9		Core	-	-	3	1.5	30	70	100
Contact Classes: Nil Tutorial Classes: Nil				Practi	cal Class	ses: 36	Tot	tal Class	es: 36
I. Implen II. Illustra	nent and stu te the conce	le the students to: dy the characteristics of I ept of rectification using h ruct different amplifier cir LIST OF	nalf wa cuits.	ave and f	full wave				
WEEK-1	ELECTRO	DNIC WORKSHOP PR	ACTI	СЕ					
dentification, specifications, testing of R, L, C components (Color Codes), potentiometers, switcher SPDT, DPDT and DIP), coils, gang condensers, relays, bread boards, PCBs, identification, specification and testing of active devices, diodes, BJTs, low power JFETs, MOSFETs, power transistors, LED LCDs, optoelectronic devices, SCR, UJT, DIACs. WEEK-2 ELECTRONIC WORKSHOP PRACTICE									
Study and op a. Multimet b. Function c. Regulate d. Study and	ers (Analog Generator 1 Power Suj								
WEEK-3	PN DIODE	E CHARACTERISTICS	5						
Verification of ardware and		cteristics of PN diode and ulation.	l calcu	late stati	c and dy	namic resis	stance u	ising	
WEEK-4	ZENER D	IODE CHARACTERIS	TICS	AND V	OLTAG	E REGUI	LATOR	2	
Verification of ardware and		cteristics of Zener diode a ulation.	and pe	rform Ze	ener diod	e as a Volt	age reg	ulator us	sing
WEEK-5	HALF WA	VE RECTIFIER							
/erification of	of half wave	rectifier without and with	h filter	rs using l	hardware	and digita	l simula	ation.	
WEEK-6	FULL W	AVE RECTIFIER							
/erification of	of Full Wave	e Rectifier without and wi	ith filt	ers using	g hardwa	re and digi	tal simu	ilation.	
Verification of Full Wave Rectifier without and with filters using hardware and digital simulation. WEEK-7 TRANSISTOR CB CHARACTERISTICS									

WEEK-8	TRANSISTOR CE CHARACTERISTICS
Verification of simulation.	f Input and Output Characteristics of CE configuration using hardware and digital
WEEK-9	FREQUENCY RESPONSE OF CE AMPLIFIER
Determine t	he Gain and Bandwidth of CE amplifier using hardware and digital simulation.
WEEK-10	FREQUENCY RESPONSE OF CC AMPLIFIER
Determine th	e Gain and Bandwidth of CC amplifier using hardware and digital simulation.
WEEK-11	UJT CHARACTERISTICS
Verification	of V-I Characteristics of UJT using hardware and digital simulation.
WEEK-12	SCR CHARACTERISTICS
Verification of	f V-I Characteristics of SCR using hardware and digital simulation.
WEEK-13	FET CHARACTERISTICS
Verification of	f V-I Characteristics of FET using digital simulation.
WEEK-14	FREQUENCY RESPONSE OF CS AMPLIFIER
Determine the	Gain and Bandwidth of CS amplifier using digital simulation.
WEEK-15	FREQUENCY RESPONSE OF CD AMPLIFIER
Determine the	Gain and Bandwidth of CS amplifier using digital simulation.
Reference Bo	oks:
2. J. Millman	n, C.C.Halkias, Millman's, "Integrated Electronics", Tata McGraw Hill, 2 nd Edition, 2001. n, C.C.Halkias and Satyabrata Jit, "Millman's Electronic Devices and Circuits", Tata Hill, 2 nd Edition, 1998.

- Mohammad Rashid, "Electronic Devices and Circuits", Cengage learning, 1st Edition, 2014.
 David A. Bell, "Electronic Devices and Circuits", Oxford University Press, 5th Edition, 2009.

Web References:

- 1. https://archive.org/details/ElectronicDevicesCircuits 2. http://www.tedpavlic.com/teaching/osu/ece327/

S. No	Name of the Equipment	Range
1	Regulated Power Supply	0-30V DC
2	Cathode Ray Oscilloscope	0-20 MHz
3	Digital voltmeter	0-1V, 0-20 V
4	Digital ammeter	0-200 mA, 0-200 µA
5	Resistors	1KΩ, 100KΩ, 470 Ω, 150 Ω,10KΩ, 47K Ω,1MΩ, 2.2k Ω, 220KΩ
6	Capacitors	0.01μF, 0.01μF, 100 μF(Electrolytic), 10μF (Electrolytic)
7	Diodes	1N4007, 4V7, 6V2.
8	Transistors	BC107, 2N2646, C106MG /XL084.
9	Semiconductor Trainer Kit	
10	Connecting Wires and Patch cords	
11	Decade resistance box	10 Ω -100k Ω
12	Decade Capacitance box	10μF-100 μF
13	Function Generator	10Hz-1M Hz
14	Digital Multimeters	0-20V/ 0-200mA/10 Ω -10k Ω
15	Bread Board	

DIGITAL SYSTEM DESIGN LABORATORY

Course Code		Category	Ho	ours / W	'eek	Credits	Maxin	num M	arks
AECB10			L	Т	Р	С	CIA	SEE	Tota
		Core	-	-	2	1	30	70	100
Contact Classes: Nil Tutorial Classes: Nil			Р	ractical	Classe	es: 24	Total Classes: 24		
I. Design II. Implem	of combination of Second	e the students to: onal circuits using Verilo equential circuits using V ferent case studies for Ve LIST OF 1	/erilog H erilog H	Hardwar DL imp	e Desci lementa	ription Lan	e. guage.		
		ION OF A BOOLEAN							
Design and si	mulate the H	DL code to realize three	and thre	e variat	le Boo	lean function	ons		
WEEK-2	DESIGN OF	DECODER AND ENG	CODER						
a. 3 to	8 Decoder	DL code for the followin Vith priority and without	-		l circui	ts			
WEEK-3	DESIGN OF	MULTIPLEXER ANI	D DEM	ULTIPI	LEXER	R			
a. Mul	simulate the tiplexer multiplexer	HDL code for the follow	ring com	binatio	nal circ	uits			
WEEK -4	DESIGN OF	CODE CONVERTER	S						
Design and si	mulate the H	DL code for the followin	ig combi	inationa	l circui	ts			
a. 4 - 1	Bit binary to g	gray code converter	C						
	Bit gray to bir	nary code converter							
WEEK -5	FULL ADDI	ER AND FULL SUBTR	ACTO	R DESI	GN M	ODELING	7		
Write a HDL modeling styl		ribe the functions of a ful	ll Adder	and full	l subtra	ctor using	three		
WEEK -6	DESIGN OF	8-BIT ALU							
Design a mod	lel to implem	ent 8-bit ALU functional	lity						
	HDL MODE	L FOR FLIP FLOPS							
WEEK -7		L FOR FEIT FLOID							

WEEK -8 DESIGN OF COUNTERS

Write a HDL code for the following counters

- a. Binary counter
- b. BCD counter (Synchronous reset and asynchronous reset)

WEEK-9 HDL CODE FOR UNIVERSAL SHIFT REGISTER

Design and simulate the HDL code for universal shift register

WEEK-10 HDL CODE FOR CARRY LOOK AHEAD ADDER

Design and simulate the HDL code for carry look ahead adder

WEEK-II HDL CODE TO DETECT A SEQUENCE

Write a HDL code to detect the sequence 1010101 and simulate the code

WEEK-12 CHESS CLOCK CONTROLLER FSM USING HDL

Design a chess clock controller FSM using HDL and simulate the code

WEEK-13 TRAFFIC LIGHT CONTROLLER USING HDL

Design a traffic light controller using HDL and simulate the code

WEEK-14 ELEVATOR DESIGN USING HDL CODE

Write HDL code to simulate Elevator operations and simulate the code

Reference Books:

- 1. Samir Palnitkar, "Verilog HDL: "A Guide to Digital Design and Synthesis", Sun Microsystems Press, 2nd Edition, 2003.
- 2. T.R. Padmanabhan, B. Bala Tripura Sundari, "Design Through Verilog HDL", New Jersey, Wiley-IEEE Press, 2009. ISBN: 978-0-471-44148-9
- 3. Zainalabedin Navabi, "Verilog Digital System Design", TMH, 2nd Edition, 2008.
- 4. Peter Minns, Ian Elliott, "FSM-based Digital Design using Verilog HDL", John Wiley & Sons Ltd, 2008.

Web References:

- 1. https://inst.eecs.berkeley.edu/~cs150/fa06/Labs/verilog-ieee.pdf
- 2. http://www.asic-world.com/ www.sxecw.edu.in

SOFTWARE AND HARDWARE REQUIREMENTS FOR A BATCH OF 36 STUDENTS:

HARDWARE: Desktop Computer Systems 36 nos

SOFTWARE: Xilinx

DATA STRUCTURES LABORATORY

Cour	se Code	Category	Но	urs / V	Week	Credits	Ma	aximum N	/Iarks
٨٢	CSB05	Core	L	Т	Р	С	CIA	SEE	Total
ACODOS		Core	-	-	3	1.5	30	70	100
	Classes: Nil	Tutorial Classes: Nil		Prace	tical Cl	asses: 36		Total Cla	isses: 36
The course I. Unde II. Impl III. Anal IV. Deve	erstand various ement linear an yze various alg elop real-time a	the students to: s data representation techn nd non-linear data structu gorithms based on their ti applications using suitable ta structure to solve vario LIST OF	res. me an e data ous con	d spac structi mputir	e comp ure. ng probl	lexity.			
WEEK-1	BASICS OF	PYTHON							
a. To find tb. To printc. To find (the biggest of g the Fibonacci GCD of two nu		ntrol s	tateme	ents and	l lists			
WEEK-2		IG TECHNIQUES							
Write Pytho ascending o a. Linear so b. Binary s	rder. earch	r implementing the follov	ving s	earchi	ng tech	niques to ar	range a l	ist of inte	gers in
WEEK-3	SORTING 7	FECHNIQUES							
Write Pytho ascending o a. Bubble s b. Insertion c. Selection	order. Fort Fort	r implementing the follow	ving s	orting	techniq	ues to arran	ge a list	of integer	s in
WEEK-4	IMPLEMEN	NTATION OF STACK	AND	QUE	JE				
a. Design a	and implement	for the following: Stack and its operations u Queue and its operations	•						
WEEK-5	APPLICAT	IONS OF STACK							
Write Pythe		r the following:	n into	nostfi	v ovpro	ssion			
a. Uses Sta		to convert infix expression for evaluating the postfix			x expre	\$\$1011.			

	programs for the following operations on Single Linked List. (ii) insertion (iii) deletion (iv) traversal
WEEK-7	IMPLEMENTATION OF CIRCULAR SINGLE LINKED LIST
	n programs for the following operations on Circular Linked List. (ii) insertion (iii) deletion (iv) traversal
WEEK-8	IMPLEMENTATION OF DOUBLE LINKED LIST
	n programs for the following operations on Double Linked List. (ii) insertion (iii) deletion (iv) traversal in both ways.
WEEK-9	IMPLEMENTATION OF STACK USING LINKED LIST
Write a Pyth	on program to implement Stack using linked list.
WEEK-10	IMPLEMENTATION OF QUEUE USING LINKED LIST
Write a Pyth	on program to implement Linear Queue using linked list.
WEEK-11	GRAPH TRAVERSAL TECHNIQUES
Write Pytho a. Depth fir b. Breadth f	
WEEK-12	IMPLEMENTATION OF BINARY SEARCH TREE
a. Create ab. Traverse	on program to perform the following: binary search tree. the above binary search tree recursively in pre-order, post-order and in-order. e number of nodes in the binary search tree.
LIST OF R	EFERENCE BOOKS:
	. Necaise, "Data Structures and Algorithms using Python", Wiley, John Wiley & Sons, INC., 2011. n Baka, David Julian, "Python Data Structures and Algorithms", Packt Publishing Ltd., 2017.
WEB REFI	CRENCES:
 http://inte http://ww http://ww http://ww 	cs.python.org/3/tutorial/datastructures.html rractivepython.org/runestone/static/pythonds/index.html w.tutorialspoint.com/data_structures_algorithms w.geeksforgeeks.org/data-structures/ w.studytonight.com/data-structures/ w.coursera.org/specializations/data-structures-algorithms

6. http://www.coursera.org/specializations/data-structures-algorithms

ANALOG AND PULSE CIRCUITS

I. Learn the concepts of high frequency anaII. Understanding of various types of ampliand tuned amplifiers.		T 1 ractica	P -	С 4	CIA	SEE	Total	
Contact Classes: 45 Tutorial Classes: 15 DJECTIVES: he course should enable the students to: I. Learn the concepts of high frequency ana II. Understanding of various types of ampliand tuned amplifiers.	Р		-	4	•			
 BJECTIVES: he course should enable the students to: I. Learn the concepts of high frequency and II. Understanding of various types of ampliand tuned amplifiers. 		ractica			30	70	100	
 he course should enable the students to: I. Learn the concepts of high frequency ana II. Understanding of various types of ampliand tuned amplifiers. 			l Class	es: Nil	Tota	al Classe	es: 60	
The course should enable the students to:I. Learn the concepts of high frequency analysis of transistors.II. Understanding of various types of amplifier circuits such as small signal, cascaded, large si								
MODULE-I MULTISTAGE AMPLIFIERS						Classe	es: 08	
Classification of Amplifiers, Distortion in amplifiers, Different coupling schemes used in amplifiers, Frequency response and Analysis of multistage amplifiers, Cascade amplifier, Darlington pair. Transistor at High Frequency: Hybrid - model of Common Emitter transistor model, f_{α} , β and unity gain bandwidth, Gain band width product.								
MODULE-II FEEDBACK AMPLIFIERS						Classes: 10		
Concepts of feedback – Classification of feed eedback amplifiers – Effect of Feedback on A Current series and Current shunt Feedback config	mplifie	r chara						
MODULE-III OSCILLATORS AND LARGE	E SIGNAL AMPLIFIERS Classes: 08							
Condition for Oscillations, RC type Oscillators Oscillators –Generalized analysis of LC Oscill amplitude stability of Oscillators, Crystal Oscilla Class A Power Amplifier- Series fed and Tran Amplifier- Push Pull and Complimentary Symmo- peration of Class AB and Class C Amplifiers.	lators, ditor. sformer netry co	Hartley couple	and C ed, Cor ations,	Colpitts Osc eversion Eff Conversion	illators, ficiency, Efficienc	Frequen Class B cy, Princ	cy and Power ciple of	
requency response of tuned amplifiers, Concept						iers – Q	-140101	
MODULE-IV LINEAR WAVE SHAPING AN	ND SAMPLING GATES					Classe	es: 10	
inear wave shaping circuits: High pass RC and with different time constants, high pass RC circu ampling gates: basic operating principle of samp	it as a d	ifferent	iator, le	ow pass RC	circuit as	s an integ		
MODULE-V MULTIVIBRATORS						Classe	es: 09	

Text Books:

- Jacob Millman, Christos C Halkias, "Integrated Electronics" McGraw Hill Education, 2nd Edition, 2010.
- 2. Thomas L. Floyd, "Electronic Devices Conventional and Current Version", Pearson Education, 2015.

Reference Books:

- 1. David A. Bell, "Electronic Devices and Circuits", Oxford, 5th Edition, 1986.
- 2. Robert L. Boylestead, Louis Nashelsky, "Electronic Devices and Circuits Theory", Pearson Education, 11th Edition, 2009.

Web References:

- 1. www.nptel.ac.in
- 2. notes.specworld.in/pdc-pulse-and-digital-circuits
- 3. http:// www.introni.it/pdf/Millman-Taub- Pulse and Digital Switching Waveforms 1965.pdf
- 4. https://www.jntubook.com/pulse-digital-circuits-textbook-free-download/

- 1. https://www.jntubook.com/electronic-circuit-analysis-textbook
- 2. http://tradownload.com/results/neamen-electronic-circuit-analysis-and-design-.htm
- 3. http://www.igniteengineers.com
- 4. http://www.ocw.nthu.edu.tw

ANALOG COMMUNICATIONS

	Category	H	Iours /	Week	Credits	Maxi	mum Marl	KS
	Corro	L	Т	Р	С	CIA	SEE	Total
AECB12 Core			1	-	4	30	70	100
Contact Classes: 45 OBJECTIVES:	Tutorial Classes: 15		Practi	ical Cla	sses: Nil	Total C	Classes: 60	
II. Understand the coIII. Underastand the cIV. Describe the beha pulse modulation	nunication system and neo ncepts of Amplitude Mod oncepts of Angular Modu vior of analog communica	ulation lation ations	on and i , FM a in the j	its types nd types presence	s of FM e of noise an			alog
	TUDE MODULATION						Cl	asses-09
SSB Modulation: Freq Modulated Wave, Tim waves. Demodulation of Modulated wave, Time	ODULATION uency domain description e domain description, Ph of SSB Waves, Vestigial s domain description, Enve ns of different AM System	ase d ide ba elop d	iscrimi and mo	nation r dulation	nethod for g	generating descriptio	eneration of AM SSB n, Generati	asses-09 AM SS Modulate on of VS
Modulated Wave, Tim waves. Demodulation of Modulated wave, Time Techniques, Applicatio	uency domain description e domain description, Ph of SSB Waves, Vestigial s domain description, Enve ns of different AM System	ase d ide ba elop d	iscrimi and mo	nation r dulation	nethod for g	generating descriptio	eneration of AM SSB n, Generati r, Comparis	AM SSI Modulate on of VSI
SSB Modulation: Freq Modulated Wave, Tim waves. Demodulation of Modulated wave, Time Techniques, Applicatio MODULE-III ANGL Basic concepts, Freque Wave, Narrow band FM Transmission bandwidt	uency domain description e domain description, Ph of SSB Waves, Vestigial s domain description, Enve ns of different AM System E MODULATION ncy Modulation: Single to A, Wide band FM, Consta h of FM Wave - Generation	ase d ide ba elop d ns. one fr nt Av on of	iscrimi and mo letectio equence erage F FM W	nation r dulation n of a V ey modu Power, aves, Di	nethod for g Frequency SB Wave p lation, Spec	generating descriptio ulse Carrie trum Analy	eneration of AM SSB n, Generation r, Comparis version of Sinu FM Waves	asses-09 AM SS Modulate on of VS son of AM asses-09 soidal FM
SSB Modulation: Freq Modulated Wave, Tim waves. Demodulation of Modulated wave, Time Techniques, Applicatio MODULE-III ANGL Basic concepts, Freque Wave, Narrow band FM Transmission bandwidt Frequency discriminato	uency domain description e domain description, Ph of SSB Waves, Vestigial s domain description, Enve ns of different AM System E MODULATION ncy Modulation: Single to A, Wide band FM, Consta	ase d ide ba elop d ns. one fr nt Av on of Phase	iscrimi and mo letectio equence erage F FM W e locke	nation r dulation n of a V ey modu Power, aves, Di d loop, C	nethod for g Frequency SB Wave p lation, Spec irect FM, De Comparison	generating descriptio ulse Carrie trum Analy	eneration of AM SSB n, Generation r, Comparis Cl ysis of Sinu FM Waves AM.	asses-09 AM SS Modulate on of VS son of AM asses-09 soidal FM

MODULE-V	RECEIVERS

Receiver Types -Tuned radio frequency receiver, Superhetrodyne receiver, RF section and Characteristics -Frequency changing and tracking, Intermediate frequency, AGC, FM Receiver, Comparison with AM Receiver, Amplitude limiting. Pulse Modulation: Types of Pulse modulation, PAM (Single polarity, double polarity) PWM: Generation and demodulation of PWM, PPM, Generation and demodulation of PPM, Time Division Multiplexing.

Text Books:

- 1. S. S. Haykin, "Communication Systems", Wiley Eastern, 2nd Edition, 2006.
- 2. Taub, Schilling, "Principles of Communication Systems", Tata McGraw-Hill, 4th Edition, 2013

Reference Books:

- 1. B.P. Lathi, "Communication Systems", BS Publication", 2nd Edition, 2006.
- 2. John G. Proakis, Masond, Salehi, "Fundamentals of Communication Systems", PEA, 1st Edition, 2006
- 3. George Kennedy, Bernard Davis, "Electronics and Communication System", Tata McGraw Hill, 5th Edition, 2011.

Web References:

- 1. http://www.web.eecs.utk.edu
- 2. https://everythingvtu.wordpress.com
- 3. http://nptel.ac.in/
- 4. http://www.iare.ac.in

- 1. http://www.bookboon.com/
- 2. http://www.jntubook.com
- 3. http://www.smartzworld.com
- 4. http://www.archive.org

ELECTROMAGNETIC WAVES AND TRANSMISSION LINES

Course Code		Category	H	lours /	Week	Credits	Maxi	imum M	Iarks
AECD12		Carro	L	Т	Р	С	CIA	SEE	Tota
AECB13		Core	3	-	-	3	30	70	100
Contact Classe	es: 45	Tutorial Classes: Nil		Prac	tical Cla	asses: Nil	Tot	al Class	ses: 45
I. Familiariz II. Have skill application III. Investigate	ald ena te abou ls in s n and a the pr ate the	ble the students to: t 3D vector co-ordinate sy electing appropriate Max nalyze the problem. ropagation characteristics ability to compute variou	well's of elec	equati tromag	ons in o	electromagne	etic theor lary of di	fferent	media.
MODULE -I		CTROSTATICS						Classe	es: 10
bsorbed in cond apacitors; Mether MODULE -II Magnetostatics:	ductor, od of in MAC	neous dielectrics; Contin Poisson's and Laplace's mages; Illustrative problem INETOSTATICS	equations.	ons; Cε	pacitanc				herica
Magnetic scalar conditions: Diel	and v ectric-	ector potentials; Forces dielectric, dielectric co	due to nducto	magn r inter	etic field faces; I	ls; Ampere'	s force l and mag	aw; Bo gnetic e	undary energy
Magnetic scalar conditions: Diel llustrative probl ampere's law for	and v ectric- lems; time v	ector potentials; Forces	due to nducto T ime v on for	magno r inter a rying	etic field faces; I fields)	ls; Ampere' inductances : Faraday's	s force l and mag law; Inc	aw; Bo gnetic e consiste	undary energy ncy o
Magnetic scalar conditions: Diel llustrative probl umpere's law for n differential for	and v ectric- lems; time v rm, inte	ector potentials; Forces dielectric, dielectric co Maxwell's equations (1 varying fields and definiti	due to inducto Time v on for ments.	magno r inter a rying	etic field faces; I fields)	ls; Ampere' inductances : Faraday's	s force l and mag law; Inc	aw; Bo gnetic e consiste	undary energy ncy of uations
Magnetic scalar conditions: Diel Illustrative probl ampere's law for n differential for MODULE -III Uniform plane and H; Wave pro Polarization, Illus Reflection/refra	and v ectric- lems; time v time v time v time v unii waves: opagati strative ction	ector potentials; Forces dielectric, dielectric co Maxwell's equations (T varying fields and definiti egral form and word State FORM PLANE WAVES wave equations for con on in lossless and conduct	due to nducto Time v on for ments. ducting ting me	magner r inter arying displace g and p edia, Le	etic field faces; I g fields) eement c perfect d oss tange action a	ds; Ampere' inductances : Faraday's urrent densit ielectric mec ent, Intrinsic t normal in	s force l and mag law; Ind y; Maxw lia; Relat impedanc cidence,	aw; Bo gnetic of consiste ell's equ Classo ion bety ce; Skin	undary energy ncy o uations es: 08 ween I u depth
Magnetic scalar conditions: Diel llustrative problempere's law for n differential for MODULE -III Uniform plane y and H; Wave proposation, Illus Reflection/refra- refraction at oblight	and v ectric- lems; time v m, inte unii waves: opagati strative ction ique ir ce; Po	ector potentials; Forces dielectric, dielectric co Maxwell's equations (1 varying fields and definiti egral form and word State FORM PLANE WAVES wave equations for con on in lossless and conduct problems. of plane waves: Reflect	due to nducto ime v on for ments. ducting ting me tion ar ; Brew	magn r inter arying displac	etic field faces; I g fields) eement c perfect d oss tange action a ngle, crit	ds; Ampere' inductances : Faraday's urrent densit ielectric med ent, Intrinsic t normal in tical angle, t	s force l and mag law; Ind y; Maxw lia; Relat impedan- cidence, total inter	aw; Bo gnetic of consiste ell's eq Classo ion bety ce; Skin reflection	undary energy ncy of uations es: 08 ween H depth on and lection
Magnetic scalar conditions: Diel llustrative problumpere's law for n differential for MODULE -III Uniform plane v and H; Wave pro Polarization, Illus Reflection/refra- gefraction at obli- surface impedance	and v ectric- lems; time v m, into UNII waves: pagati strative ction ique ir ce; Po ems.	ector potentials; Forces dielectric, dielectric co Maxwell's equations (T varying fields and definiti egral form and word State FORM PLANE WAVES Wave equations for con on in lossless and conduct e problems. of plane waves: Reflect ncidence; Standing waves	due to nducto ime v on for ments. ducting ducting tion ar ; Brew ng theo	magner r inter arying displace g and p edia, Le ad refr yster an orem-a	etic field faces; 1 g fields) eement c berfect d oss tange action a ngle, crit pplicatio	ds; Ampere' inductances : Faraday's urrent densit ielectric med ent, Intrinsic t normal in tical angle, t	s force l and mag law; Ind y; Maxw lia; Relat impedan- cidence, total inter	aw; Bo gnetic of consiste ell's eq Classo ion bety ce; Skin reflection	undary energy ncy o uations es: 08 ween I a depth on and lection iductor

MODULE -V UHF TRANSMISSION LINES AND APPLICATIONS

UHF transmission lines and applications: Input impedance relations; SC and OC lines; Reflection coefficient, VSWR; UHF lines as circuit elements, $\lambda/4$, $\lambda/2$ and $\lambda/8$ lines, impedance transformations, significance of Z_{min} and Z_{max} ; Smith chart: Configuration and applications; Single and double stub matching; Illustrative problems.

Text Books:

- 1. Matthew N.O. Sadiku, "Elements of Electromagnetic", Oxford University Press, 4th Edition, 2009.
- E.C. Jordan, K.G. Balmain, "Electromagnetic waves and Radiating Systems", PHI learning, 2nd Edition, 2000.
- 3. Umesh Sinha, Satya Prakashan, "Transmission lines and Networks", Tech India Publications, 1st Edition, 2010.

Reference Books:

- 1. Nathan Ida, "Engineering Electromagnetic", Springer (India) Pvt. Ltd, 2nd Edition, 2005
- 2. William H. Hayt Jr., John A. Buck, "Engineering electromagnetic", Tata McGraw Hill, 7th Edition, 2006.
- 3. G. Sashibushana Rao, "Electromagnetic Field theory and Transmission Lines, Wiley India, 2013.
- 4. John D. Ryder, "Networks, Lines and Fields", PHI learning, 2nd Edition, 1999.

Web References:

- 1. http:// web.stanford.edu/class
- 2. http://www.electronicagroup.com
- 3. http://www.cpri.in/about-us/departmentsunits/library-and-information-centre/digital-library-links.html
- 4. http://nptel.ac.in/courses/antennas
- 5. http://www.tutorialspoint.com/discrete_mathematics

- 1. http://www.bookboon.com/en/concepts-in-electrostatics-ebook
- 2. http://www.www.jntubook.com
- 3. http://www.allaboutcircuits.com
- 4. http://www.archive.org

IV Semester: ECE								
Course Code	Category	Ho	ours / W	/eek	Credits	Ma	ximum I	Marks
	Corre	L	Т	Р	С	CIA	SEE	Total
AECB14	Core	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil]	Practic	al Class	ses: Nil	To	tal Class	es: 45
 I. Classify signa II. Study the con- correlation pro III. Understand La 	able the students to: Is and systems and their a cepts of distortion less transperties. aplace and Z-transforms the eed for sampling of CT sig	nsmissi heir pro	ion thro operties	ugh LT	I systems, o lysis of sig	convolut nals and	systems.	
MODULE - I SIG	NAL ANALYSIS						C	lasses: 08
functions, Mean Squa functions, Classificat	ectors and Signals, Orthog are Error, Closed or comp ion of Signals and system unction, Signum function.	lete set	of Orth	nogonal	functions,	Orthogo	onality in	Complex
MODULE - II FOU	IRIER SERIES						С	lasses: 10
of standard signals,	s: nsform from Fourier serie Fourier Transform of Pe g Impulse function and Sig	eriodic	Signals	s, Prope	erties of F	ourier T	ransform	n, Fourier
MODULE - III SIG	NAL TRANSMISSION	THRO	UGH I	LINEAI	R SYSTEN	AS	С	lasses: 10
Linear Time Variant System, Distortion le HPF, and BPF charac Causality and Paley- time, Convolution and	ulse response, Response (LTV) System, Transfer ess transmission through a cteristics. Wiener criterion for phys and Correlation of Signals, presentation of Convolution	function system sical reading , Conce	on of a n, Signa alization	LTI Synal bandw	ystem, Filt vidth, Syst ionship be	er chara em Banc tween B	cteristic lwidth, I andwidtl	of Linear deal LPF,
	PLACE TRANSFORM A		-TRAN	SFOR	Μ		С	lasses: 08
Laplace Transforms, certain signals using Sequence, Distinction Transform, Constrain transforms.	(L.T), Inverse Laplace T Properties of L.T, Relation g waveform synthesis. Z on between Laplace, Founts on ROC for various	on betv Z–Trar urier an	veen L.' nsforms nd Z 7	T and F S Conce Fransfor	T of a sig ept of Z- rms, Regio	nal, Lap Transfo n of C	lace Tra rm of a onvergen , Propert	nsform of Discretence in Z- ties of Z-
MODULE - V SAN	MPLING THEOREM						C	Basse8:a0

SIGNALS AND SYSTEMS

C&5se8:a09 e

Graphical and analytical proof for Band Limited Signals, Impulse Sampling, Natural and Flat top Sampling, Reconstruction of signal from its samples, Effect of under sampling – Aliasing, Introduction to Band Pass Sampling. **Correlation:** Cross Correlation and Auto Correlation of Functions, Properties of Correlation Functions, Energy Density Spectrum, Parsevals Theorem, Power Density Spectrum, Relation between Autocorrelation Function and Energy/Power Spectral Density Function, Relation between Convolution and Correlation, Detection of Periodic Signals in the presence of Noise by Correlation, Extraction of Signal from Noise by Filtering.

Fext Books:

- 1. B.P. Lathi, "Signals, Systems & Communications", BSP, 2013.
- 2. Signals and Systems A.V. Oppenheim, A.S. Willsky and S.H. Nawabi, 2 Edition 2010.

Reference Books:

- 1. Simon Haykin and Van Veen, "Signals and Systems", Wiley Publications, 2nd Edition, 2010.
- 2. Fundamentals of Signals and Systems Michel J. Robert, 2008, MGH International Edition.

Web References:

- 1. https://www.edx.org/course/discrete-time-signal-processing-mitx-6-341x-1
- 2. https://www.mooc-list.com/course/digital-signal-processing-coursera

- 1. http://onlinevideolecture.com/ebooks
- 2. http://www.freebookcentre.net/SpecialCat/Free-Signal-Processing-Boo

CONTROL SYSTEMS

Course Cod	le	Category	He	ours / W	'eek	Credits	Max	kimum I	Marks
		Garra	L	Т	Р	С	CIA	SEE	Total
AEEB16		Core	3 1 - 4 3		30	70	100		
Contact Classe	es: 45	Tutorial Classes: 15	Practical Classes: Nil Total					tal Clas	ses: 60
I. Organize modII. Analyse contrIII. Demonstrate	deling ar rol syste the analy	e the students to: ad analysis of electrical and ms by block diagrams and ytical and graphical techn by domain and state space	d signa iques	al flow g to study	raph te	chnique.			
MODULE-I	INTRO	DUCTION AND MOD	ELIN	G OF P	HYSI	CAL SYSTI	EMS	Cla	sses: 08
modeling and di	fferentia	ction, open loop and cle l equations of physical tems, electrical systems,	syster force,	ns, conc voltage a	cept of and for	transfer fui ce, current a	nction, t		
MODULE-II	BLOC	K DIAGRAM REDUCT (SIS	TION .	AND TI	ME R	ESPONSE		Cla	sses: 10
Standard test sign response of first	nals, shi and se ic error	revomotor, signal flow fted unit step, shifting th cond order systems, tim coefficients method, effect PID controllers.	neorem ne resp	n, convo ponse sp	lution becifica	integral, imp tions, stead	oulse res y state	ponse, errors a	unit step nd error
MODULE-III	CONC	EPT OF STABILITY A	ND R	OOT L	OCUS	TECHNIQ	UE	Cla	isses: 09
criterions and lim Root locus techni	itations. ique: Int	essary and sufficient con roduction, root locus con ratio, relative stability, e	icept, d	construc	tion of	root loci, gr	aphical	determi	·
MODULE-IV	, v	UENCY DOMAIN ANA				<u></u>			sses: 10
plot, Nyquist pl	ot, calci	sis: Introduction, freque ulation of gain margin and frequency responses.	and p						
MODULE-V	STATI	E SPACE ANALYSIS A	ND C	OMPE	NSAT	ORS		Cla	asses: 08
block diagrams,	diagona	oncept of state, state var lization, solving the tin atrollability and observable	ne inv	ariant st	tate eq	uations, stat	e transi	tion ma	trix and

Text Books:

- 1. I J Nagrath, M Gopal, "Control Systems Engineering", New Age International Publications, 3rd Edition, 2007.
- 2. K Ogata, "Modern Control Engineering", Prentice Hall, 4th Edition, 2003.
- 3. N C Jagan, "Control Systems", BS Publications, 1st Edition, 2007.

Reference Books:

- 1. Anand Kumar, "Control Systems", PHI Learning, 1st Edition, 2007.
- 2. S Palani, "Control Systems Engineering", Tata McGraw-Hill Publications, 1st Edition, 2001.
- 3. N K Sinha, "Control Systems", New Age International Publishers, 1st Edition, 2002.

Web References:

- 1. https://www.researchgate.net
- 2. https://www.aar.faculty.asu.edu/classes
- 3. https://www.facstaff.bucknell.edu/
- 4. https://www.electrical4u.com
- 5. https://www.iare.ac.in

- 1. https://www.jntubook.com/
- 2. https://www.freeengineeringbooks.com

ANALOG AND PULSE CIRCUITS LABORATORY

Course	Code	Category	Hours	/Weel	k	Credits	Max	ximum N	Aarks	
AEC	R15	Core	L	Т	Р	С	CIA	SEE	Tota	
ALCI	515	Core	-	-	3	1.5	30	70	100	
Contact Class	es: Nil	Tutorial Classes: Nil	Pra	ctical	Classe	es: 36	Total Classes: 36			
I. Simula II. Demor III. Impler	should enable t the and analyze s instrate the princ inentation of circ	he students to: single stage and multistag iples of feedback amplifi cuits for linear and non-li istics of different multivil	ers and near wa	oscilla	tors th		lation.			
		LIST OF EX	XPERIN	AENT	S					
WEEK-1	BASIC AMPI	LIFIERS/ LINEAR WA	VESHA	PING						
		e of common emitter amp gh pass circuit for differen				ase amplifi	er.			
WEEK -2	BASIC AMPI	LIFIERS/ LINEAR WA	VESHA	PING	•					
		th pass circuit for difference of common emitter amp				ase amplifi	ier.			
WEEK -3	TWO STAGE	RC COUPLED AMPL	.IFIER/	NON	-LINE	CAR WAV	ESHAP	ING		
		e of two stage RC couple ics of clippers and clamp		fier.						
WEEK - 4	TWO STAGE	RC COUPLED AMPL	.IFIER/	NON	-LINE	CAR WAV	ESHAP	ING		
		cs of clippers and clampe e of two stage RC couple		fier.						
WEEK -5	SINGLE TUN	ED AMPLIFIERS/ TR	ANSIS'	FOR A	AS A S	WITCH				
	ingle tuned amp ansistor as a swi									
WEEK-6	SINGLE TUN	ED AMPLIFIERS/ TR	ANSIS	FOR A	AS A S	WITCH				
•	ansistor as a swi									
WEEK -7		AMPLIFIERS/ COMP	ARATO	R						
a. Simulate vol		back amplifier and curre			ack am	plifier.				
0	*									

a. Design of cor	
b. Simulate volt	age series feedback amplifier and current shunt feedback amplifier
WEEK-9	RC PHASE SHIFT OSCILLATOR USING TRANSISTOR/ MULTIVIBRATORS
a. Simulate sine	wave generated for a particular frequency by an RC phase shift oscillator.
b. Design differ	ent types of multivibrators and plot its waveforms.
WEEK-10	RC PHASE SHIFT OSCILLATOR USING TRANSISTOR/ MULTIVIBRATORS
a. Design differ	ent types of multivibrators and plot its waveforms.
b. Simulate sine	wave generated for a particular frequency by an RC phase shift oscillator.
WEEK-11	OSCILLATORS/ SCHMIT TRIGGER
a. Simulate sine	wave generated for a particular frequency by Colpitts and Hartley oscillator.
b. Design a Sch	mitt trigger circuit.
WEEK-12	OSCILLATORS/ SCHMIT TRIGGER
a. Design a Sch	mitt trigger circuit.
b. Simulate sine	wave generated for a particular frequency by Colpitts and Hartley oscillator.
WEEK-13	POWER AMPLIFIERS/ UJT AS A RELAXATION OSCILLATOR
a. Simulate clas	s A power amplifier (transformer less) and class B power amplifier.
b. Design of UJ'	T as a relaxation oscillator.
WEEK-L4	POWER AMPLIFIERS/ UJT AS A RELAXATION OSCILLATOR
a. Design of UJ	T as a relaxation oscillator.
b. Simulate clas	s A power amplifier (transformer less) and class B power amplifier.
Reference Bool	ks:
	man, Herbert Taub, Mothiki S. PrakashRao, "Pulse Digital and Switching Waveforms", Tata
	Hill, 3rd Edition, 2008.
	Bell, "Solid State Pulse Circuits", PHI, 4th Edition, 2002.
	, C. C. Halkias, "Integrated Electronics", Tata McGraw-Hill. 1st Edition, 2008.
-	n, Rekha Singh, "Electronic Devices and Circuits", Pearson, 1st Edition, 2006.
5. Benzad Ra	zavi, "Design of Analog CMOS Integrated Circuits", Tata McGraw-Hill, 1st Edition, 2002.
Web Reference	25:
1. http://www	v.tedpavlic.com/teaching/osu/ece327/
2. http://www	v.ee.iitkgp.ac.in
3. http://www	v.citchennai.edu.in
SOFT	WARE AND HARDWARE REQUIREMENTS FOR A BATCH OF 36 STUDENTS
HARDWARE:	Desktop Computer Systems 18 nos
SOFTWARE :	NI Multisim

S No	Name of the Equipment	Range
1	Dual Dc Regulated Power Supply	0-30V DC
2	Cathode Ray Oscilloscope	0-20 MHz
3	Function Generator	0-10 MHz
4	Semiconductor Kits	0-15 V
5	Resistors	100Ω,150 Ω,820 Ω,1k Ω,1.5k Ω, 2.2kΩ, 10kΩ, 22k Ω, 47k Ω
6	Capacitors	0.1μF, 0.001μF, 0.022μF, 0.0022μF 0.0033μF,100pF, 1000μF, 22μF
7	Diode	1N4007,4148
8	UJT	2N2646
9	Transistors	BC107,2N2222
10	Inductors	1mH,5mH
11	Probes / Connecting wires	

LIST OF EQUIPMENT REQUIRED FOR A BATCH OF 36 STUDENTS

ANALOG COMMUNICATIONS LABORATORY

Cour	se Code	Category	Hou	rs / W	eek	Credits	Maxi	mum M	larks
٨E	CB16	Core	L	Т	Р	С	CIA	SEE	Total
AL	CBIO	Core	-	-	3	1.5	30	70	100
Contact OBJECTI	Classes: Nil	Tutorial Classes: Nil	Pr	actica	l Clas	ses: 36	Tota	l Classe	s:36
I. Study II. Visua III. Obser	various modul lize various spo ve receiver cha	ortance of AGC and VCO	alyzer.						
		LIST OF EX	XPERI	MENT	15				
Week-l	LTI SYSTE	CM AND ITS RESPONSE	2						
	•	v, time invariance, stability	· ·		•	•			
		e, step, sinusoidal response	-				t system	using N	IATLA
Week-2		DE MODULATION AND							
Generation	of amplitude r	nodulation and demodulati	on usin	g hard	ware a	and MATLA	AB		
Week-3	DSB-SC MO	ODULATOR & DE	TECT	OR					
Generation	of AM-Double	e Side Band Suppressed Ca	arrier (I	OSB-S	C) sigi	nal using Ba	alanced	Modulat	or.
Week-4	SSB-SC MC	DULATOR & DE	тест	OR (P	HASE	SHIFT M	ETHOI))	
Generation MATLAB	of single side	band suppressed carrier mo	odulatio	on and	demod	lulation usii	ng hardv	vare and	
Week-5	FREQUEN	CY MODULATION ANI) DEM	ODUI	LATIO	ON			
Generation	of frequency r	nodulation and demodulati	on usin	g hard	ware a	and MATLA	AB		
Week-6	PRE-EMPH	IASIS & DE-EMPI	HASIS						
Verificatio MATLAB	n of pre-empha	sis and de-emphasis to boo	ost high	freque	ency m	nodulating s	ignal us	ing hard	ware an
Week-7	FREQUEN	CY DIVISION MULTIPI	LEXIN	G &A	MP; I	DE MULTI	PLEXI	NG	
Generation	of the frequer	ncy division multiplexing a	nd dem	ultiple	xing c	ircuit and to	o verify	its opera	tion
Week-8	TIME DIVI	SION MULTIPLEXING	&AM	P; DE	MUL	TIPLEXIN	IG		
	1								
To study th	ne operation of	Time-Division multiplexin	ıg						

To study the	e AGC Characteristics.
Week-10	CHARACTERISTICS OF MIXER
To obtain th	ne mixer characteristics of a super heterodyne receiver.
Week-l1	PHASE LOCKED LOOP
To compare	the theoretical and practical values of capture range and lock range of phase locked loop.
Week-12	GENERATION OF DSBSC USING RING MODULATION OBSERVATION OF OUTPUT WAVEFORM
To generate	AM-Double Side Band Suppressed Carrier (DSB-SC) signal using Ring Modulator.
Week-l3	FREQUENCY SYNTHESIZER
To study th	e operation of frequency synthesizer using PLL.
Week-l4	SPECTRAL ANALYSIS OF AM AND FM SIGNALS USINGSPECTRUM ANALYZER
To study the	e operation of spectrum analyzer
Reference	Books:
 Dan N Micha system 	s Shetty, Richard A. Kolk (2011), —Mechatronics System Designl, PWS Publishing Company. Jecsulescu, (2002), —Mechatronicsl, 3rd Edition, Pearson Education. el B. Histand and David G. Alciatore (2005), —Introduction to Mechatronics and Measurement nsl, McGraw-Hill. ingh (2002), —Advanced Microprocessor and Microcontrollersl, New Age International her.
Web Refer	ences:
 2. https:// 3. http:/// 	/ocw.mit.edu/courses/electrical/6analog-communications/lecture-notes /everythingvtu.wordpress.com www.iare.ac.in
HARDWA	FTWARE AND HARDWARE REQUIRED FOR A BATCH OF 36 STUDENTS RE: Desktop Computer Systems 18 nos
SOFTWAI	RE:MATLAB

SIGNALS AND SYSTEMS LABORATORY

Course Code	Category	Hours	/Weel	k	Credits	May	kimum N	Aarks	
AECB17	Core	L	Т	Р	С	CIA	SEE	Total	
ALCOIT	Core	-	-	2	1	30	70	100	
Contact Classes: Nil	Tutorial Classes: Nil	Pra	ctical	Classe	es: 24	Total Classes: 24			
The course should enable I. Understand the basi II. Simulate the generation III. Illustrate Gibbs pheno IV. Analyze the signals us	ics of MATLAB. on of signals and operation menon. sing Fourier, Laplace and 2	Z transfo	orms.						
	LIST OF E	XPERI	MEN'I	S					
WEEK-1 BASIC OPER	ATIONS ON MATRIC	ES							
Review basic operations on	matrices by using MATL	AB							
WEEK -2 GENERATIN	OF VARIOUS SIGNAL	LS AND	SEQ	UENC	E				
Generation of various signal riangular, sinusoidal by usin		init impu	llse, sii	nc, Gai	ussian, exp	onential	saw too	oth,	
WEEK -3 OPERATION		·							
Dperation on signals and security of the secur	quences such as addition, s	subtracti	on, mı	ıltiplic	ation, scali	ng, shift	ing, fold	ing by	
WEEK - 4 GIBBS PHEN	OMENON								
Verification of Gibbs pheno	menon by using MATLA	В							
WEEK -5 FOURIER TR	RANSFORMS AND INV	ERSE I	FOUR	IER T	RANSFOI	RM			
Finding the Fourier Transfor nagnitude and phase spectru		nsform o	of a giv	ven sig	nal/sequen	ce and p	lotting it	S	
WEEK-6 PROPERTIES		SFORM	S						
Verifying Time shifting and				ies of l	Fourier tran	sforms	by using		
MATLAB.									
WEEK -7 LAPLACE TI	RANSFORMS								
WEEK -7 LAPLACE TI		ocate its :	zeros a	ind pol	es in s-plar	ne.			
	m of a given signal and lo	ocate its :	zeros a	and pol	es in s-plar	1e.			

WEEK -9 CONVOLUTION BETWEEN SIGNALS AND SEQUENCES
Finding convolution between two signals /sequences by using MATLAB.
WEEK 10 AUTO CORRELATION AND CROSS CORRELATION
Finding auto correlation and cross correlation between signals and sequences by using MATLAB.
WEEK 11 GAUSS IAN NOISE
Generation of Gaussian noise, computation of its mean, M.S. value and its Skew, kurtosis, and PSD, probabili distribution function by using MATLAB.
WEEK 12 WIENER – KHINCHINE RELATIONS
Verification of wiener – Khinchine relations using MATLAB.
WEEK 13 DISTRIBUTION AND DENSITY FUNCTIONS OF STANDARD RANDOM VARIABLES
Finding distribution and density functions of standard random variables and plot them by using MATLAB
WEEK 14 WIDE SENSE STATIONARY RANDOM PROCESS
Checking a random process for stationary in wide sense by using MATLAB.
Reference Books:
 S. Varadarajan , M. M. Prasada Reddy , M. Jithendra Reddy , "Signals and systems introduce MATLAB programs", I K International Publishing House Pvt. Ltd, 2016. Scott L. Miller, Donald G. Childers, "Probability and Random Processes: With Applications to Signa Processing and communications", Elsevier, 2004. Krister Ahlersten, "An Introduction to Matlab", BookBoon, 2012. K. S. Suresh Kumar, "Electric Circuit Analysis", Pearson Education, 1st Edition, 2013.
Web References:
 http://in.mathworks.com/help/matlab http://web.mit.edu/acmath/matlab/course16/16.62x/16.62x_Matlab.pdf https://www.probabilitycourse.com/chapter12/Chapter_12.pdf http://www.iare.ac.in SOFTWARE AND HARDWARE REQUIREMENTS FOR A BATCH OF 36 STUDENTS
HARDWARE: Desktop Computer Systems 18 nos
SOFTWARE : MATLAB

ANTENNAS AND WAVE PROPAGATION

Course Code	Category	Ho	urs / W	'eek	Credits	M	Maximum Marks		
AECB18	Core	L	Т	Р	С	CIA	SEE	Total	
AECDIO	Core	2	1	-	3	30	70	100	
Contact Classes: 30 OBJECTIVES:	Tutorial Classes: 15	P	ractica	l Class	es: Nil	Tot	al Classe	es: 45	
terminology and co II. Analyze the elect formulation of the III. Explain radiation r IV. Justify the propag	adiation phenomena asso oncepts of antennas along tric and magnetic field	y with en emission pes of a	mphasis on from	s on thei n vario	r applicatior us basic an eir usage in 1	ns. atennas w real time f	vith math	iematica	
	FENNA BASICS						Class	es: 09	
Fields from Oscillatin Potentials, Radiation Distributions, Field	rectivity-Gain-Resolution ng Dipole, Field Zones, F from Small Electric Dipo Components, Radiated Comparison of Far Fields	Front-to- ole, Qua Power,	Back R arter Wa Radiati	Ratio, A ave Mor on Res	ntenna Theo nopole and H istance, Loo	orems, Rae Half Wave	diation, R e Dipole,	Retarded Current	
MODULE -II V	HF,UHF AND MICRO	WAVE	ANTE	NNAS-	I		Class	es: 10	
Antennas-Helical Ge Antenna in Axial and	ic Elements, Yagi-Uda cometry, Helix modes, l Normal Modes, Horn A ramidal Horns, Illustrative	Practica ntennas	ıl Desig - Types	gn Cons	siderations	for N	Ionofilar	Helical	
MODULE -III V	HF,UHF AND MICRO	WAVE	ANTE	NNAS-	II		Class	es: 10	
Methods of Analysis	s-Introduction, Basic ch , Rectangular and Circul of smart antennas, fixed	lar micr	o strip	antenna	is, Basic co	ncepts of	Smart an		
	- Introduction Parabolo			etallic D					
	nas:Introduction, Geome atenna, Babinet's Principl	-	ications	•				crunees	
Methods Lens Anten Applications, Slot An	nas:Introduction, Geome	e, Appl			S		Class	es: 08	

Gain Measurements (by Comparison, Absolute and 3-Antenna Methods)

MODULE -V RADIO WAVE PROPAGATION

Classes: 08

Wave Propagation - I: Introduction, definitions, categorizations, different Modes of Wave Propagation; Ground wave propagation: Introduction, plane earth reflections, , wave tilt, curved earth reflections; Space wave propagation: Introduction, field strength variation with distance and height, effect of earth's curvature, absorption, super refraction, M-Curves, duct propagation, scattering phenomena, tropospheric propagation, fading and path loss calculations; Wave propagation – II: Sky wave propagation: Introduction, structure of ionosphere, refraction and reflection of sky waves by ionosphere; Ray path, critical frequency, MUF, LUF, OF, virtual height and skip distance; Relation between MUF and skip distance; Multi-hop propagation.

Text Books:

- 1. John D. Kraus, Ronald J. Marhefka, Ahmad S. Khan, "Antennas and Wave Propagation", TMH, 4th Edition, 2010.
- 2. C.A. Balanis, "Antenna Theory", John Wiley and Sons, 2nd Edition, 2001.

Reference Books:

- 1. E.C. Jordan, K.G. Balmain, "Electromagnetic Waves and Radiating Systems", PHI, 2nd Edition, 2000.
- 2. E.V.D. Glazier, H.R.L. Lamont, "Transmission and Propagation", Her Majesty's Stationery Office, 1958.
- 3. F.E. Terman, "Electronic and Radio Engineering", McGraw-Hill, 4th Edition, 1955.
- 4. K.D. Prasad, Satya Prakashan, "Antennas and Wave Propagation", Tech India Publications, 1st Edition, 2001.

Web References:

- 1. http:// web.stanford.edu/class
- 2. http://www.electronicagroup.com
- 3. http://www.cpri.in/about-us/departmentsunits/library-and-information-centre/digital-library-links.html
- 4. http://nptel.ac.in/courses/antennas

- 1. http://www.ebookgalaxy.in/2016/01/antennas-and-wave-propagation-by-g-s-n.html#.WBGI7NJ97IU
- 2. https://www.jntubook.com/antennas-wave-propagation-textbook
- 3. http://117.55.241.6/library/E-Books/Antennas_mcgraw-hill_2nd_ed_1988-john_d_kraus.pdf
- 4. http://www.archive.org

LINEAR AND DIGITAL IC APPLICATIONS

Course Code		Category	Ног	ırs / W	eek	Credits	Ma	ximum I	Marks
AECB19		Core	L	Т	Р	С	CIA	SEE	Tota
AECDI9		Core	2	1	-	3	30	70	100
Contact Classes:	Contact Classes: 30 Tutorial Classes: 15		Pi	ractical	Classe	es: Nil	Tota	l Classes	s: 45
II. Design linear a III. Analyze and d	o basio nd non esign f	the students to: building blocks, princi linear functional modu ilters, timers, analog to onality and characteristi	Îes using digital a	g operat nd digit	tional a tal to ai	mplifier. nalog Conve	erters.	ted circu	its
MODULE -I OPERATIONAL AMPLIFIER								Classes	: 08
configuration, dual is practical Op-amp sp	nput u pecifica	ifferential Amplifier, nbalanced output. Char ations. DC characterist response, slew rate, CM	racterist ics: Inp	ics of C ut & ou)p-amp utput o	s, Op-amp	block dia	gram, id	eal and
MODULE -II	APPL	ICATIONS OF OPER	ATION	IAL AN	APLIF	IERS		Classes	: 09
nstrumentation amp riangular, saw tooth	lifier, 1 , squa	Op-amps: Inverting a AC amplifier. Non-line re wave generators, log three terminal voltage re	ear appli and ant	cations i-log ar	of Op-	Amps: Con	nparators,	multi vi	brators
MODULE -III	ACTI	VE FILTERS AND TI	MERS					Classes	: 09
oand pass, band rejection	to 555	n of filters, 1 st order lov all pass filters. 5 timer, functional diagr oduction, block schema	am, moi	no-stabl	le, astal	ole operation	ns and ap	plication	•
MODULE -IV	DATA	CONVERTERS						Classes	: 10
DAC, R-2R ladder	DAC,	ion, classification, need inverted R-2R DAC, integrating ADC. DAC/	and IC	1408	DAC.				
MODULE -V	DIGI	CAL IC APPLICATIO	NS					Classes	: 09
Transistor Logic(TT an-in, fan-out, pow	L), En er diss	milies such as Resiston nitter Coupled Logic and ipation, propagation defined ies ICs-Flip Flops (IC	d CMOS lay and	S. Chara noise n	acterist nargin,	ics of digita Familiarity	l logic fa with con	milies co nmonly a	ntainii vailab

Text Books:

- 1. D.RoyChowdhury, "Linear Integrated Circuits", New age international (p)Ltd, 2nd Edition, 2003.
- 2. Ramakanth A. Gayakwad, "Op-Amps &linear ICs", PHI, 3rd Edition, 2003.
- 3. JohnF.Wakerly, "Digital Design Principles and Practices", Prentice Hall, 3rd Edition, 2005.
- 4. M. MorrisMano, Michael D. Ciletti, "Digital Design", Pearson Education/PHI, 3rd Edition, 2008.

Reference Books:

1. Salivahanan, "Linear Integrated Circuits and Applications", TMH, 1stEdition, 2008.

Web References:

- 1. https://www.nptel.ac.in
- 2. https://www.svecw.edu.in
- 3. https://www.smartzworld.com
- 4. https://www.crectirupati.com

- 1. https://books.google.co.in/books?isbn=8122414702
- 2. https://books.google.co.in/books?isbn=013186389

V Semester: ECE								
Course Code	Category	Hours / Week Credits Maximum Ma				arks		
AECB20	Core	L	Т	Р	С	CIA	SEE	Total
		3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	Practical Classes: Nil Total C					al Class	es: 45

DIGITAL COMMUNICATIONS

OBJECTIVES:

The course should enable the students to:

- Understand the different digital modulation techniques. I.
- II. Discuss the importance of error detection and correction codes and use them in the presence of the channel.
- III. Describe and analyze the methods of transmission of digital data using baseband and carrier modulation techniques.
- IV. Decompose codes separately into source codes and develop competency in modeling and analyzing communication system elements

MODULE -I PULSE DIGITAL MODULATION

Pulse Modulation: Analog pulse modulation, Types of pulse modulation; PAM (Single polarity, double polarity); Generation & demodulation of PWM; Generation and demodulation of PPM; Introduction: Elements of digital communication systems, advantages and disadvantages of digital communication systems, applications; Pulse Digital Modulation: Elements of PCM; Sampling, quantization and coding; Quantization error, non-uniform quantization and companding; Differential PCM (DPCM); Adaptive DPCM; Delta modulation and its drawbacks; Adaptive delta modulation; Comparison of PCM and DM systems; Noise in PCM and DM systems.

MODULE -II DIGITAL MODULATION TECHNIQUES

Digital Modulation Techniques: Introduction, ASK modulator, coherent ASK detector, non-coherent ASK detector, FSK, bandwidth and frequency spectrum of FSK, non-coherent FSK detector, coherent FSK detector; BPSK, coherent BPSK detection; QPSK; DPSK, DEPSK; Optimal reception of digital signal: Baseband signal receiver; Probability of error; Optimum filter; matched filter, probability of error using matched filter; Correlation receiver; Calculation of probability of error for ASK, FSK, BPSK.

MODULE -III BASE BAND TRANSMISSION AND PULSE SHAPING

Base Band Transmission: Requirements of a line encoding format, Various line encoding formats: Unipolar, Polar, Bipolar; computation of power spectral densities of various line encoding formats. Scrambling techniques: BZ8S, HDB3.

Pulse Shaping: Inter symbol interference; pulse shaping to reduce ISI; Nyquist's criterion; Raised cosine filter; Equalization; Correlative level coding; Duo-binary encoding, modified duo -binary coding; Eye diagrams; Cross Talk.

MODULE -IV INFORMATION THEORY AND SOURCE CODING

Information Theory: Information, entropy, conditional entropy; Mutual information; Channel capacity; Various mathematical modeling of communication channels and their capacities; Source coding: Fixed length and variable length Source Coding Schemes, Huffman coding; Shannon fano coding, Source coding to increase average information per bit; Lossy source coding; Channel coding theorem; Hartley Shannon law; Tradeoff between bandwidth and S/N ratio; Spread spectrum modulation: Useofspreadspectrum;Directsequencespreadspectrum(DSSS);CodedivisionmultipleaccessusingDSSS, frequency hopping spread spectrum; PN-Sequences: Generation and characteristics; Synchronization in spread spectrum systems.

Classes: 08

Classes: 10

Classes: 09

Classes: 10

MODULE -V LINEAR BLOCK CODES AND SOURCE CODES

Linear Block Codes: Introduction to error control coding; Matrix description of linear block codes, error detection and error correction capabilities of linear block codes; Hamming code; Binary cyclic codes algebraic structure, encoding, syndrome calculation and decoding; Convolution Codes: Introduction, Encoding of convolution codes; Time Domain Approach; Transform Domain Approach; General approach; State, Tree And Trellis Diagram; Decoding using Viterbi Algorithm; Burst Error Correction: Block Inter leaving and convolution interleaving.

Text Books:

- 1. Herbert Taub, Donald L. Schilling, "Principles of Communication Systems", TMH, 3rd Edition, 2008
- K. Sam Shanmugam, "Digital and Analog Communication Systems", John Wiley & Sons, 2nd Edition, 2005.
- 3. Simon Haykin, "Digital communications", John Wiley, 3rd Edition, 2005.

Reference Books:

- 1. John Proakis, "Digital Communications", TMH, 2nd Edition1983.
- 2. B.P.Lathi, "Modern Analog and Digital Communication", Oxford reprint, 3rd Edition, 2004.
- 3. Singh, Sapre, "Communication Systems Analog and Digital", TMH, 2nd Edition, 2004.

Web References:

- 1. http://www.igniteengineers.com
- 2. http://www.ocw.nthu.edu.tw
- 3. http://www.uotechnology.edu.iq

- 1. https://www.jntubook.com/dgital-communications-textbook
- 2. http://tradownload.com/results/neamen-digital-communications-.html
- 3. http://www.everythingvtu.wordpress.com

JAVA PROGRAMMING

V Semester: ECE												
Course Code	Category	Hours / Week			Credits	Maximum Marks						
ACSB41	Core	L	Т	Р	С	CIA	SEE	Total				
		3	-	-	3	30	70	100				
Contact Classes: 45	Tutorial Classes: Nil	Practical Classes: Nil				Total Classes: 45						

OBJECTIVES:

The course should enable the students to:

- I. Understand the basic object oriented programming concepts and apply them in problem solving.
- II. Illustrate inheritance concepts for reusing the program.
- III. Demonstrate on the multi-tasking by using multiple threads.
- IV. Develop data-centric applications using JDBC.
- V. Understand the basics of java console and GUI based programming.

MODULE -I FUNDAMENTALS OF OBJECT ORIENTED PROGRAMMING: C

Classes: 10

Object oriented paradigm - Basic concepts of Object Oriented Programming - Benefits of OOP - Applications of OOP

Java Evolution: Java Features - How Java differs from C and C++ - Java and Internet - Java and World Wide Web - Web Browsers - Hardware and Software Requirements - Java Environment. Overview of Java Language: Simple Java Program - Java Program Structure - Java Tokens- Java Statements - Implementing a Java Program - Java Virtual Machine - Constants - Variables - Data types - Scope of Variables-Symbolic Constants-Type Casting and type promotions – Operators, Operator Precedence and Associativity - Control Statements – break - continue- Arrays-Multi dimensional arrays, Wrapper Classes - Simple examples.

MODULE -II CLASSES AND OBJECTS:

Classes: 09

Classes and Objects - Constructors – methods - this keyword – garbage collection- finalize - Overloading methods and constructors - Access Control- Static members – nested and inner classes – command line arguments - variable length arguments.

Inheritance: Forms of inheritance – specialization, specification, construction, extension, limitation, combination, benefits and costs of inheritance. Super uses- final - polymorphism, method overriding - dynamic method dispatch –abstract classes – exploring String class.

MODULE -III PACKAGES AND INTERFACES:

Classes: 08

Classes: 08

Defining and accessing a package – understanding CLASSPATH – access protection importing packages – Interfaces - Defining and implementing an interface, Applying interfaces, Variables in interfaces and extended interfaces. Exploring java.lang and java.util packages.

Exception Handling-Fundamentals, usage of try, catch, multiple catch clauses, throw, throws and finally. Java Built in Exceptions and creating own exception subclasses.

MODULE -IV MULTITHREADED PROGRAMMING:

Java Thread life cycle model – Thread creation - Thread Exceptions - Thread Priority – Synchronization - Messaging - Runnable Interface - Interthread Communication - Deadlock - Suspending, Resuming and stopping threads.

I/O Streams: File – Streams – Advantages - The stream classes – Byte streams – Character streams.

MODULE -V APPLET PROGRAMMING:

How Applets differ from Applications - Applet Life Cycle - Creating an Applet - Running the Applet-Designing a Webpage - Applet Tag - Adding Applet to HTML file - More about Applet Tag - Passing parameters to Applets - Aligning the display.

Event handling: basics of event handling, Event classes, Event Listeners, delegation event model, handling mouse and keyboard events, adapter classes, AWT Class hierarchy - AWT Controls - Layout Managers and Menus, limitations of AWT.

Fext Books:

- 1. Herbert Schildt, "The Complete Reference Java J2SE", TMH Publishing Company Ltd, New Delhi, 5th Edition, 2008.
- 2. Cay Horstmann, "Big Java", John Wiley and Sons, 2nd Edition, 2006.

Reference Books:

- 1. Java How to Program, Sixth Edition, H.M.Dietel and P.J.Dietel, Pearson Education/PHI
- 2. Core Java 2, Vol 1, Fundamentals, Cay.S.Horstmann and Gary Cornell, Seventh Edition, Pearson Education.
- 3. Core Java 2, Vol 2, Advanced Features, Cay.S.Horstmann and Gary Cornell, Seventh Edition, Pearson Education.

Web References:

- 1. http://www.javatpoint.com/java-tutorial
- 2. http://www.javatutorialpoint.com/introduction-to-java/

E-Text Books:

1.http://bookboon.com/en/java-programming-language-ebooks 2.https://en.wikibooks.org/wiki/Java_Programming

LINEAR AND DIGITAL IC APPLICATIONS LABORATORY

Cours	e Code	Category	He	ours / W	/eek	Credits	Maxin	num M	[arks
			L	Т	Р	С	CIA	SEE	Tota
AEC	CB21	Core	-	-	2	1	30	70	100
Contact Cla OBJECTIV		Tutorial Classes: Nil	P	ractical	l Class	es: 24	Tota	Class	es: 24
I. ImplemII. Study the III. Verify	ent different he concepts o the operation	e the students to: circuits and verify circui of multi vibrators and filt s of the 555 timers and P ombinational and sequent	ers. LLs ar ial circ	nd their a cuits.		tions.			
	[LIST OF E	XPER	RIMEN	ГS				
WEEK - I	INVERTIN	G, NON-INVERTING	AND I	DIFFER	RENTI	AL AMPI	LIFIER	S	
To construct using IC741.	and test the J	performance of an Inverti	ing, No	on-inver	ting am	plifier and	l Differe	ntial ar	nplifie
WEEK-2	INTEGRAT	FOR AND DIFFERENT	TIATC)R					
To construc	t and test the	performance of an Integ	rator a	nd Diffe	rentiat	or using IC	C 741.		
WEEK-3	SECOND C	ORDER ACTIVE LOW	PASS,	HIGH	PASS A	AND BAN	DPASS	FILT	ERS
To design an	d verify the o	operation of the Active lo	w pass	s and Hi	gh pass	using IC	741.		
WEEK-4	SECOND C	ORDER ACTIVE BANI) PAS	S AND	BAND	REJECT	FILTE	RS	
To design an	d verify the o	operation of the Band pas	s and l	Band rej	ect filte	ers using I	C 741.		
WEEK -5	ASTABLE	MULTIVIBRATORS U	JSING	555					
To design an	d construct a	n astable multivibrators u	using I	C 555.					
WEEK -6	MONOSTA	BLE MULTIVIBRAT	ORS 5	55					
To design an	d construct N	Ionostable multivibrators	s using	IC 555.					
WEEK -7	SCHMITT	TRIGGER USING 555							
To design an	d construct s	chmitt trigger using NE5	55 Tin	ner.					
WEEK -8	PLL USING	G IC 565							
Verifying cl	haracteristics	of PLL.							
WEEK -9	INSTRUM	ENTATION AMPLIFIE	ER						
T 1 ·	l d marifer that	operation of instrumentat	•	11.01					

WEEK-10 DIGITAL TO ANALOG CONVERTER

To design and verify the operation of R-2R and Inverted R-2R DAC Converter using IC 741.

WEEK-11 IC 723

To design and implement voltage regulator using IC 723.

WEEK-12 RTL LOGIC

Verify Functionality of NOR and NAND gate using RTL Logic.

WEEK-13 DTL LOGIC

Verify Functionality of NOR and NAND gate using DTL Logic.

Text Books:

- 1. D. Roy Chowdhury, "Linear Integrated Circuits", New age international (p) Ltd, 2nd Edition, 2003
- Ramakanth A. Gayakwad, "Op-Amps & linear ICs", PHI, 3rdEdition,2003.
 John F. Wakerly, "Digital Design Principles and Practices", Prentice Hall, 3rdEdition,2005.

Reference Books:

1. Salivahanan, "Linear Integrated Circuits and Applications", TMH, 1st Edition, 2008.

Web References:

- 1. http://www.ee.iitkgp.ac.in
- 2. http://www.citchennai.edu.in

SOFTWARE AND HARDWARE REQUIREMENTS FOR A BATCH OF 24 STUDENTS:

HARDWARE: Trainer kits, Analog and Digital ICs (IC741,555,74XX)

DIGITAL COMMUNICATIONS LABORATORY

Cours	e Code	Category	Hou	rs / W	eek	Credits	Maxi	mum N	larks
AEG	CB22	Core	L	Т	Р	С	CIA	SEE	Total
			-	-	2	1	30	70	100
	Classes: Nil	Tutorial Classes: Nil	Pr	actica	l Class	ses: 24	Tota	Classe	s: 24
I. Analyz II. Verify III. Under	should enable ze various digi the sampling stand the spect	the students to: ital modulation techniques. theorem. tral characteristics of Ampl se modulation techniques. LIST OF EX	litude N						
					~				
Week-l		G THEOREM – VERIFIC							
		eorem for under, perfect, o		x 0					
Week-2	PULSE AM	PLITUDE MODULATI	ON AN	D DE	MODU	JLATION			
Generation o	f Pulse Ampli	tude modulation and demo	dulation	n using	, hardv	vare and ma	atlab		
Week-3	PULSE WI	DTH MODULATION AN	ND DE	MODU	JLAT	ION			
Generation o	f Pulse width	modulation and demodulat	ion usiı	ng hard	lware a	and matlab			
Week-4	PULSE POS	SITION MODULATION	AND	DEMC	DUL	ATION.			
Generation o	f pulse positio	n modulation and demodul	lation u	sing ha	ardwar	e and matla	ıb		
Week-5	PULSE CO	DE MODULATION							
	f pulse code m ital conversion	nodulation and demodulation	on using	g hardv	ware a	nd understa	nding th	e conce	pt
Week-6	DIFFEREN	TIAL PULSE CODE MO	DDULA	TION	I				
Generation o	f differential p	oulse code modulation and	demod	ulation	using	hardware			
Week-7	DELTA MO	DDULATION.							
Generation o PCM and DM		tion and demodulation usi	ng hard	ware .	Unders	standing dif	ference	betweer	n
Week-8	FREQUEN	CY SHIFT KEYING							
Generation o	f Frequency sl	nift keying modulation and	demod	ulatior	n using	g hardware			
Week-9	PHASE SH	IFT KEYING.							
Generation o	f Phase shift k	eying modulation and dem	odulati	on usir	ng haro	lware			

Week-10	DIFFERENTIAL PHASE SHIFT KEYING
Generation o	f Differential Phase shift keying modulation and demodulation using hardware
Week-l1	AMPLITUDE SHIFT KEY(ASK)
Generation o	f Amplitude Shift Key modulation and demodulation using hardware
Week-l2	QUADRATURE PHASE SHIFT KEYING
Generation o	f QPSK modulation and demodulation using hardware
Week-l3	MATLAB for QPSK & SIMULINK for DPSK.
Understand f keying	requency domain description of Quadrature Phase Shift Keying and Differential Phase shift
Week-l4	STUDY OF THE SPECTRAL CHARACTERISTICS OF AMPLITUDE MODULATION
Understand f	requency domain description of Amplitude Modulation
Reference B	ooks:
1. K.Sam 2005.	Shanmugam, "Digital and Analog Communication Systems", Joh Wiley & Sons, 2 nd Edition,
	athi, "Modern Analog and Digital Communication", Oxford reprint, 3 rd Edition, 2004. Sapre, "Communication Systems Analog and Digital", TMH, 2 nd Edition,2004
Web Refere	nces:
2. https:// 3. http://v	/ocw.mit.edu/courses/electrical/6digital-communications/lecture-notes /everythingvtu.wordpress.com www.iare.ac.in FTWARE AND HARDWARE REQUIRED FOR A BATCH OF 36 STUDENTS
	E: Desktop Computer Systems 18 nos
SOFTWAR	E:MATLAB
<u>.</u>	

DIGITAL SIGNAL PROCESSING

	:	Category	Ho	urs / W	/eek	Credits	Ma	ximum 1	Marks
AECB23		Core	L	Т	Р	С	CIA	SEE	Tota
ALCD25			2	1	0	3	30	70	100
Contact Classes: OBJECTIVES:	: 30	Tutorial Classes: 15	P	ractica	l Class	es: Nil	Tota	l Classe	s: 45
 I. Provide backs to familiarize II. Study fundam these analytic analysis to syn III. Introduce a fe 	ground the rel nentals methe nthesis	ble the students to: and fundamental mater ationships between cont of time, frequency and od and to study the des for a given specification -world signal processing gorithm, multi-rate signa	inuous- z-plane igns an ns. gapplica	-time an e analys id struc ations.	d discr sis and tures of	ete-time sig to discuss t f digital (III	nals and he inter-1 R and FI	systems. relationsl R) filter	hips of s from
MODULE - I		IEW OF DISCRETE	<u>`</u>	, j	<u> </u>			Classe	
overlap-save and o Realization structu parallel.	overlaj ures fo	onvolution sum; Method p-add method; Realization r IIR and FIR filters using	on of di	gital fil	ters: Co	oncept of III	R and FII	R filters;	0
MODULE - II		CRETE FOURIER TR	ANSFO	ORM A	ND EI	FICIENT		Classe	
Introduction to di Properties of DF computation of I	CON iscrete T; Lin DFT; compu	IPUTATION time Fourier transform ear and circular convol Need for efficient com tation of DFT and IDF	ו (DTF lution נ putatio	T); Dis using D on of tl	crete F DFT; Fa	Fourier tran ast-Fourier- Г (FFT alg	sform (D transform gorithms)	Classe PFT) def n (FFT): ; Radix-	es: 08 inition: Direc: 2 FF1
Introduction to di Properties of DF computation of I algorithm for the	CON iscrete T; Lin DFT; compu- cal Rad	IPUTATION time Fourier transform ear and circular convol Need for efficient com tation of DFT and IDF	ו (DTF lution נ putatio	T); Dis using D on of tl	crete F DFT; Fa	Fourier tran ast-Fourier- Г (FFT alg	sform (D transform gorithms)	Classe PFT) def n (FFT): ; Radix-	es: 08 inition: Direc: 2 FFT quency
Introduction to di Properties of DF computation of I algorithm for the algorithms; Gener MODULE - III Analog filters: Bu LPF to HPF/BPF/	CON iscrete T; Lin DFT; C compu- al Rad IIR I tterwo BSF.	IPUTATION time Fourier transform ear and circular convol Need for efficient com tation of DFT and IDF lix-N FFT. FILTERS rth filters; Chebyshev ty	n (DTF lution unputatio T using pe-1 &	T); Dis using D on of th g decim	filters;	Fourier tran ast-Fourier- Γ (FFT alg n-time and Analog tran	sform (D transform orithms) decimation	Classe PFT) defin (FFT): ; Radix- on-in-fre Classe	es: 08 inition Direc 2 FF1 quency es: 09
Introduction to di Properties of DF computation of I algorithm for the algorithms; Gener MODULE - III Analog filters: Bu LPF to HPF/BPF/ Transformation of	CON iscrete T; Lin DFT; compu- al Rad IIR I itterwo BSF. f analo	IPUTATION time Fourier transform ear and circular convol Need for efficient com itation of DFT and IDF lix-N FFT.	n (DTF lution un putatio T using pe-1 & digital f	T); Dis using D on of th g decim	filters;	Fourier tran ast-Fourier- Γ (FFT alg n-time and Analog tran	sform (D transform orithms) decimation	Classe PFT) defin (FFT): ; Radix- on-in-fre Classe	es: 08 inition Direc 2 FF1 quency es: 09
Introduction to di Properties of DF computation of I algorithm for the algorithms; Gener MODULE - III Analog filters: Bu LPF to HPF/BPF/ Transformation of	CON iscrete T; Lin DFT; compu- cal Rad IIR I IIR I SSF.	IPUTATION time Fourier transform ear and circular convol Need for efficient com tation of DFT and IDF lix-N FFT. FILTERS rth filters; Chebyshev ty g filters into equivalent	n (DTF lution un putatio T using pe-1 & digital f lters.	T); Dis using D on of th g decim	filters;	Fourier tran ast-Fourier- Γ (FFT alg n-time and Analog tran	sform (D transform orithms) decimation	Classe PFT) defin (FFT): ; Radix- on-in-fre Classe	es: 08 inition Direc 2 FFT quency es: 09 ototype

MODULE - V	APPLICATIONS OF DSP
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Multirate signal processing; Decimation; Interpolation; Polyphase structures for decimation and interpolation filters; Structures for rational sampling rate conversion; Applications of multirate signal processing for design of phase shifters, interfacing of digital systems with different sampling rates, sub band coding of speech signals. Analysis of finite word length effects: Representation of numbers; ADC quantization noise, coefficient quantization error, product quantization error, truncation & rounding errors; Limit cycle due to product round-off error; Round-off noise power; Limit cycle oscillations due to overflow in digital filters; Principle of scaling; Dead band effects.

Text Books:

- 1. Digital signal processing, Principles, Algorithms and Applications, John G. Proakis, Dimitris G. Manolakis, Prentice Hall, 4th Edition,2007.
- 2. Digital signal processing, A computer base approach ,Sanjit K Mitra, McGraw-Hill Higher Education, 4th Edition,2011.
- 3. DSP-A Practical Approach Emmanuel C, Ifeacher, Barrie. W. Jervis, Pearson Education, 2nd Edition, 2002.
- 4. Discrete Time Signal Processing ,A.V. Oppenheim, R.W. Schaffer , PHI, 2nd Edition,2006.

Reference Books:

- 1. Digital signal processing: fundamentals and applications ,Li tan, Elsevier Science &.Technology Books, 2nd Edition, 2008.
- 2. FundamentalsofDigitalsignalprocessingusingMatlab ,RobertJ.schilling,Sandra.L.harris,Thomson Engineering, 2nd Edition,2005.
- 3. Digitalsignalprocessing ,Salivahanan,Vallavaraj,Gnanapriya,McGraw-HillHigherEducation,2nd Edition, 2009.

Web References:

- 1. https://nptel.ac.in/courses/117102060/
- 2. https://ocw.mit.edu/resources/res-6-008-digital-signal-processing-spring-2011/

- 1. https://b-ok.cc/s/?q=ebook+for+digital+signal+processing
- 2. https://www.e-booksdirectory.com/details.php?ebook=4117
- 3. http://freecomputerbooks.com/Design-and-Architectures-for-Digital-Signal-Processing.html

MICROPROCESSORS AND MICROCONTROLLERS

Course Code	Category	Ho	ours / V	Week	Credits	M	aximum 1	Marks
AECB24	Com	L	Т	Р	С	CIA	SEE	Tota
AECD24	Core	2	1	-	3	30	70	100
Contact Classes: 30	Tutorial Classes: 15	P	ractica	ıl Clas	ses: Nil	Tota	al Classes	s: 45
II. Demonstrate the abilit 8086 and 8051.III. Impart knowledge of 6	e the students to: dge about architecture, instru- ty to develop programmes for different types of external per and I/O interfacing with 808	or difi eriphe	ferent a erals lil	applica ke 825	tions using	g assemb	ly langua	ge of
MODULE -I 8086 M	ICROPROCESSORS						Class	ses : 08
of 2006 gratam and time		-	.				, maximu	
off 8086,assembler directiMODULE -IIPROGRMachine level programs, stack, stack structure of 80	gs, machine language instru- ives and operators. RAMMING WITH 8086 M programming with an asse 086/8088, interrupts and intervences of the second se	errup	forma OPRC er, Ass t servio	ts, add OCESS embly ce rout	Ressing mo COR language ines. Inter	ode of 80	86, instru Class s, introdu	ction se ses : 09 action t
off 8086,assembler directiMODULE -IIPROGRMachine level programs, stack, stack structure of 80 mask able interrupt and	gs, machine language instru- ives and operators. RAMMING WITH 8086 M programming with an asse	errup	forma OPRC er, Ass t servio	ts, add OCESS embly ce rout	Ressing mo COR language ines. Inter	ode of 80	86, instru Class s, introdu le of 808	ction se ses:09 action t 36, nor
off 8086,assembler directionMODULE -IIPROGRMachine level programs, stack, stack structure of 80 mask able interrupt and MODULE -IIIMODULE -IIIINTER INTER Semiconductor memory in operation of 8255, interface levices using 8255.Programmableinterrupt	gs, machine language instru- ives and operators. RAMMING WITH 8086 M programming with an asse 086/8088, interrupts and inter- mask able interrupts, inter- FACING WITH 8086/88 Interfacing, dynamic RAM cing to D/A and A/D conver- controller 8259A, the	emble errup rrupt interf rters,	oproversion of the service of the se	ocess embly ce rout cammi interfa	ressing mo OR language ines. Inter ng. acing i/o p or interfact	program rupt cyc ports, PIC	86, instru Class s, introdu le of 808 Class D 8255 n rol of hig	ction se ses : 09 action t 36, nor ses: 08 nodes c h powe
off 8086,assembler directionINDULE -IIPROGRMachine level programs, stack, stack structure of 80 mask able interrupt and MODULE -IIIINTER INTER INTER Semiconductor memory in operation of 8255, interface levices using 8255.Programmableinterrupt ommunication interface 8	gs, machine language instru- ives and operators. CAMMING WITH 8086 M programming with an asse 086/8088, interrupts and inter- mask able interrupts, inter- FACING WITH 8086/88 Interfacing, dynamic RAM cing to D/A and A/D conver-	emble errup rrupt interf rters,	oproversion of the service of the se	ocess embly ce rout cammi interfa	ressing mo OR language ines. Inter ng. acing i/o p or interfact	program rupt cyc ports, PIC	86, instru Class s, introdu le of 808 Class D 8255 n rol of hig	ction sees: 09 action t 36, nor sees: 08 nodes c h powe
off 8086,assembler directionMODULE -IIPROGRMachine level programs, stack, stack structure of 80 mask able interrupt andMODULE -IIIINTERSemiconductor memory in operation of 8255, interface devices using 8255.Programmableinterrupt sommunication interface 8 8051 Microcontroller – Int	gs, machine language instru- ives and operators. RAMMING WITH 8086 M programming with an asse 086/8088, interrupts and inter- mask able interrupts, inter- FACING WITH 8086/88 Interfacing, dynamic RAM cing to D/A and A/D conver- controller 8259A, the 251 USART, DMA Control ICROCONTROLLER ternal architecture and pin co O Port structures, assembly	emble errupt interf rters, keyt ller 8/	forma OPRO er, Ass t servic progr facing, steppo poard 257.	ts, add OCESS embly ce rout cammi interfa er mot /displ	ressing mo FOR language ines. Inter ng. acing i/o p or interfact ay contro addressing	program rupt cyc ports, PIC ing, contr poller8279 g modes,	86, instru Class s, introdu le of 808 Class D 8255 n rol of hig , progra Class instructio	ction se ses : 09 action t 36, nor ses: 08 nodes c h powe ammabl ses: 10 on set,

Text Books:

- 1. Ray A.K, Bhurchandi K.M, "Advanced Microprocessor and Peripherals", TMH, 2nd Edition, 2012
- 2. Muhammad Ali Mazidi, J.G. Mazidi, R.D McKinlay," The 8051 Microcontroller and Embedded systems using Assembly and C", Pearson education, 2nd Edition, 2009.
- 3. Douglas V. Hall, "Microprocessors and Interfacing Programming and Hardware", TMGH,
- 4. 2nd Edition, 1994.

Reference Books

- 1. Kenneth J. Ayala, "The 8051 Microcontroller", Thomson Learning, 3rd edition, 2005.
- 2. Manish K. Patel, "The 8051 Microcontroller Based Embedded Systems", McGraw Hill, 1st Edition, 2014.
- 3. Ajay V Deshmukh, "Microcontrollers", TATA McGraw Hill publications, 2nd Edition, 2012.

Web References:

- 1. http://www.nptel.ac.in/downloads/106108100/
- 2. http://www.the8051microcontroller.com/web-references
- 3. http://www.iare.ac.in

- 1. https://books.google.co.in/books
- 2. http://www.www.jntubook.com
- 3. http://www.ebooklibrary.org/articles/mpmc

BUSINESS ECONOMICS AND FINANCIAL ANALYSIS

Course Code	Category	Ho	urs / V	Week	Credits	Ma	aximum M	arks
AHSB14	Core	L	Т	Р	С	CIA	SEE	Total
AIISDIA	Core	3	-	-	3	30	70	100
Contact Classes: 45 DBJECTIVES:	Tutorial Classes: Nil	Pr	ractic	al Clas	ses: Nil	То	tal Classes	s: 45
structures. II. Analyze how capit III. Learn how organiz IV. Analyze a compan situation of the com	arket dynamics namely de tal budgeting decisions ar zations make important in ny's financial statements a	e carrie vestme nd cor	ed out ent and me to a	for sel d finan a reaso	lecting the cing decision ned conclu	best inv ions. ision abo	estment pro out the fina	oposal. ncial
	RODUCTION AND DE						Class	-
and its exceptions; Elas	cope of business economi sticity of demand: Defini sting, factors governing de	ition, 1	types,	measu				
MODULE – II PRO	ODUCTION AND COST	Г ANA	ALYS	IS			Class	es: 10
production function, int analysis (BEA), determin	soquants and isocosts, laternal and external economic eco	omies	of sc	ale, co	ost analys	is; Cost	concepts:	
MODULE - III MA	RKETS AND NEW EC	ONO	MICE	ENVIR				es: 08
Types of competition an price-output determination Features and evaluation	RKETS AND NEW EC ad markets, features of per on in case of perfect comp of different forms of bus nterprises and their types.	erfect of the section	compe	tition, monopo	CONMEN monopoly oly busines	F and moss.	Classe	_
Types of competition an price-output determination Features and evaluation	nd markets, features of per on in case of perfect comp of different forms of bus nterprises and their types.	erfect of the section	compe	tition, monopo	CONMEN monopoly oly busines	F and moss.	Classe	competitio
Types of competition an orice-output determinationFeatures and evaluationtock company, public erMODULE – IVCapital and its significationund sources of raising capudgeting: Payback perieturn method (simple prieturn	nd markets, features of per on in case of perfect comp of different forms of bus nterprises and their types. PITAL BUDGETING nce, types of capital, estin apital, capital budgeting: iod, accounting rate of re- roblems).	erfect of oetition iness of mation feature eturn(A	compendant organi	tition, monopo zations ced and capital net pr	RONMEN monopoly oly busines S: Sole pro d working budgeting resent valu	r and mo ss. oprietors capital 1 proposa ie metho	Classe onopolistic hip, partner Classe requiremen .ls; Method	competition rship, joint es: 10 ts, method ls of capita
Types of competition an orice-output determinationFeatures and evaluationFeatures and evaluationtock company, public erMODULE – IVCAICapital and its significant oudgeting: Payback periodCapital method (simple prMODULE – VINTMODULE – VINT	nd markets, features of per on in case of perfect comp of different forms of bus nterprises and their types. PITAL BUDGETING nce, types of capital, estin apital, capital budgeting: iod, accounting rate of re oblems). CRODUCTION TO FIN IANCIAL ANALYSIS	mation feature ANCL	compendant organi of fixes of c ARR),	tition, monopo zations ced and capital net pr CCOU	RONMEN monopoly oly busines s: Sole pro d working budgeting resent valu	and mo ss. oprietors capital 1 proposa ie metho	Classe onopolistic hip, partner Classe requiremen ils; Method od and inte	competitic rship, joint es: 10 ts, method ls of capita rnal rate c es : 10
Types of competition an orice-output determination Features and evaluation tock company, public er MODULE – IV CAI Capital and its significant und sources of raising car pudgeting: Payback period eturn method (simple pr MODULE – V Financial accounting ob louble-entry book keep account and balance sl	nd markets, features of per on in case of perfect comp of different forms of bus nterprises and their types. PITAL BUDGETING nce, types of capital, estin apital, capital budgeting: iod, accounting rate of re- roblems).	mation feature eturn(<i>A</i> ANCL rtance; balan ments;	and fine organi of fine es of c ARR), AL A ; Acco ace; F ; Fina	etition, monopo zations ced and capital net pr CCOU counting inal ac ncial	RONMEN monopoly oly busines s: Sole pro d working budgeting resent valu INTING A g concepts counts: Tr analysis:	and mo ss. oprietors capital n proposa ie metho ND and according a Analysis	Classe phip, partner Classe requirement ls; Method od and inter Classe counting c ccount, pre- and inter	competition rship, joint es: 10 ts, method ls of capita rnal rate of es : 10 onventions of it and lo rpretation
Types of competition an orice-output determination Features and evaluation tock company, public er MODULE – IV CAI Capital and its significant und sources of raising car pudgeting: Payback period eturn method (simple pr MODULE – V Financial accounting ob louble-entry book keep account and balance sl	ad markets, features of per on in case of perfect comp of different forms of bus nterprises and their types. PITAL BUDGETING nce, types of capital, estin apital, capital budgeting: iod, accounting rate of re- roblems). CRODUCTION TO FINA (ANCIAL ANALYSIS jectives, functions, impor- ing, journal, ledger, trial heet with simple adjust:	mation feature eturn(<i>A</i> ANCL rtance; balan ments;	and fine organi of fine es of c ARR), AL A ; Acco ace; F ; Fina	etition, monopo zations ced and capital net pr CCOU counting inal ac ncial	RONMEN monopoly oly busines s: Sole pro d working budgeting resent valu INTING A g concepts counts: Tr analysis:	and mo ss. oprietors capital n proposa ie metho ND and according a Analysis	Classe phip, partner Classe requirement ls; Method od and inter Classe counting c ccount, pre- and inter	competition rship, joint es: 10 ts, method ls of capita rnal rate of es : 10 onventions of t and lo rpretation

3. Varshney, Maheswari, "Managerial Economics", Sultan Chand Publications, 11th Edition, 2009. **Reference Books:**

- S. A. Siddiqual, A. S. Siddiqual, "Managerial Economics and Financial Analysis", New Age International Publishers, Hyderabad, Revised 1st Edition, 2013.
- 2. S. N. Maheswari, S. K. Maheswari, "Financial Accounting", Vikas publications, 3rd Edition, 2012.
- 3. J. V. Prabhakar Rao, P. V. Rao, "Managerial Economics and Financial Analysis", Maruthi Publishers, Reprinted Edition, 2011.
- 4. Vijay Kumar, Appa Rao, "Managerial Economics and Financial Analysis", Cengage Publications, 1st Edition, Paperback, 2011.

Web References:

- 1. https:// www.slideshare.net/glory1988/managerial-economics-and- financial analysis
- 2. https:// thenthata.web4kurd.net/mypdf/managerial-economics-and- financial analysis
- 3. https:// bookshallcold.link/pdfread/managerial-economics-and-financial analysis
- 4. https:// www.gvpce.ac.in/syllabi/Managerial Economics and financial analysis

- 1. https:// books.google.co.in/books/about/Managerial economics and financial analysis
- 2. http://www.ebooktake.in/pdf/title/managerial-economics-and-financial analysis
- 3. http://all4ryou.blogspot.in/2012/06/mefa-managerial-economics and financial analysis
- 4. http://books.google.com/books/about/Managerial economics and financial analysis
- 5. http://www.scribd.com/doc/37684926

DIGITAL SIGNAL PROCESSING LABORATORY

Course Code		Category	Hours	/Weel	ĸ	Credits	Max	timum N	Aarks
AECB25		Core	L	Т	Р	С	CIA	SEE	Total
ALCD25		Core	-	-	2	1	30	70	100
Contact Classes: N	il	Tutorial Classes: Nil	Pra	octical	Class	es: 24	Total	Classes:	24
I. Implementation II. Implementation III. Understand the	on of co on of di he real-	le the students to: onvolution in MATLAB gital signal processing a time operation of digita te signal processing algo	algorithn 1 filters.	ns in M	IATL	AB and C.			
		LIST OF	EXPER	IMEN	TS				
WEEK-1 LINE	EAR C	ONVOLUTION VS C	IRCUL	AR CC	ONVO	LUTION			
		lution without using bui volution without using b					onv in M	ATLAB	
WEEK -2 DFT	AND I	DFT							
Compute the Discre	te Four	ier Transform and IDFT	with ar	d with	out fft	and ifft in	MATLA	В	
WEEK -3 OVE	RLAP	ADD AND OVERLAP	-SAVE	METI	HODS				
Implementation of L	Linear c	convolution using DFT ((Overlap	add an	d Over	rlap-Save n	nethods)		
WEEK - 4 DIT-									
Implementation of I	Decima	tion-in-time radix-2 FF	Γ algorit	hm					
		LGORITHM							
Implementation of I	Decima	tion-in-frequency radix-	-2 FFT a	lgorith	m				
		AL FILTERUSING BU RMATION	U TTER	WOR	TH MI	ETHOD A	ND BIL	INEAR	
Implementation of I	IR digi	tal filter using Butterwo	orth meth	od and	l biline	ear transform	mation		
	_	Filter Using Chebyshev							
Implementation of I	IR digi	tal filter using Chebyshe	ev (Type	e I and	II) me	thod			
		AL FILTER USING V							
Implementation of F	FIR dig	ital filter using window	(Rectan	gular, l	Hamm	ing, Hannir	ng, Bartl	ett) meth	nods.
WEEK -9 FIR I	DIGIT	AL FILTER USING F	REQUI	ENCY	SAMI	PLING MI	ETHOD		
	ID dia	ital filter using frequenc	v campl	ing ma	thod				

r	
WEEK 10	OPTIMUM EQUIRIPPLE FIR DIGITAL FILTER
Implementatio	on of optimum equiripple FIR digital filter using window methods
WEEK 11	DTMF TONE GENERATION AND DETECTION
DTMF Tone C	Generation and Detection Using Goertzel Algorithm
WEEK 12	SAMPLING RATE CONVERSION
Implementation MATLAB	on of sampling rate conversion by decimation, interpolation and a rational factor using
WEEK 13	SINE WAVE GENERATION
a) Implementa MATLAB	tion of DFT b) Sine wave generation using lookup table with values generated from
WEEK 14	IIR AND FIR FILTERS USING DSP KITS
IIR and FIR F	ilter Implementation using DSP Kits
Reference Bo	oks:
Thomson 2. Vinay K. 2009. 3. DSK Don	chilling,Sandra.L.harris, "Fundamentals of Digital Signal Processing using MATlab", Engineering, 2 nd Edition,2005. Ingle , John G. Proakis, "Digital Signal Processing Using MATlab", Cengage 4 th Edition, ald Reay, Rulph Chassaing, "Digital Signal Processing and Applications with the TMS 3 and TMS 320C6416" Wiley 2 nd Edition.
Web Referen	ces:
%20v4 2. http://v 3. https:// 4. http://v	www.ece.iit.edu/~biitcomm/Yarmouk/Digital%20Signal%20Processing%20Using%20Matlab .0%20(John%20G%20Proakis).pdf web.mit.edu/acmath/matlab/course16/16.62x/16.62x_Matlab.pdf www.mathworks.com/solutions/dsp.html www.iare.ac.in VARE AND HARDWARE REQUIREMENTS FOR A BATCH OF 36 STUDENTS
	E: Desktop Computer Systems 18 nos and TMS 320C6713 DSP kits : MATLAB, CCStudio_v3.1

MICROPROCESSORS AND MICROCONTROLLERS LABORATORY

VI Semester	r: ECE <mark>V S</mark> e	mester: EEE							
Cours	se Code	Category	Ho	ours / W	eek	Credits	Maxin	num M	arks
			L	Т	Р	С	CIA	SEE	Total
AEO	CB26	Core	-	-	2	1	30	70	100
Contact (Classes: Nil	Tutorial Classes: Nil	Р	ractical	Classe	s: 24	Total	Classe	s: 24
I. Develo II. Unders applica III. Learn	should enable op assembly levestanding the invations. assemble langu	the students to: vel programs and providi terfacing of external devi tage programming using ogramming using microp	ces to t 8051 m	he proce	essor an troller.	d controlle		rious	
		LIST OF E	XPER	IMENT	S				
WEEK - I	DESIGN A P	PROGRAM USING WI	N862						
 a) Progra b) Execut c) Debug To Demonst 	ition gging rate the win 86	52 software and Trainer k			-	essor			
		perform 16 Bit arithmetic				using WI	N862 sof	ftware	
WEEK-3	MULTIBYT	E ADDITION AND SU	BRAC	TION		_			
		m to perform multi byte a m to perform 3*3 matrix							
WEEK -4	PROGRAMS	S TO SORT NUMBERS	5						
		m to perform ascending o m to perform descending							
WEEK -5	PROGRAMS	S FOR STRING MANI	PULAT	FIONS (OPERA	TIONS			
b) Write ac) Write a	in ALP program in ALP program	m to insert or delete a byt m to search a number/cha m to move a block of data m for reverse of a given s	aracter i a from	n a give	n string		e othe		
WEEK -6	CODE CON	VERSIONS							
b) Write a	in ALP program	n to convert packed BCE n to convert packed BCE n to convert hexadecima	to AS	CII	BCD				

WEEK -7	INTERFACING STEPPER MOTOR
	an ALP program to rotate stepper motor in clockwise direction an ALP program to rotate stepper motor in anti clockwise direction
WEEK -8	INTERFACING ADC & DAC DEVICES
	n ALP program to convert analog to digital using 8086 n ALP program to convert digital to analog using 8086
WEEK-9	INTERFACING KEYBOARD TO 8086
Write an AL	P program to interface keyboard to 8086
WEEK-10	SERIAL AND PARALLEL COMMUNICATION
	el communication between two microprocessors using 8255 communication between two microprocessor kits using 8251
WEEK-I1	INTERFACING TRAFFIC LIGHT CONTROLLER AND TONE GENERATOR
	a program to interface traffic light controller an ALP program to interface tone generator
WEEK-l2	ARITHMETIC AND LOGICAL OPERATIONS USING 8051
Write an AL	P program to perform 16 Bit arithmetic and logical operations using 8051 microcontroller
WEEK-13	TIMER/COUNTER
Write an AL	P Program and verify Timer/Counter using 8051
WEEK-l4	INTERFACING KEYBOARD TO 8051
Write an AL	P program to interface keyboard to 8051
Reference B	ooks:
2. Muhamr	I, Bhurchandi K.M, -Advanced Microprocessor and Peripherals , 2/e TMH, 2012 nad Ali Mazidi, J.G. Mazidi and R.D McKinlay, -The 8051 Microcontroller and Embedded using Assembly and C , 2 nd Edition, Pearson education, 2009.
Web Refere	nces:
2. http://w	ww.nptel.ac.in/downloads/106108100/ ww.the8051microcontroller.com/web-references ww.iare.ac.in ne Page:
HA	RDWARE AND SOFTWARE REQUIRED FOR A BATCH OF 24 STUDENTS
	RE: Desktop Computer Systems 24 nos
SOFTWAL	RES: win 862

VLSI DESIGN

	Category	He	ours / We	ek	Credits	Maxi	imum N	Iarks
	2	L	Т	Р	С	CIA	SEE	Total
AECB27	Core	3	-	-	3	30	70	100
Contact Classes: 4	5 Tutorial Classes: Nil	I	Practical	Classes:	: Nil	Tota	Classe	s: 45
I. Analyze MOS 7II. Develop abilityIII. Explore the des	enable the students to: Fransistors, CMOS Fabrica to analyze MOS circuits ir ign metrics of circuits like DRAM, Serial access and	n super-th power, p	reshold a ower diss	ind sub-tipation s	static and dy			n
MODULE-I	INTRODUCTION TO M	IOS TRA	NSISTC	RS			Class	es:09
Packaging, and Test	CMOS Logic, CMOS F ing, MOS transistor Theo s, DC Transfer Characteris	ory, Long						
MODULE-II	PRINCIPLES OF CIRCU	UIT DES	SIGN				Class	es:09
Technology-Related Models, Device Cha Design, Circuit Fan Circuit Design, Cir	echnology, CMOS Techno CAD Issues, Manufactur racterization, Circuit Char tilies, Silicon-On-Insulator cuit Design of Latches c Circuits, Synchronizers, V	ring Issu acterizati Circuit and Flip	es, Circu ion, Inter Design, -Flops, S	it Simul connect Sub Thr	lation, A SI Simulation. reshold Circ	PICE Tu Combin uit Desi	utorial, ational gn. Sec	Device Circuit uential
MODULE-III	DESIGN METRICS ANI			DEGLO				
	DESIGN METRICS AN	D SUB S	YSTEM	DESIGI	N		Class	es: 10
Power, Sources of Power Architectures Variation-Tolerant I Effort of Paths, Timi Datapath Subsystem	Power Dissipation, Dynam s, Robustness, Variability Design. Delay, Transient 1 ng Analysis Delay Models s, Addition/Subtraction, O Shifters, Multiplication	nic Powe , Reliab Response ,	er, Static pility, Sca e, RC De	Power, aling, S lay Moo	Energy-Del tatistical An del, Linear	nalysis Delay N	mization of Vari Iodel, l	n, Low ability, Logical
Power, Sources of Power Architecture: Variation-Tolerant I Effort of Paths, Timi Datapath Subsystem Operations, Coding,	Power Dissipation, Dynam s, Robustness, Variability Design. Delay, Transient I ng Analysis Delay Models s, Addition/Subtraction, O	nic Powe 7, Reliab Response , ne/Zero	er, Static vility, Sca e, RC De Detectors	Power, aling, S lay Moo	Energy-Del tatistical An del, Linear	nalysis Delay N	mization of Vari Model, I oolean I	n, Low ability, Logical
Power, Sources of Power Architectures Variation-Tolerant I Effort of Paths, Timi Datapath Subsystem Operations, Coding, MODULE-IV Array Subsystems,	Power Dissipation, Dynam s, Robustness, Variability Design. Delay, Transient I ng Analysis Delay Models s, Addition/Subtraction, O Shifters, Multiplication	nic Powe y, Reliab Response , ne/Zero IEMOR ly Memo	er, Static vility, Sca e, RC De Detectors IES Dry, Seria	Power, aling, S lay Moo , Compa	Energy-Del tatistical An del, Linear arators, Cou	nalysis Delay M nters, B	mization of Vari Aodel, 1 oolean 1 Class nt-Addr	n, Low ability, Logical Logical es: 09
Power, Sources of Power Architectures Variation-Tolerant I Effort of Paths, Timi Datapath Subsystem Operations, Coding, MODULE-IV Array Subsystems, Memory, Programma	Power Dissipation, Dynam s, Robustness, Variability Design. Delay, Transient I ng Analysis Delay Models s, Addition/Subtraction, O Shifters, Multiplication ROBUST DESIGN OF M SRAM, DRAM, Read-On	nic Powe y, Reliab Response , ne/Zero IEMOR ly Memo	er, Static vility, Sca e, RC De Detectors IES Dry, Seria	Power, aling, S lay Moo , Compa	Energy-Del tatistical An del, Linear arators, Cou	nalysis Delay M nters, B	mization of Vari Aodel, 1 oolean 1 Class nt-Addr	n, Low ability, Logical Logical es: 09
Power, Sources of J Power Architectures Variation-Tolerant I Effort of Paths, Timi Datapath Subsystem Operations, Coding, MODULE-IV Array Subsystems, Memory, Programma MODULE-V Packaging and Coo	Power Dissipation, Dynam s, Robustness, Variability Design. Delay, Transient I ng Analysis Delay Models s, Addition/Subtraction, O Shifters, Multiplication ROBUST DESIGN OF M SRAM, DRAM, Read-On able Logic Arrays, Robust	nic Powe y, Reliab Response ne/Zero IEMOR ly Memory Clocks,	er, Static bility, Sca c, RC De Detectors IES Dry, Seria Design, S PLLs and	Power, aling, S lay Moo , Compa l Acces Special-H	Energy-Del tatistical An del, Linear arators, Cou s Memories Purpose Sub I/O, High-	nalysis Delay M nters, B , Conter systems.	mization of Vari Iodel, 1 oolean 1 Class nt-Addr Class	n, Low ability, Logical cogical es: 09 essable es: 08
Power, Sources of Power Architectures Variation-Tolerant I Effort of Paths, Timi Datapath Subsystem Operations, Coding, MODULE-IV Array Subsystems, Memory, Programma MODULE-V Packaging and Coo	Power Dissipation, Dynam s, Robustness, Variability Design. Delay, Transient I ng Analysis Delay Models s, Addition/Subtraction, O Shifters, Multiplication ROBUST DESIGN OF M SRAM, DRAM, Read-On able Logic Arrays, Robust TESTING ling, Power Distribution,	nic Powe y, Reliab Response ne/Zero IEMOR ly Memory Clocks,	er, Static bility, Sca c, RC De Detectors IES Dry, Seria Design, S PLLs and	Power, aling, S lay Moo , Compa l Acces Special-H	Energy-Del tatistical An del, Linear arators, Cou s Memories Purpose Sub I/O, High-	nalysis Delay M nters, B , Conter systems.	mization of Vari Aodel, 1 oolean 1 Class nt-Addr Class	n, Low ability, Logical cogical es: 09 essable es: 08

Addision – Wesley, 2011

- 2. Jan M Rabey, "Digital Integrated Circuits," 2ndEdition, Pearson Education, 2003.
- 3. John F.Wakerly, "Digital Design Principles & Practices", 3rd Edition, 2005, PHI/ Pearson Education Asia,

Reference Books:

- 1. Wang Alice, Calhoun Benton High smith, Chandrakasan Anantha P., "Sub-threshold Design for Ultra Low-Power Systems," Springer 2006
- 2. Pucknell, Kamran Eshraghian, "Basic VLSI Design," Third Edition, Prentice Hall of India, 2007.
- 3. R. Jacob Baker, Harry W.LI., David E.Boyee, "CMOS Circuit Design, Layout and Simulation", Wiley-IEEE Press, USA, 2005. ISBN: 978-0-470-88132-3
- 4. Calhoun, B., C. Schurgers, A. Wang, A. Chandrakasan, "Low Energy Digital Circuit Design," in *Hardware Technology Drivers of Ambient Intelligence*, editors Satyen Mukherjee, 2006 Springer.
- 5. Park, Synghyun, "Towards Low-Power yet High-Performance Networks-on-Chip," Ph.D. Thesis, Massachusetts Institute of Technology, September 2014.
- 6. Sinangil, Mahmut, "Low-Power and Application-Specific SRAM Design for Energy-Efficient Motion Estimation," *Ph.D. Thesis* Massachusetts Institute of Technology, June 2012
- 7. Amirtharajah, Rajeevan, "Design of Low Power VLSI Systems Powered by Ambient Mechanical Vibration," *Ph.D. Thesis*, Massachusetts Institute of Technology, May 1999.

Web References:

- 1 http://dspace.mit.edu/handle/1721.1/93776
- 2 http://dspace.mit.edu/handle/1721.1/75650
- 3 https://engineering.purdue.edu/~vlsi/ECE559_Fall09/?_ga=2.120672008.1227662350.1573631317 316737531.1573631317
- 4 Class Notes: http://cobweb.ecn.purdue.edu/~vlsi/ECE559_Fall09

- 1. https://www.springer.com/gp/book/9780387335155
- 2. http://swarm.cs.pub.ro/~mbarbulescu/SMPA/CMOS-VLSI-design.pdf

SATELLITE AND MICROWAVE ENGINEERING

Course Code	Category	Ho	urs / W	eek	Credits	M	aximum	Marks
AECB28	Core	L	Т	Р	С	CIA	SEE	Total
ALCD20	Core	3	-	-	3	30	70	100
Contact Classes: 45 OBJECTIVES:	Tutorial Classes: Nil	P	ractica	l Class	es: Nil	Tot	al Classe	s: 45
satellite in GEO. II. Analyze the Satelli command system. III. Perceive the concep Waveguides. IV. Categorize different V. Imbibe knowledge	e concept of Satellite com te link budget and explain pts of waveguides and an at types of microwave cor to use microwave oscilla	n the sat alyze th nponent	tellite su e field o ts based	ubsyste compo l on the	ems like teler nents in diffe vir applicatio	metry, tr erent typ ns.	cacking an	nd
	RODUCTION TO SAT	ELLIT	E CON	IMUN	ICATION A	AND	Classe	es: 08
mechanics: Orbital eler Inclined orbits; Orbital GEO satellite sub syste	ad future trends of satellito ments; Locating the satell perturbations; Eclipse of ems; Satellite link; Propag	ite with GEO sa	respect atellite;	t to the	earth; Cover	rage ang	gle; Slant	range;
	FFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFFF	IC & M						
MODULE -II MUI	ELLITE SUB-SYSTEM	EMES					Classe	
MULTING ACCESS: Freque demand assignment mu Multiple Access (SSM reception, adjacent cha Transmitters, receivers		EMES ccess (F code Div IA (DS odulations, terror	DMA), vision N -CDMA on, hanc estrial i	Time of Aultiple A) or D lover, s nterfac	livision mul e Access (CI S spread spe satellite dive e, power tes	OMA) / ectrum ti rsity. Ea	cess (TDM Spread S cansmission arth Static	MA, pectrun on and on:
MULTING ACCESS: Freque demand assignment mu Multiple Access (SSM, reception, adjacent cha Transmitters, receivers considerations, VSAT	LTIPLE ACCESS SCHI lency division multiple ac altiple access (DAMA). C A); Direct sequence CDM nnel interference, inter m , antennas, tracking system	EMES ccess (F code Div IA (DS- odulations, terror crminal)	DMA), vision N -CDMA on, hanc estrial i System	Time of Aultiple A) or D dover, s nterfac as and F	division mul e Access (CI S spread spe satellite dive e, power tes Problems	OMA) / ectrum ti rsity. Ea	cess (TDM Spread S cansmission arth Static	MA, pectrun on and on: orbit
MULTE - III MULTE - III MULTE - III MULTE - III MULTE - III MULTE - III MULTE - III INT: APP Introduction, Analysis impedance for a TM mode characteristics of resonators; illustrative	LTIPLE ACCESS SCH nency division multiple ac altiple access (DAMA). C A); Direct sequence CDM nnel interference, inter m , antennas, tracking system (Very Small Aperture Ter RODUCTION,WAVEG LICATIONS of rectangular wavegui and TE wave in rectang of phase velocity, group problems.	EMES ccess (F. code Div IA (DS- odulations, terror rminal) UIDE (de ; W ular wa veloci	DMA), vision N -CDMA on, hanc estrial i System COMP Vave im veguida	Time of Aultiple A) or D dover, s nterfac is and F ONEN pedano e, Don velengt	division mul e Access (CI S spread spe satellite dive e, power test Problems TS AND TE in rectan ninant mode th and impo	DMA) / cctrum tr rsity. Ea t methoo gular we and de edance	cess (TDN Spread S cansmission arth Static ds, lower Classe vaveguide egenerate relations;	MA, pectrum on and on: orbit es: 09 e: Wave modes Cavity
MULE -III MUL Multiple Access: Frequ demand assignment mu Multiple Access (SSM. reception, adjacent cha Transmitters, receivers considerations, VSAT MODULE -III INT: APP Introduction, Analysis impedance for a TM mode characteristics of resonators; illustrative Wave guide multiport j	LTIPLE ACCESS SCH nency division multiple ac ultiple access (DAMA). C A); Direct sequence CDM nnel interference, inter m , antennas, tracking syster (Very Small Aperture Ter RODUCTION,WAVEG LICATIONS of rectangular wavegui and TE wave in rectang of phase velocity, group problems.	EMES ccess (F. code Div IA (DS- odulations, terror cons,	DMA), vision N -CDMA on, hance estrial i System COMP Vave introveguidation ity, wata	Time of Aultiple A) or D dover, s nterfac is and F ONEN pedance, Don velengt tation p	division mul e Access (CI S spread spe satellite dive e, power tes Problems TS AND ce in rectan ninant mode th and impe- principle, gyp	DMA) / cctrum tr rsity. Ea t methoo gular we and de edance	cess (TDN Spread S cansmission arth Static ds, lower Classe vaveguide egenerate relations;	MA, pectrun on and on: orbit es: 09 e: Wave modes Cavity
MULTE - III MULTE - III MULTE - III MULTE - III MULTE - III MULTE - III MODULE - III	LTIPLE ACCESS SCH nency division multiple ac altiple access (DAMA). C A); Direct sequence CDM nnel interference, inter m , antennas, tracking system (Very Small Aperture Ter RODUCTION,WAVEG LICATIONS of rectangular wavegui and TE wave in rectang of phase velocity, group problems.	EMES ccess (F. code Div IA (DS- odulations, terror critical) CUIDE (de ; W ular wa veloci tes: Fara BEAM	DMA), vision N -CDMA on, hand estrial i System COMP Vave im veguida ity, wav aday rot	Time of Aultiple A) or D dover, s nterfac is and F ONEN pedance, Don velengt tation p	division mul e Access (CI S spread spe satellite dive e, power tes Problems TS AND ce in rectan ninant mode th and impe- principle, gyp	DMA) / cctrum tr rsity. Ea t methoo gular we and de edance	cess (TDN Spread S cansmission arth Static ds, lower Classe vaveguide egenerate relations;	MA, pectrum on and on: orbit es: 09 c: Wave modes Cavity culator

MODULE -V	MICROWAVE SOLID-STATE DEVICES & MICROWAVE MEASUREMENTS	Classes: 09
Microwave solid	-state devices: Microwave tunnel diode; Transferred electron	devices: Gunn-effec
diodes, Avalanch	e transit time devices: IMPATT diode, TRAPATT diode, BARI	TT diode, Pin diodes
varactor diodes, o	rystal detectors. Description of microwave bench: Different bloc	cks and their features
precautions; Mic	rowave power measurement: Bolometer; Measurement of at	tenuation; Frequency
standing wave me	asurements: measurement of low and high VSWR; Cavity Q; Impe	edance measurements.
Text Books:		
1. Dennis roddy,	"Satellite Communications", 4 th Edition, 2004.	
2. Pratt. Bostian,	Allnutt, "Satellite Communications", Wiley India, 2 nd Edition, 200	6.
3. Gérard Maral,	"Satellite Communication Systems", 1993.	
4. Tri T. Ha, "Dig	gital Satellite Communications", TMH, 2 nd Edition, 1990.	
5. Samuel Y. Lia	o, "Microwave Devices and Circuits", Pearson, 3 rd Edition, 2003.	
	h, J.G. Skalnik, P.F. Ordung and H.L. Krauss, "Microwave Princips, New Delhi, 1 st Edition, 2004.	oles", CBS Publishers
	Electronic and Radio Engineering", Tata McGraw-Hill Publication	ns, 4 th Edition,1955.
Reference Books	:	
1. Rappaport T.S	., "Wireless communications", Pearson Education, 2 nd Edition, 201	0.
2. Bruce Elbert, "	Introduction to Satellite Communications", 1987.	
3. M Richharia, "	Satellite Communication Systems", R.E. Collin MacMillan, 2 nd Ed	dition, 2005.
Web References:		
1. http://nptel.ac.	in/courses/106105082/33	
2. http://onlineco	urses.nptel.ac.in/noc16_ec10/preview	
3. https://onlineco	purses.nptel.ac.in/noc16_ec10/preview http://nptel.ac.in/courses/11	7101119/1
4. http://www-gro	oup.slac.stanford.edu/kly/Lecture_Series/slac_klystron_lecture_ser	ies.htm
	oogle.co.in/books?id=ZU19Uemy83YC&printsec=frontcover&dq=	microwave+
5. https://books.g		merowaver

E-Text Books:

1.https://ecedmans.files.wordpress.com/2014/10/microwave-devices-and-circuits-samuel-liao.pdf

2.http://www.faadooengineers.com/threads/11621-Microwave-engineering-ebook-pdf-Free-Download 3.http://www2.electron.frba.utn.edu.ar/~jcecconi/Bibliografia/Ocultos/Libros/Microwave_Engineering_D avid_M_Pozar_4ed_Wiley_2012.pdf.

VLSI DESIGN LABORATORY

Course Code	Category	Ho	ours / W	'eek	Credits	Max	imum N	Aarks
AECB29	Core	L	Т	Р	С	CIA	SEE	Tota
AE\.D27	Core	-	-	3	1.5	30	70	100
Contact Classes: Nil OBJECTIVES:	Tutorial Classes: Nil	Р	ractical	Classe	es: 36	Tota	l Classe	es: 36
	concepts about MOS device ation steps of IC design and am and layout of a circuit	nd desig						
	LIST OF E	XPER	IMENT	S				
WEEK - I MOSFET								
Γο plot the (i) Output chara		-			FETs.			
(ii) Transfer characteristics	of an n-channel and p-ch	annel N	NOSFE	ſs.				
Find Drain current of an n-	channel and p-channel M	OSFET	ſs.					
WEEK-2 CMOS INV	ERTER							
Γo design and plot the stati	ic (VTC) and dynamic cha	aracteri	stics of	a digita	al CMOS in	nverter.		
Find $V_{\rm M}$ and Noise Margin	of CMOS inverter at β ra	tio of 1	, 1.5, ar	nd 2 res	pectively.			
WEEK-3 RING OSC	ILLATOR							
To design and plot the outp	out characteristics of a 9-s	tage rir	ng oscill	ator.				
Find frequency of oscillation	ons, phase noise and powe	er of 9-	stage rir	ng oscil	lator.			
WEEK -4 LOGIC GA				0				
To design 2-input NAND, Find static power, dynamic delay product (EDP) of 2-i	power, total power, prop	agation	delay,	power of	delay prodi			energy
WEEK -5 4×1 MULT	IPLEXER							
To design and plot 4×1 mu	ltiplexer using pass transi	stor an	d transn	nission	gate logic	families	•	
					delay, pow	er delay	produc	t (PDP
		in both	logic fa	milies.				
Find and compare static po and energy delay product (WEEK -6 LATCHES		in both	logic fa	milies.				

WEEK -7 REGISTERS

To design and plot the characteristics of a master-slave positive and negative edge triggered registers based on multiplexers.

Find static power, dynamic power, total power, propagation delay, power delay product (PDP), and energy delay product (EDP)

WEEK -8 DIFFERENTIAL AMPLIFIER

Design and simulation of a simple 5 transistor differential amplifier. Find out gain, transconductance (g_m) ICMR, and CMRR.

WEEK-9 NMOS INVERTER AND CMOS INVERTER

To design layout of NMOS and CMOS inverter.

Verify Design Rule Check (DRC) Layout versus Schematic (LVS)

WEEK-10 LAYOUT OF 2-INPUT NAND, NOR GATES

To design the layout of 2-input NAND, NOR gates.

Verify Design Rule Check (DRC) Layout versus Schematic (LVS)

WEEK-11 COMMON SOURCE AMPLIFIER

Analysis of Frequency response of Common source amplifiers. Find out gain, transconductance (g_m) ICMR, and CMRR.

WEEK-12 COMMON DRAIN AMPLIFIER

Analysis of Frequency response of Common drain amplifiers. Find out gain, transconductance (g_m) ICMR, and CMRR.

WEEK-13 SINGLE STAGE CASCODE AMPLIFIER

Design and Simulation of Single Stage Cascode Amplifier. Find out gain, transconductance (g_m) ICMR, and CMRR.

WEEK-14 BASIC CURRENT MIRROR, CASCODE CURRENT MIRROR AMPLIFIER

Design and Simulation of Basic Current Mirror, Cascode Current Mirror Amplifier. Find out gain, transconductance (g_m) ICMR, and CMRR.

Reference Books

- 1. Razavi, Design of Analog CMOS Integrated Circuits, Tata McGraw Hill Publications, 2002.
- 2. Allen Holberg, CMOS Analog Circuit Design, Oxford Publications, 2002.
- 3. Baker, Li, Boyce, CMOS Mixed Circuit Design, Wiley Publications, 2002.

Web References:

1. http://ee.usc.edu/~redekopp/ee209/virtuoso/setup/USCVLSI-VirtuosoTutorial.pdf

SOFTWARE AND HARDWARE REQUIREMENTS FOR 36 STUDENTS

HARDWARE: Desktop Computer Systems: 36 SOFTWARE: Cadence Virtuoso Tools

ANTENNAS AND MICROWAVE ENGINEERING LABORATORY

Cours	e Code	Category	Hou	rs / W	eek	Credits	Max	kimum N	Marks
AE	СВ30	Core	L	Т	Р	С	CIA	SEE	Tota
			0	0	3	1.5	30	70	100
OBJECTThe courtI.MeaII.EvaIII.Des	se should en asure the para luate scatteri ign and Eval	Total Tutorials: Nil able the students to: ameters using microwave cong parameters of different function uate the microwave antenna formance of an antenna in 3	omponer nicrowa as perfor	its. ve jund	ctions.	asses: 36	100	al Class	<u>cs. 30</u>
		LIST OF H	EXPERI	MEN	ГS				
Week-1	STUDY O	F MICROWAVE COMP	LONEN	TS					
To stu	dy the differe	ent wave guide components	in the m	icrow	ave bei	nch setup.			
Week-2	MODE CH	HARACTERISTICS OF I	REFLEX	KLY	STRO	N			
	dy the charac ncies of diffe	cteristics of Reflex Klystron erent modes.	oscillat	or, find	ding th	e mode nun	nbers ar	nd	
Week-3	GUNN DI	ODE CHARACTERISTI	CS						
To stu	dy the charac	cteristics of Gunn diode osc	illator.						
Week-4	DIRECTI	ONAL COUPLER CHAR	ACTER	RISTIC	CS				
To me	asure couplin	ng factor, insertion loss, iso	lation an	d direc	ctivity	of a Directi	onal cou	ıpler.	
Week-5	MEASUR	EMENT OF VSWR							
To me	asure the low	v and high VSWR's of mate	ched tern	ninals.					
Week-6	CIRCULA	TOR CHARACTERIST	ICS						
To me	asure the iso	lation and insertion loss of	a three p	ort cire	culator	•			
Week-7	MEASUR	MENT OF SCATTERIN	G PARA	MET	ERS O	F MAGIC	TEE		
To fine	d the scattering	ng parameters of a four por	t Magic '	Гее.					
Week-8	INTRODU	UCTION TO HFSS							
Introdu	uction To HF	ESS Tool							
Week -9	MONOPO	OLE ANTENNA DESIGN	J						
To fin	d the gain of	Monopole Antenna							

Week-10	DIPOLE ANTENNA DESIGN
To dra	w the Radiation Pattern of Dipole Antenna Design
Week-11	MICROSTRIP FEED ANTENNA DESIGN
To fine	d the gain and radiation pattern of Microstrip Feed Antenna Design
Week-12	PROBE FEED PATCH ANTENNA DESIGN
To dra	w the 3D polar plot of Probe Feed Patch Antenna Design
Week-13	SLOT COUPLED PATCH ANTENNA
To dra	w the 3D rectangular plot of Slot Coupled Patch Antenna
Week-14	MICROSTRIP LINE DESIGN
To fine	d the gain of Microstrip Line Design
Reference l	Books
 Herber Publi F.E. 7 1955. John 	 V. Liao, "Microwave Devices and Circuits", Pearson, 3rd Edition, 2003. ertJ.Reich, J.G.Skalnik, P.F.Ordungand H.L.Krauss, "Microwave Principles", CBS shers and Distributors, New Delhi, 1st Edition, 2004. Ferman, "Electronic and Radio Engineering", Tata McGraw-Hill Publications, 4th Edition, D. Kraus, Ronald J. Marhefka, Ahmad S. Khan, "Antennas and Wave Propagation", 4th Edition, 2010.
Web Refer	ences:
2. http://v 3. http://v	www.ee.iitkgp.ac.in www.citchennai.edu.in www.ansys.com WARE AND HARDWARE REQUIREMENTS FOR A BATCH OF 24 STUDENTS
HARDWA	RE: Desktop Computer Systems 24 nos

SOFTWARE : ANSYS HFSS TOOL

LIST OF EQUIPMENT REQUIRED FOR A BATCH OF 24 STUDENTS

S. No	Name of the Equipment	Range/Model
1	Klystron Based Microwave Bench Setup	
2	Gunn diode Based Microwave Bench Setup	
3	VSWR Meter	
4	FUNCTION GENERATOR	0-1 MHz
5	Slotted Line	
6	Magic Tee	
7	Circulator	
8	Directional Coupler	
9	Variable Attenuator	
10	Matched Terminator	
11	Cathode Ray Oscilloscope	(0-30) MHz
12	Dc Regulated Power Supply	(0-30) V

PROJECT WORK - I

VII Semester: Commo	VII Semester: Common for all branches									
Course Code	Category	Ho	urs / W	eek	Credits	Ma	Maximum Marks			
	C	L	Т	Р	С	CIA	SEE	Total		
AECB61	Core	-	-	10	5	30	70	100		
Contact Classes: Nil	Tutorial Classes: Nil	P	ractica	l Classe	es: 150	Tota	l Classe	s: 150		

The object of Project Work I is to enable the student to take up investigative study in the broad field of Electronics & Communication Engineering, either fully theoretical/practical or involving both theoretical and practical work to be assigned by the Department on an individual basis or two/three students in a group, under the guidance of a Supervisor. This is expected to provide a good initiation for the student(s) in R&D work. The assignment to normally include:

1. Survey and study of published literature on the assigned topic;

2. Working out a preliminary Approach to the Problem relating to the assigned topic;

3. Conducting preliminary Analysis / Modelling / Simulation/Experiment/Design/Feasibility;

4. Preparing a Written Report on the Study conducted for presentation to the Department;

5. Final Seminar, as oral Presentation before a departmental committee.

PROJECT WORK - II

VIII Semester: Commo	VIII Semester: Common for all branches										
Course Code	Category	Ho	urs / W	eek	Credits	Ma	Maximum Marks				
	C	L	Т	Р	С	CIA	SEE	Total			
AECB62	Core	-	-	12	6	30	70	100			
Contact Classes: Nil	Tutorial Classes: Nil	P	ractica	l Classe	es: 180	Tota	l Classes	s: 180			

The object of Project Work II & Dissertation is to enable the student to extend further the investigative study taken up under EC P1, either fully theoretical/practical or involving both theoretical and practical work, under the guidance of a Supervisor from the Department alone or jointly with a Supervisor drawn from R&D laboratory/Industry. This is expected to provide a good training for the student(s) in R&D work and technical leadership. The assignment to normally include:

1. In depth study of the topic assigned in the light of the Report prepared under EEP1;

2. Review and finalization of the Approach to the Problem relating to the assigned topic;

3. Preparing an Action Plan for conducting the investigation, including team work;

4. Detailed Analysis / Modelling / Simulation / Design / Problem Solving / Experiment as needed;

5. Final development of product/process, testing, results, conclusions and future directions;

6. Preparing a paper for Conference presentation/Publication in Journals, if possible;

7. Preparing a Dissertation in the standard format for being evaluated by the Department.

8. Final Seminar Presentation before a Departmental Committee.

INTRODUCTION TO MEMS

	Category	Но	urs / W	eek	Credits	Maxi	mum M	1	
AECB31	Elective	L	Т	Р	С	CIA	SEE	Total	
		3	-	-	3	30	70	100	
Contact Classes: 45 DBJECTIVES:	Tutorial Classes: Nil	P	ractica	d Class	ses: Nil	Tot	al Class	es: 45	
II. Educate on the rIII. Understand the iIV. Understand and	ble the students to: wledge of semiconductors udiments of Micro fabrics importance of various sen analyze different material pplications of MEMS to o	ation teo sors and ls used i	chnique d actuat for ME	es. tors MS				eering.	
MODULE -I INTR	ODUCTION						Classe	es: 08	
Introduction to Micro	s of MEMS – Energy fabrication - Silicon ba ical concepts in MEMS - Torsional deflection.	used Ml	EMS p	rocesse	es – New I	Materials	– Revi	ew of	
MODULE -II SENS	SORS AND ACTUATO	RS II					Classe	es: 12	
drive devices – Micro C Thermal couples – Th	Parallel plate capacitors - Grippers – Micro Motors hermal resistors – Thern nents – Case studies of	- Therm mal Bin	nal Sens morph	sing an - App	d Actuation lications –	– Therm Magnetie	al expan c Actua	sion – tors –	
MODULE -III SENS	SORS AND ACTUATO	RS II					Classe		
				traca	analysis of	mechani	cal elen	es: 08	
Applications to Inertia, Piezoelectric sensors a	 Piezoresistive sensor Pressure, Tactile and Flo and actuators – piezoele ile and Flow sensors. 	w sense	ors.			erials – .		nents –	
Applications to Inertia, Piezoelectric sensors a Inertia, Acoustic, Tacti	Pressure, Tactile and Flo and actuators – piezoele	w sense	ors.			erials – .		nents – ions to	
Applications to Inertia, Piezoelectric sensors a Inertia , Acoustic, Tacti MODULE -IV MIC Silicon Anisotropic Etc Deep Reaction Ion Etcl surface micro machinin	Pressure, Tactile and Flo and actuators – piezoele ile and Flow sensors.	ectric ef et Etchin Wet Etc and Sac	ng – D ching – rificial	piezoo ry Etcl Gas Pl Materi	electric mat hing of Silio hase Etchan als – Accele	con – Pla ts – Case eration of	Applicat Classo asma Etc studies sacrifici	ions to es: 08 ching – - Basic al Etch	

and Mirrors - Actuators for Active Optical MEMS.

Text Books:

- 1. Chang Liu, "Foundations of MEMS", Pearson Education Inc., 2006.
- 2. Stephen D Senturia, "Microsystem Design", Springer Publication, 2000.
- 3. Tai Ran Hsu, "MEMS & Micro systems Design and Manufacture" Tata McGraw Hill, New Delhi,2002.

Reference Books:

- 1. Nadim Maluf," An Introduction to Micro Electro Mechanical System Design", Artech House, 2000.
- 2. Mohamed Gad-el-Hak, editor, "The MEMS Handbook", CRC press Baco Raton, 2000
- 3. Julian w. Gardner, Vijay K. Varadan, Osama O. Awadelkarim, "Micro Sensors MEMS and Smart Devices", John Wiley & SonLTD,2002
- 4. James J.Allen, "Micro Electro Mechanical System Design", CRC Press Publisher, 2010
- 5. Thomas M.Adams and Richard A.Layton, "Introduction MEMS, Fabrication and Application," Springer2012.

Web References:

- 1. http://www.http//mail.vdivde-it.de/ut/EMSTO
- 2. https://nptel.ac.in/courses/117105082/
- 3. http://me.umn.edu/courses/me8254/lectnotes.html

- 1. https://www.sanfoundry.com/best-reference-books-introduction-mems/
- 2. http://www.thegreenbook.com/four-types-of-actuators.htm
- 3. https://onlinelibrary.wiley.com/doi/book/10.1002/9780470611807

ELECTRONIC MEASUREMENTS AND INSTRUMENTATION

Course Code	Category	Ho	ours / W	eek	Credits	Ma	ximum 1	Marks
		L	Т	Р	С	CIA	SEE	Total
AECB32	Elective	3	-	-	3	30	70	100
Contact Classes:	45 Tutorial Classes: Ni	I P	Practical	l Class	es: Nil	Tota	l Classe	s:45
I. Acquire a sou measurementII. Provide conceIII. Compare and	enable the students to: nd understanding theory an and apply to DC voltmeters epts and operation of difference contrast different types of on the types of D.C and A.C brid	s, ammete ent signal oscillosco	ers, ohm generat pes.	meters ors and	wave form	analyzer	s.	
MODULE -I	INTRODUCTION TO MI	EASURI	NG INS	STRUN	IENTS		Classes	: 08
	rent meters, ohmmeters, pe, staircase, dual slope in			•			•	•
							Classes	: 09
considerations, appl campling oscillosco	C, block schematic of CR ications, specifications, sp opes, storage oscilloscope measurement, CRO probes	ecial purj es, digita	pose oso	cillosco	pes: Dual	race, dua	requency al beam	/ CRO CROs,
considerations, appl sampling oscillosco	T, block schematic of CR ications, specifications, sp opes, storage oscilloscope	ecial purj es, digita s.	pose osc al stora	cillosco ge CR	opes: Dual t Os, Lissaj	race, dua	requency al beam	/ CRO CROs, quency
considerations, appl sampling oscillosco measurement, phase MODULE -III Signal Generators: A arbitrary waveform a Signal Analyzers: A	T, block schematic of CR ications, specifications, sp opes, storage oscilloscope measurement, CRO probes SIGNAL GENERATOR AF and RF signal generators generator, sweep frequency AF, HF wave analyzers,	ecial purj es, digita s. AND SIC s, sine and generato	pose oso al stora GNAL A d square ors, video	cillosco ge CR ANAL wave go o signa	yzers generators, 1 generators	function ;	requency al beam ures, fre Classes generator cification	7 CRO CROs, quency : 09 rs 1s.
considerations, appl sampling oscillosco neasurement, phase MODULE -III Signal Generators: A arbitrary waveform a	T, block schematic of CR ications, specifications, sp opes, storage oscilloscope measurement, CRO probes SIGNAL GENERATOR AF and RF signal generators generator, sweep frequency AF, HF wave analyzers,	ecial purj es, digita s. AND SIC s, sine and generato	pose oso al stora GNAL A d square ors, video	cillosco ge CR ANAL wave go o signa	yzers generators, 1 generators	function ;	requency al beam ures, fre Classes generator cification	7 CROs, CROs, quency : 09 rs ns. pectrur

MODULE -V TRANSDUCERS

Transducers: Classification, strain gauges, force and displacement, tranducers, resistance thermometers, hotwire anemometers, LVDT, themocouples, synchros; Piezoelectric transducers, variable capacitance transducers; Magneto strictive transducers, measurement of physical parameters: Flow measurement, displacement meters, liquid level measurement, measurement of humidity and moisture, velocity, force, pressure, high pressure, vacuum level, temperature measurements.

Text Books:

- K.Lal Kishore, "Electronic Measurements and Instrumentation", Pearson Education, 2nd Edition, 2010.
- 2. H.S.Kalsi, "Electronic Instrumentation", TMH, 2nd Edition, 2004.
- 3. A. K. Sawhney, "Electrical and Electronics Measurements and Instrumentation", 19th Edition, 2011.

Reference Books:

- David A. Bell, "Electronic Instrumentation and Measurements", Oxford University Press, 1st Edition, 2007.
- 2. A.D.Helbincs, W.D.Cooper, "Modern Electronic Instrumentation and Measurement Techniques", PHI, 56th Edition, 2003.
- 3. B.M.Oliver, J.M.Cage, "Electronic Measurements and Instrumentation", TMH, Reprint, 2009.
- 4. T.R.Padmanabham, "Industrial Instrumentation", Springer, 1stEdition, 2009.

Web References:

- 1. https://www.scribd.com/
- 2. https://www.worldcat.org/
- 3. https://www.infibeam.com/
- 4. https://www.abebooks.co.uk

- 1. https://www.vssut.ac.in/lecture_notes/lecture1423813026.pdf
- 2. fmcet.in/ECE/EC2351_uw.pdf
- 3. https://books.askvenkat.com/tag/measurement-and-instrumentation-lecture-notes-pdf
- 4. https://www.jntubook.com/electronics-measurements-instrumentation-textbook-free-d

NANO ELECTRONICS: DEVICES AND MATERIALS

Course Code	Category	Но	ours / W	eek	Credits	Ma	ximum 1	Marks
AECB33	Elective	L	Т	Р	С	CIA	SEE	Total
ALCD33	Elective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	F	Practica	l Class	es: Nil	Tota	l Classe	s: 45
enable the Nano II. Understand the f MOSFET in the III. Analyze the com materials will be IV. Understand the i presented. MODULE -I OVE CHA	of the art in the areas of sen electronics. Fundamentals of classical CM sub-100nm regime will be e text that needed for non class	MOS tec elaborate sical tra m and c S, NAN	hnology ed. Insistors ompoun	will be with ne ad semie	e discussed a ew device str conductor M LS, NANO	nd the iss ructure an OSFET v	sue in sca ad nano vill be Classes:	aling : 09
typical 65 nm CMOS t	caling theory, Issues in scali echnology. UIREMENTS FOR NON						Descripti	
techniques, Gate oxide Interface states, bulk c	classical MOS transistor. Me thickness scaling trend, Si harge, band offset, stability,	MOS caj iO2 vs l	pacitor, High-k g	Role of gate die	interface quelectrics. Inte	ality and	ssues of	process high-k
techniques, Gate oxide Interface states, bulk c techniques.	e thickness scaling trend, Si	MOS caj iO2 vs l reliabil	pacitor, High-k g	Role of gate die	interface quelectrics. Inte	ality and	l related ssues of	process high-k and IV
techniques, Gate oxide Interface states, bulk c techniques. MODULE -III MET Metal gate transistor: N saturation, ballistic tran SOI – double gate tran Vertical transistors - F	e thickness scaling trend, Si harge, band offset, stability, CAL GATE TRANSISTOR Motivation, requirements, In nsport, injection velocity, ve sistors, integration issues.	MOS caj iO2 vs l reliabil tegration elocity o	pacitor, High-k { ity – Qb n Issues vershoo al source	Role of gate die od high . Transj t. SOI - e/drain	interface que electrics. Inte field, possib port in Nano PDSOI and junctions - P	aality and egration i le candid MOSFE FDSOI.	l related ssues of ates, CV Classes: T, veloci Ultrathin	process high-k and IV 09 ty body
techniques, Gate oxide Interface states, bulk c techniques. MODULE -III MET Metal gate transistor: M saturation, ballistic trans SOI – double gate tran Vertical transistors - F junctions on Silicon, C	e thickness scaling trend, Si harge, band offset, stability, CAL GATE TRANSISTOR Motivation, requirements, In nsport, injection velocity, ve sistors, integration issues.	MOS caj iO2 vs l reliabil tegration clocity o ET. Meta	pacitor, High-k { ity – Qb n Issues vershoo al source	Role of gate die od high . Transj t. SOI - e/drain	interface que electrics. Inte field, possib port in Nano PDSOI and junctions - P	aality and egration i le candid MOSFE FDSOI.	l related ssues of ates, CV Classes: T, veloci Ultrathin	process high-k and IV 09 ty body ky
techniques, Gate oxide Interface states, bulk c techniques. MODULE -III MET Metal gate transistor: N saturation, ballistic tran SOI – double gate tran Vertical transistors - F junctions on Silicon, C MODULE -IV GER Germanium Nano MO NMOS. Compound set the context of channel	e thickness scaling trend, Si harge, band offset, stability, CAL GATE TRANSISTOR Motivation, requirements, In nsport, injection velocity, ve sistors, integration issues. inFET and Surround gate FH termanium and compound so	MOS caj iO2 vs l reliabil tegratio elocity o ET. Meta emicond ETS Advant perties, tero stru	pacitor, High-k g ity – Qb n Issues vershoo al source luctors – tages of MESFE acture M	Role of gate die od high . Transj t. SOI - e/drain -Work German ETs Cor	interface que electrics. Interface que field, possib port in Nano PDSOI and junctions - P function pinu nium over Sin npound semi 's exploiting	ality and egration i le candid MOSFE FDSOI. Properties hing. licon, PM conducto novel ma	l related ssues of ates, CV Classes: T, veloci Ultrathin of schot Classes: IOS vers rs MOSI aterials, s	process high-k and IV and IV a body body ky solution solution ky solution solution solution ky

Compound semiconductor hetero-structure growth and characterization: Quantum wells and Thickness measurement techniques: Contact - step height, Optical - reflectance and ellipsometry. AFM. Characterization techniques for nanomaterials: FTIR, XRD, AFM, SEM, TEM, EDAX etc. Applications and interpretation of results. Emerging nano materials: Nanotubes, nanorods and other nano structures, LB technique, Soft lithography etc. Microwave assisted synthesis, Self assembly etc.

Text Books:

- 1. R.P. Jain, "Modern digital Electronics", Tata McGraw Hill, 4th Edition, 2009.
- 2. Douglas Perry, "VHDL", Tata McGraw Hill, 4th Edition, 2002.
- 3. W.H. Gothmann, "Digital Electronics An Introduction to Theory and Practice", PHI, 2nd Edition, 2006.

Reference Books:

- 1. Fundamentals of Modern VLSI Devices, Y. Taur and T. Ning, Cambridge University Press.
- 2. Silicon VLSI Technology, Plummer, Deal, Griffin, Pearson Education India.
- 3. Encyclopedia of Materials Characterization, Edited by: Brundle, C.Richard; Evans, Charles A. Jr.; Wilson, Shaun; Elsevier.

Web References:

- 1. http://home.iitk.ac.in/~anandh/MSE694/Introduction_to_Nanomaterials-3.pdf
- 2. https://dl.acm.org/citation.cfm?id=291188
- 3. https://iopscience.iop.org/article/10.1088/0268-1242/26/1/014035/meta
- 4. http://ece.iisc.ernet.in/~navakant/nano/2007/course.html

- 1. https://arxiv.org/pdf/1812.04939.pdf
- 2. https://www.ncbi.nlm.nih.gov/pmc/articles/PMC5905289/
- 3. https://www.intel.com/pressroom/kits/advancedtech/doodle/ref_HiK-MG/high-k.htm
- 4. https://warwick.ac.uk/fac/sci/physics/research/condensedmatt/silicon/research/ge/
- 5. https://iopscience.iop.org/article/10.1088/0268-1242/26/1/014035/meta

RF CIRCUIT DESIGN

	Category	Ho	urs / W	'eek	Credits	Ma	ximum 1	Marks
AECB34	Elective	L	Т	Р	С	CIA	SEE	Tota
ALCD34	Liective	3	-	-	3	30	70	100
Contact Classes: 4	5 Tutorial Classes: Nil	P	ractica	l Class	es: Nil	Tota	al Classe	s: 45
I. Learn the fundarII. Understand the modeling.	nable the students to: nental RF circuit and system basic transmission line and biasing networks & RF	theory,	single		-	tworks,	RF com	ponen
MODULE -I IN	FRODUCTION						Classes	: 10
R, L, C, G paramete Terminations: Short Transmission Lines:	Transmission Lines: Type rs of Different Line config Circuit, Open Circuit and Power Considerations, Inpu NGLE AND MULTI-POR	gurations Quarter ut Imped	-Termin Wave ance M	nated L Transn atching	lossless Tra	insmissio es- Sourc	n Lines- ed and 1	Specia Loadec Loss.
wave Ratio, Special Connections-Basic D RF Filter Design: S Between S- and Z-p Configurations: Low	eflection Coefficient, Nor Transformation Conditions refinitions of Single and Mi Scattering Parameters: De arameters, Signal Flow Cl Pass, High Pass, Band Pa roda's Identities Transform	-Admitta ulti-Port finition, hart Moc ss and B	ance Tra Networ Meanin leling, and Sto	ansforn ks-Inte ng, Ch Genera op type	nation-Para rconnecting ain Scatter lization Bas Filters-Filt	llel and S Network ing Matr sic Resor	eries RL s. ix, Con nator and	& RČ version 1 Filter
MODULE -III AC	TIVE RF COMPONENT	Г MODE	LLIN	3			Classes	: 08
	onlinear and Linear Model	s Transis	tor Mo	dels: La	arge Signal	and Smal	l Signal	
Models.	all Signal FET Models- Sc	attering I	Paramet	ter, Dev	vice Charact	terization		BJT
Models. Large Signal and Sm					vice Charact	terization	Classes	
Models. Large Signal and Sm MODULE -IV MA Impedance Matchin Regions, Frequency	all Signal FET Models- Sc TCHING AND BIASING g Using Discrete Compo Response and Quality Fa g Networks: Classes of Op	G NETW nents: T actor, T	WORKS wo Co and Pi	s mpone Match	nt Matchin ing Networ	g Netwo ks-Ampli	Classes orks, For	: 08 bidder
Models. Large Signal and Sm MODULE -IV Impedance Matchin Regions, Frequency Operation and Biasir BJT, Biasing Networ	all Signal FET Models- Sc TCHING AND BIASING g Using Discrete Compo Response and Quality Fa g Networks: Classes of Op	G NETW nents: T actor, T beration a	wo Co and Pi nd Effi	s mpone Match	nt Matchin ing Networ	g Netwo ks-Ampli	Classes orks, For	: 08 bidder sses o: orks for

Oscillator Design, Design steps, Quartz Oscillators- Fixed Frequency High Frequency Oscillator -Basic Characteristics of Mixers: Concepts, Frequency Domain Considerations, Single Ended Mixer Design, Single, and Double Balanced Mixers.

Text Books:

- 1. Reinhold Ludwig, Pavel Bsetchko, "RF Circuit Design Theory and Applications", "Pearson Education India", 2000.
- 2. Devendra K. Misra, "Radio Frequency and Microwave Communication Circuits Analysis and Design", Wiley Student Edition John Wiley & Sons, Inc.

Reference Books:

- 1. Matthew M. Radmanesh, "Radio Frequency and Microwave Electronics", Illustrated by-PEI.
- 2. Christopher Bowick, Cheryl Aljuni and John Biyler, "RF Circuit Design", Elsevier Science, 2008.
- 3. Joseph J.Carr, "Secrets of RF Circuit Design", Mc Graw Hill Education, 2000.
- 4. Peter L.D. Abrif, "Design of RF and Microwave Amplifiers and Oscillators", Artech House, 2000.
- 5. Thomas H.Lee, "The Design of CMOS Radio Frequency Integrated Circuits", Cambridge University Press, 2nd Edition, 2004.

Web References:

- 1. http://twanclik.free.fr/electricity/electronic/pdfdone12/Radio%20Frequency%20Circuit%20Design.pdf
- 2. https://www.highfrequencyelectronics.com/index.php?...rf-circuit-design-references..
- 3. eecs.oregonstate.edu/~karti/ece621/ece621.pdf

- 1. https://ieeexplore.ieee.org/book/5628344
- 2. https://onlinelibrary.wiley.com/doi/book/10.1002/9781118309940
- 3. https://www.amazon.in/Radio-Frequency-Integrated-Circuits-Systems/.../0521190797

DIGITAL IMAGE PROCESSING

		Hours / Week Credits				Maximum Marks			
AECB35	Category	L	Т	Р	С	CIA	SEE	Total	
	Elective	3	-	-	3	30	70	100	
Contact Classes: 45	Tutorial Classes: Nil Practical Classes: Nil					Total Classes: 45			
BJECTIVES:									
The course should ena		41	a a 1 4 ma m	~ f ~~~~~~					
	nage fundamentals and mage enhancement techniques		cal tran	storms	necessary I	or mage	processi	ng.	
	ge restoration procedures.								
	ge compression procedures.								
	e segmentation and represe		techniq	ues.					
			1				~	4.0	
ODULE -I INTRODUCTION						Classes: 10			
	entals and image transform							zation,	
elationship between p	oixels; Image transforms: 2-	-D FFT	, proper	ties, W	alsh transfo	rm, Hada	amard		
ransform, discrete cos	sine transform, Haar transfo	orm, Sla	ant trans	sform, l	Hoteling tra	nsform.			
IODULE -II IMAGE ENHANCEMENT						Classes: 09			
btaining frequency do	n filter processing; Spatial pmain filters from spatial f and high pass (sharpening)	ilters, g	generatii	ng filte	rs directly i	•	• •		
10DULE -III IMA	GE RESTORATION						Classes	: 08	
mage restoration degr	adation model, algebraic a	pproach	n to rest	oration	, inverse filt	tering.			
Least mean square filt	ers, constrained least squar	e restor	ation, ir	nteracti	ve restoration	on.			
10DULE -IV IMA	GE SEGMENTATION						Classes	: 08	
nted segmentation mo	tion of discontinuities, edge rphological image processi unction, erosion; Combinin on.	ng dilat	tion and	erosio	n, structurin	ng elemen	nt		
IODULE -V IMAG	GE COMPRESSION						Classes	: 10	
	edundancies and their remo	oval me	thods, f	fidelity	criteria, ima	age comp	ression		
	er and decoder, error free co	ompress	sion, los	sy con	pression, JI			d.	

Reference Books:

- 1. Rafael, C. Gonzalez, Richard E woods, Stens L Eddings, "Digital Image Processing using MAT LAB", Tata McGraw Hill, 2nd Edition, 2010.
- 2. A.K. Jain, "Fundamentals of Digital Image Processing", PHI, 1st Edition, 1989.
- 3. Somka, Hlavac, Boyle, "Digital Image Processing and Computer Vision", Cengage Learning, 1st Edition, 2008.
- 4. Adrain Low, "Introductory Computer vision Imaging Techniques and Solutions", Tata McGraw-Hill, 2nd Edition, 2008.
- 5. John C. Russ, J. Christian Russ, "Introduction to Image Processing & Analysis", CRC Press, 1st Edition, 2010.

Web References:

- 1. https://imagingbook.com/
- 2. https://en.wikipedia.org/wiki/Digital_image_processing
- 3. http://www.tutorialspoint.com/dip/
- 4. http://www.imageprocessingplace.com/
- 5. http://web.stanford.edu/class/ee368/
- 6. https://sisu.ut.ee/dev/imageprocessing/book/1

7.https://in.mathworks.com/discovery/digitalimageprocessing.html?requestedDomain=www.mathworks.com/

- 1. http://www.sci.utah.edu/~gerig/CS6640-F2010/dip3e_chapter_02.pdf
- 2. http://www.faadooengineers.com/threads/350-Digital-Image-Processing
- 3. http://newwayofengineering.blogspot.in/2013/08/anil-k-jain-fundamentals-of-digital.html
- 4. http://bookboon.com/en/digital-image-processing-part-one-ebook

SPEECH AND AUDIO PROCESSING

Course Code	Category	Hours / Week			Credits	Maximum Marks		
AECB36	Elective	L	Т	Р	С	CIA	SEE	Total
		3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	Practical Classes: Nil Total Classes:					es: 45	
I. Understand th II. Analyze the sp III. Explore the he IV. Understand th V. Study the percent MODULE -I FU Mechanism of spee- model, losses in vo Parameters: Short t discrimination using function, and averag MODULE -II LI Basic principles of L Equations: Cholesky Autocorrelation Equations using LP analysis, Parameters	d to enable the students to be acoustic modelling of sp peech using Linear Predic comomorphic analysis of sp is speech and speaker reco ceptual modeling of audio INDAMENTALS OF D ch production, The Acou ocal tract, effect of radia time energy, average ma g energy and zero crossing the magnitude difference fur INEAR PREDICTIVE (1 INEAR PREDICTIVE	peech a stion m peech a ognitio for co IGITA astic th ation a agnitud g, pitcl nction LP) A relation for Co thods,	odelling signal. n techni mpressi L SPE heory o at lips, le, aver h period NALYS n Metho ovarianc Pitch D	iques. ion ECH P f speec Digital rage zer d estima SIS od, The C re Metho etection	ROCESSII h productio models for o crossing tion using Covariance od, Durbin'	NG on- Unif or speecl rate, S short tir method, s Recurs	Class form loss n signals peech vs ne autoco Class , Solution ive Solut	s Speech Silence orrelation es: 09 of LPC ion for th
**	n Speech Analysis: Pitch					nterpreta	tion of Ll	P analysis
Deconvolution	n Speech Analysis: Pitch	Estima	tion, Fo	ormant H		nterpreta	tion of Ll tal Wave	P analysi
Deconvolution MODULE -III HO Homomorphic Syste of Speech, Pitch Det Speech Enhancement Speech enhancement synthesis, Comb filte	OMOMORPHIC SPEE ems for Convolution: Proj ection, Formant Estimatic ent: t techniques: Single Chan ering, Wiener filtering, su	Estima CH PF perties on, The nel Ap bspace	ntion, Fo ROCES of the Homos proach, algorit	SING Comple morphic Spectra hms	Estimation a ex Cepstrur vocoder. Il Subtraction	nterpreta and Glot n, The C on, Enha	tion of Ll tal Waves Cla Complex of ncement	P analysis form sses: 09 Cepstrum by re-
Deconvolution IODULE -III H Homomorphic Syste of Speech, Pitch Det Speech Enhancemen Speech enhancement synthesis, Comb filte	OMOMORPHIC SPEE ems for Convolution: Proj ection, Formant Estimation ent: t techniques: Single Chan- ering, Wiener filtering, su UTOMATIC SPEECH 4	Estima CH PF perties on, The nel Ap bspace	ntion, Fo ROCES of the Homos proach, algorit	SING Comple morphic Spectra hms	Estimation a ex Cepstrur vocoder. Il Subtraction	nterpreta and Glot n, The C on, Enha	tion of Ll tal Waves Cla Complex of ncement	P analysis form sses: 09 Cepstrun

MODULE -V AUDIO CODING	Classes: 09
Speech Perception mechanism, Psychoacoustic model, Temporal and spectral masking, C	
Lossless Audio Coding, Lossy Audio coding, ISO-MPEG-1 Audio coding, MPEG - 2 Au	udio coding,
MPEG - 2 Advanced Audio Coding, MPEG - 4 Audio Coding.	
TEXTBOOKS:	
1. Lawrence R. Rabiner and Ronald W. Schafer, Digital Processing of Speech Signals, 1978	Prentice Hall,
2. Digital Audio Signal Processing – Udo Zolzer, 2nd Edition, Wiley, 2008	
3. Philipos C. Loizou, Speech Enhancement – Theory and Practice, CRC Press, 2013	
REFERENCE BOOKS:	
1. O'Shaughnessy, D, Speech Communication, Human and Machine, Addison-Wesley,	
 John N. Holmes, Wendy J. Holmes, Speech Synthesis and Recognition, Taylor and F Edition, 2003. 	rancis, 2nd
 Tokunbo Ogunfunmi, Roberto Togneri, Madihally Narasimha, Speech and Audio Pro Coding, Enhancement and Recognition, Springer, 2015 	ocessing for
 John R. Deller, Jr., John H. L. Hansen ANDJohn G. Proakis, Discrete-Time Processi Signals, IEEE Signal Processing Society. 	ng of Speech
 Thomas F. Quatieri , Discrete-Time Speech Signal Processing: Principles and Practic Hall, Signal Processing Series, 2002 	e, Prentice
 Lawrence R. Rabiner and Ronald W. Schafer, Introduction to Digital Speech Process publishers, 2006 	ing, now
 L. R. Rabiner and R. W. Schafer, Introduction to Digital Speech Processing, Foundat in Signal Processing, vol 1, no 1–2, pp 1–194, 2007 	tions and Trends
ONLINE RESOURCES	
1. Speech and Audio Processing 1: Introduction to Speech Processing -Professor E. Amb https://www.youtube.com/watch?v=Xjzm7S_kBU	ikairajah
 Speech and Audio Processing 3: Linear Predictive Coding (LPC) -Professor E. Ambik 	airaiah
2. Speech and Addio Processing 5. Enter Predictive Coding (EFC) Professor E. Anork https://www.youtube.com/watch?v=lWH-Oh5KnNY	unujun

VIDEO PROCESSING

Course Code	Category	He	ours / V	Veek	Credits	Ma	ximum N	larks
A ECD 27		L	Т	Р	С	CIA	SEE	Total
AECB37	Elective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil		Practic	al Class	ses: Nil	To	tal Classe	es: 45
have become a ce II. Human/computer surveillance and r III. This course offers work currently un IV. Through this cour image and video p V. Develop conceptu implementation w MODULE – I FUN Representation of dig Motion models, Geon video, Two-dimension rom samples. MODULE – II VID Video Motion estimate estimation, Block material estimation, Global mov Feature based Motion MODULE – III 2-D Video coding: Basics Texture coding for arb Object based video cosystem, Scalable video	bus applications in entertain entral component of net-ce- interfaces, and databases. remote sensing. Is fundamentals of digital in aderway in this field. rse, students will get a clear processing al understanding which w	entered , as we mage a ar imple vill ena EO PH and fur Spatio- dic sar TION Dptical rmable ased m n Estim N t deper nt shap d video of scala	computed and vide and vide ression able the state of the	ting, ta analys ta analys of the br m to und SING tals, Tim al samplin General matchi stimatio terative deo cod exture c g, Sema	sis for dom ssing and a readth and lertake furt ne-varying ling: Samp ng of 3-D methodol ng algorit n, Multi re- model. ling, Two o oding, Reg antic video	ains suc algorithm practical ther stud image to ling of a structure ogies, P hm, Me solution dimension tion base to coding	h as biom ns for mo l scope of y, researc Cl formation analog ar es, Recor Cl ixel base sh basec motion e Cl onal shap d video c g, Layere	etrics, st of the digital h and/or asses: 1(models ad digita astruction asses: 0) d motion stimation asses: 0) e coding oding, d coding
MODULE – IVVID	EO COMPRESSION						C	asses: 08
Video Compression S	EO COMPRESSION tandards; MPEG-4 Visua Coding tools and extension						ern Digita	

MODULE – V VIDEO PROCESSING AND SEGMENTATION

Stereo and multi view sequence processing: Depth perception Stereo imaging principle Disparity estimation Intermediate view synthesis Stereo sequence coding. Video Segmentation: Motion Segmentation; Tracking; Motion Tracking in Video: 2D and 3D Motion Tracking in Digital Video, Methods using Point Correspondences, Optical Flow and Direct Methods, Applications

Text Books:

- 1. R.C. Gonzalez and R.E. Woods, "Digital Image Processing", Pearson Education, 3rd Edition, 2009.
- 2. Yao Wang, Joem Ostermann and Ya–quin Zhang, "Video Processing and Communication, PH Int, 1st Edition, 2002.

Reference Books:

- 1. A. Murat Tekalp, "Digital Video Processing", Prentice Hall, 2nd Edition, 2015.
- 2. Alan C. Bovik, "The Essential Guide to Video Processing", Elsevier Science, 2nd Edition, 2009.
- Iain E. Richardson, "H.264 and MPEG-4 Video Compression: Video Coding for Next-generation Multimedia", John Wiley & Sons, 2nd Edition, 2003.
- 4. J.W. Woods, "Multidimensional Signal, Image and Video Processing and Coding", Academic Press, 2nd Edition, 2012.

Web References:

- 1. http://eeweb.poly.edu/~yao/EL6123_s16/index.htm
- 2. http://eeweb.poly.edu/~yao/EL6123_s16/Color_ContrastEnhancement.pdf
- 3. http://eeweb.poly.edu/~yao/EL6123_s16/FT_filtering_2016.pdf
- 4. http://eeweb.poly.edu/~yao/EL6123_s16/GlobalMotionStabilization.pdf

- 1. http://eeweb.poly.edu/~yao/videobook/
- 2. http://www.imageprocessingplace.com/DIP-3E/dip3e_main_page.htm
- 3. https://booksite.elsevier.com/9780123814203/

WAVELETS

Course Code	Category	H	ours / V	Veek	Credit s	Ma	aximum	Marks
		L	Т	Р	C	CIA	SEE	Tota
AECB38	Elective	3	-	-	3	30	70	100
Contact Classes: 45 OBJECTIVES:	Tutorial Classes: Nil		Practic	al Clas	ses: Nil	Tota	al Class	es: 45
 stationary II. Apply the concepts, an interdisciplinary III. Build the concept of IV. Construct Wavelets V. Explore the applicat processing, speech, MODULE – I INTRO Introduction - Stationary introduction to Fourier uncertainty principle and 	tical basis of the wavelet theory and algorithms be	ehind v analysi nd frequ velet pa oding, CLETS nals - S me Fo cewise	vavelet f is and re uency d ackets in signal c AND I Signal r ourier ti Consta	transfor elate it t omain a transie lenoisir FILTE epresen ransform nt App	rm and wave o filter banl approaches ent analysis, ng, pattern r R BANKS tation usin m - Time proximation	elet packe ks biomedia ecognitio g basis at frequenc – The	et transfo cal signa <u>n etc.</u> Cla nd framo y analy	orm from 1 sses: 09 es- Brie sis- Th
Continuous wavelet trans Wavelet Transform - Di	sform (CWT) - Condition	of adr n And	nissibili Filter t	ty and i banks -	its implicati Construction	ons – Inv on of way	velets us	ntinuou ing tim
	lomain approaches - Cor cheme - Two dimensional							
	RNATIVE WAVELET						Classes	
C	piorthogonality in vector						ets, biort	hogona
MODULE – IV WAVE	ELET TRANSFORMS A	AND A	PPLIC		NS		Classes	: 09
	m – Signal representation and Wavelet Packets in					selection	of best l	oasis.
MODULE – V DETE	CTION OF SIGNALS						Classes	: 09
	ges - analysis and classi Image fusion, Edge Det							

Text Books:

- 1. M. Vetterli, J. Kovacevic, "Wavelets and Subband Coding", Prentice Hall Inc, 1995.
- Gilbert Strang and Truong Q. Nguyen, "Wavelets and Filter banks", 2nd Edition, Wellesley- Cambridge Press, 1998.

Reference Books:

- 1. Raghuvir Rao and Ajit S. Bopardikar, "Wavelet Transforms : Introduction, Theory and Applications", Pearson Education, 2000.
- 2. J.C. Goswami and A.K. Chan, "Fundamentals of Wavelets: Theory, Algorithms and Applications",
- 3. 2nd Ed, WILEY, 2011.
- 4. K. P.Soman and K L Ramachandran, "Insight into wavelets from theory to practice", PHI, 2008

Web References:

- 1. https://www.youtube.com/watch?v=C5Z_AEhiov0
- 2. http://www.ifp.illinois.edu/minhdo/teaching/wavelets.html

- 1. http://web.stanford.edu/class/files/scribes/lecture_notes.pdf
- 2. http://www.everythingwtu.wordpress.com

CELLULAR AND MOBILE COMMUNICATIONS

Course Code	Category	Ho	urs / W	'eek	Credits	Ma	aximum	Marks
AECB39	Elective	L	Т	Р	С	CIA	SEE	Total
AECD37	Elective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	Pr	actical	Classe	s: Nil	Tota	l Classe	s: 45
II. Understand impairme models for various erIII. Evaluate the fundame IV. Interpret current and	wireless and mobile cellular ents due to multipath fadin	ng chann ne the d gies.	nel and ifferent	fading	effects.	standar	d stocha	stic chan
Introduction to cellular operation of cellular syste of the problem, concept o	LAR MOBILE RADIO S mobile System, performa ems, hexagonal shaped cell of frequency channels, Co-	ince cr s, analo channel	iteria, to og and co l Interfe	ligital crence	Cellular sy Reduction	stems, (Factor,	adio en General desired	descriptio C/I from
Introduction to cellular operation of cellular syste of the problem, concept of normal case in a omni dir system.	mobile System, performations, hexagonal shaped cell of frequency channels, Co- rectional Antenna system, (FERENCE AND CELL C	ince cr s, analo channel Cell spl	iteria, to og and c l Interfe litting, c	ligital erence conside	Cellular sy Reduction eration of the	stems, (Factor, he com	adio en General o desired ponents	vironmer descriptio C/I from
Introduction to cellular operation of cellular syste of the problem, concept of normal case in a omni dir system. MODULE -II Introduction to Co-Chann of Antenna system, Ante different types, Signal ref between direct and reflect	mobile System, performations, hexagonal shaped cell of frequency channels, Co- rectional Antenna system, (FERENCE AND CELL C	nce cra s, analo channel Cell spl COVER Co-Char r effect errain, deviatio	iteria, to og and d l Interfe litting, d AGE F nnel inte s, diver effect d on, stra	OR SI COR SI COR SI COR	Cellular sy Reduction eration of the GNAL AN ce, Co-Cha eceiver, no an made st he path loss	stems, G Factor, he comp ND unnel m on-coch tructure slope, g	adio en General d desired ponents Cla easurem annel in s, phase general f	vironmer descriptio C/I from of Cellul sses: 09 ent, desig terferenc differenc ormula fo
Introduction to cellular system operation of cellular system of the problem, concept of normal case in a omni dir system. INTERI TRAFFI Introduction to Co-Chann of Antenna system, Anto lifferent types, Signal ref between direct and reflect nobile propagation over v of a point to point model.	mobile System, performations, hexagonal shaped cell of frequency channels, Co- rectional Antenna system, Co- FERENCE AND CELL C IC el Interference, real time C enna parameters and their flections in flat and hilly t ed paths, constant standard	Cover Co-Char r effect deviation ar and l	iteria, to og and d l Interfe litting, d AGE F nnel inte s, diver effect o on, stra- long dis	OR SI COR SI COR SI COR	Cellular sy Reduction eration of the GNAL AN ce, Co-Cha eceiver, no an made st he path loss	stems, G Factor, he comp ND unnel m on-coch tructure slope, g	adio en General o desired ponents Cla easurem annel in s, phase general f a height	vironmer descriptio C/I from of Cellul sses: 09 ent, desig terferenc differenc ormula fo

handoff. Intersystem handoff, cell splitting, micro cells, vehicle locating methods, dropped call rates and their evaluation.

MODULE -IV	WIRELESS SYSTEMS AND STANDARDS	Classes: 08

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T

Second genera DECT, GSN	tion and Third generation Wireless Networks and Standards, WLL, Bluetooth, GSM, IS95, A architecture, GSM channels, multiplex access scheme, TDMA, CDMA
MODULE	-V INTELLIGENT NETWORK FOR WIRELESS COMMUNICATIONS Classes: 10
communication	concept, advanced intelligent network, SS7 network and ISDN for AIN, AIN for mobile a, asynchronous transfer mode technology, future public land mobile telecommunication system, nation superhighway.
Text Books:	
2. Gordon L.	e, "Mobile Cellular Telecommunications", Tata McGraw-Hill, 2 nd Edition, 2006. Stuber, "Principles of Mobile Communications", Springer International, 2 nd Edition, 2007. n and Imrich chlantae, "Wireless and Mobile Network Architecture", John Wiley, 1 st Edition,
Reference Boo	ks:
 Lee, "Wire Jon W. Ma 	S. Rapport, "Wireless Communications", 3 rd Edition, Pearson Education, 2003. less and Mobile Communications", McGraw Hill, 3 rd Edition, 2006. rk and Weihua Zhqung, "Wireless Communication and Networking", PHI, 1 st Edition, 2005. Wireless Communication Technology", Thompson Asia Pvt. Ltd., 1 st Edition 2004.
Web Referenc	es:
1. https://acces	ssengineeringlibrary.com
2. http:// www	.radio-electronics.com
	.jntubook.com
4. http://www.	iare.ac.in
E-Text Books	
1. http://www	v.iitg.ernet.in/scifac/qip/public_html/cd_cell/EC632.pdf

- http://www.iitg.ernet.in/scifac/qip/public_html/cd_cell/EC632.pdf
 https://books.google.co.in/books/about/Cellular_and_Mobile_Communications
 https://technicalpublications.org/.../books/ Cellular_and_Mobile_Communications

MOBILE ADHOC NETWORKS

	Category	H	ours / V	Week	Credits	Max	ximum]	Marks
AECB40	Elective	L	Т	Р	С	CIA	SEE	Total
TILED+0		3	-	-	3	30	70	100
Contact Classes: 45 DBJECTIVES:	Tutorial Classes: Nil]	Practic	al Clas	ses: Nil	Tota	l Classe	s: 45
II. understand network III. Understand active 1 IV. Interpret IEEE 802	ical model and network prot c protocols and their cross la research areas in wireless mu .11 wireless LAN and their I	yer i 11ti-h Bluet	nteracti op netv ooth sta	ons vorks. andards		nop netwo	1	
MODULE -I INTI	RODUCTION TO ADHO	C NE	TWO	RKS			Class	es: 10
	c networks, definition, cha oc mobility models, indoor a					tions, cha	aracteris	tics of
MODULE -II MEI	DIUM ACCESS PROTOC	OLS					Class	es: 09
	n issues, goals and classing protocols using directional a							
MODULE -III NET	WORK PROTOCOLS						Class	es: 08
algorithms, multicast re	sign issues, goals and class outing algorithms, m, energy aware routing alg					C		
MODULE -IV END	-END DELIVARY AND S	ECU	JRITY				Class	es: 08
1 2	in designing, transport layer			-		•	-	•
issues in ad-hoc networ	ks: issues and challenges, ne	00.00	rk secui	ing ana	ens, secure	01		•
	ks: issues and challenges, no			-			Class	
MODULE -V CRO 4G Cross layer Design: No		O INT	FEGR ayer op	ATION timizat	OF ADHO	OC FOR	Class ization	
MODULE -VCRO 4GCross layer Design: Ne techniques, cross layerYext Books:	eed for cross layer design, cr cautionary perspective; Integ	O IN Toss la gratic	TEGR A ayer op on of ad	timizat l-hoc w	OF ADH(ion, parame	OC FOR eter optimi IP networ	Classo ization ks.	
MODULE -V CRO 4G Cross layer Design: Net techniques, cross layer Text Books: 1. C.Siva Ram Murth Pearson Education 2. Prasant Mohapatra Springer, 1 st Edition	eed for cross layer design, cr cautionary perspective; Integ hy, B.S. Manoj, "Adhoc Wir h, 2 nd edition,2007. a, Srikanth Krishnamurthy, ' on, 2005.	oss la gratic eless 'Adh	regraphic properties of a constraint of a cons	timizat 1-hoc w rks Arc works T	OF ADHO	DC FOR eter optimi IP networ	Classe ization ks. ols", tocols",	es: 10
MODULE -V CRO 4G Cross layer Design: Net techniques, cross layer Cext Books: 1. C.Siva Ram Murth Pearson Education 2. Prasant Mohapatra Springer, 1 st Edition	eed for cross layer design, cr cautionary perspective; Integ hy, B.S. Manoj, "Adhoc Wir h, 2 nd edition,2007. a, Srikanth Krishnamurthy, '	oss la gratic eless 'Adh	regraphic properties of a constraint of a cons	timizat 1-hoc w rks Arc works T	OF ADHO	DC FOR eter optimi IP networ	Classe ization ks. ols", tocols",	es: 10

3. RaminHekmat, "Ad-hoc Networks: Fundamental Properties and Network Topologies" Springer, 2006.

Web References:

- 1. https://en.wikipedia.org/wiki/Mobile_ad_hoc_network
- $2.\ http://people.ee.duke.edu/~romit/group/paper-collection.html$
- 3. https://arxiv.org/ftp/arxiv/papers/1503/1503.03233.pdf
- $4. \ http://www.iare.ac.in/sites/default/files/lecture_notes/asn\%20notes.pdf$

- 1. https://books.google.co.in/books?id=izNUbXbK7e4C
- 2. https://books.google.co.in/books?id=cegpBdUxk_EC
- 3. https://books.google.co.in/books?id=4sa--GE8OGEC
- 4. https://books.google.co.in/books?id=GnkcHEsxAigC

OPTICAL COMMUNICATIONS

		Category	Н	ours / V	Veek	Credits	Ma	ximum	Marks		
AECB41		Elective	L	Т	Р	С	CIA	SEE	Total		
			3	-	-	3	30	70	100		
Contact Classes: DBJECTIVES:	45	Tutorial Classes: Nil]	Practic	al Clas	sses: Nil	Tota	l Classe	s: 45		
 The course should e I. Realize the II. Understand III. Develop the IV. Identify and 	significa the cons knowle underst	e students to: nce of optical fiber com truction and characteris dge of optical signal sou and the operation of var gn of optical systems an	tics of trces tous of	f optica and pov optical o	l fiber ver lau	nching.					
MODULE -I	OVERV	VIEW OF OPTICAL I	FIBE	R CON	IMUN	ICATION		Class	es: 10		
to vector nature of	light, pr ypes of o	ne general system, Adva ropagation of light, prop optical fibers, modal ar ded - index fiber	oagati	on of li	ght in	a cylindrica	l dielectr	ic rod; r	ays and		
MODULE -II	SIGNA	L DISTORTION IN C	PTI	CAL FI	BERS	1		Class	es: 09		
* *	nd LASI aracteris	ial Dispersion, Wavegu ER diode; Principles of tics AL DETECTORS		-	-			noise, s			
IN detector, avala uantum efficiency,	noise in						·	, sensiti	vity an		
		•		-							
	l Compo	•	NEC	CTORS	5			Class	es: 08		
Splicing Technique Joints, Single Mod	l Compo FIBER es, Splici e Fiber J	nents	Fibe Hass,	r Align Halide,	ment an Active	e Glass, Cha	algenide (node Fil Glass, Pl	ber astic		
VDM Concepts and MODULE -IV Splicing Technique Joints, Single Mod Optical Fibers. Op	l Compo FIBER es, Splici e Fiber J tical Fibe	nents SPLICING AND COM ing Single Mode Fibers, ioints. Fiber Materials C	Fibe ilass, or Ty	r Align Halide, pes, Sir	ment an Active ngle Mo	e Glass, Cha ode Fiber C	algenide (onnectors	node Fil Glass, Pl s, Conne	ber astic		

Text Books:

- 1. Gerd Keiser, "Optical Fiber Communications" TMH, 4th Edition, 2008.
- 2. Fiber Optic Communication Systems Govind P. Agarwal, John Wiley, 3rd Ediition, 2004
- 3. Emmanuel C, Ifeacher, Barrie. W. Jervis, DSP-A Practical Approach, Pearson Education,
- 4. 2nd Edition, 2002

Reference Books:

1. Fiber Optic Communications – D.K. Mynbaev, S.C. Gupta and Lowell L. Scheiner, Pearson Education, 2005.

2.Optical Fiber Communications – John M. Senior, Pearson Education, 3rd Edition, 2009.

- 3.Karminvov, T. Li "Optical Fibre Telecommunications", Vol A & B, Academic Press, 2002.
- 4. Introduction to Fiber Optics by Donald J.Sterling Jr. Cengage learning, 2004.

5.Optical Communication Systems – John Gowar, 2nd Edition, PHI,2001.

Web References:

1.http://www.ocw.nthu.edu.tw

2.http://www.uotechnology.edu.iq

E-Text Books:

1.https://www.jntubook.com/optical-communications-textbook

2.http://tradownload.com/results/neamen-optical-communications-.html

3.http://www.everythingvtu.wordpress.com

WIRELESS COMMUNICATIONS AND NETWORKS

Course Code	Category	Ho	urs / W	eek	Credits	Ma	ximum	Marks
AECB42	Elective	L	Т	Р	С	CIA	SEE	Total
ALCD42	Elective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: -	P	ractica	l Class	es: Nil	Tota	l Classe	s: 45
Design, Fundament Mechanisms and D II. Equip the students III. Understand the con cellular system IV. Understand the var communications. V. Remember the anal wireless networks a wireless networks a mireless networking MODULE -I Introduction, frequency practical handoff consid	nental treatment of wirele tal concepts like frequency iffraction Models. with various kinds of wire icept of frequency reuse a ious modulation schemes lytical perspective on the and discuss the nature of a g. CELLULAR CONCEP DAMENTALS // reuse, channel assignment derations, interference an uning for wireless system	cy reuse reless ne and be a and mu design and solu T SYS ent stra ad system	e, Radio etworks able to a ultiple a and ana ation me FEM D tegies, 1 m capac	Wave and its pply it ccess t lysis o ethods ESIGN nandofficity; Co	Propagation operation in the desig echniques th f the tradition to the funda	n of mob nat are us onal and e mental p Prioritiz terferenc	ile ed in wir emerging roblems Classe ing hand e and sy	eless in es: 10 offs, stem
	nproving coverage & capa ILE RADIO PROPAGA			syster:	ns; Cell spli	tting, sec	toring.	es: 09
power to electric field dielectrics, Brewster and Hata Model, PCS extern partition losses betwee	Introduction to radio wa ld, the three basic pro- ngle, reflection from prefe- nsion to hata Model, ind en floors, log- distance p el, signal penetration into	ppagatic ect conc loor pro path los	on mec ductors, opagatio ss mode	hanism Longle n mod el, eric	ns; Reflecti ey-Ryce mo els-partition sson multip	on: Refl del, Oku losses (le break	ection f mura Mo Same Flo point mo	from odel, por),
MODULE -III CEL	LULAR SYSTEM DES	IGN F	UNDAN	MENT	ALS		Classe	es: 08
fading, Doppler shift, i	I multipath: Small scale mpulse response model o nall; Scale multipath meas	of a mu	ltipath o					
•	nultipath time delay spre	ad flat	fodier	frame	nou colori	un fadia -	fatter	offort

r		
MODULE -IV	EQUALIZATION AND DIVERSITY	Classes: 08
communication (DFE), maximu	ndamentals of equalization, training a generic adaptive equalizer, e receiver, linear equalizers, non-linear equalization; Decision feedbac im likelihood sequence estimation (MLSE) equalizer, algorithms to forcing algorithm, least mean square algorithm, recursive least squares	k equalization for adaptive
MODULE -V	WIRELESS NETWORKS	Classes: 10
topologies, WLA	vireless networks, advantages and disadvantages of wireless local area networks advantages and disadvantages of wireless local area networks and area networks and area networks area area and area networks area and area networks area area area networks area area area networks area area area networks area area area area networks area area area area area area area are	arison of IEEE
Text Books:		
	Rapport, "Wireless Communications", Pearson Education, 2 nd Edition, 20 Wireless communication", Oxford University press, 2010.	10.
Pearson Educ	n, Prashant Krishnamurthy, "Principle of wireless networks", A United Ap ation, 2004. smith, "Wireless Communications", Cambridge University Press, 2005.	proach ^{II} ,
Reference Book	s:	
sons, 1 st Editi 2. Vijay K Garg of Elsevier, U 3. Mark Ciampa 4. X.Wang, H.V	is, M.S. Obaidat, G.I.Papadimitria, A.S. Pomportsis,"Wireless Networks" on, 2003. , "Wireless Communications and Networks", Morgan Kaufmann Publishe ISA 2009 (Indian Reprint). Jorge Olenewa, "wireless communication and Networking", IE, 2009. Poor, Wireless communication system, Pearson Education, 2004. rr,"Mobile Communication", Pearson Education, 2nd Edition, 2003.	-
Web References	s:	
2. https://www.g	iwna.org/2017IoTCOMM/Wireless_Communications_&_Networking_St oogle.com/wirelesscommunicationnetwork. nd.edu/~mhaenggi/ee598q/books/stallings_jagadish.pdf	allings_2nd.
E-Text Books:		

1. https://www.oreilly.com/library/view/wireless-communications-principles/0130422320/ 2. https://groups.google.com/forum/#!topic/kluecm2010-2014/7Q5gRhqh51g.

ADVANCED PROGRAMMABLE LOGIC DEVICE ARCHITECTURES

Course Code	Category	He	ours / We	eek	Credits	Maximu		Iarks
		L	Т	Р	С	CIA	SEE	Tota
AECB43	Elective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	F	ractical	Classes	: Nil	Tota	l Classe	s: 45
I. Classify differenII. Analyze the struIII. Understand the a		ements						
MODULE-I	INTRODUCTION TO ASICS Classes:09							
ASIC's, programmab	ypes of ASICs, full custo le logic devices, introduct levices, types of programm	ion to pro	ogramma	ble logic	, fixed versu	is progra	ammabl	e logic
MODULE-II N	IEMORY AND PROGR	AMMA	BLE LO	GIC			Classes:09	
Random Access Mem Array Logic	ory, Programmable Logic	, PLD'S,	ROM, P	rogramr	nable Logic	Array, F	Program	mable
MODULE-III	DIGITAL DESIGN WIT	H SM C	HARTS				Class	es: 10
State Machine charts,	Derivation of SM Charts,	Realizat	ion of SN	I Charts				
Implementation of Di Machines	ce Game, Alternative real	ization fo	or SM cha	rts using	g microprog	ramming	g, Linke	d State
MODULE-IV	DESIGN WITH FIELD H	PROGRA	AMMAB	LE GA	TE ARRAY	YS	Class	es: 09
	Gate Arrays – Logic blo esigning with FPGAs, Usir					w. Xilin	x 3000	Series
MODULE-V N	IEMORIES						Class	es: 08
	cture, 2D-decoding comm ng, standard SRAMS, syn	• •		•	* *			
Text Books:								
Publications, 1 st H 2. Charles H Roth, Jr	ger , —Field Program Edition, 1994 2. . "Digital System Design v 'Digital Design Principles	using VH	IDL", Ce	ngage L	earning, 200	6.		

- 1. Parag.K.Lala, "Digital System Design using Programmable Logic Devices", BS Publications, 1st Edition,2003.
- 2. Stephen Brown and Zvonko Vranesic, "Fundamentals of Digital Logic Design with Verilog Design", TMH, 2nd Edition, 2010.
- 3. Charles.H.Roth,Jr., Lizy Kurian John "Digital System Design using VHDL", Thomson, 2nd Edition, 2008.
- 4. Zainalabdien Navabi, "Verilog Digital System Design", TMH, 2nd Edition, 2008.
- 5. Cypress Semiconductors Data Book (Download from website).
- 6. John V.Oldfield, Richard C Dore, —Field Programmable Gate Arrays^{II}, Wiley Publications, 1st Edition, 1995.

Web References:

- 1. http://www.igniteengineers.com
- 2. http://www.eecg.toronto.edu
- 3. http://www.ece.uic.edu
- 4. http://www.iare.ac.in

- 1. https://books.google.co.in
- 2. http://www.www.jntubook.com
- 3. http://www.allaboutcircuits.com
- 4. http://www.archive.org

DIGITAL DESIGN THROUGH VERILOG

PE - IV: ECE Course Code	Category	Н	ours / W	eek	Credits	Max	imum N	/larks
		L	Т	Р	С	CIA	SEE	Total
AECB44	Elective	3	-	-	3	30	70	100
Contact Classes: 4	5 Tutorial Classes: Nil]	Practical Classes: Nil Tot				Total Classes: 4	
I.Familiarize tII.Design gateIII.Design beha	enable the students to: the constructs in Verilog HD level models in Verilog HDI vioral level models in Verilo quential logic and synthesi	L. og HDL						
MODULE-I	INTRODUCTION TO VE	RILOG	HDL				Class	es:09
Types, Memory Ele	erilog HDL, Language Elen ment, Constant, Parameter, G Continuous Assignment, In leling	Operator	ſS		·			
MODULE-II	GATE-LEVEL MODELIN	NG					Class	es:09
	es, Gate Delays, Design E Sequential User-Defined Prin		s, User-l	Defined	Primitives:	Combi	national	User-
MODULE-III	BEHAVIORAL MODELI	NG					Class	es: 10
using behavioral mo Loop Statements: F	ts, Procedural Assignments, odeling For Loop, While Loop, Rep ent, Design examples using	peat Lo	op, Fore	ever Loc			C	
	SWITCH LEVEL MODE						Class	es: 09
	vitches, CMOS Switch, Bi trengths and Delays, Strengt				•	vith Swi	tch Prin	nitives,
MODULE-V SE	QUENTIAL LOGIC						Class	es: 08
• •	nous Sequential Machines, Sential Machines, Synthesis of	•	•				es, Ana	lysis of
Text Books:								
2. Michael D. Cilet	h, "Verilog HDL: Digital De ti, "Advanced Digital Design h, "Digital Design and Verilo	n with V	/erilog H	DL", PH	II, 2005.			8

- 1. Stephen Brown and Zvonko Vranesic, "Fundamentals of Digital Logic design with Verilog Design", TMH, 2nd Edition, 2010.
- 2. Sunggu Lee "Advanced Digital Logic Design using Verilog, State Machine & Synthesis for FPGA", Cengage Learning, 2012.
- 3. Samir Palnitkar, "Verilog HDL", Pearson Education, 2nd Edition, 2009.
- 4. T. R. Padmanabhan and B. Bala Tripura Sundari, "Design through Verilog HDL", Wiley, 2009.
- 5. Zainalabdien Navabi, "Verilog Digital System Design", TMH, 2nd Edition, 2009.

Web References:

- 1. https://www.crcpress.com/Verilog-HDL-Digital-Design-and-Modeling/Cavanagh/p/book/9781420051544
- 2. https://www.uotechnology.edu.iq
- 3. https://www.iare.ac.in

- 1. https://www.www.jntubook.com
- 2. https://www.allaboutcircuits.com
- 3. https://www.archive.org

SCRIPTING LANGUAGES FOR VLSI DESIGN

Course C	ode	Category	Ho	urs / W	/eek	Credits	Ma	ximum	Marks
AECB4	-	Elective	L	Т	Р	С	CIA	SEE	Total
AECD4:	5	Elective	3	-	-	3	30	70	100
Contact Clas	sses: 45	Tutorial Classes: Nil	Pr	actical	Classe	es: Nil	Tota	l Classe	s: 45
I. Usage o II. Differer III. Creation IV. Learn th	uld enable f scripting aces betwee a of programe concept	the students to: lanuages in IC design. en scripting and non scripti ms in LINUX environment of TCL phenomena and ad ic concepts of Javascripts a	vanced	TCL9	concep	ots.			
	<u> </u>	UCTION TO LINUX						Clas	ses: 10
etworking com SED: Scripts, o	mands; Te	file handling utilities, secu ext processing and backup addresses, commands; A' ye arrays, string and mather	o utiliti WK: E	es: Tex xecutio	at proc	essing utili lds and re	ties and cords,	d backuj scripts,	o utilitie operatio
MODULE -II	TCL9							Clas	ses: 09
		losophy, Structure, Syntax tput, Procedures, Working							
MODULE -III	ADVAN	CED TCL9						Clas	ses: 08
lriven programs	•	l up-level commands, Libr			C ·	×		C	
Making applica rusted code, Th		rnet-aware', 'Nuts-and-bolts	s' interr	net pro	ogramn	ning, Secu	rity iss	sues, ru	nning
MODULE -IV	TK AND	JAVA SCRIPTS						Clas	ses: 08
	L-TK. Jav	mental concepts of TK, aScript – Object models,		•	.			•	
MODULE -V	INTROD	UCTION TO PYTHON						Clas	ses: 10
Basic concepts Classes, Encaps		. Object Oriented Program	mming	Conce	pts (Q	ualitative (Concept	s Only)	: Objec

Text Books:

- 1. Guido Van Rossum, Fred L. Drake Jr., "Python Tutorial" by editor, Release 2.6.4
- 2. Brent Welch, "Practical Programming in Tcl and Tk", Updated for Tcl 7.4 and Tk4.0.

Reference Books:

- 1. Brent Welch, "Practical Programming in Tcl and Tk", 4th Edition, 2003.
- 2. David Barron, "The World of Scripting Languages", Wiley Publications, 2000.
- 3. Guido van Rossum, and Fred L. Drake ", Python Tutorial, Jr., editor, Release 2.6.4.
- 4. Neil Mathew, Richard Stones, Beginning Linux Programming, Wrox, Wiley India, 4th Edition, 2011.

Web References:

- 1. https://doc.uments.com/s-vlsi-technology.pdf
- 2. https://www.quora.com/Why-are-Perl-and-TCL-scripting-languages-used-in-the-VLSI...
- 3. https://www.jntubook.com
- 4. https://www.reddit.com/r/Python/comments/37xs5j/python_in_vlsi_scripting

- 1. http://vic.gedris.org/Manual-ShellIntro/1.2/ShellIntro.pdf
- 2. http://www.freeos.com/guides/lsst/ https://technicalpublications.org/.../books/
- 3. https://python-textbok.readthedocs.io/en/1.0/Object_Oriented_Programming.html
- 4. https://www.programiz.com/python-programming/

DESIGN FOR TESTABILITY

AECB46 Elective	Course Co	ode	Category	Но	ırs / W	eek	Credits	Max	ximum N	Aarks
3 - - 3 30 70 100 Contact Classes: 45 Tutorial Classes: Nil Practical Classes: Nil Total Classes: 45 OBJECTIVES: The course should enable the students to: 1. Apply the concepts in testing which can help them design a better yield in IC design. 2. Tackle the problems associated with testing of semiconductor circuits at earlier design Analyse the various test generation methods for static & dynamic CMOS circuits. A. Apply the concepts in testing which can help them design a better yield in IC design. Analyse the various test generation methods for static & dynamic CMOS circuits. A Identify the design for testability methods for combinational & sequential CMOS circuits Analyse the various test generation methods for combinational & sequential CMOS circuits State the BIST techniques for improving testability. MODULE -1 INTRODUCTION TO TESTABILITY Classes: 09 Simulation for Design, Fault Modeling: Defects, Errors and Faults, Functional Versus Structural Testing, Levels of Fault Models, Single Stuck-at Fault. MODULE -11 LOGIC AND FAULT SIMULATION Classes: 09		6		L	Т	Р	C	CIA	SEE	Tota
OBJECTIVES: The course should enable the students to: 1. Apply the concepts in testing which can help them design a better yield in IC design. 2. Tackle the problems associated with testing of semiconductor circuits at earlier design 3. Analyse the various test generation methods for static & dynamic CMOS circuits. 4. Identify the design for testability methods for combinational & sequential CMOS circuits 5. Recognize the BIST techniques for improving testability. MODULE -1 INTRODUCTION TO TESTABILITY Classes: 09 Testing Philosophy, Role of Testing, Digital and Analog VLSI Testing, VLSI Technology Trends affecting resting, Types of Testing, Fault Modeling: Defects, Errors and Faults, Functional Versus Structural Testing, Levels of Fault Models, Single Stuck-at Fault. MODULE -11 LOGIC AND FAULT SIMULATION Classes: 09 Simulation for Design Verification and Test Evaluation, Modeling Circuits for Simulation, Algorithms for True-value Simulation, Algorithms for Fault Simulation, ATPG Classes: 10 SCOAP Controllability and Observability, High Level Testability Measures. Classes: 08 The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST. MODULE -V BOUNDARY SCAN STANDARD Classes: 09	AECB4	6	Elective	3	-	-	3	30	70	100
The course should enable the students to: 1. Apply the concepts in testing which can help them design a better yield in IC design. 2. Tackle the problems associated with testing of semiconductor circuits at earlier design 3. Analyse the various test generation methods for static & dynamic CMOS circuits. 4. Identify the design for testability methods for combinational & sequential CMOS circuits. 5. Recognize the BIST techniques for improving testability. MODULE -I INTRODUCTION TO TESTABILITY Classes: 09 Testing Philosophy, Role of Testing, Digital and Analog VLSI Testing, VLSI Technology Trends affecting festing, Types of Testing, Fault Modeling: Defects, Errors and Faults, Functional Versus Structural Testing, Levels of Fault Models, Single Stuck-at Fault. MODULE -II LOGIC AND FAULT SIMULATION Classes: 09 Simulation for Design Verification and Test Evaluation, Modeling Circuits for Simulation, Algorithms for Fault Simulation, ATPG Classes: 10 SCOAP Controllability and Observability, High Level Testability Measures. Digital DFT and Scan Design: Ad-Hoc DFT Methods, Scan Design, Partial-Scan Design, Variations of Scan. MODULE -IV BUILT -IN -SELF-TEST Classes: 08 The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation Response Compaction, BUILT In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST. MODU	Contact Clas	ses: 45	Tutorial Classes: Nil	Pra	actical	Classe	s: Nil	Tota	ll Classe	s: 45
Levels of Fault Models, Single Stuck-at Fault.Classes: 09MODULE -IILOGIC AND FAULT SIMULATIONClasses: 09Simulation for Design Verification and Test Evaluation, Modeling Circuits for Simulation, Algorithms for Frue-value Simulation, Algorithms for Fault Simulation, ATPGClasses: 10MODULE -IIITESTABILITY MEASURESClasses: 10SCOAP Controllability and Observability, High Level Testability Measures.Classes: 10Digital DFT and Scan Design: Ad-Hoc DFT Methods, Scan Design, Partial-Scan Design, Variations of Scan.Classes: 08The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST.Classes: 09MODULE -VBOUNDARY SCAN STANDARDClasses: 09Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan TestClasses: 09	 Apply the c Tackle the Analyse the Identify the Recognize MODULE -I Festing Philosop	oncepts in problems = e various t e design fo the BIST = INTROD hy, Role o	testing which can help the associated with testing of s est generation methods for or testability methods for co techniques for improving t DUCTION TO TESTABI f Testing, Digital and Ana	semicond static & ombinati- estability LITY log VLS	luctor c dynam onal & <u>7</u> .	bircuits nic CM sequen	at earlier de OS circuits itial CMOS	esign circuits	Classes nds affec	ting
Simulation for Design Verification and Test Evaluation, Modeling Circuits for Simulation, Algorithms for Frue-value Simulation, Algorithms for Fault Simulation, ATPGMODULE -IIITESTABILITY MEASURESClasses: 10SCOAP Controllability and Observability, High Level Testability Measures.SCOAP Controllability and Observability, High Level Testability Measures.Digital DFT and Scan Design: Ad-Hoc DFT Methods, Scan Design, Partial-Scan Design, Variations of Scan.Classes: 08MODULE -IVBUILT -IN -SELF-TESTClasses: 08The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST.Classes: 09MODULE -VBOUNDARY SCAN STANDARDClasses: 09Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan Test	Levels of Fault N	Aodels, Sii	ngle Stuck-at Fault.		d Fault	s, Func	tional Vers	us Struc		
SCOAP Controllability and Observability, High Level Testability Measures.Digital DFT and Scan Design: Ad-Hoc DFT Methods, Scan Design, Partial-Scan Design, Variations of Scan.MODULE -IVBUILT -IN -SELF-TESTClasses: 08The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST.Classes: 09MODULE -VBOUNDARY SCAN STANDARDClasses: 09Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan Test						Circui	ts for Simu	lation,	Algorith	nms for
Digital DFT and Scan Design: Ad-Hoc DFT Methods, Scan Design, Partial-Scan Design, Variations of Scan.MODULE -IVBUILT -IN -SELF-TESTClasses: 08The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST.Classes: 09MODULE -VBOUNDARY SCAN STANDARDClasses: 09Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan Test	MODULE -III	TESTAB	BILITY MEASURES						Classes	s: 10
MODULE -IVBUILT -IN -SELF-TESTClasses: 08The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST.Classes: 09MODULE -VBOUNDARY SCAN STANDARDClasses: 09Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan Test		·			•					
The Economic Case for BIST, Random Logic BIST: Definitions, BIST Process, Pattern Generation Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST. MODULE -V BOUNDARY SCAN STANDARD Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan Test	Digital DFT and	Scan Desi	gn: Ad-Hoc DFT Methods	s, Scan D	esign,	Partial-	Scan Desig	n, Vari	ations of	Scan.
Response Compaction, Built-In Logic Block Observers, Test-Per-Clock, Test-PerScan BIST Systems, Circular Self Test Path System, Memory BIST, Delay Fault BIST. MODULE -V BOUNDARY SCAN STANDARD Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan Test	MODULE -IV	BUILT -	IN -SELF-TEST						Classes	s: 08
Motivation, System Configuration with Boundary Scan: TAP Controller and Port, Boundary Scan Test	Response Compa	ction, Bui	lt-In Logic Block Observe	ers, Test-	Per-Clo					eration,
	MODULE -V	BOUND	ARY SCAN STANDARD						Classes	: 09
							l Port, Bou	ndary So	can Test	

Text Books:

- 1. M.L. Bushnell, V. D. Agrawal, "Essentials of Electronic Testing for Digital, Memory and Mixed Signal VLSI Circuits" Kluwer Academic Publishers
- 2. Miron Abramovici, Melvin Breuer ,Arthur Friedman "Digital Systems Testing and Testable Design" Publisher: Jaico Publishing House
- 3. Wayne Needham "Designer's Guide to Testable Asic Devices "Publisher: Kluwer Academic Publishers Group
- 4. N. Jha & S.D. Gupta, "Testing of Digital Systems", Cambridge, 2003
- 5. W. W. Wen, "VLSI Test Principles and Architectures Design for Testability", Morgan Kaufmann Publishers. 2006

Reference Books:

- 1. M. Abramovici, M. A. Breuer and A.D Friedman, "Digital Systems and Testable Design", Jaico Publishing House
- 2. P.K. Lala, "Digital Circuits Testing and Testability", Academic Press
- 3. Michael L. Bushnell & Vishwani D. Agrawal," Essentials of Electronic Testing for Digital, memory & Mixed signal VLSI Circuits", Kluwar Academic Publishers. 2000.

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- 1. http://www.iare.ac.in
- 2. https://www.researchgate.net/publication/236154999_Test_and_Testability
- 3. https://www.cambridge.org/core/books/testing-of-digital-systems/combinational-logic-and-fault-simulation
- 4. https://www.springer.com/gp/book/9781402070501
- 5. https://www.researchgate.net/publication/257947095_Implementation_of_Algorithm_For_ Testability_Measures_Using_MATLAB

- 1. https://www.barnesandnoble.com/w/designers-guide-to-built-in-self-test-charles-e-stroud/1100325085
- 2. https://dl.acm.org/citation.cfm?id=2588270
- 3. https://link.springer.com/book/10.1007/b117406

ADVANCED DIGITAL SIGNAL PROCESSING

Course Code	9	Category	Но	ırs / W	eek	Credits	Ma	ximum]	Marks
AECB47		Elective	L	Т	Р	С	CIA	SEE	Total
ALCD4/		Elective	3	-	-	3	30	70	100
Contact Classes	: 45	Tutorial Classes: Nil	P	ractical	l Class	es: Nil	Tota	al Classe	s: 45
I. Auto correlatII. Linear predicIII. Determine content	ion an tion W efficie	He the students to: d power spectrum estima /iener filters, LMS adapt ents for perfect reproduct ols to real world problem	ive filte ion filte	rs, and a r banks	applica		r design		
MODULE -I	POW	VER SPECTRAL ESTI	MATIC	DNS				Classes	: 10
Spectral Estima Performance cha nonparametric po	tion; racteri wer sp	from finite duration observation observation for the finite duration observation observation of the finite duration of the finite duratio	ds: Ba ower sp	rtlett, vectrum	Welch, estima	Blackmar tors; Comp	n and T	Tukey n requirer	nethods nents o
MODULE -II		IMATION	50110		SILC	INAL		Classes	: 09
unconstructrained models; Minimur MODULE -III nnovations repres	l least n varia LINI entatic	tto-Regressive) process squares methods; Sequer ance method, Piscaranko EAR PREDICTION AN on of a stationary random quations; Properties of lin	ntial esti <u> s harmo</u> D OP1 process	mation onic dec TIMUM s; Forwa	; Movin compos I LINF ard and	ng average(ition metho CAR FILTE backward	MA) and ds; MUS CRS linear pre	ARMA IC meth Classes diction.	od. : 08
MODULE -IV	DSP	ALGORITHMS						Classes	: 08
	quenc	ised on index mapping; S y band; Split Radix FFT;							
MODULE -V	APP	LICATIONS OF DIGI	TAL SI	GNAL	PROC	ESSING		Classes	: 10
digital audio; Ef	ficient	telephony; Adaptive telep t D/A conversion in co digital filtering; High res	mpact	wifi sy	stems;	Acquisitio	n of hig		
Fext Books:									
Applications"	, Prent	Dimitris G. Manolakis, ice Hall, 4 th Edition, 200 Digital signal processin	7.	C	•	C .		C	

- 3. Emmanuel C, Ifeacher, Barrie. W. Jervis, "DSP-A Practical Approach", Pearson Education, 2nd Edition, 2002.
- 4. A.V. Oppenheim, R.W. Schaffer, "Discrete Time Signal Processing", PHI, 2nd Edition, 2006.

- 1. Li tan Elsevier, "Digital signal processing: fundamentals and applications" Elsevier Science &. Technology Books, 2nd Edition, 2008.
- 2. Robert J.schilling, Sandra.L.harris, "Fundamentals of Digital Signal Processing using Matlab", Thomson Engineering, 2nd Edition, 2005.
- 3. Salivahanan, Vallavaraj, Gnanapriya, "Digital Signal Processing", McGraw-Hill Higher Education, 2nd Edition, 2009.

Web References:

- 1. https://en.wikipedia.org/wiki/Digital_signal_processing
- 2. http://www.algorithmix.com/
- 3. http://www.ti.com/lsds/ti/processors/dsp/overview.page
- 4. http://www.iare.ac.in

- 1. http://www.springer.com/in/book/9783642155901
- 2. https://www-elec.inaoep.mx/~jmram/Digital_Signal_Processing_LI_TAN.pdf
- 3. http://www.elcom-hu.com/ Electrical/ Digital% 20Singnal% 20Proccessing/ 4th/4th% 20Digital% 20Signal%20Processing%20-%20Proakis%20and%20Manolakis.pdf

INFORMATION THEORY AND CODING

PE - V: ECE								
Course Code	Category	He	ours / V	Veek	Credits	N	laximur	n Marks
		L	Т	Р	C	CIA	SEE	Total
AECB48	Elective	3	-	-	3	3 0	70	100
Contact Classes: 45	Tutorial Classes: Nil		Practica	l Class	es: Nil	To	tal Class	es: 45
II. Acquire know They also learIII. Gain knowled algorithm.IV. Gain knowled	able the students to: ledge about information and ledge about Hamming weig n about syndrome calculation lge about convolution cod ge about text compression to mage compression, graphics	ght, mini on and d ling. Th echnique	imum di esign of ey also es. They	f an end) learn / also le	coder and dec about seque earn about sp	coder. ential se beech and	arch an	d Viterbi
MODULE-I INF	ORMATION THEORY						Class	es: 09
theorem, Shannon-	by, Information rate, classif Fano coding, Huffman co Formation - Discrete memor	ding, E	Extended	l Huff	man coding	– Joint	and c	onditional
MODULE-II ER	ROR CONTROL CODING	G: BLO	CK CC	DDES			Class	ses: 09
	ciples: Hamming weight, Ha des, Repetition codes - L - CRC							
MODULE -III ERR	OR CONTROL CODING	: CON	VOLUI	TIONA	L CODES		Class	ses: 09
	– code tree, trellis, state diag				coding			
	RCE CODING: TEXT, A						Class	ses: 09
A	man Coding, Arithmetic Co oustic model, MEG Audio l	0	0			-	0.	U
MODULE -V SOUF	RCE CODING: IMAGE A	ND VI	DEO				Class	ses: 09
	rmats – GIF, TIFF, SIF, oles-I,B,P frames, Motion es							
Text Books:								
2. Fred Halsall, '	rmation Theory, Coding and 'Multidedia Communication ation Asia, 2002.					ols and S	Standard	s",

- 1. K Sayood, "Introduction to Data Compression" 3/e, Elsevier 2006
- 2. S Gravano, "Introduction to Error Control Codes", Oxford University Press 2007
- 3. Amitabha Bhattacharya, "Digital Communication", TMH 2006

Web References:

- 1. https://www.youtube.com/watch?v=Uk9zFrEGguM
- 2. https://lecturenotes.in/subject/540/information-theory-coding-itc

- 1. http://web.stanford.edu/class/ee376a/files/scribes/lecture_notes.pdf
- 2. http://www.everythingvtu.wordpress.com

ERROR CORRECTION CODES

	de	Category	Ho	ours / V	Veek	Credits	Ma	aximum	Marks
AECB49		Elective	L	Т	Р	С	CIA	SEE	Total
AECD		Elective	3	-	-	3	30	70	100
Contact Classes OBJECTIVES		Tutorial Classes: Nil]	Practic	al Clas	sses: Nil	Tota	al Classe	es: 45
The course shou I. Acquire to II. Understa III. Design en IV. Know the MODULE-I	Id enab the kno nd the i ncoder e applic COD STOI	ble the students to: wledge in measurement of importance of various co and decoder of various c ability of source and cha ING FOR RELIABLE	des for c odes. nnel coc DIGITA	communes of the second	ANSM	n systems. ISSION AI			ses: 10
	d Entroj	of Information, A Log py, Types of Errors, Err	-					•	
MODULE -II	LINE	AR BLOCK CODES						Class	ses: 09
Error-Detecting Probability of a	and Er n unde	Block Codes, Syndrome ror-correcting Capabiliti tected error for Linear C in data storage system.	es of a E	Block co	ode, St	andard arra	y and Syn	drome I	Decodin
MODULE -III	CYC	LIC CODES						Class	ses: 09
Decoding, Cyc	lic Har	and Parity-check Matrie						l Error I) at a at i a
Majority logic of for cyclic codes		nming Codes, shortened g	d cyclic	coues,	, Elloi	r-trapping c	lecoding		
for cyclic codes	I	0	1 cyclic	codes,		-trapping c		for cycl	
for cyclic codes MODULE -IV Encoding of Co likelihood deco	CON onvoluti ding, S	g	d Distan ority- lo	ce Prop	perties,	state, tree, of Convolu	trellis dia	for cycl Class grams, r es. Appli	ic code ses: 09 naximu
for cyclic codes MODULE -IV Encoding of Co likelihood deco	CON onvoluti ding, S ng and S	g VOLUTION CODES on Codes- Structural and equential decoding, Maj	d Distan ority- lo	ce Prop	perties,	state, tree, of Convolu	trellis dia	for cycl Class grams, r es. Appli stem.	ic code ses: 09 naximu
for cyclic codes MODULE -IV Encoding of Co likelihood deco Viterbi Decodin MODULE -V Minimum dista	CON onvoluti ding, S ng and S BCH nce and	g VOLUTION CODES on Codes- Structural and equential decoding, Maj Sequential Decoding, Ap	d Distan ority- lo plication	ce Prop ogic dec as of Co edure f	perties, coding onvolut	state, tree, of Convolu ion codes in H codes, S	trellis dia ation code a ARQ sys yndrome	for cycl Class grams, r es. Appli stem. Class	ic code ses: 09 naximu cation ses: 08
for cyclic codes MODULE -IV Encoding of Co likelihood deco Viterbi Decodin MODULE -V Minimum dista	CON onvoluti ding, S ng and S BCH nce and	g VOLUTION CODES on Codes- Structural and equential decoding, Maj Sequential Decoding, App CODES d BCH bounds, Decoding	d Distan ority- lo plication	ce Prop ogic dec as of Co edure f	perties, coding onvolut	state, tree, of Convolu ion codes in H codes, S	trellis dia ation code a ARQ sys yndrome	for cycl Class grams, r es. Appli stem. Class	ic code ses: 09 naximu cation ses: 08

- 1. John G. Proakis, "Digital Communications, TMH, 5th Edition, 2008.
- 2. Todd K. Moon, "Error Correction Coding Mathematical Methods and Algorithms", Wiley India, 2006.
- 3. Ranjan Bose, "Information Theory, Coding and Cryptography", TMH, 2nd Edition, 2009.

Web References:

- 1. http://www.igniteengineers.com
- 2. http://www.ocw.nthu.edu.tw
- 3. http://www.uotechnology.edu.iq

- 1. https://www.jntubook.com/dgital-communications-textbook
- 2. http://tradownload.com/results/neamen-digital-communications-.html
- 3. http://www.everythingvtu.wordpress.com

RADAR SYSTEMS AND PROCESSING

Course Code	Category	Ho	urs / W	eek	Credits	Ma	ximum	Marks
AECB50	Elective	L	Т	Р	С	CIA	SEE	Total
		3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	P	ractica	l Class	es: Nil	Tota	al Classe	es: 45
III. Compare the perform		of track	•			nment.		
MODULE -I INTR	ODUCTION						Classes	: 10
range; Minimum detec alarm, Probability of T Section (RCS) of targets losses	ration; Maximum unamb ctable signal; Receiver r Farget Detection, Integra s; RCS fluctuation models	noise, ation of s, trans	Receive f echo smitter p	er Ban pulses bower,	dwidth, SN - SNR imp PRF and Ra	IR; Proba	ability o t; Radai iguities;	f False Cross system
MODULE -II CW A	ND FREQUENCY MO	DULA	TED R	ADAR	1		Classes	: 09
transmitter and receiv Frequency Modulated Diagram and characteris application, Concept of	oppler Frequency; CW er, Non-zero IF receir CW radar: Range and stics, FM-CW altimeter, pulse compression, Pulse ING TARGET INDICA	ver, R Dopple multipl e Comp	eceiver er meas e freque ression	bandy sureme ency C Radars	width requ nt, Mathen W radar, A : FM & Pha	irements, natical A mbiguity ase Codeo	Applic Analysis, Diagrau d Radars	cations; Block n & its
MODULE -III RADA				CLOL			Classes	: 08
Doppler measurement u	on (MTI) on A scope, b sing Pulse radar, MTI ra itter), filter characterist	adar (w	ith pow	er amp	lifier transr	nitter), M	ITI rada	r (with
	ilters, MTI radar parame limitations to MTI perfo ler radar		•	•			.	
MODULE -IV TRAC	CKING RADAR AND R	ADAR	DETE	CTIO	N IN NOIS	E	Classes	: 08
Conical scan, Monoput comparison, Bearing Tracking in range, Acc	dars, track while scan (T lse methods; Monopuls errors (without mathema juisition, Comparison o MF response characteris	se Trac atical t f tracke stics; C	cking: A reatmen ers, Tr orrelatio	Amplitu (t), G (acking (on Rec	ide compai lint Noise with Surve eiver, Effi	rison (11 and Free eillance I iciency o	D, 2D), quency A Radar. N of non n	Phase Agility, Iatched

MODULE -V

RADAR TRANSMITTERS & RECEIVERS

Advantages and Disadvantages of Magnetron Oscillator, Klystron Amplifier, Traveling wave tube (TWT) Amplifier, Hybrid Linear-Beam Amplifier and Crossed-Field Amplifiers, Solid State Sources & Amplifiers, Methods for employing solid-state transmitters. Receiver Noise Figure (NF) - Noise Temperature; Measurement of NF, NF of Mixers, Basics of Radar Displays and Duplexers; Phased array antennas: Current and Radiation pattern, Beam steering and effects, Basics of Antenna feeds and Phase shifters.

Text Books:

1. Merrill I Skolnik, "Introduction to Radar Systems", TMH Special Indian Edition, 2nd Edition, 2007.

Reference Books:

1. Merrill I Skolnik, "Radar Handbook", McGraw-Hill Professional Publishing, 3nd Edition, 2008.

Web References:

- 1. http://www.igniteengineers.com
- 2. http://www.ocw.nthu.edu.tw
- 3. http://www.uotechnology.edu.iq
- 4. http://www.iare.ac.in

- 1. http://www.bookboon.com/en/concepts-in-electric-circuits-ebook
- 2. http://www.www.jntubook.com
- 3. http://www.allaboutcircuits.com
- 4. http://www.archive.org

EMBEDDED C

Course Co	de	Category	Ho	urs / W	eek	Credits	Ma	ximum]	Marks
AECB5	1	Elective	L	Т	Р	С	CIA	SEE	Tota
ALCDJ	1	Liective	3	-	-	3	30	70	100
Contact Class	es: 45	Tutorial Classes: Nil	Р	ractica	l Class	es: Nil	Tota	l Classe	s: 45
I. Understa II. Apply te III. Apply ol	uld enab and emb echnique bject ori	ble the students to: edded C and use it for pros s for data transfer betwee ented programming for de derstand the usage of time	n I/O p esignin	orts and g embed	l memo ided sy	ory. vstem.			
MODULE -I	PROG	RAMMING EMBEDDE	ED SYS	STEMS	IN C			Classes	: 10
software, conclu requirements, cl	isions; Ii ock freq	e, which operating system ntroduction, what's in a n uency and performance, n uption ,conclusions.	ame, th	ne extern	nal inte	rface of the	standard	8051, re	eset
	SWITC							Classes	
ntroduction, bas Reading and wri for pull-up resist	sic techn ting bits tors, Dea	iques for reading from po (simple version), Examp ling with switch bounce,	le: Rea	ding an	d writi	ng bits (gen	eric versi	es, exan on), The	nple: need
ntroduction, bas Reading and wri or pull-up resist Counting goats,	sic techn ting bits tors, Dea conclusi	iques for reading from po (simple version), Examp ling with switch bounce,	le: Rea Examp	ding and ole: Read	d writi	ng bits (gen	eric versi	es, exan on), The	nple: need mple:
Introduction, bas Reading and wri For pull-up resist Counting goats, MODULE -III Introduction, ob (PORT.H). Example: Restru	sic techn ting bits ors, Dea conclusi ADDIN ject orie	iques for reading from po (simple version), Examp ling with switch bounce, ons.	le: Rea Examp HE CC	ding and ole: Read DDE roject he	d writin ding sv	ng bits (gend vitch inputs MAIN.H), t	eric versid (basic co	tes, exan on), The de), exan Classes eader	nple: need mple: : 08
Introduction, bas Reading and wri For pull-up resist Counting goats, MODULE -III Introduction, ob (PORT.H). Example: Restru example, further	sic techn ting bits ors, Dea conclusi ADDIN ject orie	iques for reading from po (simple version), Examp ling with switch bounce, ons. G STRUCTURE TO T nted programming with C the "Hello Embedded Wo	le: Rea Examp HE CC C, the pr orld" er	ding and ole: Read DDE roject he xample,	d writin ding sv	ng bits (gend vitch inputs MAIN.H), t	eric versid (basic co	tes, exan on), The de), exan Classes eader	nple: need mple: : 08
Introduction, bas Reading and wri for pull-up resist Counting goats, MODULE -III Introduction, ob (PORT.H). Example: Restru example, further MODULE -IV oduction, creatin by, example: Creating chanisms, creating	sic techn ting bits ors, Dea conclusi ADDIN ject orie icturing r exampl MEET ng hardwe ating a p ng loop t	iques for reading from po (simple version), Examp ling with switch bounce, ons. G STRUCTURE TO T nted programming with C the "Hello Embedded We les and conclusions.	le: Rea Examp HE CC C, the pr orld" ex STRA and Ti Why no sting lo	ding and ole: Read DDE roject he kample, INTS mer 1, e ot use T oop time	d writin ding sv eader (Examp exampl imer 2, couts, e	ng bits (gend vitch inputs MAIN.H), t ble: Restruct e: Generatin The need for xample: A n	eric versid (basic co he port he turing the ng a preci or timeou nore relia	ces, exan on), The de), exan Classes eader e goat-co Classes se 50 ms t	nple: need mple: : 08 unting : 08
Introduction, bas Reading and wri For pull-up resist Counting goats, MODULE -III Introduction, ob (PORT.H). Example: Restrue example, further MODULE -IV oduction, creating y, example: Creating thanisms, creating interface, Creating	sic techn ting bits ors, Dea conclusi ADDIN ject orie icturing r exampl MEET ng hardwe ating a p ng loop t ng hardwe	iques for reading from po (simple version), Examp ling with switch bounce, ons. IG STRUCTURE TO T nted programming with C the "Hello Embedded We les and conclusions. ING REAL-TIME CON vare delays using Timer 0 portable hardware delay, " imeouts and example: Te	le: Rea Examp HE CC C, the pr orld" ex orld" ex orld" ex orld" ex orld the pr orld the pr	ding and ole: Read DDE roject he xample, INTS imer 1, e op time a hardv	d writin ding sv eader (Examp exampl imer 2, couts, e vare tir	ng bits (gend vitch inputs MAIN.H), t ble: Restruct e: Generatin The need for xample: A n	eric versid (basic co he port he turing the ng a preci or timeou nore relia	ces, exan on), The de), exan Classes eader e goat-co Classes se 50 ms t	unting 08 08 08 ch

Text Books:

Michael J. Pont, "Embedded C", Pearson Education, 2nd Edition, 2008.

Reference Books:

Nigel Gardner, "The Microchip PIC in CCS C", Ccs Inc, 2nd Revision Edition, 2002.

Web References:

1. http://www.keil.com/forum/5973/

- 2. http://nptel.ac.in/courses/Webcourse,contents/IIT%20Kharagpur/Embedded%20systems/New_index1.html
- 3. http://nptel.iitg.ernet.in/courses/Elec_Engg/IIT%20Delhi/Embedded%20Systems%20(Video).htm
- 4. http://freevideolectures.com/Course/2999/Embedded-Systems-I/5

E-Text Books:

1. http://teachers.teicm.gr/kalomiros/Mtptx/ebooks/eBook%20%20PIC%20Programming%20with%20C.pdf

2. http://www.ecpe.nu.ac.th/ponpisut/22323006-Embedded-c-Tutorial-8051.pdf

3. http://dsp-book.narod.ru/CPES.pdf

4. http://staff.ustc.edu.cn/~shizhu/WinCE/winCE6%20Fundamentals.pdf

5. http://read.pudn.com/downloads167/ebook/769402/Wrox.Professional.Microsoft.Windows.Embedd

ed.CE.6.0.Nov.2008.eBook-DDU.pdf

REAL TIME SYSTEMS

Course Co	ode	Category	Но	urs / W	eek	Credits	Ma	ximum 1	Marks
AECB5	2	Elective	L	Т	Р	С	CIA	SEE	Tota
nii CD3	-	Licenve	3	-	-	3	30	70	100
Contact Class	ses: 45	Tutorial Classes: Nil	P	ractical	Class	es: Nil	Tota	l Classe	s: 45
I. Understan II. Design th Managem III. Understan	uld enab nd the pri e Real ti ent. nd the co	ble the students to: inciples behind the structure me operating system by u ncept of Communication Operating System applic	using the	e concep nchroni	pt of Tizzation	imers, I/O s among the T	ubsystem		mory
MODULE -I	REAL	TIME OPERATING S	YSTEN	A PRIN	CIPLI	ES		Classes	: 10
	characte	ems, defining RTOS, claseristics of RTOS; Tasks: tructure.							
MODULE -II	REAL	TIME KERNEL OBJE	CTS					Classes	: 09
ypical message signals, condition	queue o n variab	ge queues, message queu perations; Typical messa les. DESIGN CONSIDERA	ige quei	ie use c					gisters
		ces: Real-time clocks as			cks, pr	ogrammabl	e interva		
nterrupt service	routines	, model for implementing	g the so	ft-timer	handli	ng facility,	timing w	heels.	
	l-size m	I/O concepts, the I/O memory management, blacks.							
MODULE -IV	TASK	5 COMMUNICATION	AND S	YNCH	RONI	ZATION		Classes	: 08
		nmunication: Synchroniz a patterns; common desig							
MODULE -V	RTOS	APPLICATION DOM	AINS					Classes	: 10
·	•	f RTOS: Vxworks and μ ce over IP, RTOS for fau					• •	•	
Fext Books:									

- David Chappell, "Understanding .NET A Tutorial and Analysis", Addison Wesley, 2nd Edition, 2002.
- 3. S. Thamarai Selvi, R. Murugesan, "A Textbook on C#", Pearson Education, 1st Edition, 2003.

- 1. Raymond J.A.Bhur, Donald L.Bailey, "An Introduction to Real Time Systems", PHI, 1st Edition, 1999.
- 2. Wayne Wolf, "Computers as Components: Principles of Embedded Computing System Design", Kindle Publishers, 2nd Edition, 2005.
- 3. Tanenbaum, "Modern Operating Systems", Pearson Edition, 3rd Edition, 2007.

Web References:

- 1. http:// www.jntumaterials.co.in
- 2. http://www.inf.ed.ac.uk/teaching/courses/es/PDFs/RTOS.pdf
- 3. http://nptel.ac.in/courses/106108101/pdf/Lecture_Notes/Mod%208_LN.pdf
- 4. http://www.iare.ac.in

- 1. http://www.bookzz.org/
- 2. http://www.www.jntubook.com
- 3. http:// www.4shared.com/web/preview/pdf/BhrrT3m0
- 4. http://www.archive.org

EMBEDDED NETWORKING

1	Category	Ho	urs / W	eek	Credits	Ma	ximum	Marks
AECB53	Elective	L	Т	Р	С	CIA	SEE	Tota
AECB55	Elective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	P	ractica	Class	es: Nil	Tota	l Classe	s: 45
II. Design of CAN ne	dded communication pre etwork based systems. ndamental usage of UD DED COMMUNICAT ntroduction, serial/paral	P, TCP TION P lel com	and FT ROTO munica	P in de COLS tion, se	sign of emb	nication	etworks. Classes	8,
I ² C- pc parallel port prog MODULE -II USB AN	gramming.		1	1	,		Classes	
NODULE -II USD AN	D CAN DUS						Classes	. 09
Simple application with CA MODULE -III ETHERN Elements of a network, i	NET BASICS	g 0 not	work I	Iordura	ra ontions	applas	Classes	
network speed.	inside Ethernet, bundin	g a net	WOIK. I	laluwa	re options,	cables, c	onnectio	ms and
		ernet	controll	ers, u	sing the	internet	in loca	al and
Design choices: Select: communications, inside th MODULE -IV EMBED	DED ETHERNET						Classes	
communications, inside the module -IV EMBED hanging messages using U	DED ETHERNET	web pag	ges with	ı dynar	nic data, ser	ving web	Classes	: 08
communications, inside th	ne Internet protocol. DED ETHERNET UDP and TCP: Serving , email for embedded sy	web pag stems,	ges with using F	ı dynar	nic data, ser	ving web	Classes pages	: 08 cure
COMMUNICATIONS, INSIDE THE MODULE -IV EMBED hanging messages using U that respond to user Input,	The Internet protocol. DED ETHERNET UDP and TCP: Serving , email for embedded sy ESS EMBEDDED NET : Introduction, application	web pag rstems, FWOR ons, net	ges with using F <mark>KING</mark> work to	dynar TP, kee pology	nic data, ser eping device	ving web es and ne	Classes pages twork se Classes	: 08 cure : 10
communications, inside theMODULE -IVEMBEDhanging messages using Uthat respond to user Input,MODULE -VWIRELIWireless sensor networks:synchronization, energy e	The Internet protocol. DED ETHERNET UDP and TCP: Serving , email for embedded sy ESS EMBEDDED NET : Introduction, application	web pag rstems, FWOR ons, net	ges with using F <mark>KING</mark> work to	dynar TP, kee pology	nic data, ser eping device	ving web es and ne	Classes pages twork se Classes	: 08 cure : 10

- 1. Dogan Ibrahim, "Advanced PIC microcontroller projects in C: from USB to RTOS with the PIC18F Series", Elsevier, 1st Edition, 2008.
- 2. Jan Axelson, "Embedded Ethernet and Internet Complete", Penram publications, 2nd Edition, 2003.
- 3. Bhaskar Krishnamachari, "Networking Wireless Sensors", Cambridge press, 1st Edition, 2005.

Web References:

- 1. http://nptel.ac.in/courses/108102045/26
- 2. http://freevideolectures.com/Course/2341/Embedded-Systems/27
- 3. http://nptel.iitg.ernet.in/courses/Elec_Engg/IIT%20Delhi/Embedded%20Systems%20(Video).htm

E-Text Books:

- 1. www.nptel.ac.in/courses/108105057/Pdf/Lesson-26.pdf
- 2. www.nptel.ac.in/courses/108105057/Pdf/Lesson-3.pdf
- 3. emanager.srmuniv.ac.in/elibrary/temp/CAN_and_CANopen.pdf
- 4. https://www.crcpress.com/Embedded-and-Networking-Systems-Design-Software-

andImplementation/Khan-Iniewski/p/book/9781466590656

ADVANCED RISC MACHINE ARCHITECTURES

Course Code	Category	He	ours / V	Week	Credits	M	aximum	Marks
AECB54	Elective	L	Т	Р	С	CIA	SEE	Total
		3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	Prac	ctical (Classes	: Nil	Total (Classes: 4	5
II Learn about In III Understand at IV Explain the sy		odes anng of A	nd cono ARM.	ditional		18.	Cla	asses: 08
e 1	hy, Registers, Program S ision, ARM Processor Far		Registe	er, Inst	ruction Pip	peline, Iı	nterrupts	and Vect
MODULE -II ARM	PROGRAMMING MO	DEL -	- I				Cla	asses: 09
nstruction Set: Data F	Processing Instructions. A	ddress	sing M	odes		1 0		tions DC
nstructions, Conditiona			,		Branch, Lo	ad, Stor	e Instruc	lions, PS
MODULE -III ARM H		EL – I	I				Cla	usses: 09
MODULE -III ARM I Thumb Instruction Set: Single-Register and Mu MODULE -IV ARM I Simple C Programs us	l Instructions PROGRAMMING MOD	EL – 1 nch In structic G HIC nters,	II structions, Sta SH LE Structor	ons Dat ack, So VEL I ures, I	ta Processin ftware Inter ANGUAG nteger and	ng Instruc rrupt Inst E Floating	Cla ctions. ructions. Cla g Point	asses: 09 asses: 09 Arithmetic
MODULE -IIIARM HFhumb Instruction Set:Single-Register and MuMODULE -IVARM HSimple C Programs usAssembly Code using InMODULE -VMODULE -VMEMO	l Instructions ROGRAMMING MOD Register Usage, Other Bra Iti Register Load-Store Ins PROGRAMMING USIN sing Function Calls, Poi astruction Scheduling, Reg DRY MANAGEMENT	EL – 1 nch In structic G HIC nters, gister A	II structions, State SHLE Struction	ons Dat ack, So VEL I ures, I ion, Co	ta Processin ftware Inter ANGUAG nteger and nditional E	ng Instruc rupt Inst E Floating xecution	Cla ctions. ructions. Cla g Point A and Loop Cla	asses: 09 asses: 09 Arithmeti os. asses: 10
Thumb Instruction Set: Single-Register and Mu MODULE -IV ARM I Simple C Programs us Assembly Code using In MODULE -V MEMC The Memory Hierarchy Flushing and Cleaning Lookaside Buffer, The C Text Books: 1. ARM Systems Dev	I Instructions PROGRAMMING MOD Register Usage, Other Bra Iti Register Load-Store Ins PROGRAMMING USIN Sing Function Calls, Poi Instruction Scheduling, Reg DRY MANAGEMENT and Cache Memory, Cac Caches and Write Buffer, A reloper's Guides- Designin	EL – 1 nch In structio G HIC nters, gister A from Access	II structions, Sta SH LE Structu Allocation chitectu an MF Permi	ons Dat ack, So VEL I ures, I ion, Co ure, Ca PU to a ssions,	ta Processin ftware Inter ANGUAG nteger and nditional E che Policy, in MMU, I Context Sy	ng Instruct rupt Inst E Floating xecution Coproce Page Tab vitch.	Cla ctions. rructions. Cla g Point A and Loop Cla essor 15 a oles, The	asses: 09 Arithmetios. and Cache Translatio
MODULE -III ARM H Fhumb Instruction Set: Single-Register and Mu MODULE -IV ARM H Simple C Programs us Assembly Code using In MODULE -V MEMC The Memory Hierarchy Flushing and Cleaning Lookaside Buffer, The O Text Books: 1. ARM Systems Dev Dominic Symes, C 2. ARM System-on-c 2E,2012.	I Instructions PROGRAMMING MOD Register Usage, Other Bra Iti Register Load-Store Ins PROGRAMMING USIN Sing Function Calls, Poi Instruction Scheduling, Reg DRY MANAGEMENT and Cache Memory, Cac Cache Memory. Moving Caches and Write Buffer, A	EL – 1 nch In structic G HIC nters, gister A from Access ng & C r.	II structions, State SHLE Structu Allocation chitectu an MF Permi	ons Dat ack, So VEL I ures, I ion, Co ure, Ca PU to a ssions, ing Sys	ta Processin ftware Inter ANGUAG nteger and nditional E che Policy, un MMU, I Context Sy stem Softw	ng Instruct rupt Inst E Floating xecution Coproce Page Tab vitch. are – And	Cla ctions. rructions. g Point A and Loop Cla essor 15 a oles, The drew N. S	asses: 09 Arithmetios. and Cache Translatio
MODULE -III ARM H Chumb Instruction Set: Single-Register and Mu MODULE -IV ARM H Simple C Programs us Simple C Programs us Assembly Code using In MODULE -V MODULE -V MEMO Che Memory Hierarchy Flushing and Cleaning Jookaside Buffer, The O Text Books: 1. ARM Systems Dev Dominic Symes, C 2. ARM System-on-c 2E,2012. Reference Books: Communicipation	I Instructions PROGRAMMING MOD Register Usage, Other Bra Iti Register Load-Store Ins PROGRAMMING USIN Sing Function Calls, Poi Instruction Scheduling, Reg DRY MANAGEMENT and Cache Memory, Cac Cache Memory. Moving Caches and Write Buffer, A reloper's Guides- Designin hris Wright, 2008, Elsevie	EL – 1 nch In structic G HIC nters, gister A he Arc from Access ng & C r. Furber	II structions, State SHLE Structu Allocation chitectu an MF Permi Dptimiz	ons Dat ack, So VEL I ures, I ion, Co ure, Ca PU to <i>a</i> ssions, ing Sys son Edu	ta Processin ftware Inter ANGUAG nteger and nditional E che Policy, in MMU, I Context Sy stem Softw	ng Instruct rupt Inst E Floating xecution Coproce Page Tab vitch. are – And N978-81	Cla ctions. rructions. g Point A and Loop Cla essor 15 a oles, The drew N. S -317-084	asses: 09 Arithmetions. Asses: 10 and Cache Translation Floss, 0-8,

Web References:

https://developer.arm.com/ https://www.arm.com/ https://electronicsforu.com/resources/learn-electronics/introduction-arm-processor https://www.scribd.com/document/90853471/Advanced-RISC-Machine-ARM-Notes-Bhurchandi

E-Text Book:

https://www.arm.com/resources/education/textbooks https://www.quora.com/Which-book-is-most-suitable-to-learn-ARM-Processor www.keil.com/books/armbooks.asp

COMPUTER ARCHITECTURE

Course Co	de	Category	Но	urs / W	/eek	Credits	Ma	30 70 10 Total Classes: 45 computers. n cycle. . ls. lpipelining. Classes: 09 interfacing, input ramming language Classes: 01 s, arithmetic micro Classes: 01 s, arithmetic micro Classes: 01 ns, input-output, cimal arithmetic ur Classes: 01 c, modes of transf Classes: 01	Marks
ACSB32		Elective	L	Т	Р	С	CIA		Tota
			3	-	-	3	30		100
Contact Class	es: 45	Tutorial Classes: Nil	P	ractica	l Class	ses: Nil	Tota	al Classe	s: 45
The course shou I. Understand II. Study the as III. Design a sir IV. Study the ba	the orga sembly nple con asic com	ble the students to: anization and architecture language program execut nputer using hardwired ar aponents of computer syst utput organization, memor	ion, ins nd micr ems bea	truction o progr sides th	n forma ammec e comp	tt and instru l control me outer arithm	ction cyc thods. etic.	cle.	
MODULE - I	INTI	RODUCTION TO CO	MPUI	rer o	RGA	NIZATIO	N	Class	es: 09
output subsyster	n organ	ation, CPU organization, and interfacing, actions, a simple instruction	a simj	ple cor	nputer				
MODULE -II	ORG	SANIZATION OF A C	COMP	UTER				Class	ses: 09
		er transfer language, regist perations, shift micro ope					sfers, ari	thmetic 1	nicro
MODULE -III	CPU	AND COMPUTER A	RITH	METI	C			Class	ses: 09
interrupt, address	ing mo	n cycle, data representa des, data transfer and man ldition and subtraction, flo	ipulatio	on, prog	gram co	ontrol.		-	-
MODULE -IV	INPU	UT-OUTPUT ORGANI	ZATIO	ON				Class	ses: 09
Input or output priority interrupt	•	ation: Input or output Ir memory access.	nterface	e, async	chronou	ıs data trar	nsfer, mo	odes of t	ransfer
MODULE -V	MEN	IORY ORGANIZATI	ION					Class	ses: 09
		Memory hierarchy, main r; Pipeline: Parallel proces					sociative	memory	, cach
Fext Books:									
1. M. Morris M	ano, "C	Computer Systems Archited	cture",	Pearson	n, 3 rd E The Her	dition, 2015 dware/Softy	vare Inte	rface" N	lorgan

Reference Books:

- 1. John. P. Hayes, "Computer System Architecture", McGraw-Hill, 3rd Edition, 1998.
- 2. Carl Hamacher, Zvonko G Vranesic, Safwat G Zaky, "Computer Organization", McGraw-Hill, 5th Edition, 2002.
- 3. William Stallings, "Computer Organization and Architecture", Pearson Edition, 8th Edition, 2010.

Web References:

- 1. https://www.tutorialspoint.com/computer_logical_organization/
- 2. https://www.courseera.org/learn/comparch
- 3. https://www.cssimplified.com/.../computer-organization-and-assembly-language-programming

- 1. https://www.groupes.polymtl.ca/inf2610/.../ComputerSystemBook.pdf
- 2. https://www.cse.hcmut.edu.vn/~vtphuong/KTMT/Slides/TextBookFull.pdf

ANALYSIS OF ALGORITHMS AND DESIGN

Course Code	Category	Ho	ours / V	Veek	Credits	Ma	ximum N	Iarks
A CED22		L	Т	Р	С	CIA 30 Tota bacts the p is. becified ap quer, gree is: Space ga notation merge so raversals: bsack prob timal bina h; Backtra	SEE	Total
ACSB33	Elective	3	-	-	3	30	70	100
Contact Classes: 45 T	Sutorial Classes: Nil	Pı	ractica	l Class	es: Nil	Tot	al Classes	:: 45
 OBJECTIVES: The course should enable I. Assess how the choice programs. II. Solve problems using III. Choose the appropriat IV. Solve problems using dynamic programming 	e of data structures and data structures such as e data structure and al algorithm design meth	s bina gorith hods s	ry sear im desi iuch as	ch trees gn met the div	s, and graph hod for a sp	s. ecified ap	plication.	
MODULE -I INTROD	OUCTION						Cla	sses: 09
Algorithm: Pseudo code complexity; Amortized Con little o notation.					•	-		•
MODULE -II DIVIDE	AND CONQUER						Cla	sses: 09
Divide and Conquer: Gene multiplication.	eral method, application	ons: E	Binary	search,	quick sort,	merge so	ort, Strass	en's matr
MODULE -III TRAVEL	RSAL TECHNIQUE	S AN	D GR	EEDY	METHOD		Cla	sses: 09
Efficient non recursive bind depth first search, connecte Greedy method: The gen shortest paths.	ed components, biconn	nected	compo	onents.	Ĩ			
MODULE -IV DYNAM	IC PROGRAMMIN	G					Cla	sses: 09
Dynamic programming: T knapsack problem, all pairs			chain	multip	lication, opt	timal bin	ary searcl	n trees, 0
MODULE -V BRANCH	H AND BOUND, BA	CKTI	RACK	ING			Cla	sses: 09
Branch and bound: The method, the 8 queens probl		vellin	g sale	sperso	n problem	; Backtra	acking: T	'he gener
Text Books:								
1. Ellis Horowitz, Satraj Sa Universities Press, 2 nd Ec	hni, Sanguthevar Raja lition, 2015.					•	C	

Reference Books:

- 1. Levitin A, "Introduction to the Design and Analysis of Algorithms", Pearson Education, 3rd Edition, 2012.
- 2. Goodrich, M. T. R Tamassia, "Algorithm Design Foundations Analysis and Internet Examples", John Wiley and Sons, 1st Edition, 2001.
- 3. Base Sara Allen Vangelder, "Computer Algorithms Introduction to Design and Analysis", Pearson, 3rd Edition, 1999.

Web References:

- 1. http://www.personal.kent.edu/~rmuhamma/Algorithms/algorithm.html
- 2. http://openclassroom.stanford.edu/MainFolder/CoursePage.php?course=IntroToAlgorithms
- 3. http://www.facweb.iitkgp.ernet.in/~sourav/daa.html

E-Text Books:

1.http://ebook/com/item/introduction_to_the_design_and_analysis_of_algorithms_3rd_editionananylevitin/ 2. https://drive.google.com/file/d/0B_Y1VbyboEDBTDVxVXpVbnk4TVE/edit?pref=2&pli=1 3. http://www.amazon.com/Computer-Algorithms-Introduction-Design-Analysis/dp/0201612445

MOOC Course:

- 1. https://www.coursera.org/learn/algorithm-design-analysis
- 2. http://www.online.stanford.edu/course/algorithms-design-and-analysis-part-1
- 3. https://www.onlinecourses.nptel.ac.in/noc16_cs04/preview

RELATIONAL DATABASE MANAGEMENT SYSTEMS

Course Code	Category	Ho	ours / V	Week	Credits	Max	ximum N	Iarks
ACSB34	Elective	L	Т	Р	С	CIA	SEE	Total
		3	-	-	3	30	70	100
Contact Classes: 45 OBJECTIVES:	Tutorial Classes: Nil	Pı	ractica	l Classe	es: Nil	То	tal Class	ses: 45
II. Design databases usi III. Construct database q IV. Understand the conce V. Learn how to evaluat MODULE -I CON Introduction to Database of DBMS over File Syste DDL-DML - Database U MODULE -II REL Database Design and ER	ble the students to: of database management ng data modeling and Lo ueries using relational alg ept of a database transact te a set of queries in quer CEPTUAL MODELING s and Database Managen em - Data Models – Insta- fsers and Administrator - ATIONAL APPROAC	gical of gebra a ion an y proc G INT nent S nces a Datab H and Er	databas and ca d relat essing TROD ystem nd sch ase Sy	se design lculus an ed concre- UCTIO - Databa nema - V rstem Str ets – Re	n techniques nd SQL. urrent, recov N ase system A l'iew of Data ructure.	Application Application A - Databa	ities. Class ons Adva ase Lang Class ationship	ses: 09 antages uages - ses: 09 Sets –
	gn with ER model - Data QUERY - BASICS, R		-			orise.	Class	ses: 09
	onal Model – Structure o traints – Querying Relati			•••				-
	ta Definition commands, erations - Join operations L							
MODULE -IV TRAN	NSACTION MANAGE	MEN	Г				Class	ses: 09
of a set of dependencies, Database Design- Proble Decomposition — Lossle	- Introduction, Basic De closure of attributes, irre ms Caused by Redundan ss Join Decomposition – nal Forms – BCNF –Mult	ducibl acy De Deper	e set o compo ndency	f depend ositions - v Preserv	lencies- Sch – Problem R ving Decomj	nema Ref Related to position -	inement FIRST,	
MODULE -V DAT	A STORAGE AND QU	JERY	PRO	CESSIN	G		Class	ses: 09
Fransaction concept- T								

1. Abraham Silberschatz, Henry F. Korth, S. Sudarshan, "Database System Concepts", McGraw-Hill, 6th Edition, 2017.

Reference Books:

- 1. Ramez Elmasri, Shamkant B. Navathe, "Fundamental Database Systems", Pearson Education, 6th Edition, 2014.
- 2. Raghu Ramakrishnan, "Database Management System", Tata McGraw-Hill Publishing Company, 3rd Edition, 2007.
- 3. Hector Garcia Molina, Jeffrey D. Ullman, Jennifer Widom, "Database System Implementation", Pearson Education, United States, 1st Edition, 2000.
- 4. Peter Rob, Corlos Coronel, "Database System, Design, Implementation and Management", Thompson Learning Course Technology, 5th Edition, 2003.

Web References:

- 1. https://www.youtube.com/results?search_query=DBMS+onluine+classes
- 2. http://www.w3schools.in/dbms/
- 3. http://beginnersbook.com/2015/04/dbms-tutorial/

E-Text Books:

- 1. http://www.e-booksdirectory.com/details.php?ebook=10166
- 2. http://www.e-booksdirectory.com/details.php?ebook=7400re
- 3. https://docs.google.com/file/d/0B9aJA_iV4kHYM2dieHZhMHhyRVE/edit

MOOC Course

- 1. https://onlinecourses.nptel.ac.in/noc18_cs15/preview
- 2. https://ocw.mit.edu/courses/electrical-engineering-and-computer-science/6-830-database-systems-fall-2010/

ADVANCED DATA STRUCTURES

Course	Code	Cotogory							
АТТЕ		Category		ours / `	Week	Credits		ximum M	larks
	330	Elective	L 3	T -	P -	C 3	CIA 30	SEE 70	Total 100
Contact Cl	asses: 45	Tutorial Classes: Nil	P	ractica	al Classe	es: Nil	Tot	al Classe	s: 45
VI. Understa VII. Under VIII. Comp IX. Understa	hould enab nd the basic erstand diction prehension of nd balanced	le the students to: data structures and technic onaries, hashing mechanis of heaps, priority queues a trees and their operations ad pattern matching algori	sms and and its 5.	d skip	lists for	•	retrieval.		
UNIT - I	OVERVI	EW OF DATA STRUCT	FURE	S				Class	ses: 09
	uctures - Th	e analysis: Time complex ne list ADT, Stack ADT,							
UNIT - II	DICTION	NARIES, HASH TABLE	S					Class	ses: 09
Hash table re	epresentation	representation, Skip list ro n, hash functions, collisio ing, double hashing, rel	on res	olutior	ı - sepai	ate chainin	g, open a	addressin	g - linea
UNIT - III	PRIORIT	Y QUEUES						Class	ses: 09
		tion, ADT, Realizing a Pr ng- Model for external so						etion, Ap	plication
UNIT - VI	SEARCH	TREES						Class	ses: 09
ADT, Balan	ce factor, C	efinition, ADT, Operatior Dperations – Insertion, D perations - insertion, delet	eletior	n, Sear	ching, I	ntroduction	to Red -	– Black a	
UNIT - V	PATTER	N MATCHING AND TI	RIES					Class	ses: 09
		hms - the Boyer - Moore igital search tree, Binary t					s - Pratt	algorithn	n. Tries -
Text Books:									
Universit	ies Press Pri ai, "Data St	taj Sahni, Sanguthevar I ivate Limited, India, 2 nd E ructures and Algorithms", ehrouz A Forouzan, "Dat	dition, , Tata I	, 2008. McGra	w Hill, I	New Delhi,	1 st Editio	n, 2008.	

Reference Books:

- 1. D. Samanta, "Classic Data Structures", Prentice Hall of India Private Limited, 2nd Edition, 2003.
- 2. Aho, Hop craft, Ullman, "Design and Analysis of Computer Algorithms", Pearson Education India, 1st Edition, 1998.
- 3. Goodman, Hedetniemi, "Introduction to Design and Analysis of Algorithms", Tata McGraw Hill, New Delhi, India, 1st Edition, 2002.
- 4. Adam Drozdek, "Data Structures and Algorithms in C++", Thomson Course Technology, 3rd Edition, 2005.
- 5. M. T. Goodrich, R. Tomassia, "Data structures and Algorithms in Java", Wiley India, 3rd Edition, 2011.

Web References:

- 5. https://www.tutorialspoint.com/data_structures_algorithms/data_structures_basics.htm
- 6. https://www.geeksforgeeks.org/data-structures/
- 7. http://www.nptelvideos.in/2012/11/data-structures-and-algorithms.html

E-Text Books:

- 1. https://pdfs.semanticscholar.org/19ec/55ed703eb24e1d98a4abd1a15387281cc0f8.pdf
- 2. https://www.academia.edu/35961658/Data.Structures.A.Pseudocode.Approach.with.C.2nd.edition_1_.pdf
- 3. https://sonucgn.files.wordpress.com/2018/01/data-structures-by-d-samantha.pdf

MOOC Course

- 1. https://nptel.ac.in/courses/106103069/
- 2. https://www.coursera.org/learn/data-structures
- 3. https://www.edureka.co/blog/data-structures-algorithms-in-java/
- 4. https://www.edx.org/micromasters/ucsandiegox-algorithms-and-data-structures

DATA COMMUNICATIONS AND NETWORKS

	Category	Н	lours / W	/eek	Credits	Max	imum M	arks
AITB31	Elective	L	Т	Р	С	CIA	SEE	Tota
AIIDJI	Liective	3	-	-	3	30	70	100
Contact Classes: 45	Tutorial Classes: Nil	I	Practical	Classes	: Nil	Tot	al Classo	es:45
II. Understand the ball. III. Provide an oppor	able the students to: rstanding of modern netwo asics and challenges of ne tunity to do network prog peration of the protocols t	twork o rammir	communi ng using '	cation. TCP/IP.	C	perform	ance pers	spective
MODULE - I DAT	A COMMUNICATION	S					Classe	s: 09
A ·	n of Data flow, Netwo and Standards, ISO / O	-			U			
MODULE – II THE	PHYSICAL LAYER						Classe	s: 09
Fransmission modes, Virtual Circuit Networ	Switching, Circuit Switc ks.	ched N	Jetworks,	Transr	nission Me	edia, Da	tagram N	letwork
MODULE – III TH	E DATALINK LAYER						Classe	s: 09
				D 1	I D G		•	
	and Error – Detection a seless Channels, Noisy Cl						ming co	de, Flo
and Error Control, Nois							ming co	
and Error Control, Nois MODULE – IV THE Logical Addressing, I	seless Channels, Noisy Cl	hannels	s, HDLC,	Point to	Point Prot	ocols.	Classe	s: 09
and Error Control, Nois MODULE – IV THE Logical Addressing, I Routing Protocols, Mu	seless Channels, Noisy Cl NETWORK LAYER Internetworking, Tunnelin	hannels	dress ma	Point to	Point Prot	ocols.	Classe	s: 09 Uni-Ca
and Error Control, Nois MODULE – IV THE Logical Addressing, I Routing Protocols, Mu MODULE – V THE	seless Channels, Noisy Cl NETWORK LAYER nternetworking, Tunnelin lticast Routing Protocols	ng, Ado PPLIC	dress ma	Point to	Point Prot	ocols. 1P, Forv	Classes varding, Classes	s: 09 Uni-Ca s: 09
And Error Control, Noise MODULE – IV THE Logical Addressing, I Routing Protocols, Mu MODULE – V THE Introduction, client ser Protocol), FTP (File System), SNMP (Simp	seless Channels, Noisy Cl NETWORK LAYER nternetworking, Tunnelin lticast Routing Protocols TRANSPORT AND AI	hannels ng, Add PPLIC (World AIL, T Protoc	dress ma ATION d Wide V ELNET, col). Intro	Point to pping, D LAYER Veb) and SECUI	Point Prot	ocols. IP, Forv /per Text 2, DNS(1	Classes varding, Classes Transfer Domain	s: 09 Uni-Ca s: 09
MODULE – IV THE Logical Addressing, I Routing Protocols, Mu MODULE – V THE ntroduction, client ser Protocol), FTP (File System), SNMP (Simp	seless Channels, Noisy Cl NETWORK LAYER nternetworking, Tunnelir lticast Routing Protocols TRANSPORT AND Al ver programming, WWW Transfer Protocol), E-M ole Network Management	hannels ng, Add PPLIC (World AIL, T Protoc	dress ma ATION d Wide V ELNET, col). Intro	Point to pping, D LAYER Veb) and SECUI	Point Prot	ocols. IP, Forv /per Text 2, DNS(1	Classes varding, Classes Transfer Domain	s: 09 Uni-Ca s: 09

Reference Books:

- 1. Douglas E. Comer "Internetworking with TCP/IP ", Prentice-Hall, 5th Edition, 2011.
- 2. Peterson, Davie, Elsevier "Computer Networks", 5th Edition, 2011
- 3. Comer, "Computer Networks and Internets with Internet Applications", 4th Edition, 2004.
- 4. Chawan- Hwa Wu, Irwin, "Introduction to Computer Networks and Cyber Security", CRC publications, 2014.
- 2014.

Web References:

- 1. http://computer.howstuffworks.com/computer-networking-channel.htm
- 2. http://www.ietf.org
- 3. http://www.rfc-editor.org/
- 4. https://technet.microsoft.com/en-us/network/default.aspx

E-Text Books:

- 1. http://www.freebookcentre.net/networking-books-download/Lecture-Notes-on-Computer-Networks.html
- 2. http://www.freebookcentre.net/networking-books-download/Introduction-to-Computer-Networks.html

MOOC Course

- 1. https://www.mooc-list.com/course/networking-introduction-computer-networking-stanforduniversity
- 2. https://lagunita.stanford.edu/courses/Engineering/Networking/Winter2014/about.

NETWORK SECURITY

Course Co	de	Category	Но	urs / W	/eek	Credits	Ma	i ximum I	Marks
AITB32		Elective	L	Т	Р	С	CIA	SEE	Tota
			3	-	-	3	30	70	100
Contact Class		Tutorial Classes: Nil	P	Practica	al Class	ses: Nil	Tota	d Classe	s: 45
I. Learn the ba II. Understand III. Apply authe IV. Analyze the V. Discuss the MODULE-I	various c ntication applicat place of	ble the students to: gories of threats to compute cryptographic algorithms and functions for providing efficient ion protocols to provide we ethics in the information se CKS ON COMPUTERS	nd be fa fective s eb secur ecurity a AND C	miliar v security ity. rea. OMPU	with pu 7. TER S	SECURITY		Classes:	
principles of sec security; Crypto	curity, ty ography	and computer security: I pes of security attacks, se concepts and techniques techniques, encryption and	curity s : Intro	ervices duction	, secur , plair	ity mechania text and	sm, a mo cipher te	odel for r ext, subs	network stitution
MODULE-II	SYMM	IETRIC AND ASYMME	TRIC	KEY C	(IPHE)	RS		Classes:	: 09
stream ciphers, a	and place	Block cipher principles and ement of encryption functions, algorithms (RSA Diffie-I	on, key	distribu			•		
MODULE-III	MESS. FUNC	AGE AUTHENTICATIO TIONS	N ALG	ORIT	HM A	ND HASH		Classes:	: 09
authentication co	odes. : Hash	algorithm and hash fund functions, secure hash a ication service.							C
MODULE-IV	E-MAI	IL SECURITY						Classes:	: 09
IP Security: IP	security	Good Privacy; S/MIME v overview, IP security a rity associations, key mana			thentic	ation heade	r, encaps	sulating s	security
MODULE-V	WEB S	SECURITY						Classes:	: 09
transaction, Intruders; Virus	and fire	rity considerations, secure walls: Intruders, intrusion Il design principles; Types	detectio	on passy					

Text Books
 William Stallings, "Cryptography and Network Security", Pearson Education, 4th Edition, 2005. Atul Kahate, "Cryptography and Network Security", McGraw-Hill, 2nd Edition, 2009.
Reference Books
1. C K Shymala, N Harini, Dr. T R Padmanabhan, "Cryptography and Network Security", Wiley India, 1 st Edition, 2016.
2. Behrouz A. Forouzan Debdeep Mukhopadhyay, "Cryptography and Network Security", McGraw-Hill, 2 nd Edition, 2010.
Web References
1. http://bookboon.com/en/search?q=INFORMATION+SECURITY
2. https://books.google.co.in/books/about/Cryptography_Network_Security_Sie_2E.html?id=Kokjwdf0E7Q C
3. https://books.google.co.in/books/about/Information_Security.html?id=Bh45pU0_E_4C
E-Text Books
1. https://books.google.co.in/books/about/Information_Security.html
2. http://www.amazon.in/Cryptography-Network-Security-Behrouz-Forouzan/dp/007070208X

ENERGY FROM WASTE

OE – II

Course Code		Category	Hou	rs / V	Veek	Credits	Max	imum M	larks		
ACEB52		Elective	L	Т	Р	С	CIA	SEE	Total		
ACED52		Liecuve	3	-	-	3	30	70	100		
Contact Classes:	45	Tutorial Classes: Nil		Pract	ical Cla	asses: Nil	To	tal Clas	ses: 60		
COURSE OBJECTIV											
The course should en											
-	incip	les associated with effectiv	ve energ	y mar	agemer	it and to app	ply these p	rinciple	s in the		
day to day life.	nto th	e collection, transfer and tr	anenori	ofm	micinal	solid waste					
,		operation of a municipal s	-		-	sonu wasie	•				
		ational challenges in opera				chemical en	ergy from	waste fa	cilities		
		es involved in recovering e					87				
						OFCONC					
MODULE - I IN	NIK	ODUCTION TO WASTE	AND	WAS	IE PRO	JCESSING	r	Class	ses: 08		
recycling of municipa generation of energy design, medical wast	al wa fron te / j	ological properties, waste ste, segregation of waste, n waste treatment and dis pharmaceutical waste treat onmental effects due to inc	size rec sposal a atment	ductio erobio techno	n, mana c comp	iging waste osting, inci	, status of neration, f	technol furnace	ogies for type and		
MODULE - II W	AST	TE TREATMENT AND I	DISPOS	SAL			Classes: 1				
and preliminary desig	gn of	vaste disposal land fill clas landfills: Composition, ch nmental monitoring system	naracteri	istics,	generat						
MODULE - III B	IO-C	CHEMICAL CONVERSION	ON					Class	ses: 09		
	cipal	aste bio-chemical conversion waste, direct combustion estion.									
MODULE - IV	HER	MO-CHEMICAL CONV	ERSIC	ON				Class	ses: 10		
generation, gasificati	ion o	ill gas generation and ution waste using gasifies bio-chemical and thermo-c	brique	tting,	utilizat						
MODULE - V E-	-WA	STE MANAGEMENT						Class	ses: 08		
concerns and health ha in hazardous waste,	azarc impa ns or	bbal context: Growth of ele ls; Recycling e-waste: A th act of hazardous e-waste n e-waste management, int on laws of India.	riving e in Inc	econor lia; N	ny of th Ianagen	e unorganiz	zed sector, vaste: E-v	global t vaste le	rade gislation		

- 1. Nicholas P Cheremisinoff, "Handbook of Solid Waste Management and Waste Minimization Technologies", An Imprint of Elsevier, New Delhi, 2003.
- 2. P Aarne Vesilind, William A Worrell and Debra R Reinhart, "Solid Waste Engineering", 2nd Edition 2002.
- 3. M Dutta, B P Parida, B K Guha and T R Surkrishnan, "Industrial Solid Waste Management and Land filling practice", Reprint Edition New Delhi, 1999.
- 4. Rajya Sabha Secretariat, "E-waste in India: Research unit", Reprint Edition, June, 2011.

Reference Books:

- 1. C Parker and T Roberts (Ed), "Energy from Waste", An Evaluation of Conversion Technologies, Elsevier Applied Science, London, 1985.
- 2. KL Shah, "Basics of Solid and Hazardous Waste Management Technology", Prentice Hall, Reprint Edition, 2000.
- 3. M Datta, "Waste Disposal in Engineered Landfills", Narosa Publishing House, 1997.

Web References:

- https://www.e-waste Management: From waste to Resource Klaus Hieronymi, Ramzy Kahnat, Eric williams Tech. & Engg.-2013 (Publisher: Earthscan 2013)
- 2. https://www.What is the impact of E-waste: Tamara Thompson
- 3. https://www. E-waste poses a Health Hazard: Sairudeen Pattazhy

- 1. https://www.unep.org
- 2. https://www.outledge.com
- 3. https://www.bookdepository.com
- 4. https://www.ecoactiv.com

DISASTER MANAGEMENT

Course Code	Category	Но	urs / V	Veek	Credits	Ma	ximum N	larks		
A CED 52		L	Т	Р	С	CIA	SEE	Total		
ACEB53	Elective	3	-	-	3	30	70	100		
Contact Classes: 45	Tutorial Classes: Nil	P	ractic	al Clas	sses: Nil	Tota	l Classes	: 45		
II. Recognize and de and refugee relief of III. Understand the key different disaster n	disaster types and develop velop awareness of the o	chronc nagem	ologica ent rel	l phase ated to	es of natura developme	al disaster	response relationsl			
MODULE - I ENV	IRONMENTAL HAZA	ARDS	AND	DISAS	STERS		Classes:	09		
environmental stress; c disasters, different app	s and disasters: meaning concept of environmental proaches and relation wit pproach, human ecology	hazaro h hum	ds, env nan eco	ironme ology,	ental stress a landscape a	and enviror	nmental cosystem			
MODULE - II TYP	PES OF ENVIRONMEN	TAL	HAZA	ARDS	AND DISA	STERS				
disasters, natural hazar	nl hazards and disasters: N rds, planetary hazards/ dis azards, exogenous hazard	asters								
MODULE - III ENI	OOGENOUS HAZARDS	5					Classes:	09		
distribution of volcane eruptions. Earthquake hazards/ d	volcanic eruption, earthq oes, hazardous effects or isasters, causes of earthc te hazards in India, human	f volc Juakes	anic e , distr	ruption ibution	ns, environr	nental imp akes, haza	acts of v rdous eff	volcanio		
MODULE - IV EXC	OGENOUS HAZARDS						Classes:	09		
events: Cyclones , ligh tropical cyclones and I Cumulative atmospher floods, flood hazards I Droughts: Impacts of c hazards/ disasters, mar Mechanics and forms of	sasters, infrequent events, tning, hailstorms; Cyclor ocal storms (causes, distri- ic hazards/ disasters: Floo ndia, flood control measu lroughts, drought hazards induced hazards /disaste of soil erosion, factors and ards/ disasters: Release of	nes: Tr ibution ods, dr res (h in Ind rs, phy d cause	ropical n huma roughts numan lia, dro ysical l es of se	cyclor in adju s, cold adjustr ought co hazards oil eros	hes and loca stment, perce waves, heat nent, percep ontrol meas s/ disasters, sion, conser	I storms, d ception and waves floo otion and m ures, extra soil erosion vation mea	estruction I mitigation ods; Caus hitigation) planetary n, Soil ero sures of s	n by on); es of); / osion: soil		

MODULE - V EMERGING APPROACHES IN DISASTER MANAGEMENT Classes: 09

Emerging approaches in Disaster Management, Three Stages

- 1. Pre, disaster stage(preparedness)
- 2. EmergencyStage
- 3. Post Disaster stage, Rehabilitation.

Text Books:

- 1. Pardeep Sahni, "Disaster Mitigation: Experiences and Reflections", PHI Learning Pvt. Ltd., 1st Edition, 2001.
- J.Glynn,GaryW.HeinKe, "EnvironmentalScienceandEngineering", PrenticeHallPublishers, 2nd Edition, 1996.

Reference Books:

- 1. R.B.Singh (Ed), "Environmental Geography", 2nd Edition, 1990.
- 2. R.B. Singh (Ed), "Disaster Management", 2nd Edition, 2006.

Web References:

- 1. https://www.google.co.in/?gfe_rd=cr&ei=,iAwWLiDIazv8we8_5LADA#q=disater+mangement
- http://ndma.gov.in/images/policyplan/dmplan/National%20Disaster%20Management%20Plan%2 0 May%202016.pdf
- 3. http://www.eib.europa.eu/attachments/pipeline/20080021_eia_en.pdf
- 4. http://www.ndmindia.nic.in/

- 1. https://www.google.co.in/?gfe_rd=cr&ei=,iAwWLiDIazv8we8_5LADA#q=disaster+management + e+textbooks
- 2. http://cbse.nic.in/natural%20hazards%20&%20disaster%20management.pdf
- 3. http://www.digitalbookindex.org/_search/search010emergencydisastera.asp
- 4. http://www.icbse.com/books/cbse,ebooks,download

ELEMENTS OF AERONAUTICS

Course Code	Category	Ho	urs / W	eek	Credits	M	aximum	Marks
AAEB55	Elective	L	Т	Р	С	CIA	SEE	Total
		3	-	-	3	30	SEE 70 al Classe and phand auto to the to the flight v space; ation, lo ris; Plan rces on classific c centre bility, d ccelerate bility, d	100
Contact Classes: 45	Tutorial Classes: Nil	P	ractica	l Class	es: Nil	Tot	al Class	es: 45
fluids, structures a propulsion and ener II. Understand the meth III. Understand the ev conducted by variou	of technical areas of aer and materials, instrumenta gy conversion, aeronautical hodology and experience of olution of human space	tion, c l and as f analys explora	ontrol tronauti is, mod ation w	and es cal sys eling, a rith a	atimation, h atems and synthesi brief introd	iumans is duction	and auto	omation
-	ISTORY OF FLIGHT AN				-	saterinte	5.	
classifications explorin atmosphere, the standa orbit, microgravity, ben environments	Conquest of space, commo g solar system and beyor rd atmosphere; The tempe efits of microgravity; Envir	nd, a p rature e conment	ermane extreme tal impa	nt pres s of sp act on s	sence of hu pace, laws o	imans in of gravit	n space; ation, lo	Earth's w earth
MODULE -II IN	TRODUCTION TO AEF	RODYN	NAMIC	S				
force coefficients; Gene NACA airfoils, aspect ratio, v characteristics-lift, drag	ne, helicopter; Understandi erating lift, moment coeffic wing loading, mach numb curves; Different types of c LIGHT VEHIVLE PERF	cients; ber, cer drag	Aerody	namic pressu	forces on a	ircraft – odynami	classific	ation o
Performance parameter symmetric maneuvers, t	s, performance in steady f turns, sideslips, takeoff and and lateral stability; Handlir	light, c landing	ruise, c g. Flight	limb, 1 vehicl	range, endu le Stability,	rance, a		•
	NTRODUCTION TO AIR	PLAN						
General types of constr & non-metallic material	uction, monocoque, semi-n ls, use of aluminum alloy, e of propeller and jets for t	nonoco titaniu	m, stair	iless s	teel and con	mposite	materials	s; Basic
MODULE -V SA	ATELLITE SYSTEMS EI	NGINE	ERINO	G HUN	IAN SPAC	E EXPI	LORAT	ION
structures, mechanisms	perational satellite system, and materials; Power systems, mission objectives. Goal sions: The mercury Gemi	ms; Co ls of hu	mmunic ıman sp	ation a	and telemetr ght mission	y; Propu s, histor	ilsion and ical back	d station ground

- 1. Newman D, "Interactive Aerospace Engineering and Design", McGraw-Hill, 1st Edition, 2002.
- 2. Anderson J. D, "Introduction To Flight", McGraw-Hill Education, 5th Edition,2002

Reference Books:

- 1. Kermode. A. C, "Flight without Formulae", McGraw Hill, 4th Edition, 1997.
- 2. Barnard R.H and Philpot. D.R, "Aircraft Flight", Pearson, 3rd Edition, 2004.
- 3. SwattonP.J, "Flight Planning", Blackwell Publisher, 6th Edition, 2002.

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- 1. https://www.aerospaceengineering.es/book/
- 2. https://www.ne.nasa.gov/education/
- 3. https://nptel.ac.in

- 1. https://www.e-booksdirectory.com/
- 2. https://www.adl.gatech.edu/extrovert/Ebooks/ebook_Intro.pdf
- 3. https://www.academia.edu/7950378/Introduction_to_Flight_-_Anderson_5th_Ed

AVIATION MANAGEMENT

OE – II						a			
Course Code		Category		urs / W		Credits		aximum	
AAEB28		Elective	L 3	Т	Р	C 2	CIA	SEE	Total
Contact Classes:	. 45	Tutorial Classes: Nil	-	- ractical	-	3	30	70 al Classe	100
 I. Understand a challenges. II. Impart the kn airport mana III. Understand a airport fee, r IV. Gain the in c V. Understand a MODULE -I History of Aviatio blayers in Airline Airline industry in 	about nowle geme and ga ates a lepth about INTR n- org indu India	ain the knowledge on the	airport of meteoro lation, e space an & ethic fferent t plans-	al envir current	n and v service ic regu gationa ronmen compa challer	arious authers, environn lation and a l aid. t-history of anies in Inc ages in airli	orities in mental re viation s	egulation egulation cecurity. Class n in India	and ses: 10 a-Major ential of
MODULE -II		PORT INFRASTRUCT							es: 10
organization struct	ure ii	rminal planning design 1 an Airline – Airport Au AI -Airline privatization –	thority	of Indi	a- com	parison of	global &	z Indian	
MODULE -III	AIR	TRANSPORT SERVIC	ES					Class	ses: 9
•		s- international air transpo bad & Bangalore. The role							.
MODULE -IV	INS	FITUTIONAL FRAME	WWOF	RK				Class	ses: 8
Role of DGCA-Sle economic Regulati		ocation -Methodology fol	lowed l	oy ATC	C & D0	GCA – man	agement	t of bi-la	iterals –
MODULE -V	CON	TROLLING						Class	ses: 8
		l- airspace & navigational privatization-Navi Mumł							

- 1. Graham. A Managing airports an International Perspective butterworth-heinemann, oxford 2001.
- 2. Wells. A. Airport Planning and Management, 4th edition McGraw-Hill, London 2000.

Reference Books:

- 1. Alexander t. wells, seth young, Principles of Airport management, McGraw-hill 2003Y. V. C. Rao,
- 2. Richard de neufille, Airport systems: Planning, Design & Management, McGraw-hill London 2007.

Web References:

- 1. https://memberfiles.freewebs.com/94/47/55224794/documents/airport%20planning%20and%20manag ement.pdf
- 2. https://books.google.co.in/books?id=RYR6cu4YSBcC&dq=Planning%20and%20Design%20of%20Ai rports &source=gbs_similarbooks

- 1. https://accessengineeringlibrary.com/browse/airport-planning-and-management-sixth-edition
- 2. https://www.only4engineer.com/2014/10/planning-and-design-of-airports-by.html

INTRODUCTION TO ROBOTICS

OE – II											
Course Code	e	Category	Hou	ırs / W	/eek	Credits	Maxi	mum M	[arks		
AMEB56		Elective	L	Т	Р	С	CIA	SEE	Total		
			3	-	-	3	30	70	100		
Contact Classes OBJECTIVES:	: 45	Tutorial Classes: Nil	P	actica	l Class	es: Nil	Tota	l Classe	s: 45		
The course shouldI.Familiarize wII.Understand th	vith the	e the students to: automation and brief history matics of robots and knowle s and feedback components	dge aboi	ıt robo			their des	ign.			
MODULE-I	INTR	ODUCTION TO ROBOT	ICS				Classes : 0				
systems; Compon	ents of	and robotic, an over view o the industrial robotics: D d other types of grippers, ge	egrees o	of free	dom, e	nd effector	s: Mech	anical g	gripper,		
MODULE-II	MOT	ION ANALYSIS AND KI	NEMAT	ICS				Classes	: 09		
homogeneous tran	sforma	tation matrices, composite r tion, problems; Manipulator inverse kinematics, problem	r kinema			•		•			
MODULE-III	KINE	MATICS AND DYNAMI	CS					Classes	: 09		
		Vifferential kinematics of pla ge, Euler formulations, Ne		.		•		•			
MODULE-IV	TRAJ	ECTORY PLANNING A	ND ACT	UAT	ORS			Classes	: 09		
Slew motion, join	nt inter	t space scheme, cubic poly polated motion, straight in neumatic and hydraulic actu	line mot								
MODULE-V	ELE	CTRIC ACTUATORS AN	D ROB	ΟΤΙΟ	APPL	ICATIONS		Classes	: 09		
	coders,	rvo motors, stepper motors, velocity sensors, tactile s spection.									
Text Books:											
		ial Robotics", Tata McGraw 1 to Robotic Mechanics and)13.				
Reference Books:											
		bbotic Engineering", Prentic cGraw-Hill, 1 st Edition, 201		st Editi	on, 201	3.					

Web References:

- 1. https://www.doc.ic.ac.uk/~ajd/Robotics/RoboticsResources/lecture1.pdf.
- 2. http://opencourses.emu.edu.tr/course/view.php?id=32
- 3. https://www.researchgate.net/publication/277712686_Introduction_to_Robotics_class_notes_UG_level

- 1. http://www.robot.bmstu.ru/
- 2. http://www.robotee.com/index.php/download-free-robotic-e-books/

RAPID PROTOTYPING

Course Code		Category	Hours / Week			Credits	Maximum Marks			
AMEB57		Elective	L T		Р	С	CIA	SEE	Tota	
			3	-	-	3	30	70	100	
Contact Classes:	45	Tutorial Classes: Nil	P	ractica	II Class	ses: Nil	1 ota	l Classe	es: 45	
II. Interpret the III. Describe the IV. Interpret the	able tin concep signifi advant various	the students to: ne compression techniques ot, process details with resp cance of each process par- ages, limitations and appli- tooling required for rapid	pect to d ameter o ications (ifferen f vario of vari	t proce us prot ous pro	sses. otyping syste ototyping Sys	stems.	ng &		
MODULE -I	INTRO	DUCTION TO RAPID	PRORT	OTYP	PING			Classes	: 09	
RapidPrototyping prototyping and testIntegration TechnologyMODULE -II	Systen ing tech ogies.	ding to Rapid Prototyping n, Generic RP process. nology, Physical Prototyp D-BASED RAPID PROT	Rapid bing and	Produ Rapid	ict De Manuf	velopment: facturing tec	An Ov hnologie	erview s and S Classes	virtual ynergic s : 09	
Disadvantages and	Applica	inter (SOUP), Rapid Freez	y Appar	atus (S	ŠLA), S	Solid Groun	d Curing			
MODULE -III S	SOLID	-BASED RAPID PROTO	OTYPIN	G SY	STEM	S		Classes: 09		
Disadvantages and	Applica	typing Systems: Princip ations of Laminated Obj Technology (PLT), Multi-	ect Man	ufactu	ring (L	OM), Fused	l Deposi	tion Me		
MODULE -IV	POWD	DER-BASED RAPID PR	οτοτγ	PING	SYST	EMS		Classes	s: 09	
Disadvantages and	Applica	totyping Systems: Principations of Selective Laser S n (MJS), Electron Beam	Sintering	(SLS)), Lasei	r Engineered	l Net Sh	aping (l	LENS)	
MODULE -V	RAPID	TOOLING						Classes	s : 09	
epoxy tools, and 31 Tool Process and D 3D model and Ap	D Kelto irect M plication	n to rapid tooling (RT),Ind ol process, Direct rapid t etal Tooling using 3DP. I ns. Virtual Augmented I Applications of Rapid P	ooling n Reverse Reality:	nethod engine Requi	s: DTN ering: 1 rement	A Rapid Too Acquiring Po of devices	ol Proces oint Data and tec	ss, EOS a, Const chnologi	Direc ructing ies and	

- 1. Chua C K, Leong K F, Chu S L, "Rapid Prototyping: Principles and Applications in Manufacturing", World Scientific, 3rd Edition, 2008.
- 2. Liou W L, Liou F W, "Rapid Prototyping and Engineering applications: A Tool Box for Prototype Development", CRC Press, 1st Edition, 2007.

Reference Books:

- 1. Gibson D W Rosen, Brent Stucker, "Additive Manufacturing Technologies: Rapid Prototyping to Direct Digital Manufacturing", Springer, 1st Edition, 2014.
- 2. Kamrani A K, Nasr E A, "Rapid Prototyping: Theory and practice", Springer, 1st Edition, 2006.
- 3. Rafiq I. Noorani, "Rapid Prototyping: Principles and Applications", John Wiley & Sons, 1st Edition, 2005.

Web References:

1.https://nptel.ac.in/courses/112102103/16 2.https://nptel.ac.in/courses/112107078/37

E-Text Book:

1.https://www.cet.edu.in/noticefiles/258_Lecture%20Notes%20on%20RP-ilovepdf-compressed.pdf

EMBEDDED SYSTEMS

	de	Category	Hours / Week			Credits	Maximum Mark			
			L	Т	Р	С	CIA	SEE	Total	
AECB58		Elective	3	-	-	3	30	70	100	
Contact Classe	es: 45	Tutorial Classes: Nil	P	ractica	l Class	es: Nil	Tota	l Classe	s: 45	
Systems. II. Understand III. Analyze di	owledge abo d Real time o fferent tools	the students to: ut the basic functions, stru operating system concepts for development of embe itecture of advanced proce	dded s	_		pplications	of Embec	lded		
MODULE -I	EMBEDD	DED COMPUTING						Classes	: 08	
ystems, comple	x systems a	em, embedded systems vs and microprocessor, class cteristics and quality attrib	ificatio	on, maj	or app	lication are	as, the e	mbedded	1	
MODULE -II	INTROD	UCTION TO EMBEDD	ED C	AND A	PPLIC	ATIONS		Classes: 09		
naligned data a	and endianne	er allocation, function ca							tields.	
ardware; Basic ounce, LED int	techniques t terfacing, int	ess, infine functions and nd running embedded C p for reading and writing fi terfacing with keyboards, terrupts, serial data comm	orogran om I/C displa	n in Kei D port j lys, D/A	il IDE, pins, sv A and	dissecting the vitch bound	ues; Emb he progra e; Applio	edded s .m, build	systems ling the	
ardware; Basic oounce, LED int A/D conversions,	techniques f erfacing, int , multiple int	nd running embedded C p for reading and writing fi terfacing with keyboards,	orogran com I/C displa unicati	n in Kei D port J Lys, D/A on usin	I IDE, pins, sw A and g embe	dissecting the vitch bound	ues; Emb he progra e; Applio	edded s .m, build	ystems ling the Switch	
ardware; Basic bounce, LED int A/D conversions, MODULE -III Operating system and multitasking, considerations, sa	techniques freefacing, int multiple int RTOS FU basics, type, how to cho aving memor	nd running embedded C p for reading and writing fi terfacing with keyboards, terrupts, serial data comm NDAMENTALS AND F es of operating systems, ta pose an RTOS ,task sched ry and power.	rogram com I/C displa unicati ROGI asks an uling, s	n in Kei D port j Lys, D/A on usin RAMM d task s semaph	II IDE, joins, sv A and g embe ING states, p ores an	dissecting the vitch bounce dded C inter process and id queues, h	ues; Emb he progra e; Applic rfacing threads, 1 ard real-t	edded s m, build cations: Classes multipro time sch	systems ling the Switch : 09 cessing	
hardware; Basic bounce, LED int A/D conversions, MODULE -III Operating system and multitasking, considerations, sa Fask communica	techniques terfacing, int multiple int RTOS FU basics, type, how to cho aving memore tion: Shared	nd running embedded C p for reading and writing fr terfacing with keyboards, terrupts, serial data comm NDAMENTALS AND F es of operating systems, ta pose an RTOS ,task sched	rogram om I/C displa unicati ROGI asks an uling, s	n in Kei D port j Lys, D/A on usin RAMM d task s semaph	il IDE, pins, sv A and g embe ING states, I ores an	dissecting the vitch bounce dded C inter- process and id queues, he call and sock	ues; Emb he progra e; Applic rfacing threads, r ard real-t	edded s m, build cations: Classes multipro time sch	systems ling the Switch : 09 cessing eduling	
ardware; Basic bounce, LED int <u>AD conversions</u> MODULE -III Departing system and multitasking onsiderations, sa Cask communica ynchronization:	techniques the rerfacing, int multiple int RTOS FU h basics, type how to cho aving memore tion: Shared Task commu	nd running embedded C p for reading and writing fi terfacing with keyboards, terrupts, serial data comm NDAMENTALS AND F es of operating systems, ta pose an RTOS ,task sched ry and power. memory, message passin	rogram om I/C displa unicati PROGI asks an uling, s g, remo	n in Kei D port j Lys, D/A on usin RAMM d task s semaph ote proc task sy	II IDE, pins, sv A and g embe ING states, J ores an edure or nchron	dissecting the vitch bounce dded C inter- process and id queues, he call and sock ization tech	ues; Emb he progra e; Applic rfacing threads, r ard real-t	edded s m, build cations: Classes multipro time sch	systems ling the Switch : 09 cessing eduling	
Ardware; Basic bounce, LED int AD conversions. MODULE -III Departing system and multitasking. considerations, sa Cask communica ynchronization: MODULE -IV Host and target	techniques terfacing, interfacing, interfacing, interfacing, interfacing, interfacing, interfacing, multiple interfacing to basics, type, how to cheaving memoritation: Shared Task community EMBEDD machines, 1	nd running embedded C p for reading and writing fi terfacing with keyboards, terrupts, serial data comm NDAMENTALS AND F es of operating systems, ta oose an RTOS ,task sched ry and power. memory, message passin, unication synchronization	rogram om I/C displa unicati ROGI asks an uling, s g, remo issues, CLOPN ded so	n in Kei D port j Lys, D/A on usin RAMM d task s semaph ote proce task sy IENT	I IDE, pins, sv A and g embe ING states, p ores an edure c nchron TOOL getting	dissecting the vitch bounce added C inter- process and ad queues, he call and sock- tization teches g embedded	ues; Emb he progra e; Applic rfacing threads, r ard real-t ard real-t cets; Task niques, d	cations: Classes multipro ime sch c c c c c c c c c c c c c	ystems ling the Switch : 09 cessing eduling ivers. : 09 ne	
ardware; Basic bounce, LED int A/D conversions. MODULE -III Dperating system and multitasking. considerations, sa Fask communica synchronization: MODULE -IV Host and target	techniques terfacing, interfacing, interfacing, interfacing, interfacing, interfacing, interfacing, multiple interface for the second s	nd running embedded C p for reading and writing fi terfacing with keyboards, terrupts, serial data comm NDAMENTALS AND F es of operating systems, ta oose an RTOS ,task sched ry and power. memory, message passin, unication synchronization DED SOFTWARE DEVE inker/locators for embed	rogram rom I/C displa unicati ROGI usks an uling, s g, remo issues, CLOPN ded so nachin	n in Kei D port j Lys, D/Z on usin RAMM d task s semaph ote proce task sy IENT ftware, e, using	I IDE, pins, sv A and g embe ING states, p ores an edure of mehron TOOL getting labora	dissecting the vitch bounce added C inter- process and ad queues, he call and sock- tization teches g embedded	ues; Emb he progra e; Applic rfacing threads, r ard real-t ard real-t cets; Task niques, d	cations: Classes multipro ime sch c c c c c c c c c c c c c	ivers. ivers.	

- 1. Shibu K.V, "Introduction to Embedded Systems", Tata McGraw Hill Education Private Limited, 2nd Edition, 2009.
- 2. Raj Kamal, "Embedded Systems: Architecture, Programming and Design", Tata McGraw-Hill Education, 2nd Edition, 2011.
- 3. Andrew Sloss, Dominic Symes, Wright, "ARM System Developer's Guide Designing and Optimizing System Software", 1st Edition, 2004.

Reference Books

- 1. Wayne Wolf, "Computers as Components, Principles of Embedded Computing Systems Design", Elsevier, 2nd Edition, 2009.
- 2. Dr. K. V. K. K. Prasad, "Embedded / Real-Time Systems: Concepts, Design & Programming", Dreamtech publishers, 1st Edition, 2003.
- 3. Frank Vahid, Tony Givargis, "Embedded System Design", John Wiley & Sons, 3rd Edition, 2006.
- 4. Lyla B Das, "Embedded Systems", Pearson Education, 1st Edition, 2012.
- 5. David E. Simon, "An Embedded Software Primer", Addison-Wesley, 1st Edition, 1999.
- 6. Michael J. Pont, "Embedded C", Pearson Education, 2nd Edition, 2008.

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- 1. https://www.smartzworld.com/notes/embedded-systems-es/
- 2. http://notes.specworld.in/embedded-systems-es/
- 3. http://education.uandistar.net/jntu-study-materials
- 4. http://www.nptelvideos.in/2012/11/embedded-systems.html

- 1. https://www.scribd.com/doc/233633895/Intro-to-Embedded-Systems-by-Shibu-Kv
- 2. http://www.ee.eng.cmu.ac.th/~demo/think/_DXJSq9r3TvL.pdf
- 3. https://www.scribd.com/doc/55232437/Embedded-Systems-Raj-Kamal
- 4. https://docs.google.com/file/d/0B6Cytl4eS_ahUS1LTkVXb1hxa00/edit
- 5. http://www.ecpe.nu.ac.th/ponpisut/22323006-Embedded-c-Tutorial-8051.pdf

COGNITIVE RADIO

Course Code		Category	Hours / Week			Credits	Maximum Mark			
AECB59		Elective	L	L T P	С	CIA	SEE	Total		
AECD59			3	-	-	3	30	70	100	
Contact Classe	es: 45	Tutorial Classes: Nil	P	ractica	l Class	es: Nil	Tota	l Classe	s: 45	
II. Learn the	e basics of the design of the	ne students to: ne software defined radios he wireless networks base epts of wireless networks a	d on the							
MODULE -I	INTRODU	CTION TO SOFTWAR	E DEF	INED	RADIO)		Classes	: 08	
Definitions and p mplications.	otential ben	efits, software radio archit	ecture	evoluti	on, tech	nology trac	leoffs and	l archited	cture	
MODULE -II	SDR ARCI	HITECTURE						Classes: 09		
oftware architec	ture, top lev	tware radio, basic SDR, h el component interfaces, i CTION TO COGNITIV	nterfac	e topolo		1	-	0		
Environment awa MODULE -IV Cognitive Radio:	reness in co COGNITT Functions,	gnitive techniques, position ognitive radios, optimization VE RADIO ARCHITEC components and design ru oture maps, building the	on of ra TURE iles, co	dio reso	cycle:	orient, plan	, decide a	Classes and act p	: 09 Dhases,	
rchitecture.		ture maps, bunding the					sontware		1 1 4 4 1 0	
MODULE -V	NEXT GE	NERATION WIRELESS	S NET	WORK	S			Classes	: 10	
The XG Network		e, spectrum sensing, spect yer design.	trum m	anagen	nent, sp	ectrum mol	bility, spe	ectrum sl	naring,	
Fext Books:	itola III, "S 1g", John W	oftware Radio Architect	ure: Ol	bject-O	riented	Approache	es to Wi	reless S	ystem	

Reference Books:

- 1. Simon Haykin, —Cognitive Radio: Brain –Empowered Wireless Communications, IEEE Journal on selected areas in communications, Feb 2005.
- 2. Hasari Celebi, Huseyin Arslan, —Enabling Location and Environment Awareness in Cognitive Radiosl, Elsevier Computer Communications, Jan 2008.
- 3. Markus Dillinger, Kambiz Madani, Nancy Alonistioti, —Software Defined Radiol, John Wiley, 2003.
- 4. Huseyin Arslan, —Cognitive Radio, SDR and Adaptive System, Springer, 2007.
- 5. Alexander M. Wyglinski, Maziarnekovee, Y. Thomas Hu, -Cognitive Radio Communication and Networksl, Elsevier, 2010

Web References:

- 1. wcsp.eng.usf.edu/cognitive_radio_links.htm
- 2. https://en.wikipedia.org/wiki/Cognitive_radio
- 3. https://www.researchgate.net/.../261021527_Cognitive_radio_networks_for_Internet.
- 4. www.informationvine.com/Cognitive+Radio.

- 1. omidi.iut.ac.ir/...CognitiveRadio/.../ebook/Fette%20B.A.(ed)%20Cognitive%20Radio.
- 2. www.supelec.fr/d2ri/flexibleradio/pub/leonardo09.pd.
- 3. www.qsl.net/.../Cognitive%20Radio%20Communications%20and%20Networks%20-%2

IOT AND APPLICATIONS

Course Code	Category	Ho	urs / W	eek	Maximum Marks					
AECB60	Flootivo	Elective L T P C						Total		
ALCDOU	Elective	3	-	-	3	30	70	100		
Contact Classes: 45	Tutorial Classes: Nil	P	ractica	l Class	es: Nil	Tota	al Classes	s: 45		
II. Explore on use of v III. Illustrate the real tin	ble the students to: nitecture of Internet of Th various hardware and sense me IoT applications to me ilable cloud services and	sing tecl ake sma	hnologi rt worl	es to bi d.	uild IoT app					
MODULE -I INTR	ODUCTION TO INTE	RNET	OF TH	INGS	(IoT)		Classes:	10		
	teristics of IoT, physics and deployment, domai		-		logical des	ign of I	loT, IoT	enabling		
MODULE -II IoT A	ND M2M						Classes:	09		
	ference between IoT an NFV) for IoT, basics of I					•		l networl		
MODULE -III IOT A	ARCHITECTURE ANI) PYTH	ION				Classes:	08		
reference model and a	e of the art introduction, irchitecture, IoT reference lata structures, control flo	ce mod	el. Log	ical de	esign using	Python:	Installin			
MODULE -IV IoT P	HYSICAL DEVICES A	AND EN	NDPOI	NTS			Classes:	08		
Introduction to Raspber devices.	ry Pi interfaces (Serial, S	PI, I2C)), progra	amming	g Raspberry	PI with	Python, c	other IoT		
MODULE -V IoT PHYSICAL SERVERS AND CLOUD OFFERINGS								Classes: 10		
	brage models and commu ating IoT design: Home a							cloud for		
Text Books:										
	Vijay Madisetti, "Internet Shawn Wallace, "Getting									
Reference Books:										
1. Adrian McEwen, Edition, 2014.	Hakim Cassimally, "De	esigning	the In	ternet	of Things",	John W	iley and	Sons, 1s		

Web References:

- 1. https://www.upf.edu/pra/en/3376/22580.
- https://www.coursera.org/learn/iot.
 https://bcourses.berkeley.edu.
 www.innovianstechnologies.com.

- 1. https://mitpress.mit.edu/books/internet-things
- 2. http://www.apress.com

INDUSTRIAL AUTOMATION AND CONTROL

Course Code		Category	He	ours / W	Veek	Credits	Max	imum N	Marks	
			L	Т	Р	С	CIA	SEE	Tota	
AEEB58		Elective	3	-	-	3	30	70	100	
Contact Classes: 45		Tutorial Classes: Nil]	Practica	al Class	es: Nil	Tot	al Classes: 45		
Study the perform Develop various	ntal co nance types	e the students to: oncepts about introductio of each system in deta of industrial automatio s control of PLC autom	il along n and c	g with p	ractical	case studie		vices.		
MODULE-I		RODUCTION TO INDU	USTRL	AL AUI	ГОМАТ	TION AND		Clas	sses: 08	
architecture of ind	ustrial	ial Automation and Co l automation system, mea arement, displacement an	asureme	ent syste	ems spec	cifications, to	emperatu	re measu	urement	
MODULE - II	PROCESS CONTROL							Clas	sses: 10	
controllers, specia	l cont	action to process contro rol structures, feed forw ns with inverse response.								
MODULE - III	PRO	GRAMMABLE LOGI	C CON	TROL	SYSTE	MS		Classes: 0		
		ntrol systems: introduct e environment and prog								
Programming, pro	gram	ning of PLCs: sequential	l functio	on charts	s, the PL	C hardware	environn	nent		
MODULE - IV	ODULE - IV CNC MACHINES AND ACTUATORS							Clas	sses: 10	
	n syst	uators: Introduction to o tems, principle and con tits.								
MODULE - V	ELE	CTRICAL MACHINE	RICAL MACHINE DRIVES							
	ctuato	s: Energy savings with va rs, DC motor drives, elec		-			-			

- 1. Madhu Chanda Mitra, Samarjit Sen Gupta, "Programmable Logic Controllers and Industrial Automation: An Introduction", Penram International Publishing (India) Pvt. Ltd., 1st Edition, 2008.
- 2. K Krishnaswamy, S Vijayachitra, "Industrial Instrumentation", New Age Publications, 1st Edition, 2010.
- Rajesh Mehra, Vikrant Vij, "PLCs & SCADA: Theory and Practice", Laxmi publications, 2nd Edition, 2016.

Reference Books:

- 1. AK Gupta, S K Arora, "Industrial Automation and Robotics", Laxmi Publications, 2nd Edition, 2013.
- 2. Jon Stenerson, "Industrial Automation and Process Control", Prentice Hall, 1st Edition, 2002.

Web References:

- 1. https://www.google.co.in/search?q=INTRODUCTION+TO+INDUSTRIAL+AUTOMATION+AND+CO NTROL&ie=utf-8&coi=utf-8&client=firefox-b-ab&gfe_rd=cr&ei=PUocWOXVL67v8weKwZngAw
- 2. https://www.noorropidah.files.wordpress.com/2012/01/plc-1-3.pdf
- 3. https://www.radix.co.in/families/automation?gclid=CJfW24PbjtACFUYeaAodiCQGHQ

- 1. https://www.plc-scada-dcs.blogspot.com/p/downloads.html
- 2. https://www.megawatt.com.gr/files/uploads/KATALOGOS%20PLC%20ABB.pdf

ARTIFICIAL NEURAL NETWORKS

Course Code		Category	Hours / Week Cree				Max	ximum Marks		
			L	Т	Р	С	CIA	SEE	Total	
AEEB59		Elective	3	-	-	3	30	70	100	
Contact Classe	Pr	actical	Classes	: Nil	Tota	al Class	es: 45			
 Understand the stand the standard stand standard standard stand standard standard stand standard standard stand standard standard stand standar	ne biolo chitectu	e the students to: gical neural network and ire, learning algorithm an al networks of various are	d issues	of vario	us feed	l forward a	nd feedb		ıral	
IV. Perform the t	raining esting of	of neural networks using f neural networks and do	various	learning	rules.				pattern	
MODULE-I	INTR	ODUCTION TO ANN						Class	ses: 09	
MODULE-II Single Layer Pero Square Filters, I Perceptron: conv Environment; Ma	PERC ceptron: .east M ergence .ltilayer	EPTRON Adaptive Filtering Problean Square Algorithm, theorem, Relation Be Perceptron: Back Prop ion Rule, Computer Expe	lem, Und Learnin tweenPe pagation	constrair g Curve crceptron Algori	ned Orges,Learn and thm X	ganizationT ning Rate Bayes Cla OR Proble	Techniqu Anneal	Class les, Lind ing Tec for a	ses: 09 ear Least chniques Gaussiar	
MODULE-III	BACK	PROPAGATION						Class	es: 09	
10		Propagation and Different ues, Virtues, and Limitat	-	Hessian	Matrix	x, Generali	zation,C	cross Va	alidation,	
BackPropagation	Learnin	g, Accelerated Converger	nce, Sup	ervised	Learnir	ng				
MODULE-IV	SELF-	ORGANIZATION MA	PS					Class	es: 09	
		ing Models, Self-Organi earning Vector Quantizat						of Feat	ure Map	
MODULE-V	DYNA	MICAL SYSTEMS						Class	es: 09	
•	Attract	ical Systems, Stability of ors as a Recurrent Net	·				•			

1. Simon Haykin, "Neural Networks a Comprehensive Foundations", Prentice Hall India, 2nd Edition, 2003

Reference Books:

- 1. B. Yegnanarayana, "Artificial Neural Networks", Prentice Hall of India Private Limited, 2005
- 2. Li Min Fu, "Neural Networks in Computer Intelligence", Tata McGraw Hill, 3rd Edition, 2003
- 3. James A Freeman David M S Kapura, "Neural Networks", Pearson Education, 2004.
- 4. Jacek M. Zurada, "Introduction to Artificial Neural Systems", JAICO Publishing House, 1st Edition, 2006.

Web References:

- 1. https:// www.en.wikipedia.org/wiki/ neural networks
- 2. https://www.jaicobooks.com/j/PDF%20HED/J-878%20Artificial%20Neural%20Systems.pdf
- 3. https://www.abebooks.co.uk/book-search/title/an-introduction-to-fuzzy-control/system.pdf

- 1. https://www.books.google.com / Computers/ Software Development & amp; Engineering.pdf
- 2. https://www.springer.com/us/book/9783319046921.pdf
- 3. https://www.bookboon.com/en/introduction-to-soft-computing-ebook.pdf

RENEWABLE ENERGY SOURCES

Course Code		Category	Но	urs / W	eek	Credits	Maxi	larks		
AEEB60		Elective	L	Т	Р	С	CIA	SEE	Total	
		Licenve	3	-	-	3	30	70	100	
Contact Classes	: 45	Tutorial Classes: Nil	I	Practica	al Classe	es: Nil	Tota	al Classes: 45		
I. Gain advanced II. Analyze the p	d enat d know ower c	S: ble the students to: vledge on role of power ex- onditioning schemes for signing wind, solar system	grid coi	nnected	systems	5.				
MODULE- I	INTR	RODUCTION						Class	ses: 10	
Development, Ene Availability, Renev Energy from Sun	ergy R wable I Sun-	Energy Scarcity, Solution esources and Classificat Energy in India. earth Geometric Relating Reaching the Earth's T	tion, Ro onship,	enewab Layer	le Energion of the	gy – World Sun, Earth	wide Re	enewable	e Energ	
MODULE - II	SOLA	AR SYSTEMS						Class	ses: 10	
Collectors, Materia System, Working Water Heating Sys Active Solar Spac Solar pond. Solar Cells: Comp Solar Cells, I – V (al Aspo of Stirl tems, l e Cool onents Charac	of Solar Cell System, El teristics of Solar Cells, E	Concer gine, So ting Sy Solar I lements	ntrating olar Co stems, A Dryers, of Sili	Collect llector S Applicat Crop D con Sola	ors, Parabol Systems into ions of Sola rying, Space ar Cell, Sola	ic Dish - Building r Water I e Cooing r Cell ma	- Stirling g Servic Heating , Solar aterials,	g Engir es, Sola System Cookers Practica	
Solar Cell Systems										
		ROGEN, WIND AND (ses: 09	
Storage, Use of Hy	droge	fits of Hydrogen Energ n Energy, Advantages an Wind Energy: Windmi	d Disa	lvantag	es of Hy	ydrogen Ene	rgy, Proł	olems As	ssociate	
Exploration, Geoth	ermal	eothermal Systems, Cla Based Electric Power Ge tural Refuse: Waste is V	neratio	n, Asso	ciated P	roblems, env	vironmen	tal Effec	ts.	

MODULE- IV BIOMASS SYSTEMS Classes:	MODULE- IV
-------------------------------------	------------

Biomass Energy: Biomass Production, Energy Plantation, Biomass Gasification, Theory of Gasification, Gasifier and Their Classifications, Chemistry of Reaction Process in Gasification, Updraft, Downdraft and Cross-draft Gasifiers, Fluidized Bed Gasification, Use of Biomass Gasifier, Gasifier Biomass Feed Characteristics, Applications of Biomass Gasifier, Cooling and Cleaning of Gasifiers. Biogas Energy: Introduction, Biogas and its Composition, Anaerobic Digestion, Biogas Production, Benefits of Biogas, Factors Affecting the Selection of a Particular Model of a Biogas Plant, Biogas Plant Feeds and their Characteristics. Tidal Energy: Introduction, Tidal Energy Resource, Tidal Energy Availability, Tidal Power Generation in India, Leading Country in Tidal Power Plant Installation, Energy Availability in Tides, Tidal Power Basin, Turbines for Tidal Power, Advantages and Disadvantages of Tidal Power, Problems Faced in Exploiting Tidal Energy

MODULE- V PV WATER PUMPING AND GRID INTERFACE	Classes: 08	
---	-------------	--

Sea Wave Energy: Introduction, Motion in the sea Waves, Power Associated with Sea Waves, Wave Energy Availability, Devices for Harnessing Wave Energy, Advantages and Disadvantages of Wave Power. Ocean Thermal Energy: Introduction, Principles of Ocean Thermal Energy Conversion (OTEC), Ocean Thermal Energy Conversion plants, Basic Rankine Cycle and its Working, Closed Cycle, Open Cycle and Hybrid Cycle, Carnot Cycle, Application of OTEC in Addition to Produce Electricity, Advantages, Disadvantages and Benefits of OTEC

Text Books:

- 1. G.D Rai, "Non conventional Energy Sources", Khanna Publications, 3nd Edition, 2008.
- 2. John Twidell and Tony Weir / E & F.N.Spon, "Renewable Energy Resources", Special Indian Edition, 3rd Edition, 2007.
- G.N.Tiwari and M.K.Ghosal , "Renewable Energy Resources Basic Principles and Applications", Narosa Edition, 2nd Edition, 2004.
- S.P. Sukhatme, "Solar Energy Principles of Thermal Collection and Storage," TMH, 4th Edition, 2017.

Reference Books:

- 1. Daniel, Hunt. V, "Wind Power A Hand Book of WECS", Van Nostrend Co., Newyork, 1998.
- 2. K.Khendelwal & S.S. Mahdi, "Biogas Technology A Practical Hand Book", McGraw-Hill
- 3. Mukund. R. Patel, "Wind and Solar Power Systems", CRC Press, 1999.

Web References:

NPTEL video lectures.

E-Text Books:

G.D. Rai, Non- Conventional Energy Resources, Khanna Publishers, 2002.

SOFT SKILLS AND INTERPERSONAL COMMUNICATION

	e Code Category Hours / Week Credits Maximum						Ma	ximum I	Marks
AHSB1	8	Elective	L	Т	Р	С	CIA	SEE	Total
	3 3 30 70						70	100	
Contact Class	ses: 45	Tutorial Classes: Nil	I	Practical	l Class	es: Nil	Tota	l Classe	s: 45
III. CommunicaIV. Use the fourV. Develop the	buld enal te in a con language art of inte	ble the students to: nprehensible English accent a skills i.e., Listening, Speakin rpersonal communication ski nding of soft skills resulting i	g, Read lls to av	ing and V ail the glo	Vriting e obal opp	ortunities			
MODULE-I	SOFT S	SKILLS						Classe	es: 09
		on – Definition and Significa f; Setting Goals; Positivity an							of Sof
MODULE -II	EFFEC	TIVENESS OF SOFT SKI	LLS					Classe	es: 09
Developing interpersonal relationships through effective soft skills; Define Listening, Speaking, Reading and Writing; Sesential formal writing skills; Public Speaking: Skills, Methods, Strategies and Essential tips for effective public speaking. MODULE-III ORAL AND AURAL SKILLS Classes: 09									
Vocabulary: Sounds of English vowels sounds and constant sounds, Word Accent and connected speech- contractions, questions tags, Listening for information, Taking notes while listening to lectures (use of Dictionary). Group Discussion: Importance, Planning, Elements, Skills, Effectively disagreeing, Initiating.								Classe	es: 09
Sounds of Englis Listening for info	ormation, '	Taking notes while listening t	to lectur	es (use of	f Dictio	nary).	contraction		
Sounds of Englis Listening for info	ormation, ' n: Importa	Taking notes while listening t	to lectur lls, Effe	es (use of	f Diction	nary).	contraction		ons tags
Sounds of Englis Listening for info Group Discussion MODULE-IV Interpersonal co	n: Importa VERB mmunicat oximity; (Taking notes while listening to ince, Planning, Elements, Ski AL AND NON-VERBAL CO ion-verbal and nonverbal e Conversation skills, Critical	to lectur lls, Effe DMMU tiquette;	res (use of actively di NICATI ; Body 1	f Diction sagreein ON anguage	nary). ng, Initiating. e, grapevine,	Postures,	ns, questio Classo Gestures	ons tags es: 09
Sounds of Englis Listening for info Group Discussion MODULE-IV Interpersonal co expressions, Pro-	ormation, n: Importa VERBA mmunicat oximity; (d Manager	Taking notes while listening to ince, Planning, Elements, Ski AL AND NON-VERBAL CO ion-verbal and nonverbal e Conversation skills, Critical	to lectur lls, Effe OMMU tiquette; l thinki	res (use of ctively di NICATI ; Body 1 ing, Tear	f Diction sagreein ON anguage	nary). ng, Initiating. e, grapevine,	Postures,	ns, questio Classo Gestures	ons tags es: 09 s, Facia Stress
Sounds of Englis Listening for info Group Discussion MODULE-IV Interpersonal co expressions, Pro- Measurement and MODULE-V Significance; Ef	ormation, ' n: Importa VERBA mmunicat oximity; (d Manager INTEF fectivenes	Taking notes while listening to ince, Planning, Elements, Ski AL AND NON-VERBAL CO ion-verbal and nonverbal e Conversation skills, Critical ment of Stress	to lectur Ils, Effe OMMU tiquette; I thinki CATION inciples	res (use of ctively di NICATI ; Body 1 ing, Tear N of Para;	f Diction sagreein ON anguage nwork, graphs :	nary). ng, Initiating. e, grapevine, Group Disc	Postures, cussion, In ;; Writing	ns, question Classe Gestures mpact of Classe introduct	es: 09 s, Facia Stress es: 09 tion and
Sounds of Englis Listening for info Group Discussion MODULE-IV Interpersonal co expressions, Pro Measurement and MODULE-V Significance; Eff conclusion; Tech	ormation, ' n: Importa VERBA mmunicat oximity; (d Manager INTEF fectivenes	Taking notes while listening to unce, Planning, Elements, Ski AL AND NON-VERBAL CO ion-verbal and nonverbal e Conversation skills, Critical ment of Stress RPERSONAL COMMUNIC s of writing; Organizing pr	to lectur Ils, Effe OMMU tiquette; I thinki CATION inciples	res (use of ctively di NICATI ; Body 1 ing, Tear N of Para;	f Diction sagreein ON anguage nwork, graphs :	nary). ng, Initiating. e, grapevine, Group Disc	Postures, cussion, In ;; Writing	ns, question Classe Gestures mpact of Classe introduct	es: 09 s, Facia Stress es: 09 tion and
Sounds of Englis Listening for info Group Discussion MODULE-IV Interpersonal co expressions, Pro- Measurement and MODULE-V Significance; Eff conclusion; Tech Writing. Text Books:	verse or mation, version of the second secon	Taking notes while listening to unce, Planning, Elements, Ski AL AND NON-VERBAL CO ion-verbal and nonverbal e Conversation skills, Critical ment of Stress RPERSONAL COMMUNIC s of writing; Organizing pr	to lectur Ils, Effe OMMU tiquette; I thinki CATION inciples :iting; F	res (use of actively di NICATI ; Body 1 ing, Tear N of Para; Formal an	f Diction sagreein ON anguage mwork, graphs d Inforr	nary). ng, Initiating. e, grapevine, Group Disc in documents nal letter writ	Postures, cussion, In ;; Writing	ns, question Classe Gestures mpact of Classe introduct	es: 09 s, Facia Stress es: 09 tion and

Reference Books:

- 1. Dorch, Patricia. What Are Soft Skills? New York: Execu Dress Publisher, 2013.
- 2. Kamin, Maxine. Soft Skills Revolution: A Guide for Connecting with Compassion for Trainers, Teams, and Leaders. Washington, DC: Pfeiffer & Company, 2013.
- 3. Klaus, Peggy, Jane Rohman & Molly Hamaker. "The Hard Truth about Soft Skills", London: HarperCollins E-books, 2007.
- 4. Stein, Steven J. & Howard E. Book. "The EQ Edge: Emotional Intelligence and Your Success" Canada: Wiley & Sons, 2006
- 5. Suresh Kumar. English for Success. Cambridge University Press IndiaPvt.Ltd.2010.
- 6. Dorling Kindersley. Communication Skills & Soft Skills An Integrated Approach. India Pvt. Ltd. 2013.

Web References:

- 1. www.edufind.com
- 2. www.myenglishpages.com
- 3. http://grammar.ccc.comment.edu
- 4. http://owl.english.prudue.edu

E-Text Books:

- 1. http://bookboon.com/en/communication-ebooks-zip
- 2. http://www.bloomsbury-international.com/images/ezone/ebook/writing-skills-pdf.pdf
- 3. https://americanenglish.state.gov/files/ae/resource_files/developing_writing.pdf
- 4. http://learningenglishvocabularygrammar.com/files/idiomsandphraseswithmeaningsandexamplespdf.pdf
- s. http://www.robinwood.com/Democracy/General Essays/CriticalThinking.pdf

OE - IV Hours / Week **Course Code** Category Credits **Maximum Marks** L Т Р SEE С CIA Total AHSB19 Elective 3 3 30 70 100 **Tutorial Classes: Nil Total Classes: 45 Contact Classes: 45 Practical Classes: Nil OBJECTIVES:** The course should enable the students to: I. Understand key terms and concepts in cyber society, cyber ethics. II. Analyze fundamentals of Cyber Law III. Learn the importance of nine P's in ethics. IV. Understand artificial intelligence and Blockchain ethics. **MODULE-I CYBER SOCIETY** Classes: 09 Definitions, Specificities of the Cyberspace, Dimensions of Cyber Ethics in Cyber Society, Fourth Industrial Revolution, Users' Motivations in Cyber-Space, Core Values and Virtues, Old Values or Eschatological Vision?, Cyber Ethics by Norms, Laws and Relations Artificial Intelligence Ethics: "AI for Good", Cyber-Capitalism: Cyber-Ethics as Business Ethics. **MODULE-II CYBER LAW AND CYBER ETHICS** Classes: 09 **Cyber Law and Cyber Ethics** The Importance of Cyber Law, The Significance of Cyber Ethics, Cyber Crime is Unethical and Illegal, Ethics Education has Positive Impact, The Need for Cyber Regulation Based on Cyber Ethics, Very Dangerous Times. **MODULE-III** Classes: 09 ETHICS IN THE INFORMATION SOCIETY, THE NINE P'S Principles: Ethical Values, Participation: Access to Knowledge for All, People: Community, Identity, Gender, Generation, Education, Profession: Ethics of Information Professions, Privacy: Dignity, Data Mining, Security. Piracy: Intellectual Property, Cybercrime, Protection: Children and Young People, Power: Economic Power of Technology, Media and Consumers, Policy: Ethics of Regulation and Freedom. **MODULE-IV DISRUPTIVE CYBER TECHNOLOGIES AND AI ETHICS** Classes: 09 **Disruptive Cyber Technologies and Ethics -I** Artificial: Negative Moral Judgment?, Artificial: Ethically Positive Innovation?, Intelligence: Action-oriented Ability, Creation Story: Human Beings Responsibility, The Commandment to Love and Artificial Intelligence; Artificial Intelligence Ethics: Top Nine Ethical Issues in Artificial Intelligence, Five Core Principles to Keep AI Ethical, Ethics Should Inform AI – But Which Ethics? **MODULE-V DISRUPTIVE CYBER TECHNOLOGIES AND ETHICS -II** Classes: 09 **Disruptive Cyber Technologies and Ethics -II BLOCKCHAIN ETHICS:** Blockchain Definition and Description, Blockchain Anonymity and Privacy: Ethical, No Possibility to Be Forgotten, Blockchain for Voting, Blockchain for Transparent Trade Tracing, Blockchain Energy: Environmental Impact, Decentralised or Majority-Owned, Ethically More Benefits or Dangers, future jobs in cyber society.

CYBER LAW AND ETHICS

Text Books:

1. Christoph Stuckelberger, Pavan Duggal, "Cyber Ethics 4.0 Serving humanity with values", Globethics.net Global Series, 2018.

Reference Books:

- 1. Dr. Farooq Ahmad, Cyber Law in India, Allahbad Law Agency- Faridabad.
- 2. J.P. Sharma, SunainaKanojia, Cyber Laws
- 3. Harish Chander , Cyber Laws and IT Protection

E-Reference:

 $1. https://www.globethics.net/documents/4289936/13403236/Ge_Global_17_web_isbn9782889312641.pdf/$

OE - IV		T								
Course (Code	Category Hours / Week Credits Maximu							rks	
AHSB	SB20 Elective						SEE 70	Total 100		
Contact Classes: 45 Tutorial Classes: Nil Practical Classes: Nil Total Classes: 45										
I. Introdu II. Provid III. Comm IV. Explor	ould enable the econe inside known unicate the e the polici	e the students to nomic developm owledge on mon importance of fi es and practices trial and exit pol	ent element etary polici iscal polici in resourc	cy and i ies in p ce base	its import romoting infrastruc	ance in econ the economy		opment		
Module-I	Introduc	tion Economic	Developm	ent an	d its Det	erminants		Classe	es: 09	
* *		development and ors of developm								
Module-II									Classes: 09	
•		r in India; Finar narkets; Working				est rate policy	y; Review o	of monetary	policy of	
Module-III	Module-III Fiscal Policy and Public Finances								Classes: 09	
		ntre-State finan nomy; Problems					C		of state	
Module-IV	Resource	Base and Infra	astructure	è				Classe	es: 09	
financing infra	structure de	ure – education evelopment. Poli plic sector; comp	cies and F	Perform	ance in I	ndustry Grov				
Module-V	The Indu	strial and Exit	Policies					Classe	es: 09	
and disinvestm	ent debate;	Sector enterprise Growth and pa s in labour mark	ttern of ir	ndustria	lization;	Small-scale	sector; Pro	ductivity in		
Text Books:										
		-Adam Smith, in mic Developmer				eger.				
3. Money, Ban	king and P	ublic Finance by	Dr. V.C.S	Sinha						
4. Governmen	t of India, I	Economic Surve	y (Annual)), Minis	stry of Fi	nance, New I	Delhi.			
5 Jain a K (1986) Ecor	nomic Planning	in India A	shish P	ublishing	House New	v Delhi			

ECONOMIC POILICIES IN INDIA

Reference Books:

- 1. Ahluwalia, I. J. and I. M. D Little (Eds.) (1999), India's Economic Reforms and Development (Essays in honour of Manmohan Singh), Oxford University Press, New Delhi.
- 2. Bardhan, P. K. (9th Edition) (1999), The Political Economy of Development in India, Oxford University Press, New Delhi.
- 3. Bawa, R. s. and P. S. Raikhy (Ed.) (1997), Structural Changes in Indian Economy, Guru Nanak Dev University Press, Amritsar.
- 4. Brahmananda, P. R. and V. R. Panchmukhi (Eds.) (2001), Development Experience in the Indian Economy: Inter-State Perspectives, Book well, Delhi.
- 5. Chakravarty, S. (1987), Development Planning: The Indian Experience, Oxford University Press, New Delhi.
- 6. Dantwala, M. L. (1996), Dilemmas of Growth: The Indian Experience, Sage Publications, New Delhi.
- 7. Datt, R. (Ed.) (2001), Second Generation Economic Reforms in India, Deep & amp; Deep Publications, New Delhi.

Web References:

- 1. Parikh, K. S. (1999), India Development Report 1999-2000, Oxford University Press, New Delhi8.
- 2. Reserve Bank of India, Report on Currency and Finance, (Annual).
- 3. Sandesara, J. c. (1992), Industrial Policy and Planning, 1947-19919 : Tendencies, Interpretations and Issues, Sage Publications, New Delhi.

GLOBAL WARMING AND CLIMATE CHANGE

Course Code	Category	Ho	urs / W	eek	Credits	Max	imum M	arks
AHSB21	OEC	L	Т	Р	С	CIA	SEE	Total
	3 3 30 70 10							100
Contact Classes: 45 Tutorial Classes: Nil Practical Classes: Nil Total Classes: 60 OBJECTIVES:								
The course should ena VI. Understand the imp VII. Comprehend compo VIII. Understand imp	ortance of Ozone layer in t	ecosyste	m.		n of greenho	use gases	5.	
MODULE - I EAR	TH'S CLIMATE SYSTE	2 M					Class	ses: 09
	nment, Ozone layer – Ozon he Hydrological cycle, Gre	-	~ ~					
MODULE -II ATM	IOSPHERE AND ITS CO	OMPON	ENTS				Class	ses: 09
atmosphere, Composi	here – Physical and chemi tion of the atmospher Temperature inversion, Ef	e,Atmos	spheric	stabil	ity, Tempe	erature	l structur profile	
MODULE - III IMP.	ACTS OF CLIMATE CH	IANGE					Class	ses: 09
Impacts of Climate Ch Human Health, Industry Methods and Scenarios	nge: Changes of Temperat hange on various sectors by, Settlement and Society. c, Projected Impacts for d	– Agric	ulture,	Forestr	y and Ecos	ystem, V	Vater Re	esources
Climate Change, Risk o MODULE - IV OBS	ERVED CHANGES ANI) ITS C	AUSES	;			Class	ses: 09
Intergovernmental Pane	Carbon credits, CDM – el on Climate change, Cli obal Climate Models (GCM a.	mate Se	ensitivity	y and l	Feedbacks.	The Mo	ntreal Pr	otocol –
MODULE - V CLIN	MATE CHANGE AND M	IITIGA	TION N	MEASU	URES		Class	ses: 09
Compost, Eco-friendly Power. Mitigation Effect Energy Supply, Transpo	echanism, Carbon Trading plastic, Alternate Energy – orts in India and Adaptati ort, Buildings, Industry, A aste (MSW & Bio-waste,	Hydroge on fund gricultur	en, Bio- ing. Ke re, Fore	fules, S y Mitig stry – 0	Solar Energy gation Tech Carbon sequ	y, Wind a nologies lestration	and Hydr and Pra , Carbon	oelectric actices – a capture
cooperation.								Regiona
cooperation. Text Books:								

Reference Books:

- 1. Atmospheric Science, J.M. Wallace and P.V Hobbs, Elsevier/ Academic Press, 2006.
- 2. "Climate Change and Climate Variability on Hydrological Regimes", Jan C. Van Dam, Cambridge University Press, 2003.

E-Text Books:

- 1. https://www.worldcat.org/title/encyclopedia-of-global-warming-climate-change/oclc/805580328
- 2. https://libguides.nus.edu.sg/c.php?g=433566&p=2955835

OE: IV Course Code Hours / Week Credits Maximum Marks Category L Т Р С CIA SEE Total AHSB22 **Elective** 3 3 30 100 70 _ **Contact Classes: 45 Tutorial Classes: Nil Practical Classes: Nil Total Classes: 45 OBJECTIVES:** The course should enable the students to: Gain knowledge in world trade organization and agreements between nations. I. II. Safeguard the intellectual property with international trade agreements. III. Understand types of intellectual property rights. IV. Apply different laws in protection of intellectual property rights and its implementation. **MODULE-I INTRODUCTION** Classes: 10 General agreement on tariffs and trade (GATT) eight rounds: Uruguay round, world trade organization: structure, technology transfer, dispute resolution mechanism, Doha declaration world trade organization agreements including trade related intellectual properties rights and trade related investment measures. **MODULE-I** WORLD INTELLECTUAL PROPERTY ORGANIZATION Classes: 08 Paris convention, Bern convention, Budapest treaty, Madrid agreement, huge agreement. **MODULE-I** PATENTS Classes: 09 Historical background of intellectual property rights, introduction, definition and classification of intellectual property, patents, patentable and non-patentable inventions. Legal requirements for patents, types of patent applications, patent document: specification and claims, important procedural aspects, management of intellectual property rights assets and intellectual property portfolio, commercial exploitation of intellectual property. DESIGNS AND GEOGRAPHICAL INDICATIONS **MODULE-I** Classes: 10 Designs: basic requirements, procedure, convention application term, date, geographical indication: definition, what can be registered, who can apply, rights, term, restrictions. **MODULE-I** TRADEMARK AND COPYRIGHTS Classes: 08 Definition, classification of trademarks, classifications of goods and services, Vienna classification, trademarks procedure, trademarks enforcement: infringement and passing off, remedies, copyrights, term of copyrights, and procedure of copyright assignment of copyright, copyright infringement remedies. Text Books: P. K. Vasudeva, World Trade Organization: Implications on Indian Economy, Pearson Education, 2015. 1. P.KrishnaRao, WTO, Text and cases, Excel Books, 2015. 2. Carlos M.Correa- Intellectual property rights, The WTO and Developing countries-Zed books. 3. **Reference Books:** Caves, Frankel, Jones, World Trade and Payments-An Introduction, Pearson4. Education, 2015. 1. Carlos M.Correa- Intellectual property rights, The WTO and Developing countries-Zed books. 2. 3. Peter-Tobias stoll, Jan busche, Katrianarend- WTO- Trade –related aspects of IPR- Library of Congress.

INTELLECTUAL PROPERTY RIGHTS

Web References:

- http://www.ebooks directory.com
 http://Campus guides.lib.utah.edu

E-Text Books:

- http://www.bookboon.com
 http://www.freemagagement.com
 http://www.emeraldinsight.com

ENTREPRENEURSHIP

Course Code	Category	Ho	urs / We	ek	Credits	May	kimum Ma	arks
AHSR73	AHSB23 L T P C CIA SEE 3 - - 3 30 70						SEE	Tota
AIISD25							70	100
Contact Classes:	45 Tutorial Clas	sses: Nil	Prac	tical Cla	asses: Nil	Tot	al Classes	: 45
I. Understand II. Adopting o III. Understand	enable the student the Entrepreneurial f the key steps in the the stages of the en the of entrepreneurial	process and e elaboration trepreneu	on of bu	siness id	lea.	-		ccessfu
MODULE-I	UNDERSTANDIN	G ENTRE	PRENE	URIAI	L MINDSET		Class	es: 09
Entrepreneurs – ty	npact of entrepren pes of entrepreneur economic developm	rs -Approa	aches to	entrep	reneurship-	Process a	pproach-	
	INDIVIDUAL ENT PERSONALITY	FREPREN	NEURIA	L MIN	D-SET ANI)	Class	es: 09
motivations- Motiv Corporate Entrepre	I journeyStress and ational cycle – Entre neurial Mindset, the rategy-sustaining co	epreneuria e nature of	1 motiva corpora	tional be te entre	ehavior – En	trepreneu	rial compe	etencies
MODULE-III	LAUNCHING EN	FREPREN	NEURIA	L VEN	TURES		Class	es: 09
entrepreneurial Im entrepreneurship.	tification- Finding agination and Crea Ventures- Creating	ntivity- the	e nature	e of the quiring	e creativity	process	- Innovat	ion and
	tage and disadvantag	ges of Fran			FUDSHID		Class	
Franchising- advan	LEGAL CHALLE	NGES OF	, H.N.I.KI	(PREN				es: IIV
Franchising- advan MODULE-IV Intellectual proper trademark pitfalls. entrepreneurial Pla	LEGAL CHALLE ty protection - Pat Feasibility Analys n- The challenges of - Critical factors for	tents, Cop sis - Indu f new vent	oyrights 1stry an ture star	- Trade d comp t-ups, de	emarks and betitor analy eveloping an	vsis - Fo effective	ecrets - A prmulation business	woiding of the
Franchising- advan MODULE-IV Intellectual proper trademark pitfalls. entrepreneurial Pla Sources of finance	ty protection - Pat Feasibility Analys n- The challenges of	tents, Cop sis - Indu f new ventu new ventu	oyrights ustry an ture start ure devel	- Trade d comp t-ups, de opment	emarks and betitor analy eveloping an - The Evalua	vsis - Fo effective ation proc	ecrets - A prmulation business ess	voiding of the

Text Books:

- 1. D F Kuratko and T V Rao, "Entrepreneurship- A South-Asian Perspective", Cengage Learning, 2012.
- 2. Bruce R. Barringer/ R.Duane Ireland, "Entrepreneurship Successfully Launching New Ventures", Pearson, 4th Edition, 2015.
- 3. S.S.Khanka, Entrepreneurship Development, S. Chand Publications, 2015.

Reference Books:

- 1. Stuart Read, Effectual Entrepreneurship, Routledge, 2013.
- 2. Rajeev Roy, Entrepreneurship, Oxford publications, 2nd Edition, 2012.
- 3. Nandan .H, Fundamentals of Entrepreneurship, PHI, 2013.

ENVIRONMENTAL SCIENCES

IV Semester: Al	E / CSE	: / IT / ECE / EEE / ME /	CE						
Course Cod	le	Category	Hou	urs / V	Veek	Credits	Maxi	mum N	Iarks
AHSB07		MCC	L	Т	Р	С	CIA	SEE	Total
			-	-	-	-	30	70	100
Contact Classes	s: Nil	Tutorial Classes: Nil	Pr	actica	l Class	es: Nil	Total	Classe	s: Nil
 COURSE OBJECTIVES: The course should enable the students to: Analyze the interrelationship between living organism and environment. Understand the importance of environment by assessing its impact on the human world. III. Enrich the knowledge on themes of biodiversity, natural resources, pollution control and waste management. IV. Understand the constitutional protection given for environment. 									
MODULE-I	ENVI	RONMENT AND ECOSYS	TEMS						
Environment: Definition, scope and importance of environment, need for public awareness; Ecosystem: Definition, scope and importance of ecosystem, classification, structure and function of an ecosystem, food chains, food web and ecological pyramids, flow of energy; Biogeochemical cycles; Biomagnifications									
MODULE-II	MODULE-II NATURAL RESOURCES								
Natural resources: Classification of resources, living and nonliving resources; Water resources: Use and over utilization of surface and ground water, floods and droughts, dams, benefits and problems; Mineral resources: Use and exploitation; Land resources; Energy resources: Growing energy needs, renewable and non renewable energy sources, use of alternate energy source, case studies.									
MODULE-III	BIOD	IVERSITY AND BIOTIC	RESOU	URCE	S				
biodiversity: Cons diversity nation; H Threats to biodiver In situ and ex situ	umptive ot spots rsity: Ha conserva	sources: Introduction, defini- use, productive use, social of biodiversity bitat loss, poaching of wildli- tion; National biodiversity ac RONMENTAL POLLUTIO	, ethica ife, hun xt.	al, aest nan-wi	hetic an Idlife co	nd optional	values; I servation	ndia as of biod	a mega iversity:
MODULE-IV	GLOB	AL ENVIRONMENTAL F	PROBL	EMS					
pollution; Solid w management; Poll Concepts of biorer	vaste: M ution co nediation	Definition, causes and effect unicipal solid waste manage ntrol technologies: Waste w n; Global environmental prol , deforestation and desertifica	ement, vater tro blems a	compo eatmen	sition a t metho	nd character ods, primary	ristics of , seconda	e-waste ary and	and its tertiary;
MODULE-V	ENVI	RONMENTAL LEGISLAT	TIONS	AND S	SUSTA	INABLE D	EVELOP	MENT	
solid waste manag waste management	ement ar t and har able dev	Environmental protection ad ad handling rules, biomedical adling rules, Environmental in elopment, population and its reen building	waste mpact a	manag ssessm	ement a nent(EIA	nd handling A); Towards	rules2016 sustainab	5, hazard le future	ous :

Text Books:

- 1. Benny Joseph, "Environmental Studies", Tata McGraw Hill Publishing Co. Ltd, New Delhi, 2005.
- 2. Erach Bharucha, "Textbook of Environmental Studies for Undergraduate Courses", Universities Press. 2005.

Reference Books:

- 1. Anji Reddy .M, "Textbook of Environmental Sciences and Technology", BS Publications, 2007.
- 2. Anjaneyulu, "Introduction to Environmental Sciences", BS Publications, 2004.
- 3. Anubha Kaushik, Perspectives in Environmental Science, New age international. 3rd Edition, 2006.
- 4. Tyler Miller, Scott Spoolman, "Environmental Science", Cengage Learning, 14th Edition, 2012.

Web References:

- 1. https://www.tndte.com
- 2. https://www.nptel.ac.in/downloads
- 3. https://www.scribd.com
- 4. https://www.cuiet.info
- 5. https://www.sbtebihar.gov.in
- 6. https://www.ritchennai.org

ESSENCE OF INDIAN TRADITIONAL KNOWLEDGE

Course Code		Category Hours / Week Credits				Category Hours / Week Credits		rs / V	Veek	Credits	Ma	aximum	Mark
AHSB	17	MCC L T P C C				L T P C				CIA	SEE	Tota	
AIISD	30 70						70	100					
Contact Cla		Tutorial Classes: Nil	Pra	ictica	l Class	ses: Nil	Tota	l Classe	s: Nil				
II. Know the III. Know the	uld enable the nd the concept e need and im e various enact	te students to: of Traditional knowledge a portance of protecting tradit truents related to the protect ots of Intellectual property to	ional kr tion of t	nowled raditio	lge. nal kno		e						
MODULE-I	INTRODU	CTION TO TRADITION	AL KN	OWL	EDGE								
physical and so traditional know	cial contexts wledge syste	, nature and characteristics, in which traditional know ms. Indigenous Knowledg itional knowledge Vs wes	ledge d ge (IK)	levelop , char	b, the lacterist	nistorical in tics, traditio	npact of sonal kno	social ch wledge	ange o vis-à-vi				
MODULE-II	PROTECT	TION OF TRADITIONAL	KNOV	VLED	GE								
		wledge: The need for protective ny, Role of Government to h			al knov	vledge Signi	ificance of	of TK Pr	otectior				
MODULE-III	LEGAL F	RAME WORK AND TK											
Varieties Protec B: The Biologi	tion and Farn	d Other Traditional Forest her's Rights Act, 2001 (PPV) y Act 2002 and Rules 20	FR Act)	;	-								
Geographical in MODULE-IV		003. DNAL KNOWLEDGE AN	DINT	ELLE	CTUA	L PROPER	ety						
		edge protection, Legal conce						edge Ce	rtain no				
Systems of tradi	s of tradition						ge, Strat	egies to	increas				
IPR mechanism	ditional know	nal knowledge protection, legal conce vledge, global legal FORA for					Tradition	nal Knov	vledge.				
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VISION AND MISSION OF THE INSTITUTE

VISION

To bring forth professionally competent and socially sensitive engineers, capable of working across cultures meeting the global standards ethically.

MISSION

To provide students with an extensive and exceptional education that prepares them to excel in their profession, guided by dynamic intellectual community and be able to face the technically complex world with creative leadership qualities.

Further, be instrumental in emanating new knowledge through innovative research that emboldens entrepreneurship and economic development for the benefit of wide spread community.

B.TECH - PROGRAM OUTCOMES (POS)

- **PO-1:** Apply the knowledge of mathematics, science, engineering fundamentals, and an engineering specialization to the solution of complex engineering problems (**Engineering Knowledge**).
- **PO-2:** Identify, formulate, review research literature, and analyze complex engineering problems reaching substantiated conclusions using first principles of mathematics, natural sciences, and engineering sciences (**Problem Analysis**).
- **PO-3:** Design solutions for complex engineering problems and design system components or processes that meet the specified needs with appropriate consideration for the public health and safety, and the cultural, societal, and environmental considerations (**Design/Development of Solutions**).
- **PO-4:** Use research-based knowledge and research methods including design of experiments, analysis and interpretation of data, and synthesis of the information to provide valid conclusions (**Conduct Investigations of Complex Problems**).
- **PO-5:** Create, select, and apply appropriate techniques, resources, and modern engineering and IT tools including prediction and modeling to complex engineering activities with an understanding of the limitations (**Modern Tool Usage**).
- **PO-6:** Apply reasoning informed by the contextual knowledge to assess societal, health, safety, legal and cultural issues and the consequent responsibilities relevant to the professional engineering practice (**The Engineer and Society**).
- **PO-7:** Understand the impact of the professional engineering solutions in societal and environmental contexts, and demonstrate the knowledge of, and need for sustainable development (Environment and Sustainability).
- **PO-8:** Apply ethical principles and commit to professional ethics and responsibilities and norms of the engineering practice (**Ethics**).
- **PO-9:** Function effectively as an individual, and as a member or leader in diverse teams, and in multidisciplinary settings (**Individual and Team Work**).
- **PO-10:** Communicate effectively on complex engineering activities with the engineering community and with society at large, such as, being able to comprehend and write effective reports and design documentation, make effective presentations, and give and receive clear instructions (**Communication**).
- **PO-11:** Demonstrate knowledge and understanding of the engineering and management principles and apply these to one's own work, as a member and leader in a team, to manage projects and in multidisciplinary environments (**Project management and finance**).
- **PO-12**: Recognize the need for, and have the preparation and ability to engage in independent and lifelong learning in the broadest context of technological change (**Life-long learning**).

OBJECTIVES OF THE DEPARTMENT

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

PROGRAM EDUCATIONAL OBJECTIVES (PEO'S)

A graduate of the Electronics and Communication Engineering Program should:

- **PEO** I: To be successful in professional career by acquiring the knowledge in the fundamentals of Electronics and Communication Engineering principles and professional skills.
- **PEO II:** To be in a position to analyze real life problems and design socially accepted and economically feasible solutions in the respective fields.
- **PEO III:** To involve themselves in lifelong learning and professional development by pursuing higher education and participation in research and development activities.
- **PEO IV:** To exhibit good communication skills in their professional career, lead a team with good leadership traits and good interpersonal relationship with the members related to other engineering streams.

PROGRAM SPECIFIC OUTCOMES (PSO's)

- **PSO I: Professional Skills:** An ability to understand the basic concepts in Electronics & Communication Engineering and to apply them to various areas, like Electronics, Communications, Signal processing, VLSI, Embedded systems etc., in the design and implementation of complex systems.
- **PSO II: Problem-Solving Skills:** An ability to solve complex Electronics and communication Engineering problems, using latest hardware and software tools, along with analytical skills to arrive cost effective and appropriate solutions.
- **PSO III:** Successful Career and Entrepreneurship: An understanding of social-awareness & environmental-wisdom along with ethical responsibility to have a successful career and to sustain passion and zeal for real-world applications using optimal resources as an Entrepreneur.

FREQUENTLY ASKED QUESTIONS AND ANSWERS ABOUT AUTONOMY

1. Who grants Autonomy? UGC, Govt., AICTE or University

In case of Colleges affiliated to a university and where statutes for grant of autonomy are ready, it is the respective University that finally grants autonomy but only after concurrence from the respective state Government as well as UGC. The State Government has its own powers to grant autonomy directly to Govt. and Govt. aided Colleges.

2 Shall IARE award its own Degrees?

No. Degree will be awarded by Jawaharlal Nehru Technological University, Hyderabad with a mention of the name IARE on the Degree Certificate.

3 What is the difference between a Deemed University and an Autonomy College?

A Deemed University is fully autonomous to the extent of awarding its own Degree. A Deemed University is usually a Non-Affiliating version of a University and has similar responsibilities like any University. An Autonomous College enjoys Academic Autonomy alone. The University to which an autonomous college is affiliated will have checks on the performance of the autonomous college.

4 How will the Foreign Universities or other stake – holders know that we are an Autonomous College?

Autonomous status, once declared, shall be accepted by all the stake holders. The Govt. of Telangana mentions autonomous status during the First Year admission procedure. Foreign Universities and Indian Industries will know our status through our website.

5 What is the change of Status for Students and Teachers if we become Autonomous?

An autonomous college carries a prestigious image. Autonomy is actually earned out of our continued past efforts on academic performances, our capability of self- governance and the kind of quality education we offer.

6 Who will check whether the academic standard is maintained / improved after Autonomy? How will it be checked?

There is a built in mechanism in the autonomous working for this purpose. An Internal Committee called Academic Program Evaluation Committee, which will keep a watch on the academics and keep its reports and recommendations every year. In addition the highest academic council also supervises the academic matters. The standards of our question papers, the regularity of academic calendar, attendance of students, speed and transparency of result declaration and such other parameters are involved in this process.

7 Will the students of IARE as an Autonomous College qualify for University Medals and Prizes for academic excellence?

No. IARE has instituted its own awards, medals, etc. for the academic performance of the students. However for all other events like sports, cultural on co-curricular organized by the University the students shall qualify.

8 Can IARE have its own Convocation?

No. Since the University awards the Degree the Convocation will be that of the University, but there will be Graduation Day at IARE.

9 Can IARE give a provisional degree certificate?

Since the examinations are conducted by IARE and the results are also declared by IARE, the college sends a list of successful candidates with their final Grades and Grade Point Averages including CGPA to the University. Therefore with the prior permission of the University the college will be entitled to give the provisional certificate.

10 Will Academic Autonomy make a positive impact on the Placements or Employability?

Certainly. The number of students qualifying for placement interviews is expected to improve, due to rigorous and repetitive classroom teaching and continuous assessment. Also the autonomous status is more responsive to the needs of the industry. As a result therefore, there will be a lot of scope for industry oriented skill development built-in into the system. The graduates from an autonomous college will therefore represent better employability.

11 What is the proportion of Internal and External Assessment as an Autonomous College?

Presently, it is 70 % external and 30% internal. As the autonomy matures the internal assessment component shall be increased at the cost of external assessment.

12 Is it possible to have complete Internal Assessment for Theory or Practicals?

Yes indeed. We define our own system. We have the freedom to keep the proportion of external and internal assessment component to choose.

13 Why Credit based Grade System?

The credit based grade system is an accepted standard of academic performance the world over in all Universities. The acceptability of our graduates in the world market shall improve.

14 What exactly is a Credit based Grade System?

The credit based grade system defines a much better statistical way of judging the academic performance. One Lecture Hour per week of Teaching Learning process is assigned One Credit. One hour of laboratory work is assigned half credit. Letter Grades like A, B,C,D, etc. are assigned for a Range of Marks. (e.g. 91% and above is A+, 80 to 90% could be A etc.) in Absolute Grading System while grades are awarded by statistical analysis in relative grading system. We thus dispense with sharp numerical boundaries. Secondly, the grades are associated with defined Grade Points in the scale of 1 to 10. Weighted Average of Grade Points is also defined Grade Points are weighted by Credits and averaged over total credits in a Semester. This process is repeated for all Semesters and a CGPA defines the Final Academic Performance

15 What are the norms for the number of Credits per Semester and total number of Credits for UG/PG program?

These norms are usually defined by UGC or AICTE. Usually around 25 Credits per semester is the accepted norm.

16 What is a Semester Grade Point Average (SGPA)?

The performance of a student in a semester is indicated by a number called SGPA. The SGPA is the weighted average of the grade points obtained in all the courses registered by the student during the semester.

$$SGPA = \sum_{i=1}^{n} (C_i G_i) / \sum_{i=1}^{n} C_i$$

Where, C_i is the number of credits of the *i*th course and G_i is the grade point scored by the student in the *i*th course and *i* represent the number of courses in which a student registered in the concerned semester. SGPA is rounded to two decimal places.

17 What is a Cumulative Grade Point Average (CGPA)?

An up-to-date assessment of overall performance of a student from the time of his first registration is obtained by calculating a number called CGPA, which is weighted average of the grade points obtained in all the courses registered by the students since he entered the Institute.

$$CGPA = \sum_{j=1}^{m} \left(C_j S_j \right) / \sum_{j=1}^{m} C_j$$

Where, S_j is the SGPA of the j^{th} semester and C_j is the total number of credits upto the semester and *m* represent the number of semesters completed in which a student registered upto the semester. CGPA is rounded to two decimal places.

18 Is there any Software available for calculating Grade point averages and converting the same into Grades?

Yes, The institute has its own MIS software for calculation of SGPA, CGPA, etc.

19 Will the teacher be required to do the job of calculating SGPAs etc. and convert the same into Grades?

No. The teacher has to give marks obtained out of whatever maximum marks as it is. Rest is all done by the computer.

20 Will there be any Revaluation or Re-Examination System?

No. There will double valuation of answer scripts. There will be a make up Examination after a reasonable preparation time after the End Semester Examination for specific cases mentioned in the Rules and Regulations. In addition to this, there shall be a 'summer term' (compressed term) followed by the End Semester Exam, to save the precious time of students.

21 How fast Syllabi can be and should be changed?

Autonomy allows us the freedom to change the syllabi as often as we need.

22 Will the Degree be awarded on the basis of only final year performance?

No. The CGPA will reflect the average performance of all the semester taken together.

23 What are Statutory Academic Bodies?

Governing Body, Academic Council, Examination Committee and Board of Studies are the different statutory bodies. The participation of external members in every body is compulsory. The institute has nominated professors from IIT, NIT, University (the officers of the rank of Pro-vice Chancellor, Deans and Controller of Examinations) and also the reputed industrialist and industry experts on these bodies.

24 Who takes Decisions on Academic matters?

The Governing Body of institute is the top academic body and is responsible for all the academic decisions. Many decisions are also taken at the lower level like Boards of Studies. Decisions taken at the Boared of Studies level are to be ratified at the Academic Council and Governing Body.

25 What is the role of Examination committee?

The Examinations Committee is responsible for the smooth conduct of internal, End Semester and make up Examinations. All matters involving the conduct of examinations spot valuations, tabulations preparation of Grade Sheet etc fall within the duties of the Examination Committee.

26 Is there any mechanism for Grievance Redressal?

The institute has grievance redressal committee, headed by Dean - Student affairs and Dean - IQAC.

27 How many attempts are permitted for obtaining a Degree?

All such matters are defined in Rules & Regulation

28 Who declares the result?

The result declaration process is also defined. After tabulation work wherein the SGPA, CGPA and final Grades are ready, the entire result is reviewed by the Moderation Committee. Any unusual deviations or gross level discrepancies are deliberated and removed. The entire result is discussed in the Examinations and Result Committee for its approval. The result is then declared on the institute notice boards as well put on the web site and Students Corner. It is eventually sent to the University.

29 Who will keep the Student Academic Records, University or IARE?

It is the responsibility of the Dean, Academics of the Autonomous College to keep and preserve all the records.

30 What is our relationship with the JNT University?

We remain an affiliated college of the JNT University. The University has the right to nominate its members on the academic bodies of the college.

31 Shall we require University approval if we want to start any New Courses?

Yes, It is expected that approvals or such other matters from an autonomous college will receive priority.

32 Shall we get autonomy for PG and Doctoral Programs also?

Yes, presently our PG programs also enjoying autonomous status.

MALPRACTICES RULES

DISCIPLINARY ACTION FOR / IMPROPER CONDUCT IN EXAMINATIONS

S.No	Nature of Malpractices/Improper conduct	Punishment
	If the candidate:	
1. (a)	Possesses or keeps accessible in examination hall, any paper, note book, programmable calculator, cell phone, pager, palm computer or any other form of material concerned with or related to the subject of the examination (theory or practical) in which he is appearing but has not made use of (material shall include any marks on the body of the candidate which can be used as an aid in the subject of the examination)	Expulsion from the examination hall and cancellation of the performance in that subject only.
(b)	Gives assistance or guidance or receives it from any other candidate orally or by any other body language methods or communicates through cell phones with any candidate or persons in or outside the exam hall in respect of any matter.	Expulsion from the examination hall and cancellation of the performance in that subject only of all the candidates involved. In case of an outsider, he will be handed over to the police and a case is registered against him.
2.	Has copied in the examination hall from any paper, book, programmable calculators, palm computers or any other form of material relevant to the subject of the examination (theory or practical) in which the candidate is appearing.	Expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted to appear for the remaining examinations of the subjects of that Semester/year. The Hall Ticket of the candidate is to be cancelled and sent to the Controller of Examinations.
3.	Impersonates any other candidate in connection with the examination.	The candidate who has impersonated shall be expelled from examination hall. The candidate is also debarred and forfeits the seat. The performance of the original candidate, who has been impersonated, shall be cancelled in all the subjects of the examination (including practicals and project work) already appeared and shall not be allowed to appear for examinations of the remaining subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all semester end examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat. If the imposter is an outsider, he will be handed over to the police and a case is registered against him.

4.	Smuggles in the Answer book or additional sheet or takes out or arranges to send out the question paper during the examination or answer book or additional sheet, during or after the examination.	Expulsion from the examination hall and cancellation of performance in that subject and all the other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all semester end examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat.
5.	Uses objectionable, abusive or offensive language in the answer paper or in letters to the examiners or writes to the examiner requesting him to award pass marks.	Cancellation of the performance in that subject.
6.	Refuses to obey the orders of the Controller of Examinations /Additional Controller of Examinations/any officer on duty or misbehaves or creates disturbance of any kind in and around the examination hall or organizes a walk out or instigates others to walk out, or threatens the COE or any person on duty in or outside the examination hall of any injury to his person or to any of his relations whether by words, either spoken or written or by signs or by visible representation, assaults the COE or any person on duty in or outside the examination hall or any of his relations, or indulges in any other act of misconduct or mischief which result in damage to or destruction of property in the examination hall or any part of the Institute premises or engages in any other act which in the opinion of the officer on duty amounts to use of unfair means or misconduct or has the tendency to disrupt the orderly conduct of the examination.	In case of students of the college, they shall be expelled from examination halls and cancellation of their performance in that subject and all other subjects the candidate(s) has (have) already appeared and shall not be permitted to appear for the remaining examinations of the subjects of that semester/year. The candidates also are debarred and forfeit their seats. In case of outsiders, they will be handed over to the police and a police case is registered against them.
7.	Leaves the exam hall taking away answer script or intentionally tears off the script or any part thereof inside or outside the examination hall.	Expulsion from the examination hall and cancellation of performance in that subject and all the other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred for two consecutive semesters from class work and all semester end examinations. The continuation of the course by the candidate is subject to the academic regulations in connection with forfeiture of seat.

8.	Possess any lethal weapon or firearm in the examination hall.	Expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred and forfeits the seat.
9.	If student of the college, who is not a candidate for the particular examination or any person not connected with the college indulges in any malpractice or improper conduct mentioned in clause 6 to 8.	Student of the colleges expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year. The candidate is also debarred and forfeits the seat. Person(s) who do not belong to the College will be handed over to police and, a police
10.	Comes in a drunken condition to the examination hall.	case will be registered against them. Expulsion from the examination hall and cancellation of the performance in that subject and all other subjects the candidate has already appeared including practical examinations and project work and shall not be permitted for the remaining examinations of the subjects of that semester/year.
11.	Copying detected on the basis of internal evidence, such as, during valuation or during special scrutiny.	Cancellation of the performance in that subject and all other subjects the candidate has appeared including practical examinations and project work of that semester/year examinations.
12.	If any malpractice is detected which is not covered in the above clauses 1 to 11 shall be reported to the University for further action to award suitable punishment.	

THE LARE TO LINE

INSTITUTE OF AERONAUTICAL ENGINEERING

(Autonomous) Dundigal, Hyderabad - 500 043

UNDERTAKING BY STUDENT / PARENT

"To make the students attend the classes regularly from the first day of starting of classes and be aware of the College regulations, the following Undertaking Form is introduced which should be signed by both student and parent. The same should be submitted to the Dean, Academic".

I, Mr. / Ms. ------ joining I Semester / III Semester for the academic year 2018-2019 / 2019-2020 in Institute of Aeronautical Engineering, Hyderabad, do hereby undertake and abide by the following terms, and I will bring the ACKNOWLEDGEMENT duly signed by me and my parent and submit it to the Dean, Academic.

- 1. I will attend all the classes as per the timetable from the starting day of the semester specified in the institute Academic Calendar. In case, I do not turn up even after two weeks of starting of classes, I shall be ineligible to continue for the current academic year.
- 2. I will be regular and punctual to all the classes (theory/laboratory/project) and secure attendance of not less than 75% in every course as stipulated by Institute. I am fully aware that an attendance of less than 65% in more than 60% of theory courses in a semester will make me lose one year.
- 3. I will compulsorily follow the dress code prescribed by the college.
- 4. I will conduct myself in a highly disciplined and decent manner both inside the classroom and on campus, failing which suitable action may be taken against me as per the rules and regulations of the institute.
- 5. I will concentrate on my studies without wasting time in the Campus/Hostel/Residence and attend all the tests to secure more than the minimum prescribed Class/Sessional Marks in each course. I will submit the assignments given in time to improve my performance.
- 6. I will not use Mobile Phone in the institute premises and also, I will not involve in any form of ragging inside or outside the campus. I am fully aware that using mobile phone to the institute premises is not permissible and involving in Ragging is an offence and punishable as per JNTUH/UGC rules and the law.
- 7. I declare that I shall not indulge in ragging, eve-teasing, smoking, consuming alcohol drug abuse or any other anti-social activity in the college premises, hostel, on educational tours, industrial visits or elsewhere.
- 8. I will pay tuition fees, examination fees and any other dues within the stipulated time as required by the Institution / authorities, failing which I will not be permitted to attend the classes.
- 9. I will not cause or involve in any sort of violence or disturbance both within and outside the college campus.
- 10. If I absent myself continuously for 3 days, my parents will have to meet the HOD concerned/ Principal.
- 11. I hereby acknowledge that I have received a copy of IARE R18 Academic Rules and Regulations, Syllabus copy and hence, I shall abide by all the rules specified in it.

ACKNOWLEDGEMENT

I have carefully gone through the terms of the undertaking mentioned above and I understand that following these are for my/his/her own benefit and improvement. I also understand that if I/he/she fail to comply with these terms, shall be liable for suitable action as per Institute/JNTUH/AICTE/UGC rules and the law. I undertake that I/he/she will strictly follow the above terms.

Signature of Student with Date

Signature of Parent with Date Name & Address with Phone Number